To all our customers

Regarding the change of names mentioned in the document, such as Hitachi Electric and Hitachi XX, to Renesas Technology Corp.

The semiconductor operations of Mitsubishi Electric and Hitachi were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Hitachi, Hitachi, Ltd., Hitachi Semiconductors, and other Hitachi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Renesas Technology Home Page: http://www.renesas.com

DataSheet4U.com

Renesas Technology Corp. DataShev Customer Support Dept. April 1, 2003

DataSheet4U.com





Cautions

Keep safety first in your circuit designs!

 Renesas Technology Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- 1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corporation product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corporation or a third party.
- Renesas Technology Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- 3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corporation or an authorized Renesas Technology Corporation product distributor for the latest product information before purchasing a product listed herein. Details heet4U.com
 - The information described here may contain technical inaccuracies or typographical errors.
- Renesas Technology Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.

Please also pay attention to information published by Renesas Technology Corporation by various means, including the Renesas Technology Corporation Semiconductor home page (http://www.renesas.com).

DataShe

- 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- 5. Renesas Technology Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corporation or an authorized Renesas Technology Corporation product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- The prior written approval of Renesas Technology Corporation is necessary to reprint or reproduce in whole or in part these materials.
- 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
- Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to the export control laws and regulations of Japan and/or the country of destination is table to ta
 - 8. Please contact Renesas Technology Corporation for further details on these materials or the products contained therein.

The revision list can be viewed directly by clicking the title page.

The revision list summarizes the locations of revisions and additions. Details should always be checked by referring to the relevant text.

SH7604

Hardware Manual

RENESAS

DataSheet4U.com

et4U.com

DataShe

ADE-602-085C Rev. 4.0 3/5/03 Hitachi, Ltd.

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

Cautions

- 1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
- 2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- 3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly
- conthreaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear DataSher power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
 - 4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
 - 5. This product is not designed to be radiation resistant.
 - 6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
 - 7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

DataSheet4U.com

www.DataSheet4U.com

Preface

The SH7604 implements high-performance operations by using a CPU which employs the Reduced Instruction Set Computer (RISC) system. The SH7604 is a new-generation RISC microcomputer which realizes low power consumption, an essential feature of microcomputer devices, as well as integrating peripheral features necessary for system configuration.

The CPU of the SH7604 has a set of RISC-type instructions; basic instructions operate at one state per instruction, that is, in one system clock cycle, dramatically increasing execution speeds. The SH7604 incorporates a 32-bit multiplier which performs high-speed sum-of-product (multiply-and-accumulate) operations. Instructions used by the SH7604 are upwardly compatible with the SH7000 Series, allowing easy migration from the SH7000 Series to the SH7604.

Moreover, the SH7604 incorporates on-chip peripheral modules such as an interrupt controller (INTC), direct memory access controller (DMAC), division unit (DIVU), timers (FRT, WDT), and serial communication interface (SCI), so that a user system can be configured using the minimum number of parts.

On-chip cache memory enhances the CPU throughput. A bus control feature, which supports external memory access, improves external memory access efficiency, allowing direct connection to synchronous DRAM, DRAM, and pseudo-SRAM without the help of glue logic.

This hardware manual explains the hardware features of the SH7604. For details of instructions, see the Programming Manual.

Related Documents

et4U.com

SH7604 instructions

"SH-1/SH-2 Programming Manual" (Document No.: ADE-602-063B)

For the development environment system, call your nearest Hitachi sales office.

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

www.DataSheet4U.com List of Items Revised or Added for This Version

Section	Page	Item	Description (see Manual for details)
1.1.1 Features of the SH7604	2	Operation Modes	Description of Clock mode added
	4	Package	176-pin plastic TFBGA (TBP-176) added
1.3.1 Pin Arrangement	5	Product Lineup	Added
	8	Figure 1.3 Pin Arrangement (176-Pin Plastic TFBGA)	Added
1.3.2 Pin Functions	9	Table 1.1 Pin Functions	Pin No. (TBP-176) added
3.2.2 Clock Operating Mode Setting	51		Description added
	52	Table 3.3 Clock Mode Pin Settings and States	Note 3 added
3.2.7 Notes on Board Design	61	When Using PLL Oscillation Circuits	Description replaced
	62	Figure 3.9 Design Consideration When Using PLL Oscillation Circuits	Figure amended, additional description of figure
Appendix C External Dimensions	616	Figure C.2 External Dimensions (TBP-176)	Added

et4U.com

DataShe

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

Contents

	Secti		Overview and Pin Functions	1 1
	1.1	1.1.1	Features Features of the SH7604	1
	1.2		Diagram	6
	1.2		tion of Pins	0 7
	1.5	1.3.1	Pin Arrangement	, 7
		1.3.2	Pin Functions	, 9
		1.5.2		,
	Secti	on 2	CPU	15
	2.1	Register	r Configuration	15
		2.1.1	General Registers	15
		2.1.2	Control Registers	16
		2.1.3	System Registers	17
		2.1.4	Initial Values of Registers	17
	2.2	Data Fo	rmats	18
		2.2.1	Data Format in Registers	18
		2.2.2	Data Format in Memory	18
		2.2.3	Immediate Data Format.	19
	2.3	Instruct	ion Features	19
		2.3.1	RISC-Type Instruction Set	19
		2.3.2	Addressing Modes	22
		2.3.3	Instruction Formats	25
	2.4	Instruct	ion Set	29
et4U.co		2.4.1	Instruction Set by Classification	DataShe
		2.4.2	Operation Code Map	42
	2.5		ing States	44
		2.5.1	State Transitions	44
		2.5.2	Power-Down State	46
		2.3.2		10
	Secti	on 3	Oscillator Circuits and Operating Modes	49
	3.1		1 C	49
	3.2		p Clock Pulse Generator and Operating Modes	49
		3.2.1	Clock Pulse Generator	49
		3.2.2	Clock Operating Mode Settings	51
		3.2.3	Connecting a Crystal Resonator	52
		3.2.4	Inputting an External Clock	54
		325	Selecting Operating Frequency with a Register	-
DataSl	neet4l	3.2.6	Operating Modes and Frequency Ranges	4 U.co m 60
		3.2.7	Notes on Board Design	60
			C	

WWW	.Data 3.3	Sheet4l Bus Wi	U.com idth of the CS0 Area	62
	3.4		ing between Master Mode and Slave Mode	63
			8	
	Secti	on 4	Exception Handling	65
	4.1	Overvie	ew	65
		4.1.1	Types of Exception Handling and Priority Order	65
		4.1.2	Exception Handling Operations	66
		4.1.3	Exception Vector Table	67
	4.2	Resets.		69
		4.2.1	Types of Resets	69
		4.2.2	Power-On Reset	70
		4.2.3	Manual Reset	70
	4.3	Addres	s Errors	71
		4.3.1	Sources of Address Errors	71
		4.3.2	Address Error Exception Handling	72
	4.4	Interrup	pts	72
		4.4.1	Interrupt Sources	72
		4.4.2	Interrupt Priority Levels	73
		4.4.3	Interrupt Exception Handling	73
	4.5	Excepti	ions Triggered by Instructions	74
		4.5.1	Instruction-Triggered Exception Types	74
		4.5.2	Trap Instructions	74
		4.5.3	Illegal Slot Instructions .DataSheet4U.com	74
		4.5.4	General Illegal Instructions	75
	4.6	When H	Exception Sources are Not Accepted	75
		4.6.1	Immediately after a Delayed Branch Instruction	75
et4U.	com	4.6.2	Immediately after an Interrupt-Disabled Instruction	76ataShe
	4.7	Stack S	tatus after Exception Handling	76
	4.8	Usage I	Notes	76
		4.8.1	Value of Stack Pointer (SP)	76
		4.8.2	Value of Vector Base Register (VBR)	76
		4.8.3	Address Errors Caused by Stacking of Address Error Exception Handling	77
		4.8.4	Manual Reset during Register Access	77
	Secti	on 5	Interrupt Controller (INTC)	79
	5.1	Overvie	ew	79
		5.1.1	Features	79
		5.1.2	Block Diagram	79
		5.1.3	Pin Configuration	81
		5.1.4	Register Configuration	81
Data	Sheet4	Interru	pt Sources	e82U.com
		5.2.1	NMI Interrupt	82
		5.2.2	User Break Interrupt	82



Ï

www.Data	Sheet4U 5.2.3	I.com IRL Interrupts	83
	5.2.4	On-chip Peripheral Module Interrupts	
	5.2.5	Interrupt Exception Vectors and Priority Order	86
5.3		ption of Registers	
5.5	5.3.1	Interrupt Priority Level Setting Register A (IPRA)	
	5.3.2	Interrupt Priority Level Setting Register B (IPRB)	
	5.3.3	Vector Number Setting Register WDT (VCRWDT)	
	5.3.4	Vector Number Setting Register A (VCRA)	
	5.3.5	Vector Number Setting Register B (VCRB)	
	5.3.6	Vector Number Setting Register D (VCRD)	
	5.3.7	Vector Number Setting Register D (VCRD)	
	5.3.8	Interrupt Control Register (ICR)	
5.4		pt Operation	
5.1	5.4.1	Interrupt Sequence	97
	5.4.2	Stack after Interrupt Exception Handling	99
5.5		pt Response Time	
5.6		ng of Pins IRL3–IRL0	
5.7	-	Notes	
011	e suge		100
Sec	tion 6	User Break Controller	107
6.1	Overvi	ew	107
	6.1.1	Features	
	6.1.2	Block DiagramDataSheet4U.com	108
	6.1.3	Register Configuration	109
6.2	Registe	er Descriptions	110
	6.2.1	Break Address Register A (BARA)	
et4U.com	6.2.2	Break Address Mask Register A (BAMRA)	HataShe
	6.2.3	Break Bus Cycle Register A (BBRA)	
	6.2.4	Break Address Register B (BARB)	114
	6.2.5	Break Address Mask Register B (BAMRB)	114
	6.2.6	Break Data Register B (BDRB)	114
	6.2.7	Break Data Mask Register B (BDMRB)	115
	6.2.8	Bus Break Register B (BBRB)	116
	6.2.9	Break Control Register (BRCR)	116
6.3	Operat	ion	120
	6.3.1	Flow of the User Break Operation	120
	6.3.2	Break on Instruction Fetch Cycle	120
	6.3.3	Break on Data Access Cycle	121
	6.3.4	Break on External Bus Cycle	122
	6.3.5	Program Counter (PC) Values Saved	122
DataSheet	463.6	Example of Use	
	6.3.7	Usage Notes	126
	6.3.8	SH7000 Series Compatible Mode	

www.Data Sect	Sheet4	U.com Bus State Controller (BSC)	129
7.1	Overvi	ew	129
	7.1.1	Features	129
	7.1.2	Block Diagram	130
	7.1.3	Pin Configuration	132
	7.1.4	Register Configuration	
	7.1.5	Address Map	
7.2	Descrip	otion of Registers	
	7.2.1	Bus Control Register 1 (BCR1)	
	7.2.2	Bus Control Register 2 (BCR2)	
	7.2.3	Wait Control Register (WCR)	
	7.2.4	Individual Memory Control Register (MCR)	142
	7.2.5	Refresh Timer Control/Status Register (RTCSR)	146
	7.2.6	Refresh Timer Counter (RTCNT)	
	7.2.7	Refresh Time Constant Register (RTCOR)	
7.3	Access	Size and Data Alignment	
	7.3.1	Connection to Ordinary Devices	
	7.3.2	Connection to Little-Endian Devices	
7.4	Access	ing Ordinary Space	151
	7.4.1	Basic Timing	
	7.4.2	Wait State Control	
7.5	Synchr	onous DRAM Interface	157
	7.5.1	Synchronous DRAM Direct Connection	
	7.5.2	Address Multiplexing	
	7.5.3	Burst Reads	160
	7.5.4	Single Reads	164
t4U.com	7.5.5	Writes	165 _{ataShe}
1-0.0011	7.5.6	Bank Active Function	
	7.5.7	Refreshes	
	7.5.8	Power-On Sequence	177
	7.5.9	Phase Shift by PLL	
7.6	DRAM	Interface	
	7.6.1	DRAM Direct Connection.	
	7.6.2	Address Multiplexing	
	7.6.3	Basic Timing	
	7.6.4	Wait State Control	
	7.6.5	Burst Access	
	7.6.6	Refresh Timing	188
	7.6.7	Power-On Sequence	
7.7		-SRAM Interface	
DataSheet		Pseudo-SRAM Direct Connection	
	7.7.2	Basic Timing	
	7.7.3	Wait State Control	



iv

www.[DataSI	heet4U. 7.7.4	.com Burst Access	10/
		7.7.5	Refreshing	
			Power-On Sequence	
	7.8		OM Interface	
	7.9		etween Access Cycles	
			pitration	
			Master Mode	
			Slave Mode	
			Partial-Share Master Mode	
			External Bus Address Monitor	
			Master/Slave Coordination	
			opics	
	/.11		Resets	
			Access as Seen from the CPU or DMAC	
			Emulator	
		7.11.5		212
	Section	on 8	Cache	213
	8.1	Introdu	ction	213
	8.2	Cache (Control Register (CCR)	214
	8.3	Address	s Space and the Cache	216
	8.4	Cache (Dperation	216
		8.4.1	Cache Reads	216
		8.4.2	Write Access DataSheet4U.com	219
		8.4.3	Cache-Through Access	
		8.4.4	The TAS Instruction	221
		8.4.5	Pseudo-LRU and Cache Replacement.	222
et4U.co	m	8.4.6	Cache Initialization	224 She
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		8.4.7	Associative Purges	
		8.4.8	Data Array Access	224
		8.4.9	Address Array Access	225
	8.5	Cache U	Jse	226
		8.5.1	Initialization	226
		8.5.2	Purge of Specific Lines	227
		8.5.3	Cache Data Coherency	
		8.5.4	Two-Way Cache Mode	
		8.5.5	Usage Notes	
	Section	on O	Direct Mamory Access Controller (DMAC)	221
			Direct Memory Access Controller (DMAC)	
	9.1		Exections	
		9.1.1	Features	
DataSl			Block Diagram	
		9.1.3	Pin Configuration	
		9.1.4	Register Configuration	254

www.Data 9.2	Sheet4l Registe	J.com r Descriptions	235
7.2	9.2.1	DMA Source Address Registers 0 and 1 (SAR0 and SAR1)	
	9.2.2	DMA Destination Address Registers 0 and 1 (DAR0 and DAR1)	
	9.2.3	DMA Transfer Count Registers 0 and 1 (TCR0 and TCR1)	
	9.2.4	DMA Channel Control Registers 0 and 1 (CHCR0 and CHCR1)	
	9.2.5	DMA Vector Number Registers 0 and 1 (VCRDMA0, VCRDMA1)	
	9.2.6	DMA Request/Response Selection Control Registers 0 and 1	
	2.2.0	(DRCR0, DRCR1)	242
	9.2.7	DMA Operation Register (DMAOR)	
9.3	Operati	on	
	9.3.1	DMA Transfer Flow	
	9.3.2	DMA Transfer Requests	
	9.3.3	Channel Priorities	
	9.3.4	DMA Transfer Types	
	9.3.5	Number of Bus Cycles	
	9.3.6	DMA Transfer Request Acknowledge Signal Output Timing	
	9.3.7	DREQ Pin Input Detection Timing	
	9.3.8	DMA Transfer End	
9.4	Exampl	les of Use	284
	9.4.1	DMA Transfer Between On-Chip SCI and External Memory	284
9.5	Usage l	Notes	285
~ .			
		Division Unit DataSheet4U.com	
10.1	Overvie	ew	287
	10.1.1	Features	287
		Block Diagram	
et4U.com		Register Configuration	
10.2	-	ption of Registers	
		Divisor Register (DVSR)	
		Dividend Register L for 32-Bit Division (DVDNT)	
		Division Control Register (DVCR)	
		Vector Number Setting Register DIV (VCRDIV)	
		Dividend Register H (DVDNTH)	
		Dividend Register L (DVDNTL)	
10.3		on	
		64-Bit ÷ 32-Bit Operations	
		32-Bit ÷ 32-Bit Operations	
		Handling of Overflows	
10.4	U	Notes	
	10.4.1	Access	293

DataSheet410.4.2 Overflow Flag

Renesas

vi

www.DataS	heet4U	.com 16-Bit Free-Running Timer	295
11.1	Overvi	ew	295
		Features	
		Block Diagram	
		Pin Configuration	
		Register Configuration	
11.2		r Descriptions	
	-	Free-Running Counter (FRC)	
		Output Compare Registers A and B (OCRA and OCRB)	
		Input Capture Register (ICR)	
		Timer Interrupt Enable Register (TIER)	
		Free-Running Timer Control/Status Register (FTCSR)	
		Timer Control Register (TCR)	
		Timer Output Compare Control Register (TOCR)	
11.3		iterface	
11.4	Operati	on	307
	11.4.1	FRC Count Timing	307
		Output Timing for Output Compare	
		FRC Clear Timing	
		Input Capture Input Timing	
		Input Capture Flag (ICF) Setting Timing	
	11.4.6	Output Compare Flag (OCFA, OCFB) Setting Timing	310
		Timer Overflow Flag (OVF) Setting Timing	
11.5		ot Sources	
11.6	Examp	le of FRT Use	312
11.7	Usage 1	Notes	313
et4U.com	•		DataShe
	on 12	Watchdog Timer (WDT)	
12.1	Overvie	ew	319
	12.1.1	Features	319
	12.1.2	Block Diagram	320
	12.1.3	Pin Configuration	320
	12.1.4	Register Configuration	321
12.2	Registe	r Descriptions	321
	12.2.1	Watchdog Timer Counter (WTCNT)	321
	12.2.2	Watchdog Timer Control/Status Register (WTCSR)	322
	12.2.3	Reset Control/Status Register (RSTCSR)	323
	12.2.4	Register Access	324
12.3	Operati	on	326
	12.3.1	Operation in Watchdog Timer Mode	326
DataSheet4	12.3.2	Operation in Interval Timer Mode	e6 28 .com
	12.3.3	Operation in Standby Mode	328
	12.3.4	Timing of Overflow Flag (OVF) Setting	329

www.Data	Sheet4	U.com	220
12.4		Timing of Watchdog Timer Overflow Flag (WOVF) Setting	
12.4		Contention between WTCNT Write and Increment	
		Changing CKS2 to CKS0 Bit Values	
		Switching between Watchdog Timer and Interval Timer Mode	
		System Reset with WDTOVF	
	12.4.5	Internal Reset in Watchdog Timer Mode	331
Sect	ion 13	Serial Communication Interface	333
13.1	Overvi	ew	333
	13.1.1	Features	333
	13.1.2	Block Diagram	334
	13.1.3	Pin Configuration	334
	13.1.4	Register Configuration	335
13.2	Registe	er Descriptions	335
		Receive Shift Register (RSR)	
	13.2.2	Receive Data Register (RDR)	335
	13.2.3	Transmit Shift Register (TSR)	336
		Transmit Data Register (TDR)	
	13.2.5	Serial Mode Register (SMR)	336
	13.2.6	Serial Control Register (SCR)	339
	13.2.7	Serial Status Register (SSR)	342
		Bit Rate Register (BRR) DataSheet4U.com	
13.3	Operati	ion	352
	13.3.1	Overview	352
	13.3.2	Operation in Asynchronous Mode	354
et4U.com		Multiprocessor Communication	
,(+0.00m		Clocked Synchronous Operation	
13.4	SCI Int	errupt Sources and the DMAC	381
13.5		Notes	
C	• • • •		
Sect	100 14	Power-Down Modes	385

	Section	on 14	Power-Down Modes	385
	14.1	Overvie	PW	385
		14.1.1	Power-Down Modes	385
		14.1.2	Register	386
	14.2	Descrip	tion of Register	387
		14.2.1	Standby Control Register (SBYCR)	387
	14.3	Sleep M	fode	389
		14.3.1	Transition to Sleep Mode	389
		14.3.2	Canceling Sleep Mode	389
)atas	14.4	Standby	Mode	889U.com
, and c	0110011	14.4.1	Transition to Standby Mode	389
		14.4.2	Canceling Standby Mode	390



www.l	DataS	heet4U	.com Standby Mode Cancellation by NMI	201
			Clock Pause Function	
			Notes on Standby Mode	
	14.5		Standby Function	
	14.5		Transition to Module Standby Function	
			Clearing the Module Standby Function	
		14.3.2	clearing the Module Standby I diction	575
	Secti	on 15	Electrical Characteristics (5V Version)	395
	15.1	Absolu	te Maximum Ratings	395
	15.2	DC Cha	aracteristics	396
	15.3	AC Cha	aracteristics	398
		15.3.1	Clock Timing	398
		15.3.2	Control Signal Timing	402
		15.3.3	Bus Timing	408
		15.3.4	DMAC Timing	474
		15.3.5	Free-Running Timer Timing	475
		15.3.6	Watchdog Timer Timing	476
		15.3.7	Serial Communication Interface Timing	477
		15.3.8	AC Characteristics Measurement Conditions	478
	a	1.5		
			Electrical Characteristics (3V Version)	
	16.1	Absolu	te Maximum Ratings	479
	16.1 16.2	Absolu DC Cha	te Maximum Ratings aracteristics	479 480
	16.1	Absolut DC Cha AC Cha	te Maximum Ratings	479 480 482
	16.1 16.2	Absolut DC Cha AC Cha 16.3.1	te Maximum Ratings aracteristics	479 480 482 482
	16.1 16.2	Absolut DC Cha AC Cha 16.3.1 16.3.2	te Maximum Ratings aracteristics	479 480 482 482 486
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3	te Maximum Ratings	479 480 482 482 486 492
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4	te Maximum Ratings	479 480 482 482 486 492 558
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5	te Maximum Ratings	479 480 482 482 486 492 558 559
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6	te Maximum Ratings	479 480 482 482 486 492 558 559 560
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7 16.3.8	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561 562
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7 16.3.8	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561 562
et4U.co	16.1 16.2 16.3	Absolut DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7 16.3.8 endix A	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561 562 563
et4U.co	16.1 16.2 16.3 om Appe	Absolu DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7 16.3.8 endix A endix B	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561 562 563 565
et4U.co	16.1 16.2 16.3 om Appe	Absolu DC Cha AC Cha 16.3.1 16.3.2 16.3.3 16.3.4 16.3.5 16.3.6 16.3.7 16.3.8 endix A endix B	te Maximum Ratings	479 480 482 482 486 492 558 559 560 561 562 563 565

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

x DataSheet4U.com

www.DataSheet4U.com Section 1 Overview and Pin Functions

1.1 SH7604 Features

The SH7604 is a new-generation single-chip RISC microprocessor that integrates a Hitachioriginal CPU, a multiplier, cache memory, and peripheral functions required for system configuration.

The CPU features a RISC-type instruction set. Most instructions can be executed in one clock cycle, which greatly improves instruction execution speed. In addition, the on-chip 4-kbyte cache memory and divider enhance data processing ability.

The SH7604 is also provided with on-chip peripheral functions including a direct memory access controller (DMAC), timers, a serial communication interface (SCI), and an interrupt controller. External memory access support functions (provided by the bus state controller) enable direct connection to DRAM, synchronous DRAM, and pseudo-SRAM.

The high-speed CPU and comprehensive peripheral functions enable designers to construct highperformance systems with advanced functionality at low cost, even in applications such as realtime control that require very high speeds, impossible with conventional microprocessors.

1.1.1 Features of the SH7604

CPU:

Original Hitachi architecture ٠

et4U.com 32-bit internal configuration

- General-registers: ٠
 - Sixteen 32-bit general registers
 - Three 32-bit control registers
 - Four 32-bit system registers
- RISC-type instruction set: ٠
 - Instruction length: 16-bit fixed length for improved code efficiency
 - Load-store architecture (basic arithmetic and logic operations are executed between registers)
 - Delayed conditional/unconditional branch instructions reduce pipeline disruption during branching
 - Instruction set based on C language

• Instruction execution time: one instruction/state (35 ns/instruction at 28.7 MHz opsation) et 4U.com

Address space: 4 Gbytes available in the architecture (128-Mbyte memory space)

- Www.DataSheet4U.com
 On-chip multiplier: multiply operations (32 bits × 32 bits → 64 bits) and multiply-andaccumulate operations (32 bits \times 32 bits + 64 bits) \rightarrow 64 bits) executed in 2 to 4 states
 - Five-stage pipeline ٠

Operating Modes:

- Clock mode: selected from the combination of an on-chip oscillator module, a frequency multiplier, clock output, PLL synchronization, and 90° phase shifting (the range of choices depends on the package)
- Slave/master mode
- ٠ Processing states
 - Power-on reset state
 - Manual reset state
 - Exception handling state
 - Program execution state
 - Power-down state
 - Bus-released state
- Power-down states
 - Sleep mode
 - Standby mode
 - Module stop mode

Interrupt Controller (INTC):

- Five external interrupt pins (NMI, IRL0 to IRL3), encoded input of 15 external interrupt • et4U.comsources via pins IRL0 to IRL3
 - Twelve internal interrupt sources (DMAC $\times 2$, DIVU $\times 1$, FRT $\times 3$, WDT $\times 1$, SCI $\times 4$, • $REF \times 1$)
 - Sixteen programmable priority levels •
 - Vector number settable for each internal interrupt source .
 - Auto-vector or external vector selectable as vector for external interrupts via pins IRL0 to **IRL3**

User Break Controller (UBC):

- Generates an interrupt when the CPU or DMAC generates an address, data, or bus cycle with ٠ the specified conditions (address, data, CPU cycle/non-CUP cycle, instruction fetch/data access, read/write, byte/word/longword access)
- Simplifies configuration of a self-debugger

www.DataSheet4U.com

www.DataSheet4U.com Clock Pulse Generator (CPG)/Phase Locked Loop (PLL):

- On-chip clock pulse generator
- Crystal clock source or external clock source can be selected
- Clock multiplication (×1, ×2, ×4), PLL synchronization, or 90° phase shift can be selected
- Supports clock pause function for frequency change of external clock

Bus State Controller (BSC):

- Supports external memory access
 - 32-bit external data bus
- Memory address space divided into four areas. It is possible to set the following characteristics for each area (32 Mbyte linear):
 - Bus size (8, 16, or 32 bits)
 - Number of wait cycles settable or not settable
 - Setting the memory space type simplifies connection to DRAM, synchronous DRAM, pseudo-SRAM, and burst ROM
 - Outputs signals \overline{RAS} , \overline{CAS} , \overline{CE} , and \overline{OE} corresponding to DRAM, synchronous DRAM, and pseudo-SRAM areas
 - Tp cycles can be generated to assure RAS precharge time
 - Address multiplexing is supported internally, so DRAM and synchronous DRAM can be connected directly DataSheet4U.com
 - Outputs chip select signals ($\overline{CS0}$ to $\overline{CS3}$) for each area
- DRAM/synchronous DRAM/pseudo-SRAM refresh functions
 - Programmable refresh interval
- et4U.com Supports CAS-before-RAS refresh and self-refresh modes

DataShe

- DRAM/synchronous DRAM/pseudo-SRAM burst access function
 - Supports high-speed access modes for DRAM/synchronous DRAM/pseudo-SRAM
- Wait cycles can be inserted by an external WAIT signal

Cache Memory:

- 4 kbytes
- 64 entries, 4-way set associative, 16-byte line length
- Write-through data writing method
- LRU replacement algorithm
- 2 kbytes of the cache can be used as 2-kbyte internal RAM

DataSheet4U.com

www.DataSheet4U.com

Renesas

www.DataSheet4U.com Direct Memory Access Controller (DMAC) (2 Channels):

- Permits DMA transfer between external memory, external I/O, on-chip peripheral modules
- Enables DMA transfer request and auto-request from external pins, on-chip SCI, and on-chip timers
- Cycle-steal mode or burst mode
- Channel priority level is selectable (fixed mode or round-robin mode)
- Dual or single address transfer mode is selectable
- Transfer data width: 1/2/4/16 bytes
- Address space: 4 Gbytes; maximum number of transfers: 16,777,216

Division Unit (DIVU):

- Executes $64 \div 32 \rightarrow 32...32$ and $32 \div 32 \rightarrow 32...32$ divisions in 39 cycles
- Overflow interrupt

16-Bit Free-Running Timer (FRT) (1 Channel):

- Selects input from three internal/external clocks
- Input capture and output compare
- Counter overflow, compare match, and input capture interrupts

Watchdog Timer (WDT) (1 Channel):DataSheet4U.com

- Can be switched between watchdog timer and interval timer functions
- Count overflow can generate an internal reset, external signal, or interrupt

et4U.comPower-on reset or manual reset can be selected as the internal reset

Serial Communication Interface (SCI) (1 Channel):

- Asynchronous or synchronous mode is selectable
- Simultaneous transmission and reception (full duplex)
- Dedicated baud rate generator
- Multiprocessor communication function

Package:

- 144-pin plastic QFP (FP-144J)
- 176-pin plastic TFBGA (TBP-176)

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com Product Lineup:

Product Code	Package	Operating Temperature	Frequency	Voltage
HD6417604SF28	QFP2020-144	- 20°C to 75°C	28 MHz	5 V
HD6417604SFI28	QFP2020-144	- 40°C to 85°C	28 MHz	5 V
HD6417604SVF20	QFP2020-144	- 20°C to 75°C	20 MHz	3.3 V
HD6417604SBP28	CSP-1313-176	- 20°C to 75°C	28 MHz	5 V
HD6417604SVBP20	CSP-1313-176	- 20°C to 75°C	20 MHz	3.3 V

DataSheet4U.com

et4U.com

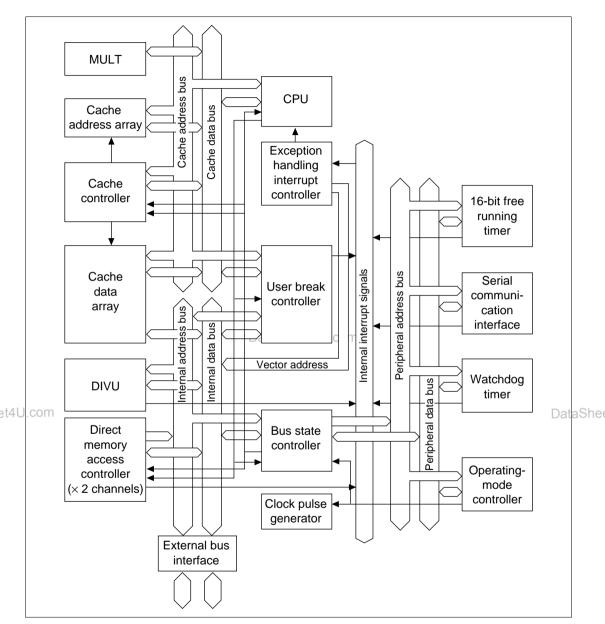
DataShe

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 1.2 Block Diagram

Figure 1.1 shows a block diagram of the SH7604.





DataSheet4U.com

www.DataSheet4U.com

6 DataSheet4U.com

www.DataSheet4U.com 1.3 Description of Pins

1.3.1 Pin Arrangement

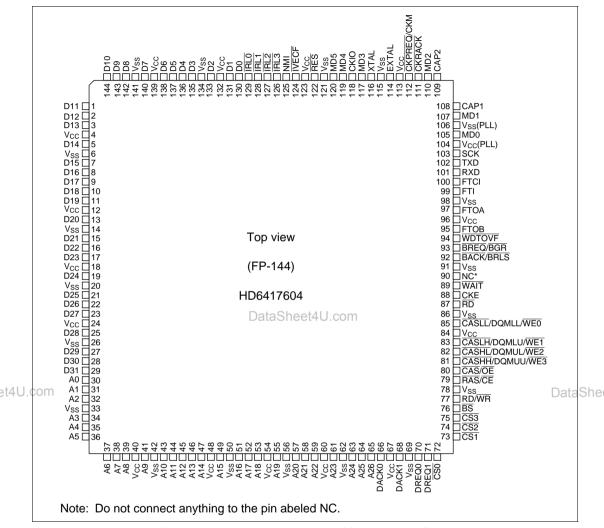


Figure 1.2 Pin Arrangement (144-Pin Plastic QFP)

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

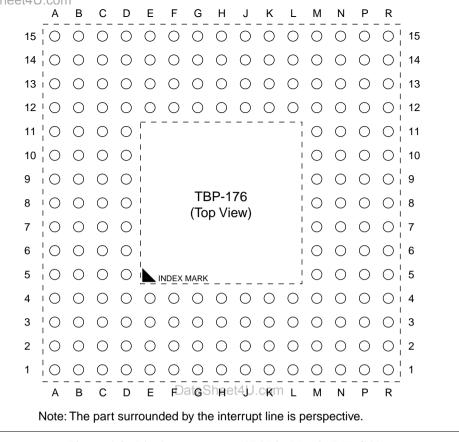


Figure 1.3 Pin Arrangement (176-Pin Plastic TFBGA)

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

8 DataSheet4U.com

Table 1.2 shows the pin functions of the SH7604.

Table 1.1Pin Functions

Pin No.

I	FP-144	TBP-17	76 Pin Name	I/O	Pin Description
-		A1	NC		Reserved pin (leave unconnected)
-		C3	NC		Reserved pin (leave unconnected)
-	_	B1	NC		Reserved pin (leave unconnected)
-		C2	NC		Reserved pin (leave unconnected)
	1	D3	D11	I/O	Data bus
2	2	C1	D12	I/O	Data bus
;	3	D2	D13	I/O	Data bus
4	4	E4	V _{CC}	I	Power
;	5	D1	D14	I/O	Data bus
(6	E3	V _{SS}	I	Ground
-	7	E2	D15	I/O	Data bus
8	8	E1	D16	DataSheet/I	Data bus
9	9	F4	D17	I/O	Data bus
	10	F3	D18	I/O	Data bus
	11	F1	D19	I/O	Data bus
CO	12	F2	V _{CC}	I	Power DataSh
	13	G4	D20	I/O	Data bus
	14	G3	V _{SS}	I	Ground
	15	G1	D21	I/O	Data bus
	16	G2	D22	I/O	Data bus
	17	H4	D23	I/O	Data bus
	18	H3	V _{CC}	I	Power
	19	H1	D24	I/O	Data bus
:	20	H2	V _{SS}	I	Ground
2	21	J4	D25	I/O	Data bus
;	22	J3	D26	I/O	Data bus
Sh	23 Pet411	J1	D27	I/O	Data bus www.DataSheet4U.con
<u> </u>	24	J2	V _{CC}	I	Power

Pin No.				
FP-144	TBP-1 7	76 Pin Name	I/O	Pin Description
25	K4	D28	I/O	Data bus
26	K3	V _{SS}	I	Ground
27	K1	D29	I/O	Data bus
28	K2	D30	I/O	Data bus
29	L3	D31	I/O	Data bus
30	L1	A0	I/O	Address bus
31	L2	A1	I/O	Address bus
32	L4	A2	I/O	Address bus
33	M1	V _{SS}	I	Ground
34	M2	A3	I/O	Address bus
35	M3	A4	I/O	Address bus
36	N1	A5	I/O	Address bus
	M4	NC		Reserved pin (leave unconnected)
	N2	NC		Reserved pin (leave unconnected)
	P1	NC	DataSheet/	Reserved pin (leave unconnected)
	P2	NC		Reserved pin (leave unconnected)
	R1	NC		Reserved pin (leave unconnected)
	N3	NC		Reserved pin (leave unconnected)
com	R2	NC		Reserved pin (leave unconnected) DataShe
	P3	NC		Reserved pin (leave unconnected)
37	N4	A6	I/O	Address bus
38	R3	A7	I/O	Address bus
39	P4	A8	I/O	Address bus
40	M5	V _{CC}	I	Power
41	R4	A9	I/O	Address bus
42	N5	V _{SS}	I	Ground
43	P5	A10	I/O	Address bus
44	R5	A11	I/O	Address bus
45	M6	A12	I/O	Address bus
sheet4U	J.com	A13	I/O	Address bus www.DataSheet4U.com
47	R6	A14	I/O	Address bus

F	Pin No.			
FP-144	4 TBP-1	76 Pin Name	I/O	Pin Description
48	P6	V _{CC}	Ι	Power
49	M7	A15	I/O	Address bus
50	N7	V _{SS}	Ι	Ground
51	R7	A16	I/O	Address bus
52	P7	A17	I/O	Address bus
53	M8	A18	I/O	Address bus
54	N8	V _{CC}	I	Power
55	R8	A19	I/O	Address bus
56	P8	V _{SS}	I	Ground
57	M9	A20	I/O	Address bus
58	N9	A21	I/O	Address bus
59	R9	A22	I/O	Address bus
60	P9	V _{CC}	I	Power
61	M10	A23	I/O	Address bus
62	N10	V _{SS}	DataSheet/I	Ground
63	R10	A24	I/O	Address bus
64	P10	A25	I/O	Address bus
65	N11	A26	I/O	Address bus
.0066	R11	DACK0	0	DMAC0 acknowledge DataSh
67	P11	V _{CC}	I	Power
68	M11	DACK1	0	DMAC1 acknowledge
69	R12	V _{SS}	I	Ground
70	P12	DREQ0	I	DMAC0 request
71	N12	DREQ1	I	DMAC1 request
72	R13	CS0	0	Chip select 0
_	M12	NC		Reserved pin (leave unconnected)
	P13	NC		Reserved pin (leave unconnected)
	R14	NC		Reserved pin (leave unconnected)
	P14	NC		Reserved pin (leave unconnected)
Shaet/I	R15	NC		Reserved pin (leave unconnected)taSheet4U.con
Sheet4L	N13	NC		Reserved pin (leave unconnected)

FP-144	TBP-176	6 Pin Name	I/O	Pin Description
_	P15	NC		Reserved pin (leave unconnected)
_	N14	NC	_	Reserved pin (leave unconnected)
73	M13	CS1	0	Chip select 1
74	N15	CS2	0	Chip select 2
75	M14	CS3	0	Chip select 3
76	L12	BS	I/O	Bus cycle start
77	M15	RD/WR	I/O	Read/write
78	L13	V _{SS}	I	Ground
79	L14	RAS/CE	0	RAS for DRAM and synchronous DRAM, CE for pseudo-SRAM
80	L15	CAS/OE	0	CAS for synchronous DRAM, OE for pseudo-SRAM
81	K12	CASHH/DQMUU/WE3	0	Most significant byte selection signal for memory
82	K13	CASHL/DQMUL/WE2	0	Second byte selection signal for memory
83	K15	CASLH/DQMLU/WE1	ataSheet4	Third byte selection signal for memory
84	K14	V _{CC}	I	Power
85	J12	CASLL/DQMLL/WE0	0	Least significant byte selection signal for memory
c 86 n	J13	V _{SS}	I	Ground Data
87	J15	RD	0	Read pulse
88	J14	CKE	0	Synchronous DRAM clock enable control
89	H12	WAIT	I	Hardware wait request
90	H13	NC		Reserved pin (leave unconnected)
91	H15	V _{SS}	I	Ground
92	H14	BACK/BRLS	I	Bus acknowledge in slave mode, bus request in master mode
93	G12	BREQ/BGR	0	Bus request in slave mode, bus grant in master mode
94	G13	WDTOVF	0	Watchdog timer output
95	G15	FTOB	0	Free-running timer output B
S96eet4U	G14	V _{CC}	1	Power www.DataSheet4U.

Pi	n No.				
FP-144	TBP-176	Pin Name	I/O	Pin Description	
97	F12	FTOA	0	Free-running timer output A	
98	F13	V _{SS}	I	Ground	
99	F15	FTI	I	Free-running timer input	
100	F14	FTCI	I	Free-running timer clock input	
101	E13	RxD	I	Serial data input	
102	E15	TxD	0	Serial data output	
103	E14	SCK	I/O	Serial clock input/output	
104	E12	V _{CC} (PLL)	I	Power for on-chip PLL	
105	D15	MD0	I	Operating mode pin	
106	D14	V _{SS} (PLL)	I	Ground for on-chip PLL	
107	D13	MD1	I	Operating mode pin	
108	C15	CAP1	0	External capacitance pin for PLL	
_	D12	NC		Reserved pin (leave unconnected)	
_	C14	NC		Reserved pin (leave unconnected)	
_	B15	NC	DataSheet41	Reserved pin (leave unconnected)	
_	B14	NC		Reserved pin (leave unconnected)	
—	A15	NC	_	Reserved pin (leave unconnected)	
_	C13	NC		Reserved pin (leave unconnected)	
.com	A14	NC		Reserved pin (leave unconnected) DataShe	
_	B13	NC	—	Reserved pin (leave unconnected)	
109	C12	CAP2	0	External capacitance pin for PLL	
110	A13	MD2	I	Operating mode pin	
111	B12	CKPACK	0	Clock pause acknowledge output	
112	D11	CKPREQ/CKM	I	Clock pause request input	
113	A12	V _{CC}	I	Power	
114	C11	EXTAL	I	Pin for connecting crystal resonator	
115	B11	V _{SS}	I	Ground	
116	A11	XTAL	0	Pin for connecting crystal resonator	
117	D10	MD3	I	Operating mode pin	
aSheet4U.	C10	CKIO	I/O	System clock input/output _{www.DataSheet4U.com}	
119	A10	MD4	I	Operating mode pin	

Pi	n No.	_			
FP-144	TBP-176	Pin Name	I/O	Pin Description	
120	B10	MD5	I	Operating mode pin	
121	D9	V _{SS}	I	Ground	
122	C9	RES	I	Reset	
123	A9	V _{CC}	Power	Power	
124	B9	IVECF	0	Interrupt vector fetch cycle	
125	D8	NMI	I	Nonmaskable interrupt request	
126	C8	IRL3	I	External interrupt source input	
127	A8	IRL2	I	External interrupt source input	
128	B8	IRL1	I	External interrupt source input	
129	D7	IRL0	I	External interrupt source input	
130	C7	D0	I/O	Data bus	
131	A7	D1	I/O	Data bus	
132	B7	V _{CC}	I	Power	
133	D6	D2	I/O	Data bus	
134	C6	V _{SS}	DataSheet4	Ground	
135	A6	D3	I/O	Data bus	
136	B6	D4	I/O	Data bus	
137	C5	D5	I/O	Data bus	
138	A5	D6	I/O	Data bus	DataSh
139	B5	V _{CC}	I	Power	
140	D5	D7	I/O	Data bus	
141	A4	V _{SS}	I	Ground	
142	B4	D8	I/O	Data bus	
143	C4	D9	I/O	Data bus	
144	A3	D10	I/O	Data bus	
_	D4	NC	—	Reserved pin (leave unconnected)	
_	B3	NC	—	Reserved pin (leave unconnected)	
_	A2	NC	—	Reserved pin (leave unconnected)	
_	B2	NC	_	Reserved pin (leave unconnected)	

DataSheet4U.com

www.DataSheet4U.com

Section 2 CPU

2.1 **Register Configuration**

The register set consists of sixteen 32-bit general registers, three 32-bit control registers and four 32-bit system registers.

2.1.1 **General Registers**

The 16 general registers (R0-R15) are shown in figure 2.1. General registers are used for data processing and address calculation. R0 is also used as an index register, and several instructions use R0 as a fixed source or destination register. R15 is used as the hardware stack pointer (SP). Saving and recovering the status register (SR) and program counter (PC) in exception handling is accomplished by referencing the stack using R15.

) *1	
		R0		
		R1		
		R2		
		R3		
		DataSh &4 4U.com		
		R5		
		R6		
		R7		
com		R8	Data	aSh
		R9		
		R10		
		R11		
		R12		
		R13		
		R14		
		R15, SP (hardware stack pointer)	*2	
Notes:	and indirect indefixed source reg	an index register in the indirect inde exed GBR addressing mode. In som gister or destination register. Is a hardware stack pointer (SP) duri	exed register addressing mode e instructions, R0 functions as a	

Figure 2.1 General Registers

www.DataSheet4U.com

The 32-bit control registers consist of the 32-bit status register (SR), global base register (GBR), and vector base register (VBR) (figure 2.2). The status register indicates processing states. The global base register functions as a base address for the GBR indirect addressing mode to transfer data to the registers of on-chip peripheral modules. The vector base register functions as the base address of the exception handling vector area (including interrupts).

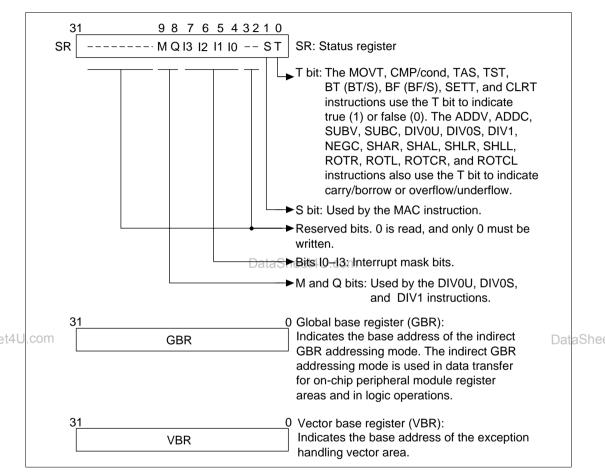


Figure 2.2 Control Registers

DataSheet4U.com

16

www.DataSheet4U.com

DataSheet4U.com

System registers consist of four 32-bit registers: high and low multiply-and-accumulate registers (MACH and MACL), the procedure register (PR), and the program counter (PC) (figure 2.3). The multiply-and-accumulate registers store the results of multiply and accumulate operations. The procedure register stores the return address from the subroutine procedure. The program counter stores program addresses to control the flow of the processing.

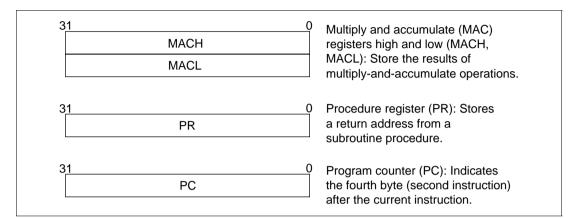


Figure 2.3 System Registers

DataSheet4U.com

2.1.4 Initial Values of Registers

Table 2.1 lists the values of the registers after a reset.

at4U.coTable 2.1 Initial Values of Registers

DataShe

Classification	Register	Initial Value		
General registers	R0–R14	Undefined		
	R15A (SP)	Value of the stack pointer in the vector address table		
Control registers	SR	Bits I3–I0 are 1111 (H'F), reserved bits are 0, and other bits are undefined		
	GBR	Undefined		
	VBR	H'0000000		
System registers	MACH, MACL, PR	Undefined		
	PC	Value of the program counter in the vector address table		

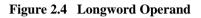
DataSheet4U.com

www.DataSheet4U.com

2.2.1 Data Format in Registers

Register operands are always longwords (32 bits) (figure 2.4). When the memory operand is only a byte (8 bits) or a word (16 bits), it is sign-extended into a longword when loaded into a register.





2.2.2 Data Format in Memory

Memory data formats are classified into bytes, words, and longwords. Byte data can be accessed at any address, but an address error will occur if you try to access word data starting from an address other than 2n or longword data starting from an address other than 4n. In such cases, the data accessed cannot be guaranteed (figure 2.5). The hardware stack area, referred to by the hardware stack pointer (SP, R15), uses only longword data starting from address 4n because this area holds the program counter and status register.

This microprocessor has a function that allows access of CS2 space (area 2) in little-endian format, which enables the microprocessor to share memory with processors that access memory in little-endian format. The microprocessor arranges byte data differently for little-endian and the more usual big-endian format.

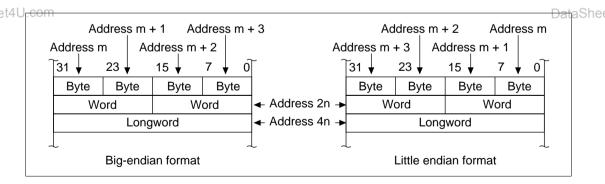


Figure 2.5 Byte, Word, and Longword Alignment

DataSheet4U.com

18

www.DataSheet4U.com

Renesas

Byte (8-bit) immediate data resides in an instruction code. Immediate data accessed by the MOV, ADD, and CMP/EQ instructions is sign-extended and handled in registers as longword data. Immediate data accessed by the TST, AND, OR, and XOR instructions is zero-extended and handled as longword data. Consequently, AND instructions with immediate data always clear the upper 24 bits of the destination register.

Word or longword immediate data is not located in the instruction code: it is stored in a memory table. An immediate data transfer instruction (MOV) accesses the memory table using the PC relative with displacement addressing mode. Specific examples are given in table 2.5, Immediate Data Accessing.

2.3 Instruction Features

2.3.1 RISC-Type Instruction Set

All instructions are RISC type. This section details their functions.

16-Bit Fixed Length: All instructions are 16 bits long, increasing program code efficiency.

One Instruction per Cycle: The microprocessor can execute basic instructions in one cycle using the pipeline system. Instructions are executed in 35 ns at 28.7 MHz.

Data Length: Longword is the standard data length for all operations. Memory can be accessed in bytes, words, or longwords. Byte or word data accessed from memory is sign-extended and handled as longword data (table 2.2). Immediate data is sign-extended for arithmetic operations or cet4U.cozero-extended for logic operations. It also is handled as longword data.

SH7604 CPU		Description	Example	of Conventional CPU
MOV.W	@(disp,PC),R1	Data is sign-extended to 32	ADD.W	#H'1234,R0
ADD R1,R0		bits, and R1 becomes H'00001234. It is next operated upon by an ADD		
.DATA.	W H'1234	instruction.		

Table 2.2	Sign I	Extension	of	Word	Data
	Night I		•••		Duin

Note: @(disp, PC) accesses the immediate data.

Load-Store Architecture: Basic operations are executed between registers. For operations that involve memory access, data is loaded into the registers and executed (load-store architecture). DataSI Instructions such as AND that manipulate bits, however, are executed directly immediate Sheet4U.com

WWW

DataSheet4U.com Delayed Branch Instructions: Unconditional branch instructions are delayed. Executing the instruction that follows the branch instruction, before branching reduces pipeline disruption during branching (table 2.3).

SH760	4 Series CPU	Description	Example	of Conventional CPU
BRA	TRGET	Executes ADD before	ADD.W	R1,R0
ADD	R1,R0	branching to TRGET	BRA	TRGET

Table 2.3 **Delayed Branch Instructions**

Multiply and Multiply-and-Accumulate Operations: 16-bit \times 16-bit \rightarrow 32-bit multiply operations are executed in one to two states. 16-bit \times 16-bit + 64-bit \rightarrow 64-bit multiply-andaccumulate operations are executed in two to three states. 32-bit \times 32-bit \rightarrow 64-bit multiply and 32-bit \times 32-bit + 64bit \rightarrow 64-bit multiply-and-accumulate operations are executed in two to four states.

T Bit: The T bit in the status register changes according to the result of the comparison, and in turn is the condition (true/false) that determines if the program will branch (table 2.4). The number of instructions that change the T bit is kept to a minimum to improve the processing speed.

	SH7604 C	PU	Description	Example	of Conventional CP	U
	CMP/GE	R1,R0	T bit is set when $R0 \ge R1$. The	CMP.W	R1,R0	
	BT	TRGET0	program branches to TRGET0 when R0 ≥ R1 and to TRGET1	BGE	TRGET0	
	BF	TRGET1	when $R0 < R1$.	BLT	TRGET1	
4U.	ADD	#−1,R0	T bit is not changed by ADD.	SUB.W	#1,R0	DataShee
	CMP/EQ	#0,R0	T bit is set when $R0 = 0$. The program branches if $R0 = 0$.	BEQ	TRGET	
	BT	TRGET	The program branches in No = 0.			

Table 2.4 T Bit

Immediate Data: Byte (8-bit) immediate data resides in the instruction code. Word or longword immediate data is not input via instruction codes but is stored in a memory table. An immediate data transfer instruction (MOV) accesses the memory table using the PC relative with displacement addressing mode (table 2.5).

et4

www.DataSheet4U.com

www.DataSheet4U.com Table 2.5 Immediate Data Accessing

Classification	SH7604 C	PU	Exampl	e of Conventional CPU
8-bit immediate	MOV	#H'12,R0	MOV.B	#H'12,R0
16-bit immediate	MOV.W	@(disp,PC),R0	MOV.W	#H'1234,R0
	.DATA.W	Н'1234		
32-bit immediate	MOV.L	@(disp,PC),R0	MOV.L	#H'12345678,R0
	.DATA.L	Н'12345678		

Note: @(disp, PC) accesses the immediate data.

Absolute Address: When data is accessed by absolute address, the absolute address value is placed in the memory table beforehand. Loading the immediate data when the instruction is executed transfers that value to the register and the data is accessed in the register indirect addressing mode (table 2.6).

Table 2.6 Absolute Address Accessing

Classification	fication SH7604 CPU		Example of Conventional CPU		
Absolute address	MOV.L	@(disp,PC),R1	MOV.B	@H'12345678,R0	
	MOV.B	@R1 DataSheet4U.com			
	.DATA.L	н'12345678			

Note: @(disp,PC) accesses the immediate data.

t4U.com

16-Bit/32-Bit Displacement: When data is accessed by 16-bit or 32-bit displacement, the displacement value is placed in the memory table beforehand. Loading the immediate data when the instruction is executed transfers that value to the register and the data is accessed in the indexed register indirect addressing addressing mode (table 2.7).

Table 2.7 16/32-Bit Displacement Accessing

Classification	SH7604 CF	บ	Example	e of Conventional CPU
16-bit displacement	MOV.W	@(disp,PC),R0	MOV.W	@(H'1234,R1),R2
	MOV.W	@(R0,R1),R2		
	.DATA.W	Н'1234		

Note: @(disp, PC) accesses the immediate data.

DataSheet4U.com

www.DataSheet4U.com

Table 2.8 shows addressing modes and effective address calculation.

Addressing Mode	Instruction Format	Effective Addresses Calculation	Equation
Register direct	Rn	The effective address is register Rn. (The operand is the contents of register Rn.)	_
Register indirect	@Rn	The effective address is the contents of register Rn. Rn Rn Rn	Rn
Register	@Rn+	The effective address is the contents of register	Rn
indirect with post-increment		Rn. A constant is added to the contents of Rn after the instruction is executed. 1 is added for a byte	(After the instruction executes)
		operation, 2 for a word operation, and 4 for a longword operation.	Byte: Rn + 1 \rightarrow Rn
		Rn + 1/2/4 + Rn	Word: Rn + 2 \rightarrow Rn
		1/2/PataSheet4U.com	Longword: Rn + 4 \rightarrow Rn
Register indirect with	@-Rn	The effective address is the value obtained by subtracting a constant from Rn. 1 is subtracted for	Byte: $Rn - 1$ $\rightarrow Rn$
pre-decrement .com		a byte operation, 2 for a word operation, and 4 for a longword operation.	Word: $Rn - 2$ $\rightarrow Rn$
		Rn $Rn - 1/2/4$ $Rn - 1/2/4$	Longword: $Rn - 4 \rightarrow Rn$ (Instruction executed with Rn after calculation)

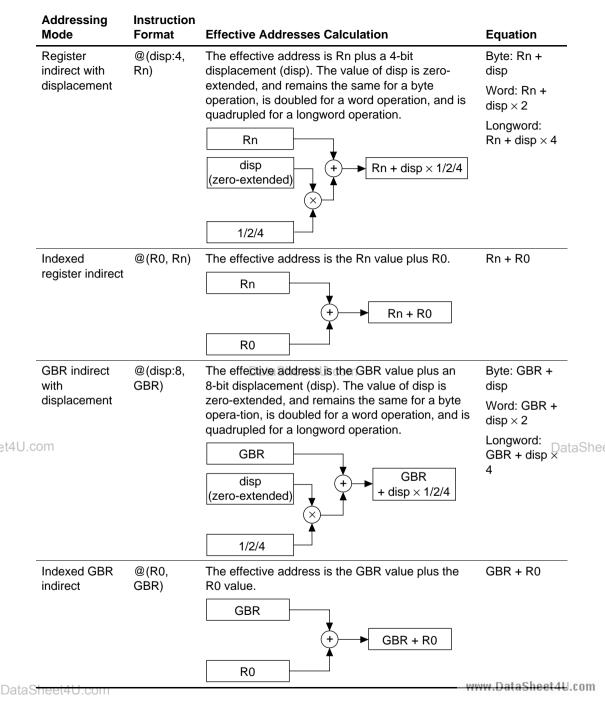
Table 2.8 Addressing Modes and Effective Addresses

DataSheet4U.com

www.DataSheet4U.com

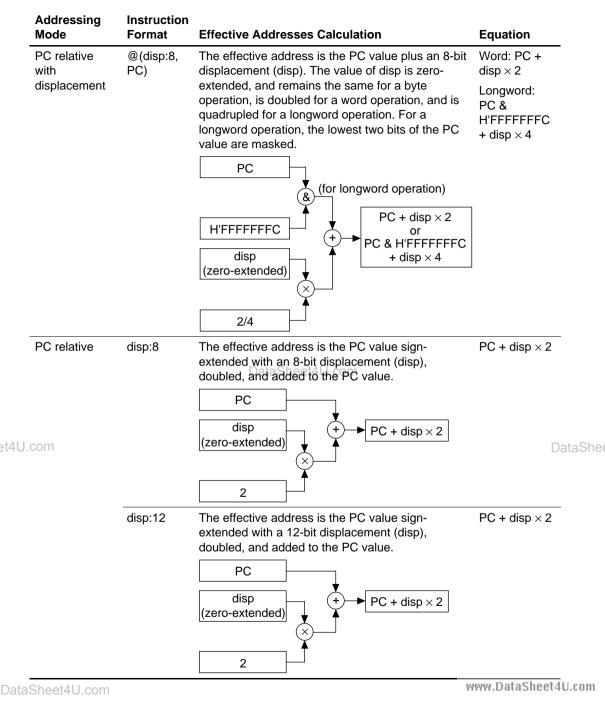
22 DataSheet4U.com

www.DataSheet4U.com Table 2.8 Addressing Modes and Effective Addresses (cont)



Renesas

vww.DataSheet4U.com Table 2.8 Addressing Modes and Effective Addresses (cont)



24 DataSheet4U.com

Addressing Mode	Instruction Format	Effective Addresses Calculation	Equation
PC relative (cont)	Rn	The effective address is the register PC value plus Rn.	PC + Rn
		PC + PC + Rn Rn	
Immediate	#imm:8	The 8-bit immediate data (imm) for the TST, AND, OR, and XOR instructions is zero-extended.	_
	#imm:8	The 8-bit immediate data (imm) for the MOV, ADD, and CMP/EQ instructions is sign-extended.	_
	#imm:8	The 8-bit immediate data (imm) for the TRAPA instruction is zero-extended and quadrupled.	_

www.DataSheet4U.com Table 2.8 Addressing Modes and Effective Addresses (cont)

2.3.3 Instruction Formats

Table 2.9 shows instruction formats and source and destination operands. The meaning of the operands depends on the instruction code: The following symbols are used in the table:

- xxxx: Instruction code
- mmmm: Source register

et4U.com nnnn: Destination register

- iiii: Immediate data
- dddd: Displacement

DataShe

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com Table 2.9 Instruction Formats

Instruction Format	Source Operand	Destination Operand	Examp	le
0 format 15 0 xxxx xxxx xxxx xxxx	_	_	NOP	
n format 15 0 xxxx nnnn xxxx xxxx	_	nnnn: Register direct	MOVT	Rn
	Control register or system register	nnnn: Register direct	STS	MACH,Rn
	Control register or system register	nnnn: Register indirect with pre-decrement	STC.L	SR,@-Rr
m format 15 0 xxxx mmmm xxxx xxxx	mmmm: Register direct	Control register or system register	LDC	Rm,SR
	mmmm: Register indirect with post-increment	Control register or system register	LDC.L	@Rm+,SR
	mmmm. Register U.c. indirect	om	JMP	@Rm
	mmmm: PC relative using Rm	_	BRAF	Rm

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com Table 2.9 Instruction Formats (cont)

Instruction Format	Source Operand	Destination Operand	Example
nm format	mmmm: Register direct	nnnn: Register direct	ADD Rm,Rn
150 xxxxxnnnn _mmmm _xxxx	mmmm: Register direct	nnnn: Register indirect	MOV.L Rm,@Rn
	mmmm: Register indirect with post- increment (multiply- and-accumulate)	MACH, MACL	MAC.W @Rm+,@Rn+
	nnnn: Register indirect with post- increment (multiply- and-accumulate)*		
	mmmm: Register indirect with post-increment	nnnn: Register direct	MOV.L @Rm+,Rn
	mmmm: Register direct	nnnn: Register indirect with pre-decrement	MOV.L Rm,@-Rn
	mmmm: Register direct	nnnn: Indexed register indirect	MOV.L Rm,@(R0,Rn)
md format	mmmmdddd:	R0 (Register	MOV.B
15 0 xxxx xxxx mmmm dddd	Register indirect with displacement	direct)	@(disp,Rn),R 0 ataS
nd4 format	R0 (Register direct)	nnnndddd:	MOV.B
150 Xxxx xxxx nnnn dddd		Register indirect with displacement	R0,@(disp,Rn)
nmd format	mmmm: Register	nnnndddd:	MOV.L
150 XXXX nnnn mmmm dddd	direct	Register indirect with displacement	Rm,@(disp,Rn)
	mmmmdddd:	nnnn: Register	MOV.L
	Register indirect with displacement	direct	@(disp,Rm),Rn

DataSheet4U.com

www.DataSheet4U.com Table 2.9 Instruction Formats (cont)

Instruction Format	Source Operand	Destination Operand	Example	е
d format 15 0 xxxx xxxx dddd dddd	ddddddd: GBR indirect with displacement	R0 (Register direct)	MOV.L @(disp	,GBR),R0
	R0 (Register direct)	ddddddd: GBR indirect with displacement	MOV.L R0,@(d	isp,GBR)
	ddddddd: PC relative with displacement	R0 (Register direct)	MOVA @(disp	,PC),R0
	ddddddd: PC relative	_	BF	label
d12 format 1 <u>5 0</u>	dddddddddd: PC relative	_	BRA	label
xxxx dddd dddd nd8 format 15 xxxx nnnn dddd	ddddddd: PC relative with displacement	nnnn: Register direct	MOV.L	disp + PC)
i format	DataSheet4U.co iiiiiiiii Immediate	Indexed GBR indirect	AND.B #imm,@	(R0,GBR)
150 Co ^m xxxx xxxx iiiii iiii	iiiiiii: Immediate	R0 (Register direct)	AND	#imm,R0
	iiiiiii: Immediate	_	TRAPA	#imm
ni format 150 xxxx nnnn iiii iiii	iiiiiii: Immediate	nnnn: Register direct	ADD	#imm,Rn

Note: In multiply-and-accumulate instructions, nnnn is the source register.

DataSheet4U.com

www.DataSheet4U.com

Renesas

www.DataSheet4U.com 2.4 Instruction Set

2.4.1 Instruction Set by Classification

Table 2.10 Instruction Set by Classification

Classification	Types	Operation Code	Function	Number of Instructions
Data transfer	5	MOV	Data transfer, immediate data transfer, peripheral module data transfer, structure data transfer	39
		MOVA	Effective address transfer	_
		MOVT	T bit transfer	_
		SWAP	Swap of upper and lower bytes	_
		XTRCT	Extraction of middle of connected registers	_
Arithmetic	21	ADD	Binary addition	33
operations		ADDC	Binary addition with carry	_
		ADDV	Binary addition with overflow check	_
		CMP/cond	Comparison	_
		DIV1	Division	_
		DIV0S	Initialization of signed division	_
		DIV0U	Initialization of unsigned division	_
		DMULS	Signed double-length multiplication	_
0.072		DMULU	Unsigned double-length multiplication	Dete
com		DT	Decrement and test	– Data
		EXTS	Sign extension	_
		EXTU	Zero extension	_
		MAC	Multiply-and-accumulate, double-length multiply and-accumulate operation	-
		MUL	Double-length multiplication	_
		MULS	Signed multiplication	_
		MULU	Unsigned multiplication	_
		NEG	Negation	_
		NEGC	Negation with borrow	_
		SUB	Binary subtraction	_
Sheet4U.com		SUBC	Binary subtraction with borrow www.	DataSheet4U.c
		SUBV	Binary subtraction with underflow check	_

www.DataSheet4U.com Table 2.10 Instruction Set by Classification (cont)

Classification	Types	Operation Code	Function	Number of Instructions
Logic	6	AND	Logical AND	14
operations Shift Branch		NOT	Bit inversion	
		OR	Logical OR	
		TAS	Memory test and bit set	
		TST	Logical AND and T bit set	
		XOR	Exclusive OR	
Shift	10	ROTL	One-bit left rotation	14
		ROTR	One-bit right rotation	
		ROTCL	One-bit left rotation with T bit	
		ROTCR	One-bit right rotation with T bit	
		SHAL	One-bit arithmetic left shift	
		SHAR	One-bit arithmetic right shift	
		SHLL	One-bit logical left shift	
		SHLLn	n-bit logical left shift	
		SHLR	One-bit logical right shift	
		SHLRn	n-bit logical right shift	
Branch	9	BF	Conditional branch, conditional branch with delay $(T = 0)$	11
com		BT	Conditional branch, conditional branch with delay $(T = 1)$	Da
		BRA	Unconditional branch	
		BRAF	Unconditional branch	
		BSR	Branch to subroutine procedure	
		BSRF	Branch to subroutine procedure	
		JMP	Unconditional branch	
		JSR	Branch to subroutine procedure	
		RTS	Return from subroutine procedure	

DataSheet4U.com

www.DataSheet4U.com

30 DataSheet4U.com

www.DataSheet4U.com Table 2.10 Instruction Set by Classification (cont)

Classification	Types	Operation Code	Function	Number of Instructions
System	11	CLRT	T bit clear	31
control		CLRMAC	MAC register clear	
		LDC	Load to control register	
		LDS	Load to system register	
		NOP	No operation	
		RTE	Return from exception handling	
		SETT	T bit set	
		SLEEP	Shift to power-down state	
		STC	Store control register data	
		STS	Store system register data	
		TRAPA	Trap exception handling	
Tota	1:62			142

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

ltem	Format	Explanation
Instruction mnemonic	OP.Sz SRC,DEST	OP: Operation code Sz: Size (B: byte, W: word, or L: longword) SRC: Source DEST: Destination Rm: Source register Rn: Destination register imm: Immediate data disp: Displacement* ¹
Instruction code	$MSB \leftrightarrow LSB$	mmmm: Source register nnnn: Destination register 0000: R0 0001: R1
		1111: R15 iiii: Immediate data dddd: Displacement
Operation	$ ightarrow$, \leftarrow	Direction of transfer
summary	(xx)	Memory operand
	M/Q/T	Flag bits in SR
	&	Logical AND of each bit
		Logical OR of each bit
	٨	Exclusive OR of each bit
	~	Logical NOT of each bit
com	< <n,>>n</n,>	n-bit shift
Execution states	_	Value when no wait states are inserted*2
T bit	_	Value of T bit after instruction is executed. An em-dash (—) in the column means no change.
	epending on the op e SH-1/SH-2 progra	erand size, displacement is scaled $\times 1$, $\times 2$, or $\times 3$. For details, see amming manual.
		states: The execution states shown in the table are minimums. states may be increased when:
		between instruction fetch and data access
•	I he destination reg	ister of the load instruction (memory \rightarrow register) and the register

www.DataSheet4U.com Table 2.11 Instruction Code Format

DataSheet4U.com

www.DataSheet4U.com

32 DataSheet4U.com

www.DataSheet4U.com Table 2.12 Data Transfer Instructions

Instruct	tion	Instruction Code	Operation	Execu- tion States	T Bit
MOV	#imm,Rn	1110nnnniiiiiiii	#imm \rightarrow Sign extension \rightarrow	1	
			Rn		
MOV.W	@(disp,PC),Rn	1001nnnnddddddd	$\begin{array}{l} (\text{disp} \times 2 + \text{PC}) \rightarrow \text{Sign} \\ \text{extension} \rightarrow \text{Rn} \end{array}$	1	_
MOV.L	@(disp,PC),Rn	1101nnnnddddddd	$(disp \times 4 + PC) \to Rn$	1	_
MOV	Rm,Rn	0110nnnnmmmm0011	$Rm \to Rn$	1	_
MOV.B	Rm,@Rn	0010nnnnmmm0000	$Rm \rightarrow (Rn)$	1	_
MOV.W	Rm,@Rn	0010nnnnmmm0001	$Rm \rightarrow (Rn)$	1	_
MOV.L	Rm,@Rn	0010nnnnmmm0010	$Rm \rightarrow (Rn)$	1	_
MOV.B	@Rm,Rn	0110nnnnmmmm0000	$\begin{array}{l} (\text{Rm}) \rightarrow \text{Sign extension} \rightarrow \\ \text{Rn} \end{array}$	1	_
MOV.W	@Rm,Rn	0110nnnnmmmm0001	$\begin{array}{l} (\text{Rm}) \rightarrow \text{Sign extension} \rightarrow \\ \text{Rn} \end{array}$	1	_
MOV.L	@Rm,Rn	0110nnnnmmm0010	$(Rm) \rightarrow Rn$	1	_
MOV.B	Rm,@-Rn	0010nnnnmmm0100	$Rn1 \rightarrow Rn, Rm \rightarrow (Rn)$	1	_
MOV.W	Rm,@-Rn	0010nnnnmmm0101	Rn−2 → Rn, Rm → (Rn)	1	_
MOV.L	Rm,@-Rn	0010nnnnmmm0110	Rn−4 → Rn, Rm → (Rn)	1	_
MOV.B	@Rm+,Rn	0110nnnnmmm0100	$\begin{array}{l} (\text{Rm}) \rightarrow \text{Sign extension} \rightarrow \\ \text{Rn,Rm + 1} \rightarrow \text{Rm} \end{array}$	1	_
MOV.W	@Rm+,Rn	0110nnnnmmm0101	$\begin{array}{l} (\text{Rm}) \rightarrow \text{Sign extension} \rightarrow \\ \text{Rn,Rm + 2} \rightarrow \text{Rm} \end{array}$	1	DataSh
MOV.L	@Rm+,Rn	0110nnnnmmm0110	$(Rm) \to Rn, Rm + 4 \to Rm$	1	_
MOV.B	R0,@(disp,Rn)	10000000nnnndddd	$\text{R0} \rightarrow (\text{disp + Rn})$	1	_
MOV.W	R0,@(disp,Rn)	10000001nnnndddd	$\text{R0} \rightarrow (\text{disp} \times \text{2 + Rn})$	1	
MOV.L	Rm,@(disp,Rn)	0001nnnnmmmdddd	$\text{Rm} \rightarrow (\text{disp} \times 4 + \text{Rn})$	1	
MOV.B	@(disp,Rm),R0	10000100mmmmdddd	$\begin{array}{l} (\text{disp + Rm}) \rightarrow \text{Sign} \\ \text{extension} \rightarrow \text{R0} \end{array}$	1	_
MOV.W	@(disp,Rm),R0	10000101mmmmdddd	$\begin{array}{l} (\text{disp} \times 2 + \text{Rm}) \rightarrow \text{Sign} \\ \text{extension} \rightarrow \text{R0} \end{array}$	1	
MOV.L	@(disp,Rm),Rn	0101nnnnmmmdddd	$(disp \times 4 + Rm) \to Rn$	1	_
MOV.B	Rm,@(R0,Rn)	0000nnnnmmm0100	$Rm \rightarrow (R0 + Rn)$	1	_
MOV.W	Rm,@(R0,Rn)	0000nnnnmmm0101	$Rm \rightarrow (R0 + Rn)$	w.DataSh	eet411.com
MOV.L	.com Rm,@(R0,Rn)	0000nnnnmmm0110	$Rm \rightarrow (R0 + Rn)$	1 1	

et4

www.DataSheet4U.com Table 2.12 Data Transfer Instructions (cont)

Instruct	ion	Instruction Code	Operation	Execu- tion States	T Bit
MOV.B	@(R0,Rm),Rn	0000nnnnmmm1100	$(R0 + Rm) \rightarrow Sign$ extension $\rightarrow Rn$	1	_
MOV.W	@(R0,Rm),Rn	0000nnnnmmm1101	$(R0 + Rm) \rightarrow Sign$ extension $\rightarrow Rn$	1	_
MOV.L	@(R0,Rm),Rn	0000nnnnmmm1110	$(R0 + Rm) \rightarrow Rn$	1	_
MOV.B	R0,@(disp,GBR)	11000000ddddddd	$\text{R0} \rightarrow (\text{disp + GBR})$	1	_
MOV.W	R0,@(disp,GBR)	11000001ddddddd	$R0 \rightarrow (disp \times 2 + GBR)$	1	_
MOV.L	R0,@(disp,GBR)	11000010ddddddd	$\text{R0} \rightarrow (\text{disp} \times \text{4 + GBR})$	1	_
MOV.B	@(disp,GBR),R0	11000100ddddddd	(disp + GBR) \rightarrow Sign extension \rightarrow R0	1	_
MOV.W	@(disp,GBR),R0	11000101ddddddd	$\begin{array}{l} (\text{disp} \times 2 + \text{GBR}) \rightarrow \text{Sign} \\ \text{extension} \rightarrow \text{R0} \end{array}$	1	_
MOV.L	@(disp,GBR),R0	11000110ddddddd	$(\text{disp} \times 4 + \text{GBR}) \rightarrow \text{R0}$	1	_
MOVA	@(disp,PC),R0	11000111ddddddd	$\text{disp} \times \text{4} + \text{PC} \rightarrow \text{R0}$	1	_
MOVT	Rn	0000nnnn00101001	$T \to Rn$	1	_
SWAP.B	Rm,Rn	0110nnnnmmm1000 DataSheet4U	$Rm \rightarrow Swap$ the bottom two bytes $\rightarrow Rn$	1	_
SWAP.W	Rm,Rn	0110nnnnmmm1001	$Rm \rightarrow Swap two$ consecutive words $\rightarrow Rn$	1	_
XTRCT COM	Rm,Rn	0010nnnnmmm1101	Rm: Middle 32 bits of $Rn \rightarrow Rn$	1	Dat

DataSheet4U.com

www.DataSheet4U.com

34 DataSheet4U.com

www.DataSheet4U.com Table 2.13 Arithmetic Instructions

Instructio	on	Instruction Code	Operation	Execution States	T Bit
ADD	Rm,Rn	0011nnnnmmm1100	$Rn + Rm \rightarrow Rn$	1	_
ADD	#imm,Rn	0111nnnniiiiiiii	$Rn + imm \rightarrow Rn$	1	_
ADDC	Rm,Rn	0011nnnnmmm1110	$\begin{array}{l} Rn + Rm + T \rightarrow Rn, \\ Carry \rightarrow T \end{array}$	1	Carry
ADDV	Rm,Rn	0011nnnnmmm1111	$\begin{array}{l} Rn + Rm \to Rn, \\ Overflow \to T \end{array}$	1	Overflow
CMP/EQ	#imm,R0	10001000iiiiiiii	If R0 = imm, $1 \rightarrow T$	1	Comparison result
CMP/EQ	Rm,Rn	0011nnnnmmm0000	If Rn = Rm, $1 \rightarrow T$	1	Comparison result
CMP/HS	Rm,Rn	0011nnnnmmm0010	If Rn≥Rm with unsigned data, $1 \rightarrow T$	1	Comparison result
CMP/GE	Rm,Rn	0011nnnnmmm0011	If Rn \ge Rm with signed data, 1 \rightarrow T	1	Comparison result
CMP/HI	Rm,Rn	0011nnnnmmm0110	If Rn > Rm with unsigned data, $1 \rightarrow T$	1	Comparison result
CMP/GT	Rm,Rn	0011nnnnmmmm0111 DataSh	If Rn > Rm with signed data, $1 \rightarrow T$	1	Comparison result
CMP/PZ	Rn	0100nnnn00010001	If $Rn \ge 0, 1 \rightarrow T$	1	Comparisor result
CMP/PL	Rn	0100nnnn00010101	If Rn > 0, 1 \rightarrow T	1	Comparison result
CMP/ST	Rm,Rn	0010nnnnmmm1100	If Rn and Rm have an equivalent byte, $1 \rightarrow T$	1	Comparison result
DIV1	Rm,Rn	0011nnnnmmm0100	Single-step division (Rn ÷ Rm)	1	Calculation result
DIVOS	Rm,Rn	0010nnnnmmm0111	$ \begin{array}{l} \text{MSB of } \text{Rn} \rightarrow \text{Q}, \\ \text{MSB of } \text{Rm} \rightarrow \text{M}, \\ \text{M} \land \text{Q} \rightarrow \text{T} \end{array} $	1	Calculation result
DIV0U		000000000011001	$0 \rightarrow M/Q/T$	1	0
DMULS.	Rm,Rn	0011nnnnmmm1101	Signed operation of Rn \times Rm \rightarrow MACH, MACL 32 \times 32 \rightarrow 64 bits	2 to 4*	_

DataSheet4U.com

www.DataSheet4U.com Table 2.13 Arithmetic Instructions (cont)

Instructi	on	Instruction Code	Operation	Execution States	T Bit
DMULU.I	Rm,Rn	0011nnnnmmm0101	Unsigned operation of Rn \times Rm \rightarrow MACH, MACL 32 \times 32 \rightarrow 64 bit	2 to 4*	
DT	Rn	0100nnnn00010000	$Rn - 1 \rightarrow Rn$, when Rn is 0, 1 $\rightarrow T$	1	Comparison result
			When Rn is nonzero, $0 \rightarrow T$		
EXTS.B	Rm,Rn	0110nnnnmmm1110	A byte in Rm is signextended \rightarrow Rn	1	_
EXTS.W	Rm,Rn	0110nnnnmmm1111	A word in Rm is signextended \rightarrow Rn	1	_
EXTU.B	Rm,Rn	0110nnnnmmm1100	A byte in Rm is zero-extended \rightarrow Rn	1	_
EXTU.W	Rm,Rn	0110nnnnmmm1101	A word in Rm is zero-extended \rightarrow Rn	1	_
MAC.L	@Rm+,@Rn+	0000nnnnmmm1111 DataSh	Signed operation of (Rn) × (Rm) \rightarrow MAC $\rightarrow MAC 32 \times 32 \rightarrow$ 64 bits	3/(2 to 4)*	_
MAC	@Rm+,@Rn+	0100nnnmmm1111	Signed operation of (Rn) × (Rm) + MAC \rightarrow MAC 16 × 16 + 64 \rightarrow 64 bits	3/(2)*	Data
MUL.L	Rm,Rn	0000nnnnmmm0111	$\begin{array}{l} \text{Rn} \times \text{Rm} \rightarrow \text{MACL}, \\ 32 \times 32 \rightarrow 32 \text{ bits} \end{array}$	2 to 4*	_
MULS.W	Rm,Rn	0010nnnmmm1111	Signed operation of Rn \times Rm \rightarrow MAC 16 \times 16 \rightarrow 32 bits	1 to 3 [*]	_
MULU.W	Rm,Rn	0010nnnmmm1110	Unsigned operation of Rn \times Rm \rightarrow MAC 16 \times 16 \rightarrow 32 bits	1 to 3 [*]	_
NEG	Rm,Rn	0110nnnnmmm1011	$0-Rm \rightarrow Rn$	1	_
NEGC	Rm,Rn	0110nnnnmmm1010	0–Rm–T → Rn, Borrow → T	1	Borrow

DataSheet4U.com

www.DataSheet4U.com

36 DataSheet4U.com

Instruc	tion	Instruction Code	Operation	Execution States	T Bit
SUB	Rm,Rn	0011nnnnmmm1000	$RnRm \rightarrow Rn$	1	_
SUBC	Rm,Rn	0011nnnnmmm1010	$\begin{array}{l} Rn-Rm-T\toRn,\\ Borrow\toT \end{array}$	1	Borrow
SUBV	Rm,Rn	0011nnnnmmm1011	$\begin{array}{l} \text{Rn-Rm} \rightarrow \text{Rn}, \\ \text{Underflow} \rightarrow \text{T} \end{array}$	1	Underflow

Note: The normal minimum number of execution cycles. (The number in parentheses is the number of cycles when there is contention with preceding or following instructions.)

Table 2.14 Logic Operation Instructions

	Instruct	tion	Instruction Code	Operation	Execu- tion States	T Bit
-	AND	Rm,Rn	0010nnnnmmm1001	$Rn \& Rm \rightarrow Rn$	1	_
=	AND	#imm,R0	11001001iiiiiiii	R0 & imm \rightarrow R0	1	_
_	AND.B	#imm,@(R0,GBR)	11001101iiiiiiii	(R0 + GBR) & imm \rightarrow (R0 + GBR)	3	_
=	NOT	Rm,Rn	0110nnnnmmmm0111	~Rm → Rn	1	_
-	OR	Rm,Rn	0010nnnnmmm1011	$Rn \mid Rm \rightarrow Rn$	1	_
-	OR	#imm,R0	11001011iiiiiii	$R0 \mid imm \rightarrow R0$	1	_
et4U.c	OR.B	<pre>#imm,@(R0,GBR)</pre>	11001111iiiiiii	$(R0 + GBR) imm \rightarrow$ (R0 + GBR)	3	 DataSh
51-0.0	TAS.B	@Rn	0100nnnn00011011	If (Rn) is 0, 1 \rightarrow T; 1 \rightarrow MSB of (Rn)	4	Test result
-	TST	Rm,Rn	0010nnnnmmm1000	Rn & Rm; if the result is 0, $1 \rightarrow T$	1	Test result
_	TST	#imm,R0	11001000iiiiiiii	R0 & imm; if the result is 0, 1 \rightarrow T	1	Test result
_	TST.B	#imm,@(R0,GBR)	11001100iiiiiiii	(R0 + GBR) & imm; if the result is 0, $1 \rightarrow T$	3	Test result
=	XOR	Rm,Rn	0010nnnnmmm1010	$Rn \wedge Rm \rightarrow Rn$	1	_
=	XOR	#imm,R0	11001010iiiiiiii	R0 ^ imm \rightarrow R0	1	_
	XOR.B	#imm,@(R0,GBR)	11001110iiiiiiii	$(R0 + GBR) \wedge imm \rightarrow$ (R0 + GBR)	3	—

DataSheet4U.com

www.DataSheet4U.com Table 2.15 Shift Instructions

Instruc	tion	Instruction Code	Operation	Execution States	T Bit
ROTL	Rn	0100nnnn00000100	$T \gets Rn \gets MSB$	1	MSB
ROTR	Rn	0100nnnn00000101	$LSB\toRn\toT$	1	LSB
ROTCL	Rn	0100nnnn00100100	$T \gets Rn \gets T$	1	MSB
ROTCR	Rn	0100nnnn00100101	$T \to Rn \to T$	1	LSB
SHAL	Rn	0100nnnn00100000	$T \gets Rn \gets 0$	1	MSB
SHAR	Rn	0100nnnn00100001	$MSB \to Rn \to T$	1	LSB
SHLL	Rn	0100nnnn00000000	$T \gets Rn \gets 0$	1	MSB
SHLR	Rn	0100nnnn00000001	$0 \to Rn \to T$	1	LSB
SHLL2	Rn	0100nnnn00001000	$Rn << 2 \rightarrow Rn$	1	_
SHLR2	Rn	0100nnnn00001001	$Rn >> 2 \rightarrow Rn$	1	_
SHLL8	Rn	0100nnnn00011000	$Rn << 8 \rightarrow Rn$	1	_
SHLR8	Rn	0100nnnn00011001	$Rn >> 8 \rightarrow Rn$	1	_
SHLL16	5 Rn	0100nnnn00101000	$Rn << 16 \rightarrow Rn$	1	_
SHLR16	5 Rn	0100nnnn00101001	$Rn >> 16 \rightarrow Rn$	1	_

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

38 DataSheet4U.com

www.DataSheet4U.com Table 2.16 Branch Instructions

Instruc	tion	Instruction Code	Operation	Execution States	T Bit
BF	label	10001011ddddddd	If T = 0, disp \times 2 + PC \rightarrow PC; if T = 1, nop	3/1*	_
BF/S	label	10001111ddddddd	Delayed branch, if T = 0, disp \times 2 + PC \rightarrow PC; if T = 1, nop	2/1*	—
BT	label	10001001ddddddd	Delayed branch, if T = 1, disp \times 2 + PC \rightarrow PC; if T = 0, nop	3/1*	_
BT/S	label	10001101ddddddd	If T = 1, disp \times 2 + PC \rightarrow PC; if T = 0, nop	2/1*	_
BRA	label	1010ddddddddddd	Delayed branch, disp $\times2$ + PC \rightarrow PC	2	_
BRAF	Rm	0000mmmm00100011	Delayed branch, Rm + PC \rightarrow PC	2	
BSR	label	1011ddddddddddd	Delayed branch, PC \rightarrow PR, disp \times 2 + PC \rightarrow PC	2	—
BSRF	Rm	0000mmmm00000011	Delayed branch, PC \rightarrow PR, Rm + PC \rightarrow PC	2	_
JMP	@Rm	0100mmmm00101011	Delayed branch, $Rm \to PC$	2	_
JSR	@Rm	0100mmmm00001011 Da	Delayed branch, PC \rightarrow PR, tRm \rightarrow PC.com	2	—
RTS		000000000001011	Delayed branch, $PR \rightarrow PC$	2	

Note: One state when the instruction does not branch.

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com Table 2.17 System Control Instructions

	Instruct	tion	Instruction Code	Operation	Execu- tion States	T Bit	
-	CLRT		0000000000001000	$0 \rightarrow T$	1	0	
-	CLRMAC	!	0000000000101000	$0 \rightarrow MACH, MACL$	1	_	
-	LDC	Rm,SR	0100mmmm00001110	$Rm \to SR$	1	LSB	
-	LDC	Rm,GBR	0100mmmm00011110	$Rm \to GBR$	1	_	
-	LDC	Rm,VBR	0100mmmm00101110	$Rm \to VBR$	1	_	
-	LDC.L	@Rm+,SR	0100mmmm00000111	$(Rm) \to SR, Rm + 4 \to Rm$	3	LSB	
-	LDC.L	@Rm+,GBR	0100mmmm00010111	$(Rm) \to GBR, Rm + 4 \to Rm$	3	_	
-	LDC.L	@Rm+,VBR	0100mmmm00100111	$(Rm) \rightarrow VBR, Rm + 4 \rightarrow Rm$	3	_	
-	LDS	Rm,MACH	0100mmmm00001010	$Rm \to MACH$	1	_	
-	LDS	Rm,MACL	0100mmmm00011010	$Rm \to MACL$	1	_	
-	LDS	Rm,PR	0100mmmm00101010	$Rm \to PR$	1	_	
-	LDS.L	@Rm+,MACH	0100mmmm00000110	$(Rm) \to MACH, Rm + 4 \to Rm$	1	_	
-	LDS.L	@Rm+,MACL	0100mmmm00010110	$(Rm) \to MACL, Rm + 4 \to Rm$	1	_	
-	LDS.L	@Rm+,PR	0100mmmm00100110	$(Rm) \to PR, Rm + 4 \to Rm$	1	_	
-	NOP		000000000001001S	Notoperation	1	_	
-	RTE		000000000101011	Delayed branch, stack area \rightarrow PC/SR	4	_	
-	SETT		000000000011000	$1 \rightarrow T$	1	1	
1U.	SLEEP		000000000011011	Sleep	3*	— Data	Sh
-	STC	SR,Rn	0000nnnn00000010	$SR \to Rn$	1	_	
-	STC	GBR,Rn	0000nnnn00010010	$\text{GBR} \rightarrow \text{Rn}$	1	_	
-	STC	VBR,Rn	0000nnnn00100010	$VBR\toRn$	1	_	
-	STC.L	SR,@-Rn	0100nnnn00000011	$Rn-\!\!\!\!-\!\!\!\!\!-\!$	2	_	
-	STC.L	GBR,@-Rn	0100nnnn00010011	$\text{Rn-4} \rightarrow \text{Rn, GBR} \rightarrow (\text{Rn})$	2	_	
-	STC.L	VBR,@-Rn	0100nnnn00100011	Rn−4 → Rn, VBR → (Rn)	2	_	

DataSheet4U.com

www.DataSheet4U.com

40 DataSheet4U.com

www.DataSheet4U.com Table 2.17 System Control Instructions (cont)

Instruc	tion	Instruction Code	Operation	Execu- tion States	T Bit
STS	MACH,Rn	0000nnnn00001010	$MACH \to Rn$	1	_
STS	MACL,Rn	0000nnnn00011010	$MACL \to Rn$	1	—
STS	PR,Rn	0000nnnn00101010	$PR\toRn$	1	—
STS.L	MACH,@-Rn	0100nnnn00000010	Rn–4 \rightarrow Rn, MACH \rightarrow (Rn)	1	—
STS.L	MACL,@-Rn	0100nnnn00010010	$\text{Rn-}4 \rightarrow \text{Rn}, \text{MACL} \rightarrow (\text{Rn})$	1	—
STS.L	PR,@-Rn	0100nnnn00100010	Rn–4 \rightarrow Rn, PR \rightarrow (Rn)	1	—
TRAPA	#imm	11000011iiiiiiii	PC/SR \rightarrow stack area, (imm) \rightarrow PC	8	_

Note: The number of execution states before the chip enters the sleep mode. Instruction states: The values shown for the execution states are minimums. The actual number of states may be increased when:

Contention occurs between instruction fetch and data access

• The destination register of the load instruction (memory → register) and the register used by the next instruction are the same.

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

 Table 2.18
 Operation Code Map

lr	nstructi	ion C	ode	Fx: 0000	Fx: 0001	Fx: 0010	Fx: 0011–1111
MSB LSB		LSB MD: 00 MD: 0		MD: 01	MD: 10	MD: 11	
0000	Rn	Fx	0000		1		
0000	Rn	Fx	0001	-			
0000	Rn	Fx	0010	STC SR,Rn	STC GBR,Rn	STC VBR,Rn	
0000	Rm	Fx	0011	BSRF Rm		BRAF Rm	
0000	Rn	Rm	01MD	MOV.B RM, @(R0,Rn)	MOV.W RM, @(R0,Rn)	MOV.L RM, @(R0,Rn)	MUL.L Rm,Rn
0000	0000	Fx	1000	CLRT	SETT	CLRMAC	
0000	0000	Fx	1001	NOP	DIVOU		
0000	0000	Fx	1010				
0000	0000	Fx	1011	RTS	SLEEP	RTE	
0000	Rn	Fx	1000				
0000	Rn	Fx	1001			MOVT Rn	
0000	Rn	Fx	1010	STS MACH,Rn	STS MACL,Rn	STS PR,Rn	
0000	Rn	Fx	1011	Data	Sheet4U.com		
0000	Rn	Rm	11MD	MOV.B @(R0,Rm),Rn	MOV.W @(R0,Rm),Rn	MOV.L @(R0,Rm),Rn	MAC.L @Rm+,@Rn+
0001	Rn	Rm	disp	MOV.L Rm,@(di	isp:4,Rn)		
0010	Rn	Rm	00MD	MOV.B Rm,@Rn	MOV.W Rm,@Rn	MOV.L Rm,@Rn	Dat
0010	Rn	Rm	01MD	MOV.B Rm, @-Rn	MOV.W Rm, @-Rn	MOV.L Rm, @-Rn	DIVOS Rm,Rn
0010	Rn	Rm	10MD	TST Rm,Rn	AND Rm,Rn	XOR Rm,Rn	OR Rm,Rn
0010	Rn	Rm	11MD	CMP/STR Rm,Rn	XTRCT Rm,Rn	MULU.W Rm,Rn	MULS.W Rm,Rn
0011	Rn	Rm	00MD	CMP/EQ Rm,Rn		CMP/HS Rm,Rn	CMP/GE Rm,Rn
0011	Rn	Rm	01MD	DIV1 Rm,Rn	DMULU.L Rm,Rn	CMP/HI Rm,Rn	CMP/GT Rm,Rn
0011	Rn	Rm	10MD	SUB Rm,Rn		SUBC Rm,Rn	SUBV Rm,Rn
0011	Rn	Rm	11MD	ADD Rm,Rn	DMULS.L Rm,Rn	ADDC Rm,Rn	ADDV Rm,Rn
0100	Rn	Fx	0000	SHLL Rn	DT Rn	SHAL Rn	www.DataSheet4U

DataSheet4U.com

1	Instruction Code			Fx: 0000	Fx: 0001	Fx: 0010	Fx: 0011–1111
MSB LSB		MD: 00	MD: 01	MD: 10	MD: 11		
0100	Rn	Fx	0001	SHLR Rn	CMP/PZ Rn	SHAR Rn	
0100	Rn	Fx	0010	STS.L MACH, @-Rn	STS.L MACL, @-Rn	STS.L PR, @-Rn	
0100	Rn	Fx	0011	STC.L SR,@-Rn	STC.L GBR,@-Rn	STC.L VBR,@-Rn	
0100	Rn	Fx	0100	ROTL Rn		ROTCL Rn	
0100	Rn	Fx	0101	ROTR Rn	CMP/PL Rn	ROTCR Rn	
0100	Rm	Fx	0110	LDS.L @Rm+,MACH	LDS.L @Rm+,MACL	LDS.L @Rm+,PR	
0100	Rm	Fx	0111	LDC.L @Rm+,SR	LDC.L @Rm+,GBR	LDC.L @Rm+,VBR	
0100	Rn	Fx	1000	SHLL2 Rn	SHLL8 Rn	SHLL16 Rn	
0100	Rn	Fx	1001	SHLR2 Rn	SHLR8 Rn	SHLR16 Rn	「
0100	Rm	Fx	1010	LDS Rm,MACH	LDS Rm,MACL	LDS Rm,PR	
0100	Rm/Rn	Fx	1011	JSR @Rm	TAS.B @Rn	JMP @Rm	
0100	Rm	Fx	1100	Deteo			
0100	Rm	Fx	1101	DataSi	heet4U.com		
0100	Rm	Fx	1110	LDC Rm,SR	LDC Rm,GBR	LDC Rm,VBR	
0100	Rn	Rm	1111	MAC.W @Rm+,@R	2n+		
0101	Rn	Rm	disp	MOV.L @(disp:	:4,Rm),Rn		Dat
0110	Rn	Rm	00MD	MOV.B @Rm,Rn	MOV.W @Rm,Rn	MOV.L @Rm,Rn	MOV Rm,Rn
0110	Rn	Rm	01MD	MOV.B @Rm+,Rn	MOV.W @Rm+,Rn	MOV.L @Rm+,Rn	NOT Rm,Rn
0110	Rn	Rm	10MD	SWAP.B Rm,Rn	SWAP.W Rm,Rn	NEGC Rm,Rn	NEG Rm,Rn
0110	Rn	Rm	11MD	EXTU.B Rm,Rn	EXTU.W Rm,Rn	EXTS.B Rm,Rn	EXTS.W Rm,Rn
0111	Rn	i'	imm	ADD #imm:8,Rn	l		
1000	00MD	Rn	disp	MOV.B R0, @(disp:4,Rn)	MOV.W R0, @(disp:4,Rn)		
1000	01MD	Rm	disp	MOV.B @(disp:4, Rm),R0	MOV.W @(disp:4, Rm),R0		

www.DataSheet4U.com Table 2.18 Operation Code Map (cont)

DataSheet4U.com

ww.DataSheet4U.com Table 2.18 Operation Code Map (cont)

Instruction Code			Fx: 0000	Fx: 0001	Fx: 0010	Fx: 0011–1111
MSB		LSB	MD: 00	MD: 01	MD: 10	MD: 11
1000	10MD	imm/disp	CMP/EQ #imm:8,R0	BT label:8		BF label:8
1000	10MD	imm/disp		BT/S label:8		BF/S label:8
1001	Rn	disp	MOV.W @(disp	:8,PC),Rn	L	
1010		disp	BRA label:12			
1011		disp	BSR label:12			
1100	00MD	imm/disp	MOV.B R0, @(disp:8, GBR)	MOV.W R0, @(disp:8, GBR)	MOV.L R0, @(disp:8, GBR)	TRAPA #imm:8
1100	01MD	disp	MOV.B @(disp:8, GBR),R0	MOV.W @(disp:8, GBR),R0	MOV.L @(disp:8, GBR),R0	MOVA @(disp:8, PC),R0
1100	10MD	imm	TST #imm:8,R0	AND #imm:8,R0	XOR #imm:8,R0	OR #imm:8,R0
1100	11MD	imm	TST.B #imm:8, @(R0,GBR)	AND.B #imm:8, @(R0,GBR)	XOR.B #imm:8, @(R0,GBR)	OR.B #imm:8, @(R0,GBR)
1101	Rn	disp	MOV.L @(disp	8,pc;4,kncom		
1110	Rn	imm	MOV #imm:8,R	n		
1111						

et4U.com

2.5 Processing States

2.5.1 State Transitions

The CPU has five processing states: reset, exception handling, bus-released, program execution, and power-down. Figure 2.6 shows the transitions between the states. See section 14, Power-Down State, for more information on the power-down state.

DataSheet4U.com

www.DataSheet4U.com



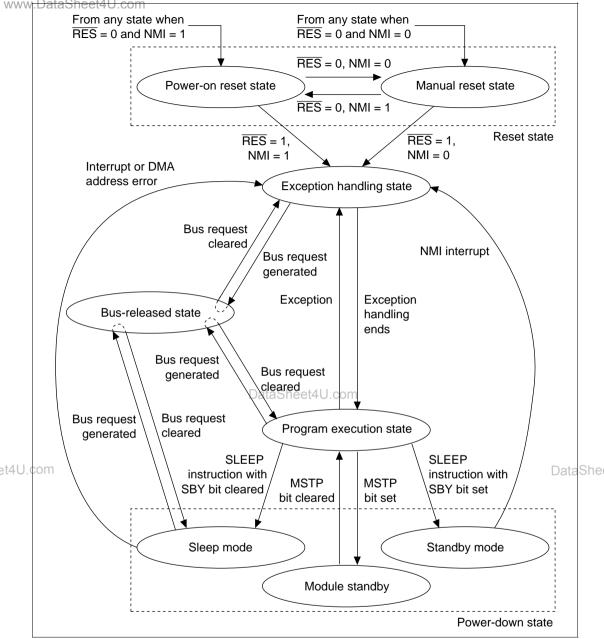


Figure 2.6 Transitions between Processing States

www.DataSheet4U.com

DataSheet4U.com Reset State: The CPU resets in the reset state. This occurs when the $\overline{\text{RES}}$ pin level goes low. When the NMI pin is high, the result is a power-on reset; when it is low, a manual reset will occur.

Exception Handling State: The exception handling state is a transient state that occurs when an exception handling source such as a reset or interrupt alters the CPU's processing state flow.

For a reset, the initial values of the program counter (PC) (execution start address) and stack pointer (SP) are fetched from the exception vector table and stored; the CPU then branches to the execution start address and execution of the program begins.

For an interrupt, the stack pointer (SP) is accessed and the program counter (PC) and status register (SR) are saved to the stack area. The exception service routine start address is fetched from the exception processing vector table; the CPU then branches to that address and the program starts executing, thereby entering the program execution state.

Program Execution State: In the program execution state, the CPU sequentially executes the program.

Power-Down State: In the power-down state, the CPU operation halts and power consumption declines. The SLEEP instruction places the CPU in the power-down state. This state has two modes: sleep mode and standby mode. See section 2.5.2 for more details.

Bus-Released State: In the bus-released state, the CPU releases the bus to the device that has requested it.

2.5.2 **Power-Down State**

Besides the ordinary program execution states, the CPU also has a power-down state in which CPU operation halts, lowering power consumption (table 2.19). There are two power-down state DataShee modes, sleep mode and standby mode, and also a module standby function.

Sleep Mode: When standby bit SBY (in the standby control register SBYCR) is cleared to 0 and a SLEEP instruction executed, the CPU moves from program execution state to sleep mode. The onchip peripheral modules other than the CPU do not halt in the sleep mode. To return from sleep mode, use a reset, any interrupt, or a DMA address error; the CPU returns to the ordinary program execution state through the exception handling state.

Software Standby Mode: To enter the standby mode, set the standby bit SBY (in the standby control register SBYCR) to 1 and execute a SLEEP instruction. In standby mode, all CPU, on-chip peripheral module, and oscillator functions are halted. When entering the standby mode, confirm that the DMAC master enable bit is 0. If a multiply instruction is in progress on entry to standby mode, the MACL and MACH registers will be invalid. CPU internal register contents and on-chip www.DataSheet4U.com Data SRAM4data are retained. Cache (and on-chip RAM) data is not retained.

www.DataSheet4U.com To return from standby mode, use a reset or an external NMI interrupt. For resets, the CPU returns to the ordinary program execution state through the exception handling state when placed in a reset state after the oscillator stabilization time has elapsed. For NMI interrupts, the CPU returns to the ordinary program execution state through the exception handling state after the oscillator stabilization time has elapsed. Turn the cache off before entering standby mode. In this mode, power consumption drops substantially because the oscillator stops.

Module Standby Function: The module standby function is available for the multiplier (MULT), divider (DIVU), 16-bit free-running timer (FRT), serial communication interface (SCI), and DMA controller (DMAC) on-chip peripheral modules.

The supply of the clock to these on-chip peripheral modules can be halted by setting the corresponding bits 4–0 (MSTP4–MSTP0) in the standby control register (SBYCR). By using this function, the power consumption can be reduced.

The external pins of the on-chip peripheral modules in module standby mode are reset and all registers except DMAC, MULT, and DIVU are initialized. The module standby function is cleared by clearing the MSTP4-MSTP0 bits to 0.

When MULT has entered the software standby mode, do not execute the DMULS.L, DMULU.L, MAC.L, MAC.W, MUL.L, MULS, and MULU instructions (all of which are multiply instructions) or any instructions that access the MACH and MACL registers (CLRMAC, LDS MACH/MACL, STS MACH/MACL).

When the DMAC module standby function is used, set the DMAC's DMA master enable bit to 0.

t4U.com

www.DataSheet4U.com Table 2.19 Power-Down State

			State			
Conditions	Clock	CPU	On-Chip Peripheral Modules	CPU Registers	RAM	Canceling
Execute SLEEP instruction with SBY bit	Active	Halted	Active	Held	Held	 Interrupt DMA address error
in SBYCR						 Power-on reset
						4. Manual reset
Execute	Halted	Halted	Halted and	Held	Undefined	1. NMI
instruction			initialized			2. Power-on reset
set to 1 in SBYCR						3. Manual reset
MSTP4– MSTP0 bits of SBYCR set to 1	Active	Active (MULT is halted:)a	Supply of clock to affected module is halted tand modulecom initialized. ^{*2}	Held	Held	Clear bits MSTP 4–0 of SBYCR to 0
	Execute SLEEP instruction with SBY bit cleared to 0 in SBYCR Execute SLEEP instruction with SBY bit set to 1 in SBYCR MSTP4– MSTP0 bits of SBYCR	Execute SLEEP instruction with SBY bit cleared to 0 in SBYCR Halted SLEEP instruction with SBY bit set to 1 in SBYCR MSTP4- MSTP0 bits of SBYCR	Execute SLEEP instruction with SBY bit cleared to 0 in SBYCRActive Halted Halted HaltedExecute SLEEP instruction with SBY bit set to 1 in SBYCRHalted 	ConditionsClockCPUOn-Chip Peripheral ModulesExecute SLEEP instruction with SBY bit cleared to 0 in SBYCRActiveHaltedActiveExecute SLEEP instruction with SBY bit cleared to 0 in SBYCRHaltedHaltedActiveExecute SLEEP instruction with SBY bit set to 1 in SBYCRHaltedHaltedHalted and initialized*1MSTP4- MSTP0 bits of SBYCRActiveActive (MULT isSupply of clock to affected module is halted	ConditionsClockCPUOn-Chip Peripheral ModulesCPU RegistersExecute SLEEP instruction with SBY bit cleared to 0 in SBYCRActiveHaltedActiveHeldExecute SLEEP instruction with SBY bit cleared to 0 in SBYCRHaltedHaltedActiveHeldExecute SLEEP instruction with SBY bit set to 1 in SBYCRHaltedHaltedHalted and initialized*1HeldMSTP4- MSTP0 bits of SBYCRActiveActiveSupply of clock module is haltedHeld	ConditionsClockCPUOn-Chip Peripheral ModulesCPU RegistersRAMExecute SLEEP instruction with SBY bit cleared to 0 in SBYCRActiveHaltedActiveHeldHeldExecute SLEEP instruction with SBY bit set to 1 in SBYCRHaltedHalted and initialized*1HeldUndefinedMSTP4- MSTP0 bits of SBYCRActiveActiveSupply of clock to affected module is haltedHeldHeld

et4U.com

settings.

DataShe

DataSheet4U.com

www.DataSheet4U.com

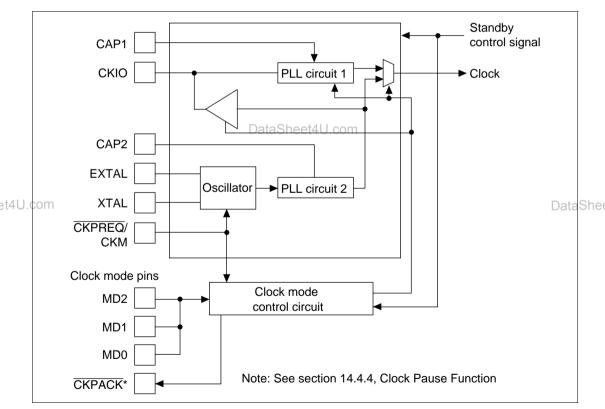
www.DataSheet4U.com Section 3 Oscillator Circuits and Operating Modes

3.1 Overview

Operation of the on-chip clock pulse generator, CS0 area bus width specification, and switching between master and slave modes are controlled by the operating mode pins. A crystal resonator or external clock can be selected as the clock source.

3.2 On-Chip Clock Pulse Generator and Operating Modes

3.2.1 Clock Pulse Generator



A block diagram of the on-chip clock pulse generator circuit is shown in figure 3.1.

Figure 3.1 Block Diagram of Clock Pulse Generator Circuit

DataSheet4U.com

www.DataSheet4U.com

Renesas

www.DataSheet4U.com **Pin Configuration:** Table 3.1 lists the functions relating to the pins relating to the oscillator circuit.

Pin Name	I/O	Function
CKIO	I/O	External clock input pin or internal clock output pin
XTAL	0	Connects to the crystal resonator.
EXTAL	I	Connects to the crystal resonator or to the external clock input when using PLL circuit 2.
CAP1	I	Connects to capacitance for operating PLL circuit 1.
CAP2	Ι	Connects to capacitance for operating PLL circuit 2.
MD0	I	The level applied to these pins specifies the clock mode.
MD1	I	_
MD2	I	_
CKPREQ/CKM	I	Used as the clock pause request pin, or specifies operation of the crystal oscillator.

Pin Functions Table 3.1

PLL Circuit 1: PLL circuit 1 eliminates phase differences between external clocks and clocks supplied internally within the chip. In high-speed operation, the phase difference between the reference clocks and operating clocks in the chip directly affects the interface margin with peripheral devices. On-chip PLL circuit 1 is provided to eliminate this effect.

PLL circuit 1 can also make the phase difference between the clocks 90 degrees, enabling highspeed interface with synchronous DRAM.

et4U.com

PLL Circuit 2: PLL circuit 2 either leaves unchanged, doubles, or quadruples the frequency of clocks provided from the crystal resonator or the EXTAL pin external clock input for the chip operating frequency. The frequency modification register sets the clock frequency multiplication factor.

www.DataSheet4U.com

3.2.2 Clock Operating Mode Settings

Table 3.2 lists the functions and operation of clock modes 0 to 6.

Note that TBP-176 package products can only be used in clock modes 4 to 6.

Clock Mode	Function/Operation	Clock Source
0	PLL circuits 1 and 2 operate. A clock with the same phase as the internal chip clock is output from the CKIO pin.	Crystal resonator/ External clock input
1	PLL circuits 1 and 2 operate. A clock shifted 90° from the CKIO pin output is supplied to the internal chip clock.	Crystal resonator/ External clock input
2	Only PLL circuit 2 operates. The clock from PLL circuit 2 is output from the CKIO pin. Phases are not matched in this mode.	Crystal resonator/ External clock input
3	Only PLL circuit 2 operates. The CKIO pin is high impedance. Phases are not matched in this mode.	Crystal resonator/ External clock input
4	Set this mode when the CKIO pin inputs a clock having a frequency equivalent to the object operating frequency and PLL circuit 1 synchronizes the phases of the input clock and the internal clock.	External clock input
5	Set this mode when the CKIO pin inputs a clock having a frequency equivalent to the object operating frequency and PLL circuit 1 shifts the phases of the input clock and internal clock by 90 degrees.	External clock input
6 om	Set this mode when a clock having a frequency equivalent to that of clocks input from the CKIO pin are used. PLL circuits 1 and 2 do not operate.	External clock input

Table 3.2Operating Modes

When clock modes 0 to 3 are selected, the input frequency or its double or quadruple (produced by PLL circuit 2) is used as the internal clock. When clock modes 4 to 6 are selected, the clock pause function can modify the frequency of clocks input from the CKIO pin or can stop the sending of clock signals (see section 14.4, Standby Mode). When clock modes 4 to 6 are set, PLL circuit 2 stops.

Table 3.3 lists the relationship between pins MD2 to MD0 and the clock operating mode. Do not switch the MD2–MD0 pins while they are operating. Switching will cause operating errors.

DataSheet4U.com

				Pi	in* ¹			
Clock Mode	MD2	MD1	MD0	CKPREQ/ CKM	EXTAL	XTAL	СКІО	- Internal Clock
0	0	0	0	0 1	Clock input	Open	Output	Synchronized to a phase difference of
					Crystal oscillation	Crystal oscillation		0° from CKIO by PLL circuit 1
1	0	0	1	0 1	Clock input	Open	Output	Synchronized to a phase difference of
					Crystal oscillation	Crystal oscillation		90° from CKIO by PLL circuit 1
2	0	1	0	0 1	Clock input	Open	Output	CKIO
					Crystal oscillation	Crystal oscillation		
3	0	1	1	0 1	Clock input	Open	High impe-	PLL circuit 2 output
					Crystal oscillation	Crystal oscillation	dance	
4	1	0	0	*2 Da	Open ataSheet4	Open U.com	Clock input	Synchronized to a phase difference of 0° from CKIO by PLL circuit 1
5 com	1	0	1	-	Open	Open	Clock input	Synchronized to a phase difference of Da 90° from CKIO by PLL circuit 1
6	1	1	0	_	Open	Open	Clock input	CKIO

www.DataSheet4U.com Table 3.3 Clock Mode Pin Settings and States

Notes: 1. Do not use in combinations other than those listed.

2. In clock modes 4, 5, and 6, CKPREQ/CKM functions as the clock pause request pin.

3. For TBP-176 package products, only clock mode 4, 5, or 6 can be selected.

3.2.3 Connecting a Crystal Resonator

Connecting a Crystal Resonator: Figure 3.2 shows how to connect a crystal resonator. Use the value shown in table 3.4 for the damping resistance Rd. The crystal resonator should be an AT-cut parallel-resonance type. Be sure to connect load capacitors (CL1, CL2) as shown in the figure. DataSheet4U.com

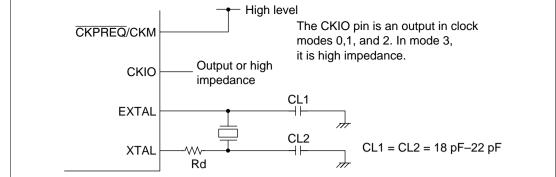


Figure 3.2 Example of Crystal Resonator Connection

Table 3.4	Damping Resistance (Reference	e Values)
-----------	-------------------------------	-----------

Frequency (MHz)	4	6	8
Rd (Ω)	500	200	0

Crystal Resonator: Figure 3.3 shows a crystal resonator equivalent circuit. Use a crystal resonator that has the characteristics shown in table 3.5.

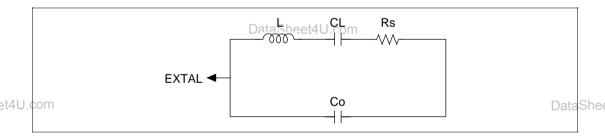


Figure 3.3 Crystal Resonator Equivalent Circuit

Table 3.5 Crystal Resonator Characteristics (Reference Values)

		Frequency	(MHz)	
Parameters	4	6	8	
Rs max (Ω)	120	100	80	
Co max (pF)		7 pF ma	х	

DataSheet4U.com

Input the external clock from the EXTAL pin or the CKIO pin, depending on the clock mode.

Clock Input from the EXTAL Pin: This can be used in clock modes 0,1, 2, and 3.

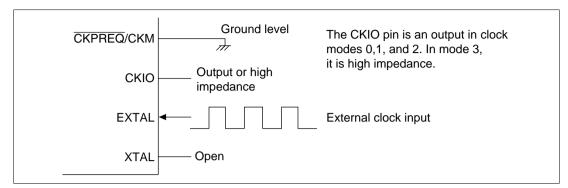
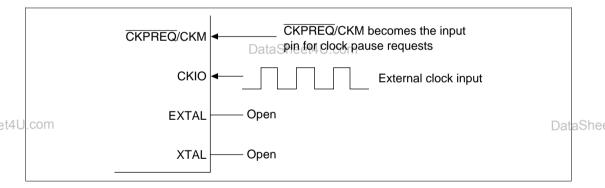
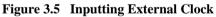


Figure 3.4 Inputting External Clock

Clock Input from the CKIO Pin: This can be used in clock modes 4, 5, and 6.





3.2.5 Selecting Operating Frequency with a Register

PLL circuit 2 and the frequency modification register can double or quadruple the operating frequency in clock modes 0 to 3. Figure 3.6 shows a block diagram of PLL circuit 2 and the frequency modification register.

DataSheet4U.com

www.DataSheet4U.com

54 DataSheet4U.com

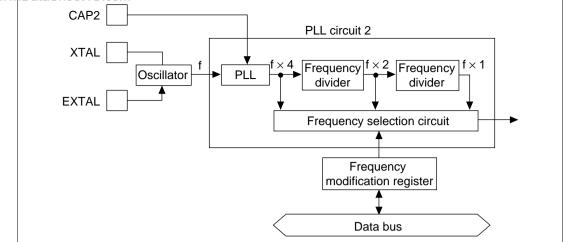


Figure 3.6 Relationship between PLL Circuit 2 and the Frequency Modification Register

PLL circuit 2 includes the PLL circuit (which quadruples frequency f of clocks generated by the oscillator) and frequency dividers, which divide the output of the PLL circuit by 2 or 4. The clocks ($f \times 1$, $f \times 2$, and $f \times 4$) are input to the frequency selection circuit, where one is selected according to the value set in the frequency modification register, and is then output from PLL circuit 2.

Frequency Modification Register: This register is only initialized by a power-on reset. It holds its values in a manual reset and in standby mode. Table 3.6 shows the register configuration, and the following figure shows the bit combinations and functions.

Register			Abbr	ev. R/W	Initial	Value	Address	Acce	ess Size ^{Data}
Frequency mod	lificatio	on register	FMR	R/W	H'00		H'FFFFFE	90 8	
	Bit:	7	6	5	4	3	2	1	0
Bit nai	me:	—	_	_		—	_	FR1	FR0
Initial val	ue:	0	0	0	0	0	0	0	0
R	/W:	R	R	R	R	R	R	R/W	R/W
Bit 1: FR1	Bi	t 0: FR0	De	escription					
0	0		No	multiplicati	on			(In	itial value)
	1		×2	multiplicati	on				
heet4U.com	0		×4	multiplicati	on			www.Dat	aSheet4U.c
	1		Se	tting prohib	ited				

Table 3.6 Frequency Modification Register

Bits 2–7 are reserved. They always read 0, and the write value should always be 0.

Modifying Frequencies: In the following modifications, the device is running in clock modes 0 to 3, and the operating frequency is left unchanged, doubled, or quadrupled using PLL circuit 2.

- Set the TME bit to 0 in or above the oscillation settling time that specifies the on-chip WDT's overflow time.
- Set the frequency modification register to the target value. (The chip will go internally to standby mode temporarily.)
- All circuits involved in oscillation operate and the clock is supplied to the WDT. The WDT overflows with this clock.
- When the WDT overflows, a clock at the frequency set within the chip begins to be supplied and the chip returns from standby mode.

Frequency Modification Guidelines:

- Only write to the frequency modification register while the cache is disabled.
- The frequency modification program is always in cache memory and so should be executed utilizing the forced access space of the data array. Figure 3.7 shows how the frequency modification register is set.
- When the frequency modification program is executed, execute an associative or forced purge of the entries in the data array used.
- Place at least eight consecutive NOP instructions after an instruction that writes to the frequency modification register.

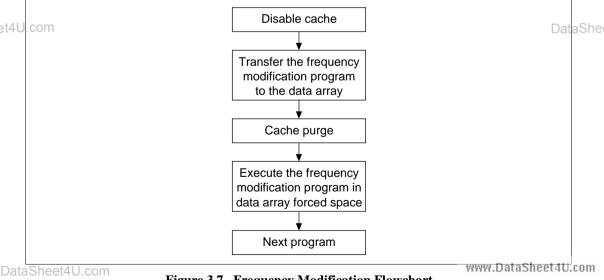


Figure 3.7 Frequency Modification Flowchart

56

www.DataSheet4U.com Frequency Modification Register Setting Program (Sample)

			3		57
		MOV.L	R2,@R1		
Dataone		the data arr	ay		
DataShe	et4U.com	MOV.L	@(12,R0),R5 ^{*1}		www.DataSheet4U.com
		MOV.L	@(8,R0),R4 ^{*1}		
		MOV.L	@(4,R0),R3 ^{*1}		
		MOV.L	@R0,R2		
	; Read from	m the main me	mory		
	PRG_TRNS				
	;				
	; Transfer	frequency mo	dification prog	ram to the data ar:	ray
	;				
		MOV.B	R3,@R2		
		MOV	#H'10,R3	;Forced purge set	ting
		MOV.B	@R2,R3	;Dummy read	DataShe
et4U.con	n	MOV.B	R3,@R2	5	DataSha
		MOV	#H'00,R3	;Disable setting	
		MOV.B	@R2,R6		
		MOV.L	DataSheet4U #MDC_CCR, R2	.com	
	; Cache_CC		le, and forced	purge	
		MOV.L	#CLOCK2_END,R1	1	
		MOV.L	#DIRECT_RW,R1		
		MOV.L	#CLOCK2_START,	R0	
	; Program	initializatio	n		
	;				
	WTCSR	.EQU	H'FFFFE80		
	MDC_CCR	.EQU	H'FFFFFE92		
1	MDC_FLCR	.EQU	H'FFFFE90		
1	DIRECT_RW	.EQU	н'С0000000		
	i				
	MAP-IO	.EQU	H'FFFFF000		
	MAP_ROM	.EQU	н'00000000		
	;				
	PURGE	~ .EQU	н'40000000		
	WAIT_TIME	-	н'00080000		
	CLR	.EQU	н'0000000		
	; DEFINE C	ONSTANTS			
4					

DataSheet4U.com	1	Renesa	S	
58				
	NOP			
DataSheet4U.com	NOP		www.DataSheet	4U.com
	NOP			
; Wait dur		y modification		
	MOV.B	R1,@R2	, bouble the internal frequency	<u>r</u>
	MOV	#H'01,R1	register setting ;Double the internal frequency	7
	MOV.L	#MDC_FLCR,R2	;Frequency modification	
et4U.com			Γ	DataShe
	MOV.W	R1,@R0		
			stabilized	
	MOV.L		;Set enough time for PLL to be	
	MOV.L	#WTCSRtR0heet4U	CWDT setting	
			Lot one mene program	
	то х .п	TIGAT_FROG, KS	for the next program	
CLUCKZ_SIA	MOV.L	HNEXT PROC R3	;Branch destination address	
; CLOCK2_STA	RT			
	.CONST -			
	NOP .CONST ^{*2}			
	JMP	@R0		
	MOV.L	#DIRECT_RW,R0		
; Branch t		rray forced acces	s space	
	BF	PRG_TRNS		
	CMP/GT	R11,R0		
; Loop				
	ADD	#H'10,R1		
	ADD	#H'10,R0		
; Incremen				
	MOV.L	R5,@(12,R1) ^{*1}		
	MOV.L	R4,@(8,R1) ^{*1}		
		R3,@(4,R1) ^{*1}		
www.DataSheet4U	.com	*1		

```
www.DataSheet4U.com
                    NOP
                    NOP
                    NOP
                    NOP
                    NOP
                    NOP
        ; Branch to the next program
                    JMP
                                   @R3
                    NOP
                    .CONST<sup>*2</sup>
       CLOCK2 END
        ;
        ; Next program
       NEXT_PROG
        ; Cache_CCR load
                    MOV.L
                                   #MDC_CCR,R2
                    MOV.B
                                   R6,@R2aSheet4U.com
```

- *1 This example shows Hitachi cross-assembler coding. With the Hitachi cross-assembler the values to which scaling (×1, ×2, ×4) is applied are written. For coding in other cross-assemblers, see the notation rules.
 - *2 This is a literal pool output control statement. Code according to the notation rule for the assembler used. The Hitachi cross-assembler is not required.
 - *3 When the WTCSR set value is read, H'0000A51F' is returned.

DataSheet4U.com

Table 3.7 shows the operating modes and the associated frequency ranges for input clocks.

	PLL (Circuit	Clock Input		Internal Clock	CKIO Output	
Mode	PLL1	PLL2	Pin	Input Frequency Range (MHz)	Frequency (MHz)	Frequency (MHz)	Comments
0	Active	Active	EXTAL	4–8 ^{*1}	4- max*2	7-max*2	Multiplication
1	_		(including				ratio settable
2	Halted	_	when resonator			4– max*2	(×1, ×2, ×4)
3	_		is used)				
4	Active	Halted	CKIO	7-max*2	7-max*3		Multiplication
5	_						not settable
6	Halted	_		4-max*2	4-max*2		(×1 only)

Table 3.7 Operating Modes and Frequency Ranges

Notes: 1. Make the setting so that the clock frequency output from the CKIO pin does not exceed the maximum operating frequency. For example, if 8 MHz is input, set the multiplication ratio of the frequency to ×1 or ×2. (If ×4 is used, a 32-MHz clock is output from the CKIO pin, which is outside the range for the PLL circuit 1 input frequency.)

- 2. "max" represents the maximum operating frequency of 28.7 MHz at 5 V operation and 20.0 MHz at 3.3 V operation.
- 3. If CKIO output below 7 MHz is used during PLL circuit 1 operation, AC characteristics using the CKIO output are not guaranteed.

t4U.com

3.2.7 Notes on Board Design

When Using a Crystal Resonator: Place the crystal resonator and capacitors as close to the EXTAL and XTAL pins as possible. Do not let the pins' signal lines cross other signal lines. If they do, induction may prevent proper oscillation.

DataSheet4U.com

www.DataSheet4U.com

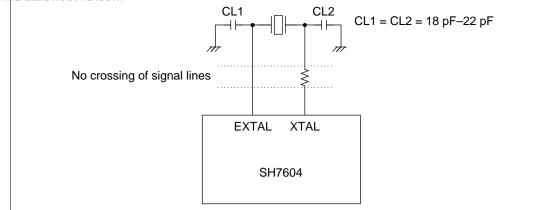


Figure 3.8 Design Considerations when Using a Crystal Resonator

When Using PLL Oscillation Circuits: Place oscillation settling capacitors C1 and C2 and resistors R1 and R2 near the CAP1 and CAP2 pins, and keep the wiring from the CAP pins as short as possible. As the CAP pin circuits are susceptible to influence by other signals, avoid crossing signal lines both on the board surface and in internal layers. PLL-V_{CC} and PLL-V_{SS} should be isolated from other V_{CC} and V_{SS} lines away from the board's power supply sources, and bypass capacitors CPB and CB must be inserted near the pins.

In the clock circuits in this product, clock stability may be affected by reflected noise generated by the CKIO pin. This influence is especially great in clock modes 0 and 1, in which the PLL1 and PLL2 circuits are used simultaneously, so the board design should ensure that reflected noise does not occur in CKIO. In clock mode 6, in which no PLLs are used, connect PLL-V_{CC} to V_{CC} and PLL-V_{ss} to V_{ss}.

4U.com

	Mode Setting						
Resistance/Capacitance	0	1	2	3	4	5	6
R1 = 3 kΩ C1 = 470 pF	Needed	Needed	Not needed	Not needed	Needed	Needed	Not needed
R2 = 3 kΩ C2 = 470 pF	Needed	Needed	Needed	Needed	Not needed	Not needed	Not needed

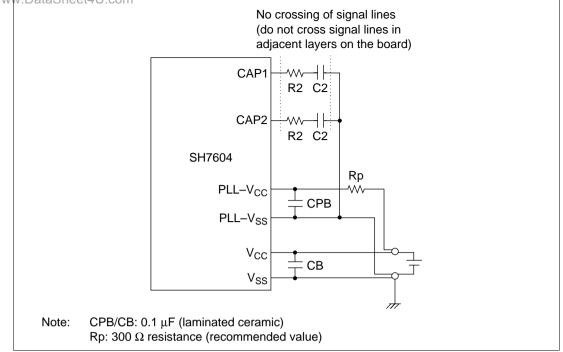
Table 3.8 Connected Resistance and Capacitance Reference Values

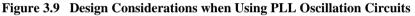
When the PLL circuits are off, CAP1 and CAP2 should be left open or used as shown in the recommended example.

DataSheet4U.com

www.DataSheet4U.com







DataSheet4U.com

3.3 Bus Width of the CS0 Area

Pins MD3 and MD4 are used to specify the bus width of the CS0 area (boot ROM area). The pin combination and functions are listed in table 3.9. Do not switch the MD4 and MD3 pins while t4U. They are operating. Switching them will cause operating errors.

Table 3.9 Bus Width of the CS0 Area

Pin		
MD4	MD3	Function
0	0	8-bit bus width selected
0	1	16-bit bus width selected
1	0	32-bit bus width selected
1	1	Setting prohibited

DataSheet4U.com

www.DataSheet4U.com

62 DataSheet4U.com

www.DataSheet4U.com 3.4 Switching between Master Mode and Slave Mode

The SH7604 has two master modes and a slave mode for bus rights that can be selected with the MD5 pin. The master modes consist of a total master mode and a partial-share master mode, which are specified using the MD5 pin and the partial-share space specification bit (PSHR) in bus control register 1 (BCR1). When the slave mode is selected with the MD5 pin, the device enters total slave mode. When master mode is selected with the MD5 pin and partial-space share is specified with the PSHR bit, the device enters partial-share master mode. When partial-space share is not specified with the PSHR bit, the device enters total master mode.

Total master mode has rights to bus use. External devices can be accessed freely. The bus can be allocated to another CPU upon request.

Total slave mode does not have any rights to bus use. When an external device is accessed, bus rights have to be requested from the master CPU, and permission to use the bus gained, before the external device can be accessed.

Partial-share master mode lacks bus rights only for the CS2 space. To access the CS2 space, bus rights must first be requested from the master CPU, and permission granted. This mode has bus rights for all other spaces and does not require a request for the bus when accessing them (table 3.10). Do not change MD5 while external device accesses are in progress.

Mode	MD5 Total Slave Mode Specification Pin		Function
Total slave mode	1	(Not used)	Has no bus rights. To use the bus, it must request the bus and receive permission from pata the master CPU.
Partial-share master mode	0	1	Has bus rights to CS0, CS1, and CS3 spaces, but not normally to CS2. To access CS2, it must first request and be granted bus rights.
Total master mode	0	0	Always has bus rights. Grants bus rights to slave CPUs.

Table 3.10 Master Modes and Slave Mode

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

64 DataSheet4U.com

Section 4 Exception Handling

4.1 Overview

4.1.1 **Types of Exception Handling and Priority Order**

Exception handling is initiated by four sources: resets, address errors, interrupts, and instructions (table 4.1). When several exception handling sources occur at once, they are processed according to priority.

Exception	Source		Priority		
Reset	Power-on reset		High		
	Manual reset				
Address	CPU address error				
error	DMA address error				
Interrupt	NMI				
	User break				
	IRL (IRL1–IRL15 (set with IRL3, IRL2, IRL1, IRL0 pins))				
	On-chip peripheral modules	Division unit (DIVU)			
		Direct memory access controller (DMAC)	_		
		Watchdog timer (WDT)			
om		Compare match interrupt (part of the bus state controller)	Data		
		Serial communication interface (SCI)			
		16-bit free-running timer (FRT)			
Instructions	Trap instruction (TRAPA)				
	General illegal instructions (undefined code)				
	Illegal slot instructions (undefined code placed directly following a delayed branch instruction ^{1^{1}} or instructions that rewrite the PC ^{2^{1}})				
	Delayed branch instructions: JM BRAF	P, JSR, BRA, BSR, RTS, RTE, BF/S, BT/S,	BSRF,		
	nstructions that rewrite the PC: 3F/S, BT/S, BSRF, BRAF	JMP, JSR, BRA, BSR, RTS, RTE, BT, BF, T	RAPA,		
heet4U.com		ພພພ Da	taSheet4U.		

Types of Exception Handling and Priority Order Table 4.1

Exception Handling Operations 4.1.2

Exception handling sources are detected, and exception handling started, according to the timing shown in table 4.2.

Power-on reset Manual reset	Starts when the NMI pin is high and the RES pin changes from low to high. Starts when the NMI pin is low and the RES pin changes from low to high.
Manual reset	1 1 5
	Detected when instruction is decoded and starts when the previous executing instruction finishes executing.
	Detected when instruction is decoded and starts when the previous executing instruction finishes executing.
Trap instruction	Starts from the execution of a TRAPA instruction.
General illegal instructions	Starts from the decoding of undefined code anytime except after a delayed branch instruction (delay slot).
Illegal slot instructions	Starts from the decoding of undefined code placed directly following a delayed branch instruction (delay slot) or of an instruction that rewrites the PC.
i I	General illegal nstructions llegal slot

Table 4.2 **Timing of Exception Source Detection and Start of Exception Handling**

When exception handling starts, the CPU operates as follows:

- 1. Exception handling triggered by reset
- et4U.comThe initial values of the program counter (PC) and stack pointer (SP) are fetched from the exception vector table (PC and SP are respectively addresses H'00000000 and H'00000004 for a power-on reset and addresses H'00000008 and H'0000000C addresses for a manual reset). See section 4.1.3, Exception Vector Table, for more information. 0 is then written to the vector base register (VBR) and 1111 is written to the interrupt mask bits (I3-I0) of the status register. The program begins running from the PC address fetched from the exception vector table.
 - 2. Exception handling triggered by address errors, interrupts, and instructions SR and PC are saved to the stack address indicated by R15. For interrupt exception handling, the interrupt priority level is written to the SR's interrupt mask bits (I3-I0). For address error and instruction exception handling, the I3-I0 bits are not affected. The start address is then fetched from the exception vector table and the program begins running from that address.

www.DataSheet4U.com

Before exception handling begins, the exception vector table must be written in memory. The exception vector table stores the start addresses of exception service routines. (The reset exception table holds the initial values of PC and SP.)

All exception sources are given different vector numbers and vector table address offsets, from which the vector table addresses are calculated. During exception handling, the start addresses of the exception service routines are fetched from the exception vector table.

Table 4.3 lists the vector numbers and vector table address offsets. Table 4.4 shows vector table address calculations.

Exception Source		Vector Number	Vector Table Address Offset	Vector Address
Power-on reset	PC	0	H'00000000-H'00000003	Vector number $\times 4$
	SP	1	H'00000004-H'00000007	
Manual reset	PC	2	H'0000008-H'000000B	
	SP	3	H'0000000C-H'0000000F	
General illegal instru	ction	4	H'00000010-H'00000013	VBR + (vector
(Reserved by system	ı)	5 DataSI	H'00000014–H'00000017	number × 4)
Slot illegal instruction	1	6	H'00000018-H'0000001B	
(Reserved by system	ו)	7	H'0000001C-H'0000001F	
:om		8	H'00000020-H'00000023	DataS
CPU address error		9	H'00000024-H'00000027	Datas
DMA address error		10	H'00000028-H'0000002B	
Interrupt	NMI	11	H'0000002C-H'0000002F	
	User break	12	H'00000030-H'00000033	
(Reserved by system	ı)	13	H'00000034-H'00000037	
		:	:	
		31	H'0000007C-H'0000007F	
Trap instruction (use	r vector)	32	H'00000080-H'00000083	
		:	:	
		63	H'000000FC-H'000000FF	

Table 4.3Exception Vector Table

DataSheet4U.com

et4U

www.DataSheet4U.com Table 4.3 Exception Processing Vector Table (cont)

Exception Source		Vector Number	Vector Table Address Offset	Vector Addresses
Interrupt	IRL1 ^{*1}	64 ^{*2}	H'00000100-H'00000103	VBR + (vector
	IRL2 ^{*1}	65 ^{*2}	H'00000104-H'00000107	number × 4)
	IRL3 ^{*1}	_		
	IRL4 ^{*1}	66 ^{*2}	H'00000108-H'0000010B	
	IRL5 ^{*1}	_		
	IRL6 ^{*1}	67 ^{*2}	H'0000010C-H'0000010F	
	IRL7 ^{*1}	_		
	IRL8 ^{*1}	68 ^{*2}	H'00000110-H'00000113	
	IRL9 ^{*1}	_		
	IRL10 ^{*1}	69 ^{*2}	H'00000114-H'00000117	
	IRL11 ^{*1}	_		
	IRL12 ^{*1}	70 ^{*2}	H'00000118-H'0000011B	
	IRL13 ^{*1}	_		
	IRL14 ^{*1}	71 ^{*2}	H'0000011C-H'0000011F	
	IRL15 ^{*1}	_		
	On-chip peripheral module* ³	0 ^{*4} DataS	H'00000000-H'00000003 :	_
	module	255 ^{*4}	H'000003FC-H'000003FF	

Notes: 1. When 1110 is input to the IRL3, IRL2, IRL1, and IRL0 pins, an IRL1 interrupt results.

- 2. External vector number fetches can be performed without using the auto-vector numbers in this table.
- 3. The vector numbers and vector table address offsets for each on-chip peripheral module interrupt are given in section 5, Interrupt Controller, and table 5.4, Interrupt Exception Vectors and Priorities.
- Vector numbers are set in the on-chip vector number register. See section 5.3, Description of Registers, section 9, Direct Memory Access Controller, and section 10, Division Unit, for more information.

DataSheet4U.com

68

www.DataSheet4U.com

www.DataSheet4U.com **Table 4.4** Calculating Exception Vector Table Addresses

Exception Source	Vector Table Address Calculation			
Power-on reset	(Vector table address) = (vector table address offset)			
Manual reset	= (vector number) \times 4			
Other exception handling	(Vector table address) = VBR + (vector table address offset) = VBR + (vector number) × 4			

Note: VBR: Vector base register Vector table address offset: See table 4.3. Vector number: See table 4.3.

4.2 Resets

4.2.1 Types of Resets

Resets have the highest priority of any exception source. There are two types of resets: manual resets and power-on resets. As table 4.5 shows, both types of resets initialize the internal status of the CPU. In power-on resets, all registers of the on-chip peripheral modules are initialized; in manual resets, registers of all on-chip peripheral modules except the bus state controller (BSC), user break controller (UBC) and frequency modification register are initialized. (Use the power-on reset when turning the power on.)

Table 4.5Types of Resets

t4U.c	om		ditions for to Reset Status		Internal Status	taShe
1-0.0	Туре	NMI Pin	RES Pin	CPU	On-Chip Peripheral Modules	SHE
	Power-on reset	High	Low	Initialized	Initialized	
	Manual reset	Low	Low	Initialized	Initialized except for BSC, UBC, and FMR register	

DataSheet4U.com

When the NMI pin is high and the $\overline{\text{RES}}$ pin is driven low, the device performs a power-on reset. For a reliable reset, the $\overline{\text{RES}}$ pin should be kept low for at least the duration of the oscillation settling time (when the PLL circuit is halted) or for 20 clock cycles (when the PLL circuit is running). During a power-on reset, the CPU's internal state and all on-chip peripheral module registers are initialized. See appendix A, Pin States, for the state of individual pins in the power-on reset state.

In a power-on reset, power-on reset exception handling starts when the NMI pin is kept high and the $\overline{\text{RES}}$ pin is first driven low for a set period of time and then returned to high. The CPU will then operate as follows:

- 1. The initial value (execution start address) of the program counter (PC) is fetched from the exception vector table.
- 2. The initial value of the stack pointer (SP) is fetched from the exception vector table.
- 3. The vector base register (VBR) is cleared to H'00000000 and the interrupt mask bits (I3–I0) of the status register (SR) are set to H'F (1111).
- 4. The values fetched from the exception vector table are set in the PC and SP, and the program begins executing.

4.2.3 Manual Reset

DataSheet4U.com

When the NMI pin is low and the $\overline{\text{RES}}$ pin is driven low, the device executes a manual reset. For a reliable reset, the $\overline{\text{RES}}$ pin should be kept low for at least 20 clock cycles. During a manual reset, the CPU's internal state is initialized. Registers of all on-chip peripheral modules except the bus

et4U. state controller (BSC), user break controller (UBC) and the frequency modification register are DataShee initialized. Since the BSC is not affected, the DRAM and synchronous DRAM refresh control functions remain operational even if the manual reset state continues for a long period of time. When the chip enters the manual reset state in the middle of a bus cycle, manual reset exception handling does not start until the bus cycle has ended. Thus, manual resets do not abort bus cycles. See appendix A, Pin States, for the state of individual pins in the manual reset state.

In a manual reset, manual reset exception handling starts when the NMI pin is kept low and the $\overline{\text{RES}}$ pin is first kept low for a set period of time and then returned to high. The CPU will then operate in the same way as for a power-on reset.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 4.3 Address Errors

Sources of Address Errors 4.3.1

Address errors occur when instructions are fetched or data read or written, as shown in table 4.6.

Table 4.6Bus Cycles and Address Errors

Bus C	ycle		
Туре	Bus Master	Bus Cycle Description	Address Errors
Instruction	CPU	Instruction fetched from even address	None (normal)
fetch		Instruction fetched from odd address	Address error occurs
		Instruction fetched from other than on-chip peripheral module space	None (normal)
		Instruction fetched from on-chip peripheral module space	Address error occurs
Data	CPU or	Word data accessed from even address	None (normal)
read/write	DMAC	Word data accessed from odd address	Address error occurs
		Longword data accessed from a longword boundary	None (normal)
		Longword data accessed from other than a longword boundary	Address error occurs
		Access of cache purge space, address array read/ write space or on-chip I/O space by PC-relative addressing	Address error occurs
J.com		Access of cache purge space, address array read/ Address error o write space, data array read/write space or on-chip /O space by a TAS.B instruction	
		Byte data accessed in on-chip peripheral module space at addresses H'FFFFF00 to H'FFFFFFF	Address error occurs
		Word or longword data accessed in on-chip peripheral module space at addresses H'FFFFFF00 to H'FFFFFFFF	None (normal)
		Longword data accessed in on-chip peripheral module space at addresses H'FFFFE00 to H'FFFFFEFF	Address error occurs
		Word or byte data accessed in on-chip peripheral module space at addresses H'FFFFE00 to H'FFFFEFF	None (normal)

Notes: 1. Address errors do not occur during the synchronous DRAM mode register write cycle. www.DataSheet4U.com DataSheet4U.20rfl6-byte DMAC transfers use longword accesses.

4.3.2 Address Error Exception Handling

When an address error occurs, address error exception handling begins after the end of the bus cycle in which the error occurred and completion of the executing instruction. The CPU operates as follows:

- 1. The status register (SR) is saved to the stack.
- 2. The program counter (PC) is saved to the stack. The PC value saved is the start address of the instruction to be executed after the last instruction executed .
- 3. The exception service routine start address is fetched from the exception vector table entry that corresponds to the address error that occurred, and the program starts executing from that address. The jump that occurs is not a delayed branch.

4.4 Interrupts

4.4.1 Interrupt Sources

Table 4.7 shows the sources that initiate interrupt exception handling. These are divided into NMI, user breaks, IRL, and on-chip peripheral modules. Each interrupt source is allocated a different vector number and vector table address offset. See table 5.4, Interrupt Exception Vectors and Priority Order, in section 5, Interrupt Controller, for more information.

Туре	Request Source	Number of Sources	
NMI	NMI pin (external input)	1	
User break	User break controller	1 Da	itaShe
IRL	IRL1–IRL15 (external input)	15	
On-chip peripheral module	Direct memory access controller (DMAC)	2	
	Division unit (DIVU)	1	
	Serial communication interface (SCI)	4	
	Free-running timer (FRT)	3	
	Watchdog timer (WDT)	1	
	Bus state controller (BSC)	1	

Table 4.7 Types of Interrupt Sources DataSheet4U.com

DataSheet4U.com

www.DataSheet4U.com

72 DataSheet4U.com

The interrupt priority order is predetermined. When multiple interrupts occur simultaneously, the interrupt controller (INTC) determines their relative priorities and begins exception handling accordingly.

The priority order of interrupts is expressed as priority levels 0-16, with priority 0 the lowest and priority 16 the highest. The NMI interrupt has priority 16 and cannot be masked, so it is always accepted. The user break interrupt priority level is 15 and IRL interrupts have priorities of 1-15. On-chip peripheral module interrupt priority levels can be set freely using the INTC's interrupt priority level setting registers A and B (IPRA and IPRB) as shown in table 4.8. The priority levels that can be set are 0-15. Level 16 cannot be set. For more information on IPRA and IPRB, see sections 5.3.1 and 5.3.2, Interrupt Priority Level Setting Registers A and B (IPRA and IPRB).

Туре	Priority Level	Comment
NMI	16	Fixed priority level. Cannot be masked.
User break	15	Fixed priority level.
IRL	1–15	Set with IRL3-IRL0 pins.
On-chip peripheral module	0–15	Set with interrupt priority level setting registers A and B (IPRA and IPRB).
	Data	Sheet4U.com

Table 4.8 **Interrupt Priority Order**

4.4.3 **Interrupt Exception Handling**

When an interrupt occurs, its priority level is ascertained by the interrupt controller (INTC). NMI is always accepted, but other interrupts are only accepted if they have a priority level higher than the priority level set in the interrupt mask bits (I3–I0) of the status register (SR).

When an interrupt is accepted, exception handling begins. In interrupt exception handling, the CPU saves SR and the program counter (PC) to the stack. The priority level value of the accepted interrupt is written to SR bits I3-I0. For NMI, however, the priority level is 16, but the value set in I3-I0 is H'F (level 15). Next, the start address of the exception service routine is fetched from the exception vector table for the accepted interrupt, that address is jumped to and execution begins. For more information about interrupt exception handling, see section 5.4, Interrupt Operation.

www.DataSheet4U.com 4.5 Exceptions Triggered by Instructions

4.5.1 Instruction-Triggered Exception Types

Exception handling can be triggered by a trap instruction, general illegal instruction or illegal slot instruction, as shown in table 4.9.

Туре	Source Instruction	Comment
Trap instruction	TRAPA	-
Illegal slot instruction	Undefined code placed immediately after a delayed branch instruction (delay slot)	Delayed branch instructions: JMP, JSR, BRA, BSR, RTS, RTE, BF/S, BT/S, BSRF, BRAF
	and instructions that rewrite the PC	Instructions that rewrite the PC: JMP, JSR, BRA, BSR, RTS, RTE, BT, BF, TRAPA, BF/S, BT/S, BSRF, BRAF
General illegal instruction	Undefined code anywhere besides in a delay slot	_

Table 4.9	Types of Exceptions Triggered by Instructions
-----------	--

4.5.2 Trap Instructions

DataSheet4U.com

When a TRAPA instruction is executed, trap instruction exception handling starts. The CPU operates as follows:

1. The status register (SR) is saved to the stack.

- 2. The program counter (PC) is saved to the stack. The PC value saved is the start address of the DataSher instruction to be executed after the TRAPA instruction.
 - 3. The exception service routine start address is fetched from the exception vector table entry that corresponds to the vector number specified by the TRAPA instruction. That address is jumped to and the program starts executing. The jump that occurs is not a delayed branch.

4.5.3 Illegal Slot Instructions

An instruction placed immediately after a delayed branch instruction is said to be placed in a delay slot. If the instruction placed in the delay slot is undefined code, illegal slot exception handling begins when the undefined code is decoded. Illegal slot exception handling also starts up when an instruction that rewrites the program counter (PC) is placed in a delay slot. The exception handling starts when the instruction is decoded. The CPU handles an illegal slot instruction as follows:

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

- 1. The status register (SR) is saved to the stack.
- 2. The program counter (PC) is saved to the stack. The PC value saved is the jump address of the delayed branch instruction immediately before the undefined code or the instruction that rewrites the PC.
- 3. The exception service routine start address is fetched from the exception vector table entry that corresponds to the exception that occurred. That address is jumped to and the program starts executing. The jump that occurs is not a delayed branch.

4.5.4 General Illegal Instructions

When undefined code placed anywhere other than immediately after a delayed branch instruction (i.e., in a delay slot) is decoded, general illegal instruction exception handling starts. The CPU handles general illegal instructions in the same way as illegal slot instructions. Unlike processing of illegal slot instructions, however, the program counter value stored is the start address of the undefined code.

4.6 When Exception Sources are Not Accepted

When an address error or interrupt is generated after a delayed branch instruction or interruptdisabled instruction, it is sometimes not immediately accepted but is stored instead, as described in table 4.10. When this happens, it will be accepted when an instruction for which exception acceptance is possible is decoded. DataSheet4U.com

Table 4.10 Exception Source Generation Immediately after a Delayed Branch Instruction or Interrupt-Disabled Instruction

om	Exception	on Source Da	ataS
Point of Occurrence	Address Error	Interrupt	•
Immediately after a delayed branch instruction*1	Not accepted	Not accepted	-
Immediately after an interrupt-disabled instruction*2	Accepted	Not accepted	-
Notes: 1. Delayed branch instructions: JMP, JSR, BRA BRAF	l.		-

2. Interrupt-disabled instructions: LDC, LDC.L, STC, STC.L, LDS, LDS.L, STS, STS.L

4.6.1 Immediately after a Delayed Branch Instruction

When an instruction placed immediately after a delayed branch instruction (delay slot) is decoded, neither address errors nor interrupts are accepted. The delayed branch instruction and the instruction located immediately after it (delay slot) are always executed consecutively, so no www.DataSheet4U.com

4.6.2 Immediately after an Interrupt-Disabled Instruction

When an instruction immediately following an interrupt-disabled instruction is decoded, interrupts are not accepted. Address errors are accepted.

4.7 Stack Status after Exception Handling

The status of the stack after exception handling ends is as shown in table 4.11.

Table 4.11	Stack Status	after	Exception	Handling
-------------------	--------------	-------	-----------	----------

Туре	Stack	Status	
Address error	$\text{SP} \rightarrow$	Address of instruction after executed instruction	32 bits
		SR	32 bits
Trap instruction	$\text{SP} \rightarrow$	Address of instruction after TRAPA instruction	32 bits
		SR	32 bits
General illegal instruction	$\text{SP} \rightarrow$	Start address of illegal instruction	32 bits
		SR	32 bits
Interrupt	$\text{SP} \rightarrow$	Address of instruction after executed instruction	32 bits
		SR	32 bits
Illegal slot instruction	$\text{SP} \rightarrow$	Jump destination address of delayed branch instruction	32 bits
		SR	32 bits

4.8 Usage Notes

DataShe

4.8.1 Value of Stack Pointer (SP)

The value of the stack pointer must always be a multiple of four, otherwise an address error will occur when the stack is accessed during exception handling.

4.8.2 Value of Vector Base Register (VBR)

The value of the vector base register must always be a multiple of four, otherwise an address error will occur when the vector table is accessed during exception handling.

DataSheet4U.com

www.DataSheet4U.com

If the stack pointer value is not a multiple of four, an address error will occur during stacking of the exception handling (interrupts, etc.). Address error exception handling will begin as soon as the first exception handling is ended, but address errors will continue to occur. To ensure that address error exception handling does not go into an endless loop, no address errors are accepted at that point. This allows program control to be shifted to the address error exception service routine and enables error handling to be carried out.

When an address error occurs during exception handling stacking, the stacking bus cycle (write) is executed. In stacking of the status register (SR) and program counter (PC), the SP is decremented by 4 for both, so the value of SP will not be a multiple of four after the stacking either. The address value output during stacking is the SP value, so the address where the error occurred is itself output. This means that the write data stacked will be undefined.

4.8.4 Manual Reset during Register Access

Do not initiate a manual reset during access of a bus state controller (BSC) or user break controller (UBC) register, otherwise a write error may result.

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

78 DataSheet4U.com

Section 5 Interrupt Controller (INTC)

5.1 Overview

The interrupt controller (INTC) ascertains the priority of interrupt sources and controls interrupt requests to the CPU. The INTC has registers for setting the priority of each interrupt which allow the user to set the order of priority in which interrupt requests are handled.

5.1.1 Features

The INTC has the following features:

- 16 interrupt priority levels: By setting the two interrupt-priority level registers, the priorities of on-chip peripheral module interrupts can be set at 16 levels for different request sources.
- Settable vector numbers for on-chip peripheral module interrupts: two vector number setting registers enable on-chip peripheral module interrupt vector numbers to be set in the range 0–127 by interrupt source.
- The IRL interrupt vector number setting method can be selected: Either of two modes can be selected by a register setting: auto-vector mode in which vector numbers are determined internally, and external vector mode in which vector numbers are set externally.

5.1.2 Block Diagram

DataSheet4U.com

Figure 5.1 shows a block diagram of the INTC.

t4U.com

DataShe

DataSheet4U.com

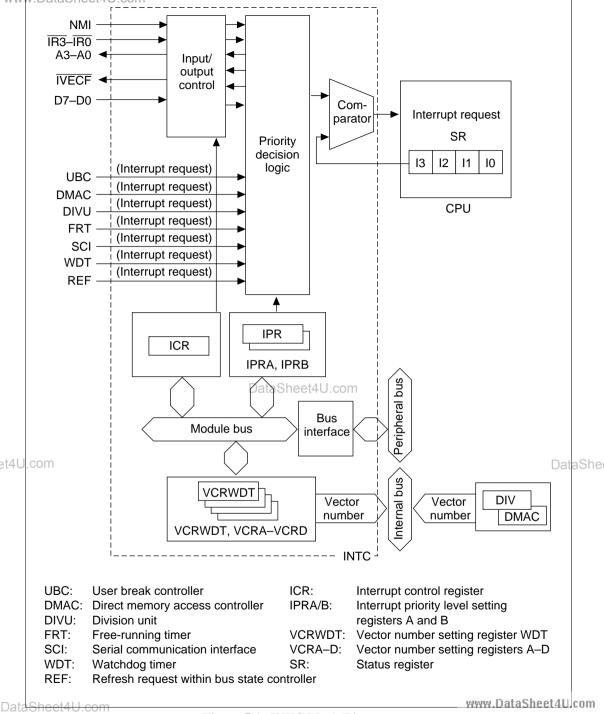


Figure 5.1 INTC Block Diagram

Table 5.1 shows the INTC pin configuration.

Table 5.1Pin Configuration

Name	Abbreviation	I/O	Function
Nonmaskable interrupt input pin	NMI	Ι	Input of nonmaskable interrupt request signal
Level request interrupt input pins	IRL3-IRL0	I	Input of maskable interrupt request signals
Interrupt acceptance level output pins	A3–A0	0	In external vector mode, output an interrupt level signal when an IRL interrupt is accepted
External vector fetch pin	IVECF	0	Indicates external vector read cycle
External vector number input pins	D7–D0	I	Input external vector number

5.1.4 Register Configuration

The INTC has the eight registers shown in table 5.2. These registers perform various INTC functions including setting interrupt priority, and controlling external interrupt input signal detection. DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

ww.DataSheet4U.com **Table 5.2** Register Configuration

Name	Abbr.	R/W	Initial Value	Address	Access Size*
Interrupt priority level setting register A	IPRA	R/W	H'0000	H'FFFFFEE2	8, 16
Interrupt priority level setting register B	IPRB	R/W	H'0000	H'FFFFFE60	8, 16
Vector number setting register A	VCRA	R/W	H'0000	H'FFFFFE62	8, 16
Vector number setting register B	VCRB	R/W	H'0000	H'FFFFFE64	8, 16
Vector number setting register C	VCRC	R/W	H'0000	H'FFFFFE66	8, 16
Vector number setting register D	VCRD	R/W	H'0000	H'FFFFFE68	8, 16
Vector number setting register WDT	VCRWDT	R/W	H'0000	H'FFFFFEE4	8, 16
Vector number setting register DIV	VCRDIV	R/W	_	H'FFFFFF0C	32
Vector number setting register DMAC0	VCRDMA0	R/W	_	H'FFFFFFA0	32
Vector number setting register DMAC1	VCRDMA1	R/W	_	H'FFFFFFA8	32
Interrupt control register	ICR	R/W	H'8000/ H'0000*	H'FFFFFEE0	8, 16

—: Undefined

Note: The value when the NMI pin is high is H'8000; when the NMI pin is low, it is H'0000. See the sections 9, Direct Memory Access Controller, and 10, Division Unit, for more information on VCRDIV, VCRDMA0, and VCRDMA1.

DataSheet4U.com

5.2 Interrupt Sources

There are four types of interrupt sources: NMI, user breaks, IRL, and on-chip peripheral modules. Each interrupt has a priority expressed as a priority level (0 to 16, with 0 the lowest and 16 the highest). Giving an interrupt a priority level of 0 masks it.

5.2.1 NMI Interrupt

The NMI interrupt has priority 16 and is always accepted. Input at the NMI pin is detected by edge. Use the NMI edge select bit (NMIE) in the interrupt control register (ICR) to select either the rising or falling edge. NMI interrupt exception handling sets the interrupt mask level bits (I3–I0) in the status register (SR) to level 15.

5.2.2 User Break Interrupt

A user break interrupt has priority level 15 and occurs when the break condition set in the user break controller (UBC) is satisfied. User break interrupt exception handling sets the interrupt merku.com level bits (I3–I0) in the status register (SR) to level 15. For more information about the user break interrupt, see section 6, User Break Controller.

RENESAS

82

IRL interrupts are requested by input from pins IRL3–IRL0. Fifteen interrupts, IRL15–IRL1, can be input externally via pins IRL3–IRL0. The priority levels of interrupts IRL15–IRL0 are 15–1, respectively, and their vector numbers are 71–64. Set the vector numbers with the IRL interrupt vector mode select (VECMD) bit of the interrupt control register (ICR) to enable external input. External input of vector numbers consists of vector numbers 0–127 from the external vector input pins (D7–D0). Internal vectors are called auto-vectors and vectors input externally are called external vectors. Table 5.3 lists IRL priority levels and auto vector numbers.

When an IRL interrupt is accepted in external vector mode, the IRL interrupt level is output from the interrupt acceptance level output pins (A3–A0). The external vector fetch pin (\overline{IVECF}) is also asserted. The external vector number is read from pins D7–D0 at this time. Figures 5.2 and 5.3 show interrupt connection examples.

IRL interrupt exception processing sets the interrupt mask level bits (I3 to I0) in the status register (SR) to the priority level value of the IRL interrupt that was accepted.

	Vector	Priority		Pin		
	Number	Level	IRL0	IRL1	IRL2	IRL3
	71	15	o aSheet4U.com	0 Da	0	0
		14	1	0	0	0
	70	13	0	1	0	0
		12	1	1	0	0
DataShe	69	11	0	0	1	c 0 U
		10	1	0	1	0
	68	9	0	1	1	0
		8	1	1	1	0
	67	7	0	0	0	1
		6	1	0	0	1
	66	5	0	1	0	1
		4	1	1	0	1
	65	3	0	0	1	1
		2	1	0	1	1
	64	1	0	1	1	1

Table 5.3	IRL Interrupt Priority Levels and Auto-Vector Numbers
-----------	---

DataSheet4U.com

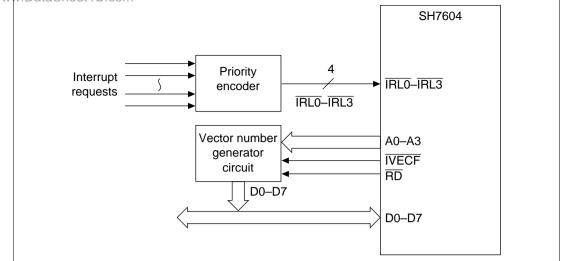


Figure 5.2 Example of Connections for External Vector Mode Interrupts

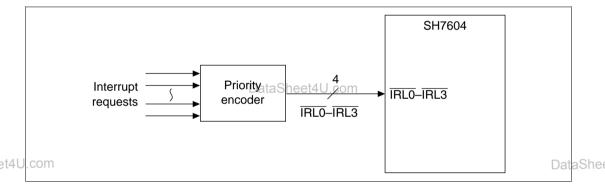


Figure 5.3 Example of Connections for Auto-Vector Mode Interrupts

Figure 5.4 shows the interrupt fetch cycle for the external vector mode. During this cycle, $\overline{CS0}$ - $\overline{CS3}$ stay high. A26–A4 output undefined values. The \overline{WAIT} pin is sampled, but programmable waits are not valid.

DataSheet4U.com

www.DataSheet4U.com

84 DataSheet4U.com



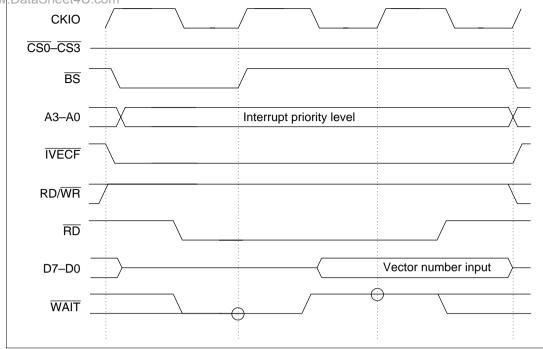


Figure 5.4 External Vector Mode Interrupt Vector Fetch Cycle



5.2.4 **On-chip Peripheral Module Interrupts**

On-chip peripheral module interrupts are interrupts generated by the following 6 on-chip peripheral modules:

t4U.com

- Division unit (DIVU)
- Direct memory access controller (DMAC)
- Serial communication interface (SCI)
- Bus state controller (BSC) •
- Watchdog timer (WDT)
- Free-running timer (FRT)

A different interrupt vector is assigned to each interrupt source, so the exception service routine does not have to decide which interrupt has occurred. Priority levels between 0 and 15 can be assigned to individual on-chip peripheral modules in interrupt priority registers A and B (IPRA and IPRB). On-chip peripheral module interrupt exception handling sets the interrupt mask level bits (I3–I0) in the status register (SR) to the priority level value of the on-chip peripheral module interrupt that was accepted.

www.DataSheet4U.com

Table 5.4 lists interrupt sources and their vector numbers, vector table address offsets and interrupt priorities.

Each interrupt source is allocated a different vector number and vector table address offset. Vector table addresses are calculated from vector numbers and address offsets. In interrupt exception handling, the exception service routine start address is fetched from the vector table entry indicated by the vector table address. See table 4.4, Calculating Exception Vector Table Addresses, for more information on this calculation.

IRL interrupts IRL15–IRL1 have interrupt priority levels of 15–1, respectively. On-chip peripheral module interrupt priorities can be set freely between 0 and 15 for each module by setting interrupt priority registers A and B (IPRA and IPRB). The ranking of interrupt sources for IPRA and IPRB, however, must be the order listed under Priority Within IPR Setting Unit in table 5.4 and cannot be changed. A reset assigns priority level 0 to on-chip peripheral module interrupts. If the same priority level is assigned to two or more interrupt sources and interrupts from those sources occur simultaneously, their priority order is the default priority order indicated at the right in table 5.4.

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

86 DataSheet4U.com

		Interrupt Priority Order		Priority within IPR		Vectors			
Interrupt S	ource	(Initial Value)	IPR (Bit Numbers)	Setting Unit	Vector No.	Vector Table Address	Defau Prior		
NMI		16	_	_	11	VBR + (vector	High		
User break		15	_	_	12	No. × 4)			
IRL15		15	_	_	71 ^{*1}	_	-		
IRL14		14	_	_	_				
IRL13		13	_	_	70 ^{*1}				
IRL12		12	_	_	_				
IRL11		11	_	_	69 ^{*1}				
IRL10		10	_	_	_				
IRL9		9	_	_	68 ^{*1}				
IRL8		8	_	_	_				
IRL7		7	_	_	67 ^{*1}				
IRL6		6	_	_	_				
IRL5		5	DataShee	t4II.com	66 ^{*1}				
IRL4		4			_				
IRL3		3	_	_	65 ^{*1}				
IRL2		2	_	_	_				
IRL1		1	_	_	64 ^{*1}			Data	
DIVU	OVFI	0–15 (0)	IPRA (15–12	2)	0–127 ^{*2}		Low		

DataSheet4U.com

Interrupt Source		Interrupt Priority Order		Priority within IPR			
		(Initial Value)	IPR (Bit Numbers)	Setting Unit	Vector No.	Vector Table Address	Default Priority
DMAC0	Transfer end	0–15 (0)	IPRA (11–8)	1	0–127 ^{*2}	VBR + (vector	
DMAC1	Transfer end			0	0–127 ^{*2}	[–] No. × 4)	
WDT	ITI	0–15 (0)	IPRA (7–4)	1	0–127 ^{*2}	_	
REF ^{*3}	CMI			0	0–127 ^{*2}	_	
SCI	ERI	0–15 (0)	IPRB (15–12)	3	0–127 ^{*2}	_	
	RXI			2	0–127 ^{*2}	_	
	TXI			1	0–127 ^{*2}	_	
	TEI			0	0–127 ^{*2}	_	
FRT	ICI	0–15 (0)	IPRB (11-8)	2	0–127 ^{*2}	_	
	OCI			1	0–127 ^{*2}	_	
	OVI			0	0–127 ^{*2}	_	
Reserved	b	_	_	—	128–255	—	Low

Notes: 1. An external vector number fetch can be performed without using the auto-vector numbers shown in this table. The external vector numbers are 0–127.

2. Vector numbers are set in the on-chip vector number register.

3. REF is the refresh control unit within the bus state controller.

et4U.com 5.3

Description of Registers

5.3.1 Interrupt Priority Level Setting Register A (IPRA)

Interrupt priority level setting register A (IPRA) is a 16-bit read/write register that assigns priority levels from 0 to 15 to on-chip peripheral module interrupts. IPRA is initialized to H'0000 by a reset. It is not initialized in standby mode. Unless otherwise specified, 'reset' refers to both power-on and manual resets throughout this manual.

DataSheet4U.com

www.DataSheet4U.com

88 DataSheet4U.com

/ww.DataSheet4U.com Bit:								
Bit:	15	14	13	12	11	10	9	8
Bit name:	DIVU	DIVU	DIVU	DIVU	DMAC	DMAC	DMAC	DMAC
	IP3	IP2	IP1	IP0	IP3	IP2	IP1	IP0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W							
Bit:	7	6	5	4	3	2	1	0
Bit name:	WDT	WDT	WDT	WDT	_	_	_	_
	IP3	IP2	IP1	IP0				
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W	R/W	R/W	R/W	R	R	R	R

- Bits 15 to 12—Division Unit (DIVU) Interrupt Priority Level (DIVUIP3–DIVUIP0): These bits set the division unit (DIVU) interrupt priority level. There are four bits, so levels 0–15 can be set.
- Bits 11 to 8—DMA Controller Interrupt Priority Level (DMACIP3–DMACIP0): These bits set the DMA controller (DMAC) interrupt priority level. There are four bits, so levels 0–15 can be set. The same level is set for both DMAC channels. When interrupts occur simultaneously, channel 0 has priority.
- Bits 7 to 4—Watchdog Timer (WDT) Interrupt Priority Level (WDTIP3–WDTIP0): These bits set the watchdog timer (WDT) interrupt priority level and bus state controller (BSC) interrupt priority level. There are four bits, so levels 0–15 can be set. When WDT and BSC interrupts occur simultaneously, the WDT interrupt has priority.

4U.com

W

Bits 3 to 0—Reserved: These bits always read 0. The write value should always be 0.

5.3.2 Interrupt Priority Level Setting Register B (IPRB)

Interrupt priority level setting register B (IPRB) is a 16-bit read/write register that assigns priority levels from 0 to 15 to on-chip peripheral module interrupts. IPRB is initialized to H'0000 by a reset. It is not initialized in standby mode.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com									
Bit:	['] 15	14	13	12	11	10	9	8	
Bit name:	SCIIP3	SCIIP2	SCIIP1	SCIIP0	FRTIP3	FRTIP2	FRTIP1	FRTIP0	
Initial value:	0	0	0	0	0	0	0	0	
R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Bit:	7	6	5	4	3	2	1	0	
Bit name:	_	—	—	_	—	_	_	—	
Initial value:	0	0	0	0	0	0	0	0	
R/W:	R	R	R	R	R	R	R	R	

- Bits 15 to 12—Serial Communication Interface (SCI) Interrupt Priority Level (SCIIP3– SCIIP0): These bits set the serial communication interface (SCI) interrupt priority level. There are four bits, so levels 0–15 can be set.
- Bits 11 to 8—Free-Running Timer (FRT) Interrupt Priority Level (FRTIP3–FRTIP0): These bits set the free-running timer (FRT) interrupt priority level. There are four bits, so levels 0–15 can be set.
- Bits 7 to 0—Reserved: These bits always read 0. The write value should always be 0.

Table 5.5 shows the relationship between on-chip peripheral module interrupts and interrupt priority level setting registers. DataSheet4U.com

Table 5.5 Interrupt Request Sources and IPRA/IPRB

лн	Register	Bits 15 to 12	Bits 11 to 8	Bits 7 to 4	Bits 3 to 0	DataSho
40.	IPRA	DIVU	DMAC0, DMAC1	WDT	Reserved	DataShee
	IPRB	SCI	FRT	Reserved	Reserved	

As table 5.5 shows, two or three on-chip peripheral modules are assigned to each interrupt priority register. Set the priority levels by setting the corresponding 4-bit groups (bits 15 to 12, bits 11 to 8, and bits 7 to 4) with values in the range of H'0 (0000) to H'F (1111). H'0 is interrupt priority level 0 (the lowest); H'F is level 15 (the highest). When two on-chip peripheral modules are assigned to the same bits (DMAC0 and DMAC1, or WDT and DRAM refresh control unit), those two modules have the same priority. A reset initializes IPRA and IPRB to H'0000. They are not initialized in standby mode.

DataSheet4U.com

www.DataSheet4U.com

90 DataSheet4U.com

Vector number setting register WDT (VCRWDT) is a 16-bit read/write register that sets the WDT interval interrupt and BSC compare match interrupt vector numbers (0–127). VCRWDT is initialized to H'0000 by a reset. It is not initialized in standby mode.

Bit:	15	14	13	12	11	10	9	8
Bit name:	—	WITV6	WITV5	WITV4	WITV3	WITV2	WITV1	WITV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W						
Bit:	7	6	5	4	3	2	1	0
Bit name:	—	BCMV6	BCMV5	BCMV4	BCMV3	BCMV2	BCMV1	BCMV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W						

- Bits 15, 7—Reserved: These bits always read 0. The write value should always be 0.
- Bits 14 to 8—Watchdog Timer (WDT) Interval Interrupt Vector Number (WITV6–WITV0): These bits set the vector number for the interval interrupt (ITI) of the watchdog timer (WDT). There are seven bits, so the value can be set between 0 and 127.
- Bits 6 to 0—Bus State Controller (BSC) Compare Match Interrupt Vector Number (BCMV6–BCMV0): These bits set the vector number for the compare match interrupt (CMI) of the bus state controller (BSC). There are seven bits, so the value can be set between 0 and 127.

t4U.com

DataShe

5.3.4 Vector Number Setting Register A (VCRA)

Vector number setting register A (VCRA) is a 16-bit read/write register that sets the SCI receiveerror interrupt and receive-data-full interrupt vector numbers (0–127). VCRA is initialized to H'0000 by a reset. It is not initialized in standby mode.

DataSheet4U.com

www.DataSheet4U.com Bit:	15	14	13	12	11	10	9	8
Bit name:	_	SERV6	SERV5	SERV4	SERV3	SERV2	SERV1	SERV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W						
Bit:	7	6	5	4	3	2	1	0
Bit name:	—	SRXV6	SRXV5	SRXV4	SRXV3	SRXV2	SRXV1	SRXV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W						

- Bits 15, 7—Reserved: These bits always read 0. The write value should always be 0.
- Bits 14 to 8—Serial Communication Interface (SCI) Receive-Error Interrupt Vector Number (SERV6–SERV0): These bits set the vector number for the serial communication interface (SCI) receive-error interrupt (ERI). There are seven bits, so the value can be set between 0 and 127.
- Bits 6 to 0—Serial Communication Interface (SCI) Receive-Data-Full Interrupt Vector Number (SRXV6–SRXV0): These bits set the vector number for the serial communication interface (SCI) receive-data-full interrupt (RXI). There are seven bits, so the value can be set between 0 and 127.

5.3.5 Vector Number Setting Register B (VCRB)

Vector number setting register B (VCRB) is a 16-bit read/write register that sets the SCI transmitdata-empty interrupt and transmit-end interrupt vector numbers (0–127). VCRB is initialized to DataShet H'0000 by a reset. It is not initialized in standby mode.

Bit:	15	14	13	12	11	10	9	8
Bit name:		STXV6	STXV5	STXV4	STXV3	STXV2	STXV1	STXV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Bit:	7	6	5	4	3	2	1	0
Bit name:	_	STEV6	STEV5	STEV4	STEV3	STEV2	STEV1	STEV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
							ພພພ Da	taSheet/

DataSheet4U.com

www.DataSheet4U.com

92 DataSheet4U.com

www.DataSheet4U.com

• Bits 15, 7—Reserved: These bits always read 0. The write value should always be 0.

- Bits 14 to 8—Serial Communication Interface (SCI) Transmit-Data-Empty Interrupt Vector Number (STXV6–STXV0): These bits set the vector number for the serial communication interface (SCI) transmit-data-empty interrupt (TXI). There are seven bits, so the value can be set between 0 and 127.
- Bits 6 to 0—Serial Communication Interface (SCI) Transmit-End Interrupt Vector Number (STEV6–STEV0): These bits set the vector number for the serial communication interface (SCI) transmit-end interrupt (TEI). There are seven bits, so the value can be set between 0 and 127.

5.3.6 Vector Number Setting Register C (VCRC)

Vector number setting register C (VCRC) is a 16-bit read/write register that sets the FRT inputcapture interrupt and output-compare interrupt vector numbers (0–127). VCRC is initialized to H'0000 by a reset. It is not initialized in standby mode.

	Bit:	15	14	13	12	11	10	9	8	
	Bit name:		FICV6	FICV5	FICV4	FICV3	FICV2	FICV1	FICV0	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
				DataShee	et4U.com					
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:	—	FOCV6	FOCV5	FOCV4	FOCV3	FOCV2	FOCV1	FOCV0	
et4U.com	Initial value:	0	0	0	0	0	0	0	0 Data	Shee
, 140.00m	R/W:	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W	IONEC

- Bits 15, 7—Reserved: These bits always read 0. The write value should always be 0.
- Bits 14 to 8—Free-Running Timer (FRT) Input-Capture Interrupt Vector Number (FICV6– FICV0): These bits set the vector number for the free-running timer (FRT) input-capture interrupt (ICI). There are seven bits, so the value can be set between 0 and 127.
- Bits 6 to 0—Free-Running Timer (FRT) Output-Compare Interrupt Vector Number (FOCV6–FOCV0): These bits set the vector number for the free-running timer (FRT) output-compare interrupt (OCI). There are seven bits, so the value can be set between 0 and 127.

DataSheet4U.com

Vector number setting register D (VCRD) is a 16-bit read/write register that sets the FRT overflow interrupt vector number (0-127). VCRD is initialized to H'0000 by a reset. It is not initialized in standby mode.

Bit:	15	14	13	12	11	10	9	8
Bit name:	—	FOVV6	FOVV5	FOVV4	FOVV3	FOVV2	FOVV1	FOVV0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R/W						
Bit:	7	6	5	4	3	2	1	0
Bit name:	_	—		—				—
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R	R

- Bits 15, 7–0—Reserved: These bits always read 0. The write value should always be 0.
- Bits 14 to 8—Free-Running Timer (FRT) Overflow Interrupt Vector Number (FOVV6– FOVV0): These bits set the vector number for the free-running timer (FRT) overflow interrupt (OVI). There are seven bits, so the value can be set between 0 and 127.

Tables 5.6 and 5.7 show the relationship between on-chip peripheral module interrupts and interrupt vector number setting registers.

Table 5.6 Interrupt Request Sources and Vector Number Setting Registers (1)

DataShe

		Bits
Register	14–8	6–0
Vector number setting register WDT	Interval interrupt (WDT)	Compare-match interrupt (BSC)
Vector number setting register A	Receive-error interrupt (SCI)	Receive-data-full interrupt (SCI)
Vector number setting register B	Transmit-data-empty interrup (SCI)	tTransmit-end interrupt (SCI)
Vector number setting register C	Input-capture interrupt (FRT)	Output-compare interrupt (FRT)
Vector number setting register D	Overflow interrupt (FRT)	Reserved

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

As table 5.6 shows, two on-chip peripheral module interrupts are assigned to each register. Set the vector numbers by setting the corresponding 7-bit groups (bits 14 to 8 and bits 6 to 0) with values in the range of H'00 (000000) to H'7F (111111). H'00 is vector number 0 (the lowest); H'7F is vector number 127 (the highest). The vector table address is calculated by the following equation.

```
Vector table address = VBR + (vector number \times 4)
```

A reset initializes a vector number setting register to H'0000. They are not initialized in standby mode.

Table 5.7 lists functions for vector number setting registers DIV, DMAC0, and DMAC1. The vector number for DIV overflow interrupts is set in VCRDIV and the vector numbers for DMAC transfer-end interrupts are set in VCRDMA0 and VCRDMA1. See sections 9, Direct Memory Access Controller, and 10, Division Unit, for more details.

Table 5.7 Interrupt Request Sources and Vector Number Setting Registers (2)

Register	Setting Function
Vector number setting register DIV (VCRDIV)	Overflow interrupts for division unit
Vector number setting register DMAC0 (VCRDMA0)	Channel 0 transfer end interrupt for DMAC
Vector number setting register DMAC1 (VCRDMA1)	Channel 1 transfer end interrupt for DMAC

5.3.8 Interrupt Control Register (ICR)

ICR is a 16-bit register that sets the input signal detection mode of external interrupt input pin NMI and indicates the input signal level at the NMI pin. It also sets the IRL interrupt vector mode. A reset initializes ICR to H'8000 or H'0000 but the standby mode does not.

Bit:	15	14	13	12	11	10	9	8
Bit name:	NMIL	—	—	—	—	_	—	NMIE
Initial value:	0/1*	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R	R/W
Bit:	7	6	5	4	3	2	1	0
Bit name:	—	—	—	—	—	—	_	VECMD
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R	R/W
date! \//bop NI/I ii	oput ic hia	h. 1. whor		t is low: 0			www.Dat	aSheet4U.co

DataShote: UWhen NMI input is high: 1; when NMI input is low: 0

www.DataSheet4U.com

Bit 15—NMI Input Level (NMIL): Sets the level of the signal input at the NMI pin. This bit can be read to determine the NMI pin level. This bit cannot be modified.

Bit 15: NMIL	Description
0	NMI input level is low
1	NMI input level is high

- Bits 14 to 9—Reserved: These bits always read 0. The write value should always be 0.
- Bit 8—NMI Edge Select (NMIE): Selects whether the falling or rising edge of the interrupt request signal to the NMI pin is detected.

Bit 8: NMIE	Description
0	Interrupt request is detected on falling edge of NMI input (Initial value)
1	Interrupt request is detected on rising edge of NMI input

- Bits 7 to 1—Reserved: These bits always read 0. The write value should always be 0.
- Bit 0—IRL Interrupt Vector Mode Select (VECMD): This bit selects auto-vector mode or external vector mode for IRL interrupt vector number setting. In auto-vector mode, an internally determined vector number is set. The IRL15 and IRL14 interrupt vector numbers are set to 71 and the IRL1 vector number is set to 644 In external vector mode, a value between 0 and 127 can be input as the vector number from the external vector number input pins (D7–D0).

	Bit 0: VECMD	Description
40	.com 0	Auto vector mode, vector number automatically set internally
		(Initial value)
	1	External vector mode, vector number set by external input

DataSheet4U.com

96

www.DataSheet4U.com

5.4.1 Interrupt Sequence

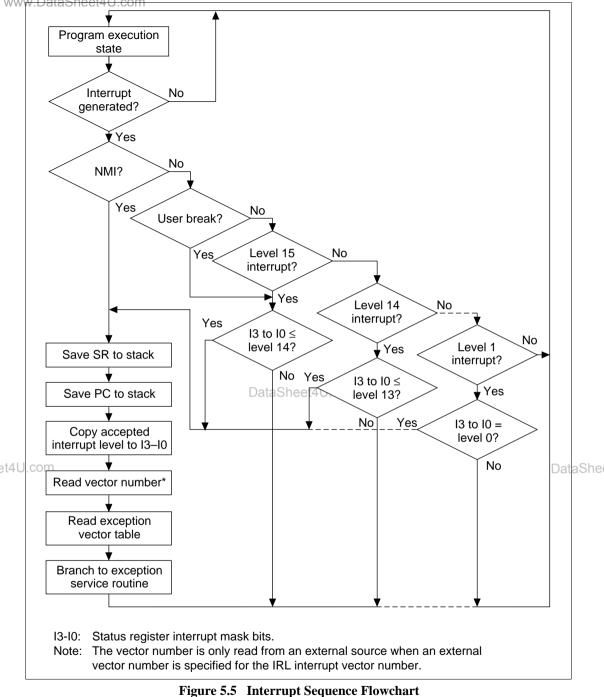
The sequence of interrupt operations (figure 5.5) is explained below:

- 1. The interrupt request sources send interrupt request signals to the interrupt controller.
- 2. The interrupt controller selects the highest-priority interrupt among the interrupt requests sent, according to the priority levels set in interrupt priority level setting registers A and B (IPRA and IPRB). Lower-priority interrupts are held pending. If two of these interrupts have the same priority level or if multiple interrupts occur within a single module, the interrupt with the highest default priority or the highest priority within its IPR setting unit (as indicated in table 5.4) is selected.
- 3. The interrupt controller compares the priority level of the selected interrupt request with the interrupt mask bits (I3–I0) in the CPU's status register (SR). If the request priority level is equal to or less than the level set in I3–I0, the request is held pending. If the request priority level is higher than the level in bits I3–I0, the interrupt controller accepts the interrupt and sends an interrupt request signal to the CPU.
- 4. The CPU detects the interrupt request sent from the interrupt controller when it decodes the next instruction to be executed. Instead of executing the decoded instruction, the CPU starts interrupt exception handling.
- 5. SR and PC are saved onto the stackDataSheet4U.com
- 6. The priority level of the accepted interrupt is copied to the interrupt mask level bits (I3 to I0) in the status register (SR).
- 7. When external vector mode is specified for the IRL interrupt, the vector number is read from the external vector number input pins (D7–D0).
 - 8. The CPU reads the start address of the exception service routine from the exception vector table entry for the accepted interrupt, jumps to that address, and starts executing the program there. This jump is not a delayed branch.

DataSheet4U.com

www.DataSheet4U.com

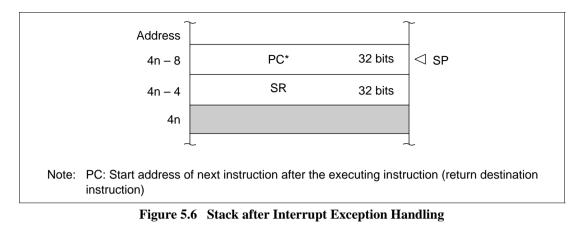
DataSheet4U.com



98

www.DataSheet4U.com

Figure 5.6 shows the stack after interrupt exception handling.



DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com 5.5 Interrupt Response Time

Table 5.8 shows the interrupt response time, which is the time from the occurrence of an interrupt request until interrupt exception handling starts and fetching of the first instruction of the interrupt service routine begins. Figure 5.7 shows the pipeline when an IRL interrupt is accepted.

Table 5.8 Interrupt Response Time

			Numbe	er of States		
Item		NMI	Peripheral Module	IRL	Notes	
	dentified inter- y with SR mask	2		5	_	
	ompletion of currently being by CPU	X (≥ 0)			The longest sequence is for interrupt or address- error exception handling (X = 4 + m1 + m2 + m3 + m4). If an interrupt- masking instruction follows, however, the time may be even longer.	
Time from interrupt exception handling (SR and PC saves and vector address fetch) until fetch of first instruction of exception service routine starts		5 + m1 + m2 + m3 DataSheet4U.com			D	
Interrupt	Total:	7 + m1	+ m2 + m3	10 + m1 + m2 + m3	_	
response	Minimum:	10		13	_	
	Maximum:	11 + 2 m3) +	(m1 + m2 + m4	14 + 2 (m1 + m2 + m3) + m4	_	
m1 m2 m3	-m4 are the num : SR save (longw 2: PC save (longw 3: Vector address 4: Fetch of first ins	vord wri vord wri read (lo	te) te) ongword read)		ory accesses	

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

100

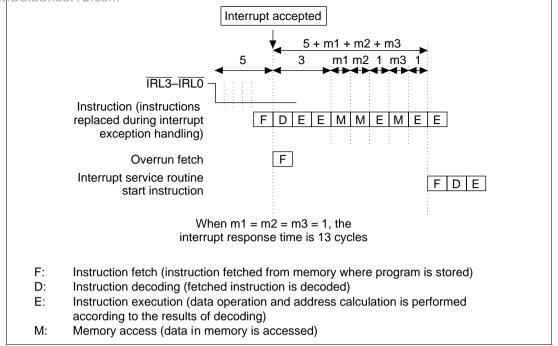


Figure 5.7 Pipeline when an IRL Interrupt is Accepted

5.6 Sampling of Pins IRL3-IRL0

Signals on interrupt pins IRL3 to IRL0 pass through the noise canceler before being sent by the interrupt controller to the CPU as interrupt requests. The noise canceler cancels noise that changes t4U.com short cycles. The CPU samples the interrupt requests between executing instructions. During DataShee this period, the noise canceler output changes according to the noise-eliminated pin level, so the pin level must be held until the CPU samples it. This means that interrupt sources generally must not be cleared inside interrupt routines.

When an external vector is fetched, the interrupt source can also be cleared when the external vector fetch cycle is detected.

Figure 5.8 shows a block diagram of the interrupt response procedure. Figure 5.9 shows interrupt response timing.

DataSheet4U.com

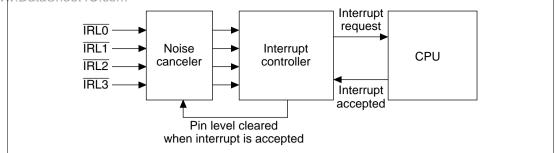


Figure 5.8 Interrupt Response Block Diagram

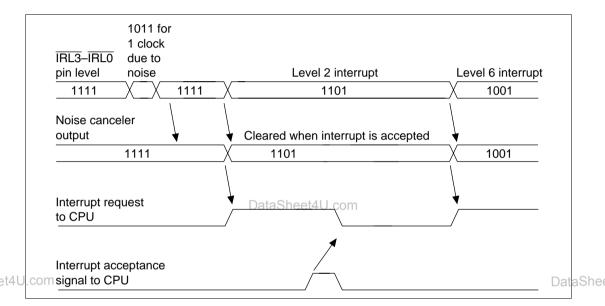


Figure 5.9 Interrupt Response Timing Chart

DataSheet4U.com

www.DataSheet4U.com

102 DataSheet4U.com

- 1. Do not execute module standby for modules that have the module-stop function when the possibility remains that an interrupt request may be output.
- 2. As shown in figure 5.10, the point at which the NMI request is cleared is the state following the decoding stage for the instruction replaced by the interrupt exception handling.

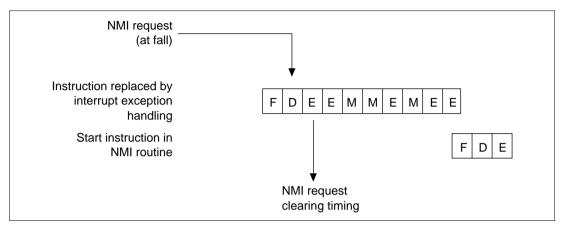


Figure 5.10 NMI Request Clearing Timing

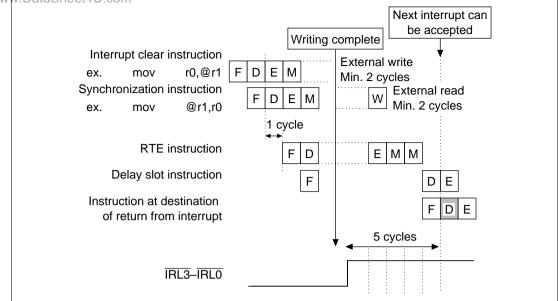
3. Clearing Interrupt Sources:

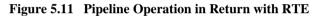
External Interrupt Sources: When an interrupt source is cleared by writing to an I/O address, another instruction will be executed before the write can be completed because of the write buffer. To ensure that the next instruction is executed after the write is completed, read from the same address after the write to obtain total synchronization.

- Returning from interrupt handling with an RTE instruction: Figure 5.11 shows how a minimum interval of 1 cycle is required between the read instruction used for synchronization and the RTE instruction. A read instruction for synchronization and a minimum of 1 instruction should thus be executed between the source clear and the RTE instruction.
- Changing the level during interrupt handling: Figure 5.12 shows how a minimum interval of 4 cycles is required between the synchronization instruction and the LDC instruction when an LDC instruction is used to enable another overlapping interrupt by changing the SR value. A read instruction for synchronization and a minimum of 4 instructions should thus be executed between the source clear and the LDC instruction.

DataSheet4U.com

www.DataSheet4U.com





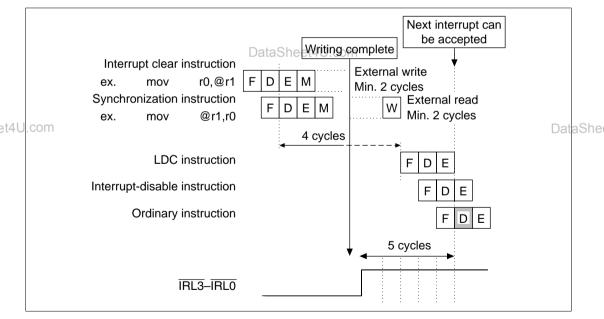


Figure 5.12 Pipeline Operation when Interrupts are Enabled by Modifying SR

DataSheet4U.com

www.DataSheet4U.com

104 DataSheet4U.com

On-Chip Interrupt Sources: Pipeline operation must be taken into account to ensure that the same interrupt does not occur again when the interrupt source is from an on-chip peripheral module. At least 2 cycles are required for the CPU to recognize that the interrupt is from an on-chip peripheral module. Two cycles are also required for the fact that there is no longer an interrupt request to be relayed.

- Returning from interrupt handling with an RTE instruction: Figure 5.13 shows how an extra cycle is required after the read instruction used for synchronization before interrupts are accepted, even when an RTE instruction is executed. A read instruction for synchronization should thus be executed between the source clear and the RTE instruction.
- Changing the level during interrupt handling: Figure 5.14 shows how a minimum interval of 2 cycles is required between the synchronization instruction and the LDC instruction when an LDC instruction is used to enable another overlapping interrupt by changing the SR value. A read instruction for synchronization and a minimum of 2 instructions should thus be executed between the source clear and the LDC instruction.

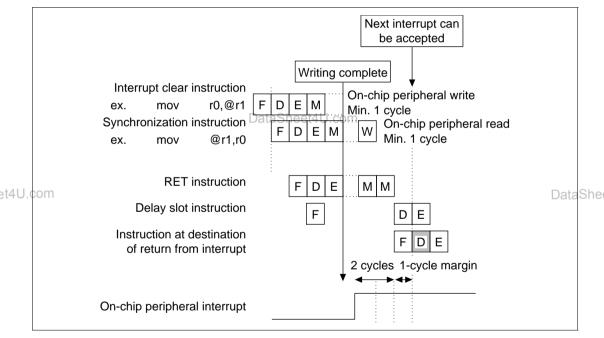


Figure 5.13 Pipeline Operation in Return with RTE

DataSheet4U.com



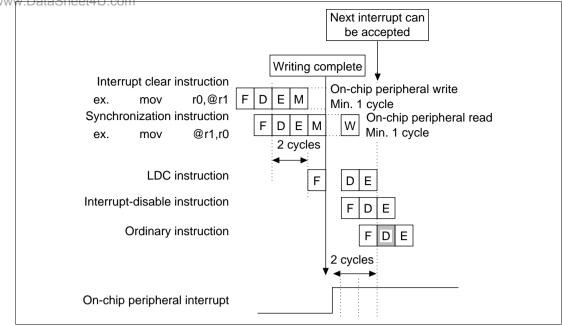


Figure 5.14 Pipeline Operation when Interrupts are Enabled by Changing the SR

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

106 DataSheet4U.com

Section 6 User Break Controller

6.1 Overview

The user break controller (UBC) provides functions that simplify program debugging. Break conditions are set in the UBC and a user break interrupt is generated according to the conditions of the bus cycle generated by the CPU, on-chip DMAC, or external bus master.

This function makes it easy to design an effective self-monitoring debugger, enabling the chip to debug programs without using an in-circuit emulator. The UBC can be set in an SH7000 series compatible mode, facilitating porting of monitoring programs that use other SH7000 series UBCs.

6.1.1 Features

The features of the user break controller are listed below:

- The following break compare conditions can be set: Two break channels (channel A, channel B). User break interrupts can be requested using either independent or sequential condition for the two channels (sequential breaks are channel A, then channel B).
 - Address
 - Data (channel B only)
 - Bus master: CPU cycle/DMA cycle/external bus cycle
 - Bus cycle: instruction fetch/data access
 - Read or write
 - Operand size: byte/word/longword
- User break interrupt generated upon satisfying break conditions. A user-designed user break DataSher interrupt exception handling routine can be run.
 - Select breaking in the instruction fetch cycle before the instruction is executed, or after.
 - Compatible with SH7000 series UBCs after a power-on reset.

DataSheet4U.com

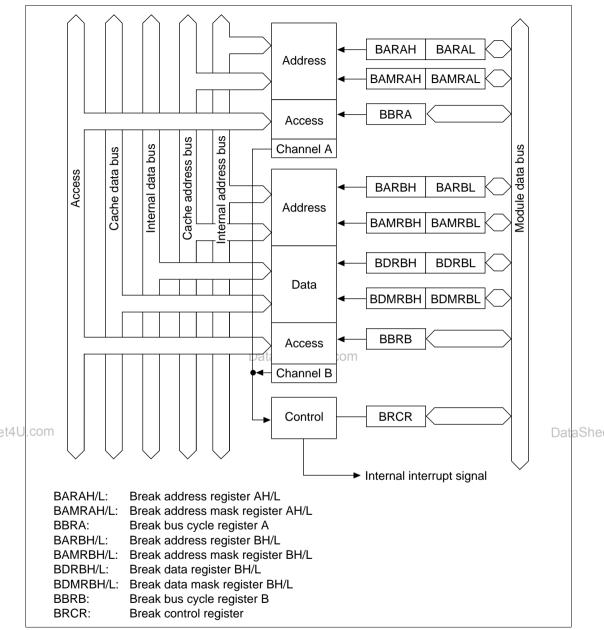


Figure 6.1 User Break Controller Block Diagram

DataSheet4U.com

www.DataSheet4U.com

108 DataSheet4U.com

Table 6.1 Register Configuration

Name	Abbr.	R/W	Initial Value* ¹	Address	Access	s Size ^{*2}
Break address register AH	BARAH	R/W	H'0000	H'FFFFFF40	16	32
Break address register AL	BARAL	R/W	H'0000	H'FFFFFF42	16	_
Break address mask register AH	BAMRAH	R/W	H'0000	H'FFFFFF44	16	32
Break address mask register AL	BAMRAL	R/W	H'0000	H'FFFFFF46	16	_
Break bus cycle register A	BBRA	R/W	H'0000	H'FFFFFF48	16, 32	
Break address register BH	BARBH	R/W	H'0000	H'FFFFF60	16	32
Break address register BL	BARBL	R/W	H'0000	H'FFFFF62	16	_
Break address mask register BH	BAMRBH	R/W	H'0000	H'FFFFF64	16	32
Break address mask register BL	BAMRBL	R/W	H'0000	H'FFFFF66	16	_
Break data register BH	BDRBH	R/W	H'0000	H'FFFFFF70	16	32
Break data register BL	BDRBL	R/W	H'0000	H'FFFFFF72	16	_
Break data mask register BH	BDMRBH	R/W	H'0000	H'FFFFFF74	16	32
Break data mask register BL	BDMRBL	R/W	H'0000	H'FFFFFF76	16	_
Break bus cycle register B	BBRBtaShe	R/W	0000	H'FFFFF68	16, 32	
Break control register	BRCR	R/W	H'0000	H'FFFFFF78	16, 32	

Notes: 1. Initialized by a power-on reset. Values held in standby mode. Value undefined after a manual reset.

2. Byte access not permitted.

DataShe

SH7000 Series UBC Compatibility: When set in the SH7000-series-compatible mode, SH7000 series UBC registers on the SH7604 are as shown in table 6.2.

Table 6.2 SH7000 Series and SH7604 UBCs

SH7000 Series		SH7604	
Name	Abbr.	Name	Abbr.
Break address register H	BARH	Break address register AH	BARAH
Break address register L	BARL	Break address register AL	BARAL
Break address mask register H	BAMRH	Break address mask register AH	BAMRAH
Break address mask register L	BAMRL	Break address mask register AL	BAMRAL
S Break bus cycle register	BBR	Break bus cycle register A	w.DBBBAeet4U.com

et4U.com

www.DataSheet4U.com 6.2 Register Descriptions

6.2.1 Break Address Register A (BARA)

BARAH:

	Bit:	15	14	13	12	11	10	9	8
	Bit name:	BAA31	BAA30	BAA29	BAA28	BAA27	BAA26	BAA25	BAA24
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W							
	Bit:	7	6	5	4	3	2	1	0
	Bit name:	BAA23	BAA22	BAA21	BAA20	BAA19	BAA18	BAA17	BAA16
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W							
BAR	AL:								
	Bit:	15	14	13	12	11	10	9	8
	Bit name:	BAA15	BAA14	BAA13	BAA12	BAA11	BA10	BAA9	BAA8
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W							
com	Bit:	7	6	5	4	3	2	1	0 _{Da}
	Bit name:	BAA7	BAA6	BAA5	BAA4	BAA3	BAA2	BAA1	BAA0
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W							

The two break address registers A—break address register AH (BARAH) and break address register AL (BARAL)—together form a single group. Both are 16-bit read/write registers. BARAH stores the upper bits (bits 31 to 16) of the address of the channel A break condition, while BARAL stores the lower bits (bits 15 to 0). A power-on reset initializes both BARAH and BARAL to H'0000. Their values are undefined after a manual reset.

BARAH Bits 15 to 0—Break Address A 31 to 16 (BAA31 to BAA16): These bits store the upper bit values (bits 31 to 16) of the address of the channel A break condition.
 Sheet4U.com

DataSheet4U.com

BARAL Bits 15 to 0—Break Address A 15 to 0 (BAA15 to BAA0): These bits store the lower bit values (bits 15 to 0) of the address of the channel A break condition.

```
DataSheet4U.com
```

www.DataSheet4U.com 6.2.2 Break Address Mask Register A (BAMRA)

BAMRAH:

	Bit:	15	14	13	12	11	10	9	8
	Bit name:	BAMA31	BAMA30	BAMA29	BAMA28	BAMA27	BAMA26	BAMA25	BAMA24
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Bit:	7	6	5	4	3	2	1	0
	Bit name:	BAMA23	BAMA22	BAMA21	BAMA20	BAMA19	BAMA18	BAMA17	BAMA16
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
BAM	RAL:								
	Bit:	15	14	13	12	11	10	9	8
	Bit name:	BAMA15	BAMA14	BAMA13	BAMA12	BAMA11	BAMA10	BAMA9	BAMA8
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
			Γ	DataShee	et4U.com				
	Bit:	7	6	5	4	3	2	1	0
	Bit name:	BAMA7	BAMA6	BAMA5	BAMA4	BAMA3	BAMA2	BAMA1	BAMA0
	Initial value:	0	0	0	0	0	0	0	0
om	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W ^{Dat}

The two break address mask registers A (BAMRA)—break address mask register AH (BAMRAH) and break address mask register AL (BAMRAL)—together form a single group. Both are 16-bit read/write registers. BAMRAH determines which of the bits in the break address set in BARAH are masked. BAMRAL determines which of the bits in the break address set in BARAL are masked. A power-on reset initializes BAMRAH and BAMRAL to H'0000. Their values are undefined after a manual reset.

• BAMRAH Bits 15 to 0—Break Address Mask A 31 to 16 (BAMA31 to BAMA16): These bits specify whether bits 31–16 (BAA31 to BAA16) of the channel A break address set in BARAH are masked.

BAMRAL Bits 15 to 0—Break Address Mask A 15 to 0 (BAMA15 to BAMA0): These bits
 DataSheet4U com specify whether bits 15–0 (BAA15 to BAA0) of the channel A break address set in BARAL are masked.

DataSheet4U.com

(Initial v
Channel A break address BAAn is included in the break conditions (Initial value)
Channel A break address BAAn is masked and therefore not included in the break conditions

6.2.3 Break Bus Cycle Register A (BBRA)

Bit:	15	14	13	12	11	10	9	8
Bit name:				_				—
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R	R
Bit:	7	6	5	4	3	2	1	0
Bit name:	CPA1	CPA0	IDA1	IDA0	RWA1	RWA0	SZA1	SZA0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W							

The break bus cycle register A (BBRA) is a 16-bit read/write register that selects the following four channel A break conditions:

1. CPU cycle/peripheral cycle

et4U.c2mInstruction fetch/data access

- 3. Read/write
- 4. Operand size

A power-on reset initializes BBRA to H'0000. Its value is undefined after a manual reset.

- Bits 15 to 8—Reserved: These bits always read 0. The write value should always be 0.
- Bits 7 and 6—CPU Cycle/Peripheral Cycle Select A (CPA1, CPA0): These bits select whether to break channel A on a CPU and/or peripheral bus cycle. Peripheral cycles are defined as on-chip DMAC bus cycles, and external bus master bus cycles when the bus is released. When the peripheral cycle setting is made, on-chip DMAC cycles are always included in the break conditions; however, external bus master cycles can be included or excluded, according to the setting of the EBBE bit in the BRCR register.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U. Bit 7: CPA1	Bit 6: CPA0	Description	
0	0	No channel A user break interrupt occurs	(Initial value)
	1	Break only on CPU cycles	
1	0	Break only on peripheral cycles	
	1	Break on both CPU and peripheral cycles	

• Bits 5 and 4—Instruction Fetch/Data Access Select A (IDA1, IDA0): These bits select whether to break channel A on instruction fetch and/or data access cycles.

Bit 5: IDA1	Bit 4: IDA0	Description
0	0	No channel A user break interrupt occurs (Initial value
	1	Break only on instruction fetch cycles
1	0	Break only on data access cycles
	1	Break on both instruction fetch and data access cycles

• Bits 3 and 2—Read/Write Select A (RWA1, RWA0): These bits select whether to break channel A on read and/or write cycles.

Bit 3: RWA1	Bit 2: RWA0	Description	
0	0	No channel A user break interrupt occurs	(Initial value)
	1	Break only on read cycles	
1	0	Break only on write cycles	
	1	Break on both read and write cycles	
om			Dete

• Bits 1 and 0—Operand Size Select A (SZA1, SZA0): These bits select bus cycle operand size as a channel A break condition.

Bit 1: SZA1	Bit 0: SZA0	Description	
0	0	Operand size is not a break condition	(Initial value)
	1	Break on byte access	
1	0	Break on word access	
	1	Break on longword access	

Note: When breaking on an instruction fetch, set the SZA0 bit to 0. All instructions are considered to be word-size accesses (instruction fetches are always longword). Operand size is word for instructions or determined by the operand size specified for the CPU/DMAC data access. It is not determined by the bus width of the space being accessed.

DataSheet4U.com

www.DataSheet4U.com 6.2.4 Break Address Register B (BARB)

The channel B break address register has the same bit configuration as BARA.

6.2.5 Break Address Mask Register B (BAMRB)

The channel B break address mask register has the same bit configuration as BAMRA.

6.2.6 Break Data Register B (BDRB)

BDRBH:

	Bit:	15	14	13	12	11	10	9	8	
	Bit name:	BDB31	BDB30	BDB29	BDB28	BDB27	BDB26	BDB25	BDB24	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:	BDB23	BDB22	BDB21	BDB20	BDB19	BDB18	BDB17	BDB16	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R/W	R/W	R/W DataShe	R/W	R/W	R/W	R/W	R/W	
				Dutuono	01-0.00.	11				
BDRI	BL:									
	Bit:	15	14	13	12	11	10	9	8	
com	Bit name:	BDB15	BDB14	BDB13	BDB12	BDB11	BDB10	BDB9	BDB8 ^{D8}	ataShee
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:	BDB7	BDB6	BDB5	BDB4	BDB3	BDB2	BDB1	BDB0	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

The two break data registers B (BDRB)—break data register BH (BDRBH) and break data register BL (BDRBL)—together form a single group. Both are 16-bit read/write registers. BDRBH specifies the upper half (bits 31–16) of the data that is the break condition for channel B, while Data BDRBL specifies the lower half (bits 15–0). A power-on reset initializes BDRBH and BDRBL to H'0000. Their values are undefined after a manual reset.

114

- Www.DataSheet4U.com
 BDRBH Bits 15 to 0—Break Data B 31 to 16 (BDB31 to BDB16): These bits store the upper half (bits 31–16) of the data that is the break condition for break channel B.
 - BDRBL Bits 15 to 0—Break Data B 15 to 0 (BDB15 to BDB0): These bits store the lower half • (bits 15–0) of the data that is the break condition for break channel B.

6.2.7 **Break Data Mask Register B (BDMRB)**

BDMRBH:

	Bit:	15	14	13	12	11	10	9	8
	Bit name:	BDMB31	BDMB30	BDMB29	BDMB28	BDMB27	BDMB26	BDMB25	BDMB24
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Bit:	7	6	5	4	3	2	1	0
	Bit name:	BDMB23	BDMB22	BDMB21	BDMB20	BDMB19	BDMB18	BDMB17	BDMB16
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
BDN	IRBL:		Γ	DataShee	et4U.com				
	Bit:	15	14	13	12	11	10	9	8
	Bit name:	BDMB15	BDMB14	BDMB13	BDMB12	BDMB11	BDMB10	BDMB9	BDMB8
	Initial value:	0	0	0	0	0	0	0	0
com	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Bit:	7	6	5	4	3	2	1	0
	Bit name:	BDMB7	BDMB6	BDMB5	BDMB4	BDMB3	BDMB2	BDMB1	BDMB0
	Initial value:	0	0	0	0	0	0	0	0
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

The two break data mask registers B (BDMRB)-break data mask register BH (BDMRBH) and break data mask register BL (BDMRBL)-together form a single group. Both are 16-bit read/write registers. BDMRBH determines which of the bits in the break address set in BDRBH are masked. BDMRBL determines which of the bits in the break address set in BDRBL are masked. A power-on reset initializes BDMRBH and BDMRBL to H'0000. Their values are DataS undefined after a manual reset. www.DataSheet4U.com

www.DataSheet4U.com

- BDMRBH Bits 15 to 0—Break Data Mask B 31 to 16 (BDMB31 to BDMB16): These bits specify whether bits B 31–16 (BDB31 to BDB16) of the channel B break data set in BDRBH are masked.
- BDMRBL Bits 15 to 0—Break Data Mask B 15 to 0 (BDMB15 to BDMB0): These bits specify whether bits B 15–0 (BDB15 to BDB0) of the channel B break data set in BDRBL are masked.

Bits 31–0: BDMBn	Description
0	Channel B break address bit BDBn is included in the break condition (Initial value)
1	Channel B break address bit BDBn is masked and therefore not included in the break condition
n = 31 to 0	

Notes: 1. When the data bus value is included in the break conditions, specify the operand size.

- 2. For word data, set in bits 15–0 of BDRB and BDMRB. For byte data, set the same data in bits 0–7 and bits 8–15 of BDRB and BDMRB.
- 3. External bus master bus cycles when the bus is released cannot be included in the data bus conditions.

6.2.8 Bus Break Register B (BBRB)

The channel B bus break register has the same bit configuration as BBRA.

6.2.9 Break Control Register (BRCR)

4U.com	Bit:	15	14	13	12	11	10	9	8 Da	ataShee
	Bit name:	CMFCA	CMFPA	EBBE	UMD	—	PCBA	_	—	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R/W	R/W	R/W	R/W	R	R/W	R	R	
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:	CMFCB	CMFPB		SEQ	DBEB	PCBB	_	_	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R/W	R/W	R	R/W	R	R/W	R	R	

DataSheet4U.com

www.DataSheet4U.com

116

DataSheet4U.com

- 1. Determines whether to use channels A and B as two independent channels or as sequential conditions.
- 2. Selects SH7000 series compatible mode or SH7604 mode.
- 3. Selects whether to break before or after instruction execution during the instruction fetch cycle.
- 4. Enables or disables the external bus.
- 5. Selects whether to include the data bus in channel B comparison conditions.

It also has a condition-match flag that is set when conditions match. A power-on reset initializes BRCR to H'0000. Its value is undefined after a manual reset.

• Bit 15—CPU Condition-Match Flag A (CMFCA): Set to 1 when CPU bus cycle conditions included in the break conditions set for channel A are met. Not cleared to 0.

Bit 15: CMFCA	Description
0	Channel A CPU cycle conditions do not match, no user break interrupt generated (Initial value)
1	Channel A CPU cycle conditions have matched, user break interrupt generated

• Bit 14—Peripheral Condition-Match Flag A (CMFPA): Set to 1 when peripheral bus cycle conditions (on-chip DMAC, or external bus cycle when external bus breaks are enabled) included in the break conditions set for channel A are met. Not cleared to 0.

Bit 14: CMFPA	Description	
t4U.cc 9 n	Channel A peripheral cycle conditions do no interrupt generated	ot match, no user break DataShee (Initial value)
1	Channel A peripheral cycle conditions have interrupt generated	matched, user break

• Bit 13—External Bus Break Enable (EBBE): Monitors the external bus master's address bus when the bus is released, and includes the external bus master's bus cycle in the bus cycle select conditions (CPA1, CPB1). External bus breaks are possible in the total master mode and total slave mode. When the external bus break is enabled, set CPA1 in BBRA or CPB1 in BBRB.

Bit 13: EBBE	Description
0	Chip-external bus cycle not included in break conditions (Initial value)
1 taS heet4U.com	Chip-external bus cycle included in break conditions

Www.DataSheet4U.com
 Bit 12—UBC Mode (UMD): Selects SH7000 series-compatible mode or SH7604 mode.

Bit 12: UMD	Description	
0	Compatible mode for SH7000 Series UBCs	(Initial value)
1	SH7604 mode	

- Bit 11—Reserved: This bit always reads 0. The write value should always be 0.
- Bit 10—PC Break Select A (PCBA): Selects whether to place the channel A break in the instruction fetch cycle before or after instruction execution.

Bit 10: PCBA	Description	
0	Places the channel A instruction fetch cycle break be execution	efore instruction (Initial value)
1	Places the channel A instruction fetch cycle break af execution	ter instruction

- Bits 9 and 8—Reserved: These bits always read 0. The write value should always be 0.
- Bit 7—CPU Condition-Match Flag B (CMFCB): Set to 1 when CPU bus cycle conditions included in the break conditions set for channel B are met. Not cleared to 0 (once set, it must be cleared by a write before it can be used again).

Bit 7: CMFCB	Description	
0	Channel B CPU cycle conditions do not ma generated	atch, no user break interrupt (Initial value)
4U.cpm	Channel B CPU cycle conditions have mat generated	tched, user break interrupt DataShee

• Bit 6—Peripheral Condition-Match Flag B (CMFPB): Set to 1 when peripheral bus cycle conditions (on-chip DMAC, or external bus cycle when external bus monitoring is enabled) included in the break conditions set for channel B are met. Not cleared to 0 (once set, it must be cleared by a write before it can be used again).

Bit 6: CMFPB	Description	
0	Channel B peripheral cycle conditions do not match, interrupt generated	, no user break (Initial value)
1	Channel B peripheral cycle conditions have matched interrupt generated	d, user break

DataSheet4U.com

www.DataSheet4U.com

Www.DataSheet4U.com
 Bit 5—Reserved: This bit always reads 0. The write value should always be 0.

• Bit 4—Sequence Condition Select (SEQ): Selects whether to handle the channel A and B conditions independently or sequentially.

Bit 4: SEQ	Description	
0	Channel A and B conditions compared independently	(Initial value)
1	Channel A and B conditions compared sequentially (chan channel B)	nnel A, then

• Bit 3—Data Break Enable B (DBEB): Selects whether to include data bus conditions in the channel B break conditions.

Bit 3: DBEB	Description
0	Data bus conditions not included in the channel B conditions
	(Initial value)
1	Data bus conditions included in the channel B conditions

• Bit 2—Instruction Break Select (PCBB): Selects whether to place the channel B instruction fetch cycle break before or after instruction execution.

Bit 2: PCBB	Description	
0	Places the channel B instruction fetch cycle bre execution	ak before instruction (Initial value)
1	Places the channel B instruction fetch cycle bre execution	ak after instruction
et4U.com		DataS

• Bits 1 and 0—Reserved: These bits always read 0. The write value should always be 0.

DataSheet4U.com

6.3.1 Flow of the User Break Operation

The flow from setting of break conditions to user break interrupt exception handling is described below:

- 1. The break addresses are set in the break address registers (BARA, BARB), the masked addresses are set in the break address mask registers (BAMRA, BAMRB), the break data is set in the break data register (BDRB), and the masked data is set in the break data mask register (BDMRB). The breaking bus conditions are set in the break bus cycle registers (BBRA, BBRB). The three groups of the BBRA and BBRB registers—CPU cycle/peripheral cycle select, instruction fetch/data access select, and read/write select— are each set. No user break interrupt will be generated if even one of these groups is set with 00. The conditions are set in the respective bits of the BRCR register.
- When the set conditions are satisfied, the UBC sends a user break interrupt request to the interrupt controller. When conditions match, the CPU condition match flags (CMFCA, CMFCB) and peripheral condition match flags (CMFPA, CMFPB) for the respective channels are set.
- 3. The interrupt controller checks the user break interrupt's priority level. The user break interrupt has priority level 15, so it is accepted only if the interrupt mask level in bits I3–I0 in the status register (SR) is 14 or lower. When the I3–I0 bit level is 15, the user break interrupt cannot be accepted but it is held pending until user break interrupt exception handling can be carried out. Section 5, Interrupt Controller, describes the handling of priority levels in greater detail.

4. When the priority is found to permit acceptance of the user break interrupt, the CPU starts user DataSh

5. The appropriate condition match flag (CMFCA, CMFPA, CMFCB, CMFPB) can be used to check if the set conditions match or not. The flags are set by the matching of the conditions, but they are not reset. 0 must first be written to them before they can be used again.

6.3.2 Break on Instruction Fetch Cycle

- 1. When CPU/instruction fetch/read/word is set in the break bus cycle registers (BBRA/BBRB), the break condition becomes the CPU's instruction fetch cycle. Whether it breaks before or after the execution of the instruction can then be selected for the appropriate channel with the PCBA/PCBB bit in the break control register (BRCR).
- The instruction fetch cycle always fetches 32 bits (two instructions). Only one bus cycle occurs, but breaks can be placed on each instruction individually by setting the respective addresses in the break address registers (BARA, BARB).

- www.DataSheet4U.com 3. An instruction set for a break before execution breaks when it is confirmed that the instruction has been fetched and will be executed. This means this feature cannot be used on instructions fetched by overrun (instructions fetched at a branch or during an interrupt transition, but not to be executed). When this kind of break is set for the delay slot of a delayed branch instruction or an instruction following an interrupt-disabled instruction, such as LDC, the interrupt is generated prior to execution of the first instruction at which the interrupt is subsequently then accepted.
 - 4. When the condition stipulates after execution, the instruction set with the break condition is executed and then the interrupt is generated prior to the execution of the next instruction. As with pre-execution breaks, this cannot be used with overrun fetch instructions. When this kind of break is set for a delayed branch instruction or an interrupt-disabled instruction, such as LDC, the interrupt is generated at the first instruction at which the interrupt is subsequently accepted.
 - 5. When an instruction fetch cycle is set for channel B, break data register B (BDRB) is ignored. There is thus no need to set break data for an instruction fetch cycle break.

6.3.3 **Break on Data Access Cycle**

- The memory cycles in which CPU data access breaks occur are: memory cycles from 1. instructions, and stacking and vector reads during exception handling. These breaks cannot be used in dummy cycles for single reads of synchronous DRAM.
- 2. The relationship between the data access cycle address and the comparison condition for operand size are shown in table 6.3. This means that when address H'00001003 is set without specifying the size condition, for example, the bus cycle in which the break condition is satisfied is as follows (where other conditions are met):

Longword access at address H'00001000 Word access at address H'00001002 Byte access at address H'00001003

Table 6.3 Data Access Cycle Addresses and Operand Size Comparison Conditions

Access Size	Address Compared
Longword	Break address register bits 31–2 compared with address bus bits 31–2
Word	Break address register bits 31–1 compared with address bus bits 31–1
Byte	Break address register bits 31–0 compared with address bus bits 31–0

3. When the data value is included in the break conditions on channel B:

When the data value is included in the break conditions, specify either longword, word, or byte as the operand size in the break bus cycle registers (BBRA, BBRB). When data values are et 4U.com

included in break conditions, a break interrupt is generated when the address conditions and data conditions both match. To specify byte data for this case, set the same data in the two

www.DataSheet4U.com bytes at bits 15–8 and bits 7–0 of the break data register B (BDRB) and break data mask register B (BDMRB). When word or byte is set, bits 31–16 of BDRB and BDMRB are ignored.

6.3.4 **Break on External Bus Cycle**

- 1. Enable the external bus break enable bit (the EBBE bit in BRCR) to generate a break for a bus cycle generated by the external bus master when the bus is released. External bus cycle breaks can be used in total master mode or total slave mode.
- 2. Address and read/write can be set for external buses, but size cannot be specified. Setting sizes of byte/word/longword will be ignored. Also, no distinction can be made between instruction fetch and data access for external bus cycles. All cycles are considered data access cycles, so set 1 in bits IDA1 and IDB1 in BBRA and BBRB.
- 3. External input of addresses uses A26–A0, so set bits 31–27 of the break address registers (BARA, BARB) to 0, or set bits 31–27 of the break address mask registers (BAMRA, BAMRB) to 1 to mask the addresses not input.
- 4. When the conditions set for the external bus cycle are satisfied, the CMFPA and CMFPB bits are set for the respective channels.

6.3.5 **Program Counter (PC) Values Saved**

- 1. Break on Instruction Fetch (Before Execution): The program counter (PC) value saved to the stack in user break interrupt exception handling is the address that matches the break condition. The user break interrupt is generated before the fetched instruction is executed. If a break condition is set on an instruction that follows an interrupt-disabled instruction, however, the break occurs before execution of the instruction at which the next interrupt is accepted, so the PC value saved is the address of the break.
- - 2. Break on Instruction Fetch (After Execution): The program counter (PC) value saved to the stack in user break interrupt exception handling is the address executed after the one that matches the break condition. The fetched instruction is executed and the user break interrupt generated before the next instruction is executed. If a break condition is set on an interruptdisabled instruction, the break occurs before execution of the instruction at which the next interrupt is accepted, so the PC value saved is the address of the break.
 - 3. Break on Data Access (CPU/Peripheral): The program counter (PC) value is the start address of the next instruction after the last instruction executed before the user break exception handling started. When data access (CPU/peripheral) is set as a break condition, the place where the break will occur cannot be specified exactly. The break will occur at an instruction fetched close to where the data access that is to receive the break occurs.

www.DataSheet4U.com

Break on a CPU Instruction Fetch Bus Cycle:

А.	Register settings:	BARA = H'00000404, BAMRA = H'00000000, BBRA = H'0054
		BARB = H'00008010, BAMRB = H'00000006, BBRB = H'0054
		BDRB = H'00000000, BDMRB = H'00000000
		BRCR = H'1400

Conditions set (channel A/channel B independent mode):

Channel A:	Address = H'00000404, address mask H'00000000
	Bus cycle = CPU, instruction fetch (after execution), read
	(operand size not included in conditions)
Channel B:	Address = H'00008010, address mask H'00000006
	Data H'00000000, data mask H'00000000
	Bus cycle = CPU, instruction fetch (before execution), read
	(operand size not included in conditions)

A user break will occur after the instruction at address H'00000404 is executed, or a user break will be generated before the execution of the instruction at address H'00008010–H'00008016.

Register settings:	BARA = H'00037226, BAMRA = H'00000000, BBRA = H'0056	
	BARB = H'0003722E, BAMRB = H'00000000, BBRB = H'0056	
	BDRB = H'00000000, BDMRB = H'00000000	
	BRCR = H'1010	
Conditions set (cha	nnel A \rightarrow channel B sequential mode):	DataShe
Channel A:	Address = H'00037226, address mask H'00000000	
	Bus cycle = CPU, instruction fetch (before execution), read, word	
Channel B:	Address = H'0003722E, address mask H'00000000	
	Data H'00000000, data mask H'00000000	
	Bus cycle = CPU, instruction fetch (before execution), read, word	
	Conditions set (cha Channel A:	BARB = H'0003722E, BAMRB = H'0000000, BBRB = H'0056 BDRB = H'00000000, BDMRB = H'00000000 BRCR = H'1010 Conditions set (channel A \rightarrow channel B sequential mode): Channel A: Address = H'00037226, address mask H'00000000 Bus cycle = CPU, instruction fetch (before execution), read, word Channel B: Address = H'0003722E, address mask H'00000000 Data H'0000000, data mask H'00000000

The instruction at address H'00037226 will be executed and then a user break interrupt will occur before the instruction at address H'0003722E is executed.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com C. Register settings:	BARA = H'00027128, BAMRA = H'00000000, BBRA = H'005A BARB = H'00031415, BAMRB = H'00000000, BBRB = H'0054 BDRB = H'00000000, BDMRB = H'00000000 BRCR = H'1000
Conditions set (cha	nnel A/channel B independent mode):
Channel A:	Address = H'00027128, address mask H'00000000
	Bus cycle = CPU, instruction fetch (before execution), write, word
Channel B:	Address = H'00031415, address mask H'00000000
	Data H'00000000, data mask H'00000000
	Bus cycle = CPU, instruction fetch (before execution), read (operand size not included in conditions)

A user break interrupt is not generated for channel A since the instruction fetch is not a write cycle. A user break interrupt is not generated for channel B because the instruction fetch is for an odd address.

D.	Register settings:	BARA = H'00037226, BAMRA = H'00000000, BBRA = H'005A	
		BARB = H'0003722E, BAMRB = H'00000000, BBRB = H'0056	
		BDRB = H'00000000, BDMRB = H'00000000	
		BRCR = H'1010	
		DataSheet4U.com	
	Conditions set (cha	nnel A \rightarrow channel B sequential mode):	
	Channel A:	Address = H'00037226, address mask H'00000000	
		Bus cycle = CPU, instruction fetch (before execution), write, word	
4U.com	Channel B:	Address = H'0003722E, address mask H'00000000	DataShee
		Data H'00000000	
		Data mask H'00000000	
		Bus cycle = CPU, instruction fetch (before execution), read, word	

The break for channel A is a write cycle, so conditions are not satisfied; since the sequence conditions are not met, no user break interrupt occurs.

DataSheet4U.com

et4

www.DataSheet4U.com

www.DataSheet4U.com Break on CPU Data Access Cycle:

Register settings:	BARA = H'00123456, BAMRA = H'00000000, BBRA = H'0064		
	BARB = H'000ABCDE, BAMRB = H'000000FF, BBRB = H'006A		
	BDRB = H'0000A512, BDMRB = H'00000000		
	BRCR = H'1008		
Conditions set (channel A/channel B independent mode):			
Channel A:	annel A: Address = H'00123456, address mask H'00000000		
	Bus cycle = CPU , data access, read		
	(operand size not included in conditions)		
Channel B:	Address = H'000ABCDE, address mask H'000000FF		
	Data H'0000A512, data mask H'00000000		
	Bus cycle = CPU, data access, write, word		

For channel A, a user break interrupt occurs when it is read as longword at address H'00123454, as word at address H'00123456 or as byte at address H'00123456. For channel B, a user break interrupt occurs when H'A512 is written as word at H'000ABC00–H'000ABCFE.

Break on DMAC Data Access Cycle:

Register settings:	BARA = H'00314156, BAMRA = H'00000000, BBRA = H'0094
	BARB = H'000555555, BAMRB = H'00000000, BBRB = H'00A9
	BDRB = H'00007878, BDMRB = H'00000F0F
	BRCR = H'1008

et4U.com	Conditions set (channel A/channel B independent mode):		
	Channel A:	Address = H'00314156, address mask H'00000000	
		Bus cycle = DMA, instruction fetch, read	
		(operand size not included in conditions)	
	Channel B:	Address = H'00055555, address mask H'00000000	
		Data H'00007878, data mask H'00000F0F	
		Bus cycle = peripheral, data access, write, byte	

For channel A, a user break interrupt does not occur, since no instruction fetch occurs in the DMAC cycle. For channel B, a user break interrupt occurs when the DMAC writes H'7* (where * means don't care) as byte at H'00055555.

DataSheet4U.com

www.DataSheet4U.com

- 1. UBC registers can only be read or written to by the CPU.
- 2. When set for a sequential break, conditions match when a match of channel B conditions occurs some time after the bus cycle in which a channel A match occurs. This means that the conditions will not be satisfied when set for a bus cycle in which channel A and channel B occur simultaneously. Since the CPU uses a pipeline structure, the order of the instruction fetch cycle and memory cycle is fixed, so sequential conditions will be satisfied when the respective channel conditions are met in the order the bus cycles occur.
- 3. When set for sequential conditions (the SEQ bit in BRCR is 1) and the instruction fetch cycle of the channel A CPU is set as a condition, set channel A for before instruction execution (PCBA bit in BRCR is 0).
- 4. When register settings are changed, the write values usually become valid after three cycles. For on-chip memory, instruction fetches get two instructions simultaneously. If a break condition is set on the fetch of the second of these two instructions but the contents of the UBC registers are changed so as to alter the break condition immediately after the first of the two instructions is fetched, a user break interrupt will still occur before the second instruction. To ensure the timing of the change in the setting, read the register written last as a dummy. The changed settings will be valid thereafter.
- 5. When a user break interrupt is generated upon a match of the instruction fetch condition and the conditions match again in the UBC while the exception handling service routine is executing, the break will cause exception handling when the I3–I0 bits in SR are set to 14 or lower. When masking addresses, when setting instruction fetch and after-execution as break conditions, and when executing in steps, the UBC's exception service routine should not cause a match of addresses with the UBC.
- 6. When the emulator is used, the UBC is used on the emulator system side to implement the emulator's break function. This means none of the UBC functions can be used when the emulator is being used.

DataShe

DataSheet4U.com

www.DataSheet4U.com

- -
- 1. In SH7000 Series compatible mode:

In SH7000 Series compatible mode, functions are as follows:

- The registers shown in the table 6.2 are valid; all others are not.
- External bus breaks are not possible in SH7000 Series compatible mode. The instruction fetch cycle occurs prior to instruction execution. The flags are not set when break conditions match.
- 2. Differences between SH7000 Series compatible mode and SH7604 mode:

When set for the CPU instruction fetch cycle in the SH7000 Series compatible mode, the break occurs before the instruction that matches the conditions. The break conditions differ as shown below from setting for before-execution in SH7604 mode. For data access cycles, the address is always compared to 32 bits in the SH7000 Series compatible mode, but in SH7604 mode is compared as shown in table 6.3. This produces the differences in break conditions shown in table 6.4.

	Match Determination	SH7000 Series Compatible Mode	SH7604 Mode	
	Conditions match when set for instruction fetch cycle/before-execution	Breaks if instruction is overrun-fetched and not executed (as during branching)	Does not break if instruction is overrun fetched and not execute (as during branching)	ed
-	Conditions match in longword access when set for addresses other than longword boundaries (4n address)	Does not break	Breaks	
4U.c	Conditions match in word access when set for addresses other than word boundaries (2n addresses)	Does not break	Breaks	DataShe

Table 6.4 Differences in Break Conditions

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

128 DataSheet4U.com

www.DataSheet4U.com Section 7 Bus State Controller (BSC)

7.1 **Overview**

The bus state controller (BSC) manages the address spaces and outputs control signals so that optimum memory accesses can be made in the four spaces. This enables memories like DRAM, synchronous DRAM and pseudo-SRAM, and peripheral chips, to be linked directly.

7.1.1 Features

The BSC has the following features:

- Address space is divided into four spaces •
 - A maximum linear 32 Mbytes for each of the address spaces CS0-CS3
 - The type of memory connected can be specified for each space (DRAM, synchronous DRAM, pseudo-SRAM, burst ROM, etc.).
 - Bus width can be selected for each space (8, 16, or 32 bits).
 - Wait state insertion can be controlled for each space.
 - Outputs control signals for each space.
- Cache •
 - Cache areas and cache-through areas can be selected by access address.
 - When a cache access misses, 16 bytes are read consecutively in 4-byte units (because of cache fill); writes use the write-through system.
 - Cache-through accesses are accessed according to access size.

et4U.com Refresh

- Supports CAS-before-RAS refresh (auto-refresh) and self-refresh.
- Refresh interval can be set using the refresh counter and clock selection.
- Direct interface to DRAM ٠
 - Multiplexes row/column address output.
 - Burst transfer during reads, high-speed page mode for consecutive accesses.
 - Generates a Tp cycle to ensure RAS precharge time.
- Direct interface to synchronous DRAM ٠
 - Multiplexes row/column address output.
 - Burst read, single write
 - Bank active mode

www.DataSheet4U.com

- www.DataSheet4U.com Master and slave modes (bus arbitration)
 - Total master and partial-share master modes. In total master mode, all resources are shared with other CPUs. Bus permission is shared when an external bus release request is received. In partial-share master mode, only the CS2 space is shared with other CPUs; all other spaces can be accessed at any time.
 - In slave mode, the external bus is accessed when a bus use request is output and bus use permission is received.
 - Refresh counter can be used as an interval timer ٠
 - Interrupt request generated upon compare match (CMI interrupt request signal).

7.1.2 **Block Diagram**

Figure 7.1 shows the BSC block diagram.

www.DataSheet4U.com

130 DataSheet4U.com

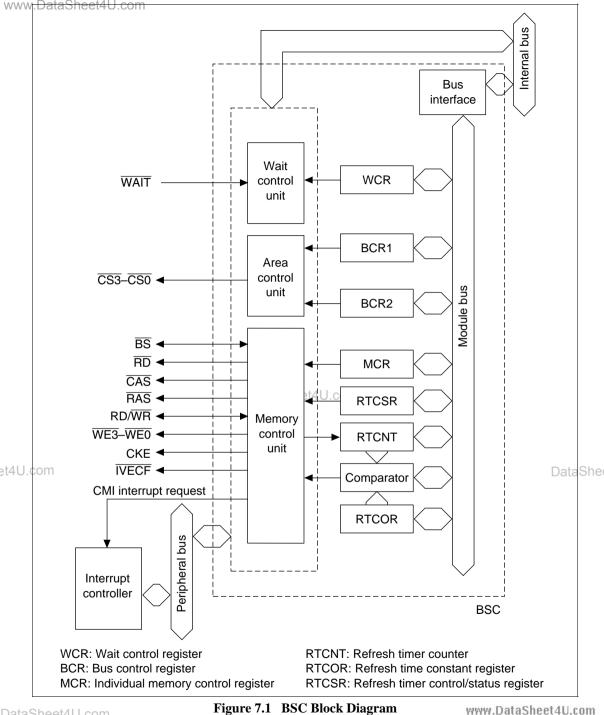


Table 7.1 lists the bus state controller pin configuration.

Table 7.1Pin Configuration

Signal	I/O	With Bus Released	Description
A26-A0	I/O	I	Address bus. 27 bits are available to specify a total 128 Mbytes of memory space. The most significant 2 bits are used to specify the CS space, so the size of the spaces is 32 Mbytes. When the bus is released, these become inputs for the external bus cycle address monitor.
D31–D0	I/O	Hi-Z	32-bit data bus. When reading or writing a 16-bit width area, use D15–D0; when reading or writing a 8-bit width area, use D7–D0. With 8-bit accesses that read or write a 32-bit width area, input and output the data via the byte position determined by the lower address bits of the 32-bit bus.
BS	I/O	I	Indicates start of bus cycle or monitor. With the basic interface (device interfaces except for DRAM, synchronous DRAM, pseudo- SRAM), signal is asserted for a single clock cycle simultaneous with address output. The start of the bus cycle can be determined by this signal. This signal is asserted for 1 cycle synchronous with column address output in DRAM, synchronous DRAM and pseudo- SRAM accesses. When the bus is released, BS becomes an input for address monitoring of external bus cycles.
CS0– CS3	0	Hi-Z	Chip select. Signals that select area; specified by A26 and A25.
RD/WR, WE	I/O	I	Read/write signal. Signal that indicates access cycle direction (read/write). Connected to WE pin when DRAM/synchronous DRAM is connected. When the bus is released, becomes an input for address monitoring of external bus cycles.
$\overline{RAS}, \overline{CE}$	0	Hi-Z	\overline{RAS} pin for DRAM/synchronous DRAM. \overline{CE} pin for pseudo-SRAM.
$\overline{CAS}, \overline{OE}$	0	Hi-Z	Open when using DRAM. \overline{CAS} pin for synchronous DRAM. \overline{OE} pin for pseudo-SRAM.
Cashh, Dqmuu, We3	0	Hi-Z	When DRAM is used, connected to \overline{CAS} pin for the most significant byte (D31–D24). When synchronous DRAM is used, connected to DQM pin for the most significant byte. When pseudo- SRAM is used, connected to \overline{WE} pin for the most significant byte. For basic interface, indicates writing to the most significant byte.
CASHL, DQMUL, WE2 aSheet4U.o	O com	Hi-Z	When DRAM is used, connected to \overline{CAS} pin for the second byte (D23–D16). When synchronous DRAM is used, connected to DQM pin for the second byte. When pseudo-SRAM is used, connected to \overline{WE} pin for the second byte. For basic interface, where the second byte.

www.DataSheet4U.com Table 7.1 Pin Configuration (cont)

	Signal	I/O	With Bus Released	Description
	CASLH, DQMLU, WE1	0	Hi-Z	When DRAM is used, connected to \overline{CAS} pin for the third byte (D15–D8). When synchronous DRAM is used, connected to DQM pin for the third byte. When pseudo-SRAM is used, connected to \overline{WE} pin for the third byte. For basic interface, indicates writing to the third byte.
	CASLL, DQMLL, WE0	0	Hi-Z	When DRAM is used, connected to \overline{CAS} pin for the least significant byte (D7–D0). When synchronous DRAM is used, connected to DQM pin for the least significant byte. When pseudo-SRAM is used, connected to \overline{WE} pin for the least significant byte. For basic interface, indicates writing to the least significant byte.
-	RD	0	Hi-Z	Read pulse signal (read data output enable signal). Normally, connected to the device's /OE pin; when there is an external data buffer, the read cycle data can only be output when this signal is low.
-	WAIT	I	Ignore	Hardware wait input.
-	BACK, BRLS	I	Ι	Bus use enable input in partial-share master or slave mode: BACK. Bus release request input in total master: BRLS.
-	BREQ, BGR	0	0	Bus request output in partial-share master or slave mode: \overline{BREQ} . Bus grant output in total master: \overline{BGR} .
-	CKE	0	0	Synchronous DRAM clock enable control. Signal for supporting synchronous DRAM self-refresh.
-	IVECF	0	Hi-Z	Interrupt vector fetch.
	DREQ0	I	I	DMA request 0.
et4U.c	DACK0	0	0	DMA acknowledge 0. DataS
	DREQ1	I		DMA request 1.
	DACK1	0	0	DMA acknowledge 1.

Note: Hi-Z: High impedance

DataSheet4U.com

www.DataSheet4U.com

The BSC has seven registers. These registers are used to control wait states, bus width, interfaces with memories like DRAM, synchronous DRAM, pseudo-SRAM, and burst ROM, and DRAM, synchronous DRAM, and pseudo-SRAM refreshing. The register configurations are shown in table 7.2.

The size of the registers themselves is 16 bits. If read as 32 bits, the upper 16 bits are 0. *In order to prevent writing mistakes, 32-bit writes are accepted only when the value of the upper 16 bits of the write data is H'A55A; no other writes are performed.* Initialize the reserved bits.

Initialization Procedure: Do not access a space other than CS0 until the settings for the interface to memory are completed.

Abbr.	R/W	Initial Value	Address* ¹	Access Size
BCR1	R/W	H'03F0	H'FFFFFFE0	16 ^{*2} , 32
BCR2	R/W	H'00FC	H'FFFFFFE4	16 ^{*2} , 32
WCR	R/W	H'AAFF	H'FFFFFFE8	16 ^{*2} , 32
MCR	R/W	H'0000	H'FFFFFFEC	16 ^{*2} , 32
RTCSR	R/W	H'0000	H'FFFFFF60	16 ^{*2} , 32
RTCNT	R/W	H'0000	H'FFFFFFF4	16 ^{*2} , 32
RTCOR	R/W	H'0000	H'FFFFFF8	16 ^{*2} , 32
	BCR1 BCR2 WCR MCR RTCSR RTCNT	BCR1 R/W BCR2 R/W WCR R/W MCR R/W RTCSR R/W RTCNT R/W	BCR1 R/W H'03F0 BCR2 R/W H'00FC WCR R/W H'AAFF MCR R/W H'0000 RTCSR R/W H'0000 RTCNT R/W H'0000	BCR1R/WH'03F0H'FFFFFE0BCR2R/WH'00FCH'FFFFFE4WCRR/WH'AAFFH'FFFFFFE8MCRR/WH'0000H'FFFFFFECRTCSRR/WH'0000H'FFFFFF60RTCNTR/WH'0000H'FFFFFF64

Table 7.2 Register Configuration

Notes: 1. This address is for 32-bit accesses; for 16-bit accesses add 2.

2. 16-bit access is for read only.

et4U.cor

DataShe

www.DataSheet4U.com

7.1.5 Address Map

The SH7604 address map, which has a memory space of 256 Mbytes, is divided into four spaces. The types and data width of devices that can be connected are specified for each space. The overall space address map is shown in table 7.3. Since the spaces of the cache area and the cache-through area are the same, the maximum memory space that can be connected is 128 Mbytes. This means that when address H'20000000 is accessed in a program, the data accessed is actually in H'00000000.

There are several spaces for cache control. These include the associative purge space for cache purges, address array read/write space for reading and writing addresses (address tags), and data array read/write space for forced reads and writes of data arrays.

DataSheet4U.com

134 DataSheet4U.com

www.DataSheet4U.com Table 7.3 Address Map

Address	Space	Memory	Size
H'00000000 to H'01FFFFF	CS0 space, cache area	Ordinary space or burst ROM	32 Mbytes
H'02000000 to H'03FFFFF	CS1 space, cache area	Ordinary space	32 Mbytes
H'04000000 to H'05FFFFF	CS2 space, cache area	Ordinary space or synchronous DRAM	32 Mbytes
H'06000000 to H'07FFFFF	CS3 space, cache area	Ordinary space, synchronous DRAM, DRAM or pseudo-DRAM	32 Mbytes
H'08000000 to H'1FFFFFF	Reserved		
H'20000000 to H'21FFFFF	CS0 space, cache- through area	Ordinary space or burst ROM	(32 Mbytes)
H'22000000 to H'23FFFFF	CS1 space, cache- through area	Ordinary space	(32 Mbytes
H'24000000 to H'25FFFFF	CS2 space, cache- through area	Ordinary space or synchronous DRAM	(32 Mbytes
H'26000000 to H'27FFFFF	CS3 space, cache- through area	Ordinary space, synchronous DRAM, DRAM or pseudo-DRAM	(32 Mbytes
H'28000000 to H'3FFFFFF	Reserved		
H'40000000 to H'47FFFFF	Associative purge et4 space	U.com	128 Mbytes
H'48000000 to H'5FFFFFF	Reserved		
H'60000000 to H'7FFFFFF	Address array, read/write space		512 Mbytes
H'80000000 to H'BFFFFFF	Reserved		
H'C0000000 to H'C0000FFF	Data array, read/write space		4 kbytes
H'C0001000 to H'DFFFFFF	Reserved		
H'E0001000 to H'FFFF7FFF	Reserved		
H'FFFF8000 to H'FFFFBFFF	For setting synchronous DRAM mode		16 kbytes
H'FFFFC000 to H'FFFFFDFF	Reserved		15.5 kbytes
H'FFFFFE00 to H'FFFFFFF	On-chip peripheral modules		512 bytes

Note: Do not access reserved spaces, as this will cause operating errors.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 7.2 Description of Registers

Bit:	15	14	13	12	11	10	9	8
Bit name:	MASTER	—	—	ENDIAN	BSTROM	PSHR	AHLW1	AHLW0
Initial value:	—	0	0	0	0	0	1	1
R/W:	R	R	R	R/W	R/W	R/W	R/W	R/W
Bit:	7	6	5	4	3	2	1	0
Bit name:	A1LW1	A1LW0	A0LW1	A0LW0	—	DRAM2	DRAM1	DRAM0
Initial value:	1	1	1	1	0	0	0	0
R/W:	R/W	R/W	R/W	R/W	R	R/W	R/W	R/W

7.2.1 Bus Control Register 1 (BCR1)

Initialize ENDIAN, BSTROM, PSHR and DRAM2–DRAM0 bits after a power-on reset and do not write to them thereafter. To change other bits by writing to them, write the same value as they are initialized to. Do not access any space other than CS0 until the register initialization ends.

• Bit 15—Bus Arbitration (MASTER): The MASTER bit is used to check the settings of the bus arbitration function set by the mode settings with the external input pin. It is a read-only bit.

Bit 15 (MASTER)	Description
0	Master mode
1	Slave mode

4U.com

- Bits 14, 13, and 3—Reserved bits: These bits always read 0. The write value should always be 0.
- Bit 12—Endian Specification for Area 2 (ENDIAN): In big-endian format, the MSB of byte data is the lowest byte address and byte data goes in order toward the LSB. For little-endian format, the LSB of byte data is the lowest byte address and byte data goes in order toward the MSB. When this bit is 1, the data is rearranged into little-endian format before transfer when the CS2 space is read or written to. It is used when handling data with little-endian processors or running programs written with little-endian format in mind.

Bit 12: ENDIAN	Description	
0	Big-endian, as in other areas	(Initial value)
1	Little-endian	
aSheet4U.com		www.DataSheet4U.com

www.DataSheet4U.com Bit 11—Area 0 Burst ROM Enable (BSTROM)

Bit 11: BSTROM	Description	
0	Area 0 is accessed normally	(Initial value)
1	Area 0 is accessed as burst ROM	

- Bit 10—Partial Space Share Specification (PSHR): When bus arbitration is in master mode and the PSHR bit is 1, only area 2 is handled as a shared space. When areas other than area 2 are accessed, bus ownership is not requested. When this bit is 1, address monitor specification is disabled. This mode is called partial-share master mode. The initial value is 0.
- Bits 9 and 8—Long Wait Specification for Areas 2 and 3 (AHLW1, AHLW0): When the basic memory interface setting is made for area 2 and area 3, the wait specification of this field is effective when the bits that specify the respective area waits in the wait control register (W21/W20 or W31/W30) specify long waits (i.e., 11).

Bit 9: AHLW1	Bit 8: AHLW0	Description	
0	0	3 waits	
	1	4 waits	
1	0	5 waits	
	1	6 waits	(Initial value)
		DataSheet4U.com	

• Bits 7 and 6—Long Wait Specification for Area 1 (A1LW1, A1LW0): When the basic memory interface setting is made for area 1, the wait specification of this field is effective when the bits that specify the wait in the wait control register specify long wait (i.e., 11).

Bit 6: A1LW0	Description	DataSi
0	3 waits	
1	4 waits	
0	5 waits	
1	6 waits	(Initial value)
	Bit 6: A1LW0 0 1 0 1 1	0 3 waits 1 4 waits 0 5 waits

• Bits 5 and 4—Long Wait Specification for Area 0 (A0LW1, A0LW0): When the basic memory interface setting is made for area 0, the wait specification of this field is effective when the bits that specify the wait in the wait control register specify long wait (i.e., 11).

DataSheet4U.com

www.DataSheet4U.com

www.DataShe Bit 5: A0l	et4U.com W1 Bit 4: A0LW0	Description	
0	0	3 waits	(Initial value)
	1	4 waits	
1	0	5 waits	
	1	6 waits	

• Bits 2 to 0—Enable for DRAM and Other Memory (DRAM2–DRAM0)

DRAM2	DRAM1	DRAM0	Description			
0	0	0	Areas 2 and 3 are ordinary spaces	(Initial value)		
		1	Area 2 is ordinary space; area 3 is synchronous DRAM			
	1	0	Area 2 is ordinary space; area 3 is DRAM space			
		1	Area 2 is ordinary space; area 3 is pseudo-SRAM spa	ace		
1	0	0	Area 2 is synchronous DRAM space, area 3 is ordinar			
		1	Areas 2 and 3 are synchronous DRAM spaces			
	1	0	Reserved (do not set)			
		1	Reserved (do not set)			

7.2.2 Bus Control Register 2 (BCR2)taSheet4U.com

	Bit:	15	14	13	12	11	10	9	8	
		.0		.0	·		.0	5		
	Bit name:				—				—	
et4U.com	Initial value:	0	0	0	0	0	0	0	0 _{Da}	taShee
	R/W:	R	R	R	R	R	R	R	R	
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:	A3SZ1	A3SZ0	A2SZ1	A2SZ0	A1SZ1	A1SZ0		—	
	Initial value:	1	1	1	1	1	1	0	0	
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R	R	

Initialize BCR2 after a power-on reset and do not write to it thereafter. When writing to it, write the same values as those the bits are initialized to. Do not access any space other than CS0 until the register initialization ends.

DataSheet4U.com

www.DataSheet4U.com

Www.DataSheet4U.com
 Bits 15 to 8—Reserved: These bits always read 0. The write value should always be 0.

• Bits 7 and 6—Bus Size Specification for Area 3 (A3SZ1–A3SZ0). Effective only when ordinary space is set.

Bit 7: A3SZ1	Bit 6: A3SZ0	Description	
0	0	Reserved (do not set)	
	1	Byte (8-bit) size	
1	0	Word (16-bit) size	
	1	Longword (32-bit) size	(Initial value)

• Bits 5 and 4—Bus Size Specification for Area 2 (A2SZ1–A2SZ0): Effective only when ordinary space is set.

Bit 5: A2SZ1	Bit 4: A2SZ0	Description	
0	0	Reserved (do not set)	
	1	Byte (8-bit) size	
1	0	Word (16-bit) size	
	1	Longword (32-bit) size	(Initial value)

• Bits 3 and 2—Bus Size Specification for Area 11 (A1SZ1-A1SZ0)

Bit 3: A1	SZ1 Bit 2: A1SZ0	Description	
0	0	Reserved (do not set)	
et4U.com	1	Byte (8-bit) size	DataShe
1	0	Word (16-bit) size	
	1	Longword (32-bit) size	(Initial value)

• Bits 1 and 0—Reserved: These bits always read 0. The write value should always be 0.

Note: The bus size of area 0 is specified by the mode input pins.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 7.2.3 Wait Control Register (WCR)

Bit:	15	14	13	12	11	10	9	8
Bit name:	IW31	IW30	IW21	IW20	IW11	IW10	IW01	IW00
Initial value:	1	0	1	0	1	0	1	0
R/W:	R/W							
Bit:	7	6	5	4	3	2	1	0
Bit name:	W31	W30	W21	W20	W11	W10	W01	W00
Initial value:	1	1	1	1	1	1	1	1
R/W:	R/W							

Do not access a space other than CS0 until the settings for register initialization are completed.

• Bits 15 to 8—Idles between Cycles for Areas 3 to 0 (IW31–IW00): These bits specify idle cycles inserted between consecutive accesses to different areas. Idles are used to prevent data conflict between ROM or the like, which is slow to turn the read buffer off, and fast memories and I/O interfaces. Even when access is to the same area, idle cycles must be inserted when a read access is followed immediately by a write access. The idle cycles to be inserted comply with the specification for the previously accessed area.

IW31, IW21, IW11,	IW01 IW30,	IW20, IW10, IW00 ^{U.C} Description	
0	0	No idle cycle	
	1	One idle cycle inserted	
4U.com	0	Two idle cycles inserted	(Initial value)
	1	Reserved (do not set)	Dataono

• Bits 7 to 0—Wait Control for Areas 3 to 0 (W31–W00)

During the basic cycle:

W31, W21, W11, W01	W30, W20, W10, W00	Description
0	0	External wait input disabled without wait
0	1	External wait input enabled with one wait
1	0	External wait input enabled with two waits
1	1	Complies with the long wait specification of bus control register 1 (BCR1). External wait input is enabled

www.DataSheet4U.com When area 3 is DRAM, the number of CAS assert cycles is specified by wait control bits W31 and W30:

Bit 7: W31	Bit 6: W30	Description
0	0	1 cycle
	1	2 cycles
1	0	3 cycles
	1	Reserved (do not set)

When the setting is for 2 or more cycles, external wait input is enabled.

When area 2 or 3 is synchronous DRAM, CAS latency is specified by wait control bits W31 and W30, and W21 and W20, respectively:

W31, W21	W30, W20	Description	
0	0	1 cycle	
	1	2 cycles	
1	0	3 cycles	
	1	4 cycles	

With synchronous DRAM, external wait input is ignored regardless of any setting.

When area 3 is pseudo-SRAM, the number of cycles from \overline{BS} signal assertion to the end of the cycle is specified by wait control bits W31 and W30:

et4U.coBit 7: W31	Bit 6: W30	Description	DataShee
0	0	2 cycles	
	1	3 cycles	
1	0	4 cycles	
	1	Reserved (do not set)	

When the setting is for 3 or more cycles, external wait input is enabled.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 7.2.4 Individual

Individual Memory Control Register (MCR)

Bit:	15	14	13	12	11	10	9	8
Bit name:	TRP	RCD	TRWL	TRAS1	TRAS0	BE	RASD	—
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R
Bit:	7	6	5	4	3	2	1	0
Bit name:	AMX2	SZ	AMX1	AMX0	RFSH	RMD	—	—
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R	R

The TRP, RCD, TRWL, TRAS1-TRAS0, BE, RASD, AMX2-AMX0 and SZ bits are initialized after a power-on reset. Do not write to them thereafter. When writing to them, write the same values as they are initialized to. Do not access any space other than CS2 and CS3 until the register initialization ends.

Bit 15-RAS Precharge Time (TRP): When DRAM is connected, specifies the minimum number of cycles after \overline{RAS} is negated before the next assert. When pseudo-SRAM is connected, specifies the minimum number of cycles after $\overline{\text{CE}}$ is negated before the next assert. When synchronous DRAM is connected, specifies the minimum number of cycles after precharge until a bank active command is output. See section 7.5, Synchronous DRAM Interface, for details.

Bit 15: TRP	Description	
t4U.com	1 cycle	(Initial value)ataShee
1	2 cycles	

Bit 14-RAS-CAS Delay (RCD): When DRAM is connected, specifies the number of cycles • after \overline{RAS} is asserted before \overline{CAS} is asserted. When pseudo-SRAM is connected, specifies the number of cycles after \overline{CE} is asserted before \overline{BS} is asserted. When synchronous DRAM is connected, specifies the number of cycles after a bank active (ACTV) command is issued until a read or write command (READ, READA, WRIT, WRITA) is issued.

Bit 14: RCD	Description	
0	1 cycle	(Initial value)
1	2 cycles	

www.DataSheet4U.com

www.DataShee Bit 13

4U com -Write-Precharge Delay (TRWL): When the synchronous DRAM is not in the bank active mode, this bit specifies the number of cycles between the write cycle and the start-up of the auto-precharge. The timing from this point to the point at which the next command can be issued is calculated within the bus state controller. In bank active mode, this bit specifies the period for which the precharge command is disabled after the write command (WRIT) is issued. This bit is ignored when memory other than synchronous DRAM is connected.

Bit 13: TRWL	Description	
0	1 cycle	(Initial value)
1	2 cycles	

Bits 12 and 11—CAS-Before-RAS Refresh RAS Assert Time (TRAS1-TRAS0): The RAS assertion width for DRAM is TRAS; the OE width for pseudo-SRAM is TRAS + 1 cycle. After an auto-refresh command is issued, the synchronous DRAM does not issue a bank active command for TRAS + 2 cycles, regardless of the TRP bit setting. For synchronous DRAMs, there is no RAS assertion period, but there is a limit for the time from the issue of a refresh command until the next access. This value is set to observe this limit. Commands are not issued for TRAS + 1 cycle when self-refresh is cleared.

Bit 12: TRAS1	Bit 11: TRAS0	Description	
0	0	2 cycles	(Initial value)
	1	3 cyclesneet4U.com	
1	0	4 cycles	
	1	Reserved (do not set)	

et4U.com Bit 10—Burst Enable (BE)

Bit 10: BE	Description	
0	Burst disabled	(Initial value)
1	High-speed page mode during DRAM in continuously transferred in static columr interfacing. During synchronous DRAM always enabled regardless of this bit.	n mode during pseudo-SRAM

www.DataSheet4U.com

Description
For DRAM, RAS is negated after access ends (normal operation).
For synchronous DRAM, a read or write is performed using auto- precharge mode. The next access always starts with a bank active command.
For DRAM, after access ends RAS down mode is entered in which RAS is left asserted. When using this mode with an external device connected which performs writes other than to DRAM, see section 7.6.5, Burst Access.
For synchronous DRAM, access ends in the bank active state. This is only valid for area 3. When area 2 is synchronous DRAM, the mode is always auto-precharge.

• Bits 7, 5, and 4—Address Multiplex (AMX2–AMX0)

Bit 7: AMX2	Bit 5: AMX1	Bit 4: AMX0	Description	
0	0	0	8-bit column address DRAM	
		1 DataSh	eet4U9-bit column address DRAM	
	1	0	10-bit column address DRAM	
		1	11-bit column address DRAM	
1	0	0	Reserved (do not set)	
U.com		1	Reserved (do not set)	DataShe
	1	0	Reserved (do not set)	
		1	Reserved (do not set)	
	1	0 1		

DataSheet4U.com

et4

www.DataSheet4U.com

www.DataSheet4U.com For synchronous DRAM interface:

Bit 7: AMX2	Bit 5: AMX1	Bit 4: AMX0	Description
0	0	0	16-Mbit DRAM (1M \times 16 bits)
		1	16-Mbit DRAM (2M × 8 bits)*
	1	0	16-Mbit DRAM (4M × 4 bits)*
		1	4-Mbit DRAM (256k × 16 bits)
1	0	0	Reserved (do not set)
		1	Reserved (do not set)
	1	0	Reserved (do not set)
		1	2-Mbit DRAM (128k × 16 bits)

Note: Reserved. Do not set when SZ bit in MCR is 0 (16-bit bus width).

• Bit 6—Memory Data Size (SZ): For synchronous DRAM, DRAM, and pseudo-SRAM space, the data bus width of BCR2 is ignored in favor of the specification of this bit.

Bit 6: SZ	Description	
0	Word	(Initial value)
1	Longword	
	DataSheet4U.com	

• Bit 3—Refresh Control (RFSH): This bit determines whether or not the refresh operation of DRAM/synchronous DRAM/pseudo-SRAM is performed. This bit is not valid in the slave mode and is always handled as 0.

et4U.com

Bit 3: RFSH	Description	Duta
0	No refresh	(Initial value)
1	Refresh	

• Bit 2—Refresh Mode (RMODE): When the RFSH bit is 1, this bit selects normal refresh or self-refresh. When the RFSH bit is 0, do not set this bit to 1. When the RFSH bit is 1, self-refresh mode is entered immediately after the RMD bit is set to 1. When the RFSH bit is 1 and this bit is 0, a CAS-before-RAS refresh or auto-refresh is performed at the interval set in the 8-bit interval timer. When a refresh request occurs during an external area access, the refresh is performed after the access cycle is completed. When set for self-refresh, self-refresh mode is entered immediately unless the SH7604 is in the middle of an synchronous DRAM or pseudo-SRAM area access. If it is, self-refresh mode is entered when the access ends. Refresh requests

DataSheefrom the interval timer are ignored during self-refresh. Self-refresh is not supported at a Sheet 4U.com DRAM, so always set RMD to 0 when using DRAM.

WWW	.DataSheet4U.com Bit 2: RMODE	Description	
	0	Normal refresh	(Initial value)
	1	Self-refresh	

Bits 8, 1, and 0-Reserved: These bits always read 0. •

7.2.5 **Refresh Timer Control/Status Register (RTCSR)**

Bit:	15	14	13	12	11	10	9	8
Bit name:	—	_	—	—	—	—	—	—
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R	R
Bit:	7	6	5	4	3	2	1	0
Bit name:	CMF	CMIE	CKS2	CKS1	CKS0	—	—	
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W	R/W	R/W	R/W	R/W	R	R	R

Bits 15 to 8—Reserved: These bits always read 0.

DataSheet4U.com Bit 7—Compare Match Flag (CMF): This status flag, which indicates that the values of • RTCNT and RTCOR match, is set/cleared under the following conditions:

	Bit 7: CMF	Description	
et4U.o	o <mark>9</mark> m	RTCNT and RTCOR match Clear condition: After RTCSR is read when CMF is 1, 0 is written in CMF	DataShee
	1	RTCNT and RTCOR do not match Set condition: RTCNT = RTCOR	

Bit 6—Compare Match Interrupt Enable (CMIE): Enables or disables an interrupt request ٠ caused by the CMF bit of RTSCR when CMF is set to 1.

Bit 6: CMIE	Description	
0	Interrupt request caused by CMF is disabled	(Initial value)
1	Interrupt request caused by CMF is enabled	

DataSheet4U.com

www.DataSheet4U.com

146 DataSheet4U.com

Bit 4: CKS1	Bit 3: CKS0	Description	
0	0	Count-up disabled	(Initial value)
	1	CLK/4	
1	0	CLK/16	
	1	CLK/64	
0	0	CLK/256	
	1	CLK/1024	
1	0	CLK/2048	
	1	CLK/4096	
	0	$ \begin{array}{c} 0 \\ \hline 1 \\ 1 \\ \hline 0 \\ \hline 1 \end{array} $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

www.DataSheet4U.com • Bits 5 to 3—Clock Select Bits (CKS2–CKS0)

• Bits 2 to 0—Reserved: These bits always read 0. The write value should always be 0.

	Bit:	15	14	13	12	11	10	9	8	
	Bit name:	—	—		—	—	—	—	—	
	Initial value:	0	0	0	0	0	0	0	0	
	R/W:	R	R	DataShee	et4U.com	R	R	R	R	
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:									
t4U.com	Initial value:	0	0	0	0	0	0	0	o Data	aShee
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

7.2.6 Refresh Timer Counter (RTCNT)

The 8-bit counter RTCNT counts up with input clocks. The clock select bit of RTCSR selects an input clock. RTCNT values can always be read/written by the CPU. When RTCNT matches RTCOR, RTCNT is cleared. Returns to 0 after it counts up to 255.

• Bits 15 to 8—Reserved: These bits always read 0. The write value should always be 0.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 7.2.7 Refresh Time Constant Register (RTCOR)

Bit:	15	14	13	12	11	10	9	8
Bit name:	_	_	_	—		—		—
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R	R
Bit:	7	6	5	4	3	2	1	0
Bit name:								
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W							

RTCOR is an 8-bit read/write register. The values of RTCOR and RTCNT are constantly compared. When the values correspond, the compare match flag in RTCSR is set and RTCNT is cleared to 0. When the refresh bit (RFSH) in the individual memory control register is set to 1, a refresh request signal occurs. The refresh request signal is held until refresh operation is performed. If the refresh request is not processed before the next match, the previous request becomes ineffective.

When the CMIE bit in RTSCR is set to 1, an interrupt request is sent to the controller by this match signal. The interrupt request is output continuously until the CMF bit in RTSCR is cleared. When the CMF bit clears, it only affects the interrupt; the refresh request is not cleared by this operation. When a refresh is performed and refresh requests are counted using interrupts, a refresh can be set simultaneously with the interval timer interrupt.

et4U.comBits 15 to 8—Reserved: These bits always read 0. The write value should always be 0.

7.3 Access Size and Data Alignment

7.3.1 Connection to Ordinary Devices

Byte, word, and longword are supported as access units. Data is aligned based on the data width of the device. Therefore, reading longword data from a byte-width device requires four read operations. The bus state controller automatically converts data alignment and data length between interfaces. The data width for external devices can be connected to either 8 bits, 16 bits or 32 bits by setting BCR2 (for the CS1–CS3 spaces) or using the mode pins (for the CS0 space). Since the data width of devices connected to the respective spaces is specified statically, however, the data width cannot be changed for each access cycle.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

Instruction fetches are always performed in 32-bit units. When branching to an odd word boundary (4n + 2 address), instruction fetches are performed in longword units from a 4n address. Figures 7.2 to 7.4 show the relationship between device data widths and access units.

A26–A0	D31	D23	D15	D7	D0	32-bit device data input/output pin
000000	7	0				Byte read/write of address 0
000001		7	0			Byte read/write of address 1
000002			7	0		Byte read/write of address 2
000003				7	0	Byte read/write of address 3
000000	15	8 7	0			Word read/write of address 0
000002			15	8 7	0	Word read/write of address 2
000000	31	24 23	16 15	8 7	0	Longword read/write of address 0

Figure 7.2 32-Bit External Devices and Their Access Units (Ordinary)

A26-A0D13D7D016-bit device data input/output pin000000 $\overline{7}$ 0Byte read/write of address 0000001 $\overline{7}$ 0Byte read/write of address 1000002 $\overline{7}$ 0Byte read/write of address 2000003 $\overline{7}$ 0Byte read/write of address 3000000150Word read/write of address 0000002150Word read/write of address 2000000150Longword read/write of address 2000000150Longword read/write of address 2	000001 000002 000003 000000 000002 000000
--	--

Figure 7.3 16-Bit External Devices and Their Access Units (Ordinary)

et4U.com					DataShee
	A26–A0	D7	D0	8-bit device data input/output pin	
	000000	7	0	Byte read/write of address 0	
	000001	7	0	Byte read/write of address 1	
	000002	7	0	Byte read/write of address 2	
	000003	7	0	Byte read/write of address 3	
	000000	15	8 \	-	
	000001	7	0 /	Word read/write of address 0	
	000002	15	8 \		
	000003	7	0 /	Word read/write of address 2	
	000000	31	24 \		
	000001	23	26		
	000002	15	8		
	000003	7	0 /	Longword read/write of address 0	
DataSheet4U.com	7 4 0 D'			www.Data	Sheet4U.c om

Figure 7.4 8-Bit External Devices and Their Access Units (Ordinary)

www.DataSheet4U.com 7.3.2 Connection to Little-Endian Devices

The SH7604 provides a conversion function in CS2 space for connection to and to maintain program compatibility with devices that use little-endian format (in which the LSB is the 0 position in the byte data lineup). When the endian specification bit of BCR1 is set to 1, CS2 space is little-endian. The relationship between device data width and access unit for little-endian format is shown in figures 7.5 and 7.6. When sharing memory or the like with a little-endian bus master, the SH7604 connects D31–D24 to the least significant byte of the other bus master and D7–D0 to the most significant byte, when the bus width is 32 bits. When the width is 16 bits, the SH7604 connects D15–D8 to the least significant byte of the other bus master and D7–D0 to the most significant byte.

When support software like the compiler or linker does not support switching, the instruction code and constants in the program do not become little-endian. For this reason, be careful not to place program code or constants in the CS2 space. When instructions or data in other CS spaces are used by transferring them to CS2 space with the SH7604, there is no problem because the SH7604 converts the endian format. Programs that are designed for use with little-endian format assume that the LSB is stored in the lowest address. Even when a program written in a high-level language like C is recompiled as is, it may not execute properly. The sign bit of signed 16-bit data at address 0 is stored at address 1 in little-endian format and at address 0 in big-endian format. It is possible to correctly execute a program written for little-endian format by allocating the program and constants to an area other than CS2 space and the data area to CS2 space. Note that the SH7604 does not support little-endian mode for devices with an 8-bit data bus width.

	A26–A0	D31	D23	D15	D7	D0	32-bit device data input/output pin	
	000000	7	0	I	I		Byte read/write of address 0	
et4U	.com000001		7	0			Byte read/write of address 1	DataShe
	000002			7	0		Byte read/write of address 2	
	000003				7	0	Byte read/write of address 3	
	000000	7	0 15	8			Word read/write of address 0	
	000002			7	0 15	8	Word read/write of address 2	
	000000	7	0 15	8 23	16 31	24	Longword read/write of address 0	
	1							

Figure 7.5 32-Bit External Devices and Their Access Units (Little-Endian Format)

DataSheet4U.com

150

www.DataSheet4U.com

A26–A0	D15	D7	D0	16-bit device data input/output pin
000000	7	0		Byte read/write of address 0
000001		7	0	Byte read/write of address 1
000002	7	0		Byte read/write of address 2
000003		7	0	Byte read/write of address 3
000000	7	0 15	8	Word read/write of address 0
000002	7	0 15	8	Word read/write of address 2
000000	7	0 15	8	
000002	23	16 31	24 /	Longword read/write of address 0

Figure 7.6 16-Bit External Devices and Their Access Units (Little-Endian Format)

Using the Little-Endian Function: The SH7604 normally uses big-endian alignment for data input and output, but an endian conversion function is provided for the CS2 space to enable connection to little-endian devices. The following two points should be noted when using this function:

- Little endian alignment should be used in the CS2 through-area.
- When data is shared with another little-endian device using this function, the same access size must be used by both. For example, to read data written in longword size by another little-endian device, the SH7604 must use longword read access.

7.4 Accessing Ordinary Space Sheet4U.com

7.4.1 Basic Timing

SRAM direct connections. Figure 7.7 shows the basic timing of ordinary space accesses. Ordinary accesses without waits end in 2 cycles. The BS signal is asserted for 1 cycle to indicate the start of the bus cycle. The CSn signal is negated by the fall of clock T2 to ensure the negate period. The negate period is thus half a cycle when accessed at the minimum pitch.

The access size is not specified during a read. The correct access start address will be output to the LSB of the address, but since no access size is specified, the read will always be 32 bits for 32-bit devices and 16 bits for 16-bit devices. For writes, only the \overline{WE} signal of the byte that will be written is asserted. For 32-bit devices, $\overline{WE3}$ specifies writing to a 4n address and $\overline{WE0}$ specifies writing to a 4n+3 address. For 16-bit devices, $\overline{WE1}$ specifies writing to a 2n address and $\overline{WE0}$ specifies writing to a 2n+1 address. For 8-bit devices, only $\overline{WE0}$ is used.

The RD signal must be used to control data output of external devices so that conflicts do not occur between trace information for emulators or the like output from the SH7604 and external DataSidevice read data. In other words, when data buses are provided with buffers, the RD DataSidevice read data output in the read direction. When RD/WR signals do not perform accesses, the

Renesas

www.DataSheet4U.com chip stays in read status, so there is a danger of conflicts occurring with output when this is used to

chip stays in read status, so there is a danger of conflicts occurring with output when this is used to control the external data buffer.

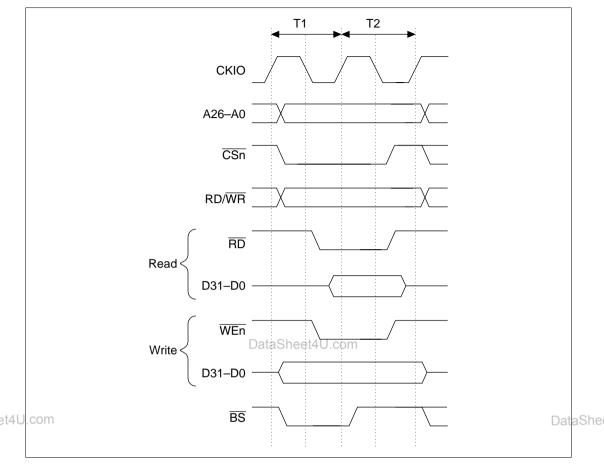


Figure 7.7 Basic Timing of Ordinary Space Access

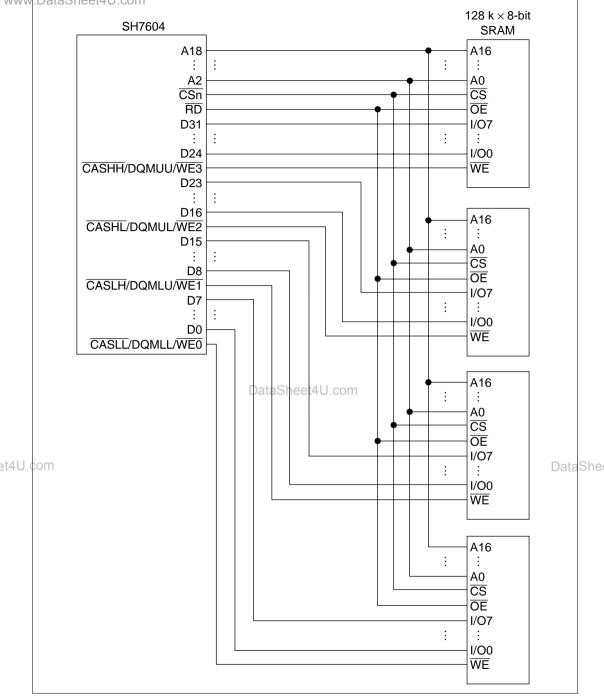
Figure 7.8 shows an example of a 32-bit data width SRAM connection, figure 7.9 a 16-bit data width SRAM connection, and figure 7.10 an 8-bit data width SRAM connection.

DataSheet4U.com

www.DataSheet4U.com

152 DataSheet4U.com

www.DataSheet4U.com



DataSheet4U.com Figure 7.8 Example of 32-Bit Data Width SRAM Connection DataSheet4U.com

www.DataSheet4U.com

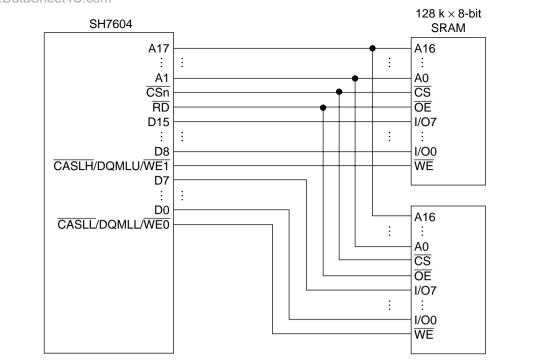


Figure 7.9 Example of 16-Bit Data Width SRAM Connection

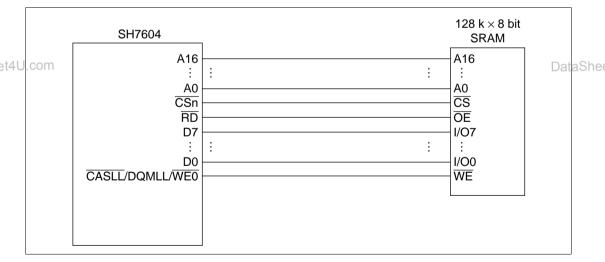


Figure 7.10 Example of 8-Bit Data Width SRAM Connection

DataSheet4U.com

www.DataSheet4U.com

154 DataSheet4U.com

www.DataSheet4U.com 7.4.2 Wait State Control

The number of wait states inserted into ordinary space access states can be controlled using the WCR and BCR1 register settings. When the Wn1 and Wn0 wait specification bits in WCR for the given CS space are 01 or 10, software waits are inserted according to the wait specification. When Wn1 and Wn0 are 11, wait cycles are inserted according to the long wait specification bit AnLW in BCR1. The long wait specification in BCR1 can be made independently for CS0 and CS1 spaces, but the same value must be specified for CS2 and CS3 spaces. All WCR specifications are independent. A Tw cycle as long as the number of specified cycles is inserted as a wait cycle at the wait timing for ordinary access space shown in figure 7.11.

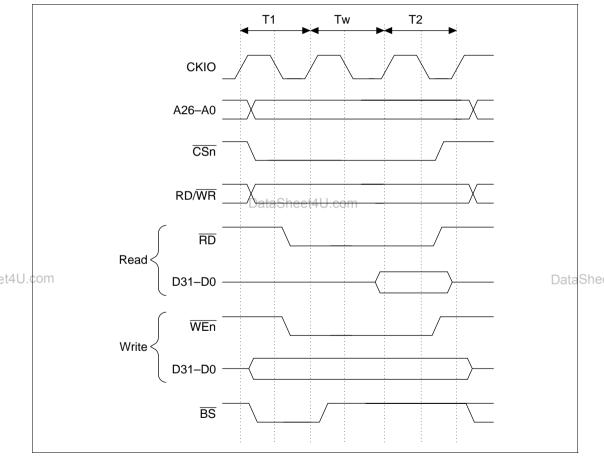


Figure 7.11 Wait Timing of Ordinary Space Access (Software Wait Only)

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com When the wait is specified by software using WCR, the wait input \overline{WAIT} signal from outside is sampled. Figure 7.12 shows \overline{WAIT} signal sampling. A 2-cycle wait is specified as a software wait. The sampling is performed when the Tw state shifts to the T2 state, so there is no effect even when the $\overline{\text{WAIT}}$ signal is asserted in the T1 cycle or the first Tw cycle. The $\overline{\text{WAIT}}$ signal is sampled at the clock rise. External waits should not be inserted, however, into word accesses of devices (such as ordinary space and burst ROM) that have an 8-bit bus width (byte-size devices). Control waits in such cases with software only.

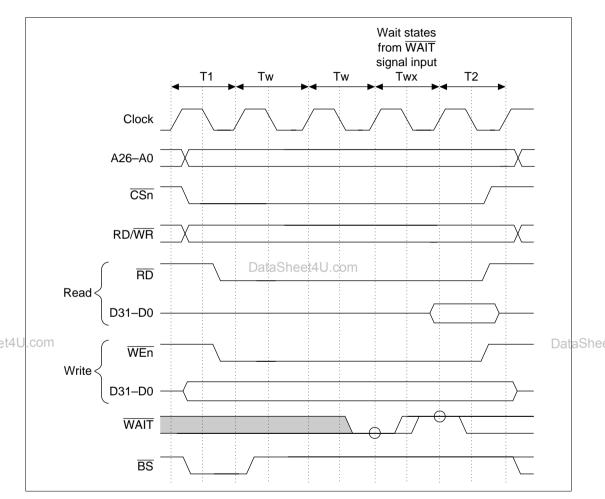


Figure 7.12 Wait State Timing of Ordinary Space Access (Wait States from WAIT Signal)

www.DataSheet4U.com

156 DataSheet4U.com

7.5.1 Synchronous DRAM Direct Connection

2-Mbit (128k × 16), 4-Mbit (256k × 16), and 16-Mbit (1M× 16, 2M× 8, and 4M× 4) synchronous DRAMs can be connected directly to the SH7604. All of these are internally divided into two banks. Since synchronous DRAM can be selected by the $\overline{\text{CS}}$ signal, areas CS2 and CS3 can be connected using a common $\overline{\text{RAS}}$ or other control signal. When the enable bits for DRAM and other memory (DRAM2–DRAM0) in BCR1 are set to 001, CS2 is ordinary space and CS3 is synchronous DRAM space. When set to 100, CS2 is synchronous DRAM space. When set to 101, both CS2 and CS3 are synchronous DRAM spaces.

The supported synchronous DRAM operating mode is for burst read and single write. The burst length depends on the data bus width, comprising 4 bursts for a 32-bit width, and 8 bursts for a 16-bit width. The data bus width is specified by the SZ bit in MCR. Burst operation is always performed, so the burst enable (BE) bit in MCR is ignored.

Control signals for directly connecting synchronous DRAM are the $\overline{RAS}/\overline{CE}$, $\overline{CAS}/\overline{OE}$, RD/\overline{WR} , $\overline{CS2}$ or $\overline{CS3}$, DQMUU, DQMUL, DQMLU, DQMLL, and CKE signals. Signals other than $\overline{CS2}$ and $\overline{CS3}$ are common to every area, and signals other than CKE are valid and fetched only when $\overline{CS2}$ or $\overline{CS3}$ is true. Therefore, synchronous DRAM of multiple areas can be connected in parallel. CKE is negated (to the low level); only when a self-refresh is performed otherwise it is asserted (to the high level). DataSheet4U.com

Commands can be specified for synchronous DRAM using the RAS/CE, CAS/OE, RD/WR, and certain address signals. These commands are NOP, auto-refresh (REF), self-refresh (SELF), all-bank precharge (PALL), specific bank precharge (PRE), row address strobe/bank active (ACTV), read (READ), read with precharge (READA), write (WRIT), write with precharge (WRITA), and taShe mode register write (MRS).

Bytes are specified using DQMUU, DQMUL, DQMLU, and DQMLL. The read/write is performed on the byte whose DQM is low. For 32-bit data, DQMUU specifies 4n address access and DQMLL specifies 4n + 3 address access. For 16-bit data, only DQMLU and DQMLL are used. Figure 7.13 shows an example in which a 32-bit connection uses a $256k \times 16$ bit synchronous DRAM. Figure 7.14 shows an example with a 16-bit connection.

DataSheet4U.com

www.DataSheet4U.com



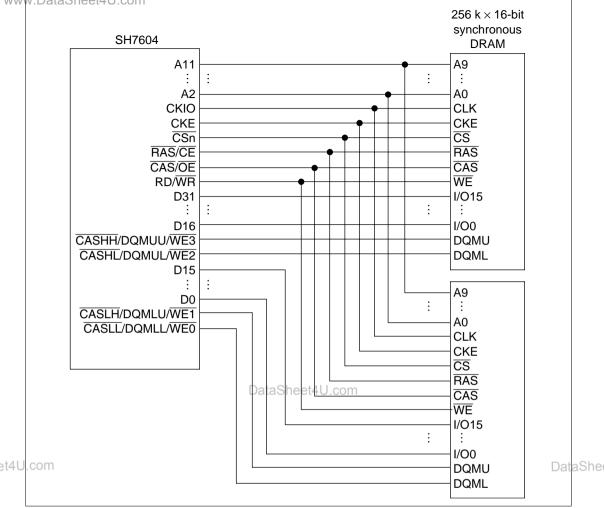
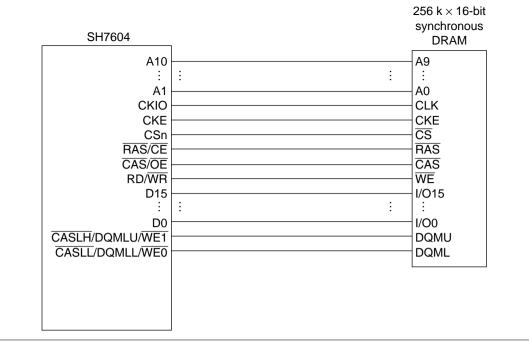


Figure 7.13 Synchronous DRAM 32-bit Device Connection

DataSheet4U.com

www.DataSheet4U.com

158 DataSheet4U.com





7.5.2 Address Multiplexing

DataSheet4U.com

Addresses are multiplexed according to the MCR's address multiplex specification bits AMX2– AMX0 and size specification bit SZ so that synchronous DRAMs can be connected directly at4U.cowithout an external multiplex circuit. Table 7.4 shows the relationship between the multiplex DataSho specification bits and bit output to the address pins.

A26–A14 and A0 always output the original value regardless of multiplexing.

When SZ = 0, the data width on the synchronous DRAM side is 16 bits and the LSB of the device's address pins (A0) specifies word address. The A0 pin of the synchronous DRAM is thus connected to the A1 pin of the SH7604, the rest of the connection proceeding in the same order, beginning with the A1 pin to the A2 pin.

When SZ = 1, the data width on the synchronous DRAM side is 32 bits and the LSB of the device's address pins (A0) specifies longword address. The A0 pin of the synchronous DRAM is thus connected to the A2 pin of the SH7604, the rest of the connection proceeding in the same order, beginning with the A1 pin to the A3 pin.

DataSheet4U.com

www.DataSheet4U.com

	S	etting			External Address Pins						
SZ	AMX2	AMX1	AMX0	Output Timing	A1–A8	A9	A10	A11	A12	A13	
1	0	0	0	Column address	A1–A8	A9	A10	A11	L/H*1	A21 ^{*2}	
				Row address	A9–A16	A17	A18	A19	A20	A21 ^{*2}	
1	0	0	1	Column address	A1–A8	A9	A10	A11	L/H*1	A22 ^{*2}	
				Row address	A10–A17	A18	A19	A20	A21	A22 ^{*2}	
1	0	1	0	Column address	A1–A8	A9	A10	A11	L/H*1	A23 ^{*2}	
				Row address	A11–A18	A19	A20	A21	A22	A23 ^{*2}	
1	0	1	1	Column address	A1–A8	A9	L/H*1	A19 ^{*2}	A12	A13	
				Row address	A9–A16	A17	A18	A19 ^{*2}	A20	A21	
1	1	1	1	Column address	A1–A8	A9	L/H*1	A18 ^{*2}	A12	A13	
				Row address	A9–A16	A17	A17	A18 ^{*2}	A20	A21	
0	0	0	0	Column address	A1–A8	A9	A10	L/H*1	A20 ^{*2}	A13	
				Row address	A9–A16	A17	A18	A19	A20 ^{*2}	A21	
0	0	1	1	Column address	A1–A8	L/H*1	A18 ^{*2}	A11	A12	A13	
				Row address	A9–A16	A17	A18 ^{*2}	A19	A20	A21	
0	1	1	1	Column address	A1–A8	L/H*1	A17 ^{*2}	A11	A12	A13	
				Row address	A9–A16	A16	A17 ^{*2}	A19	A20	A21	

vw_DataSheet4U.com Table 7.4 SZ and AMX Bits and Address Multiplex Output

AMX2–AMX0 settings of 100, 101 and 110 are reserved, so do not use them. When SZ = 0, the settings 001 and 010 are reserved as well, so do not use them either.

Notes: 1. L/H is a bit used to specify commands. It is fixed at L or H according to the access mode.

DataShe

2. Specifies bank address.

7.5.3 Burst Reads

Figure 7.15 shows the timing chart for burst reads. In the following example, 2 synchronous DRAMs of 256k × 16 bits are connected, the data width is 32 bits and the burst length is 4. After a Tr cycle that performs ACTV command output, a READA command is called in the Tc cycle and read data is accepted at internal clock falls from Td1 to Td4. Tap is a cycle for waiting for the completion of the auto-precharge based on the READA command within the synchronous DRAM. During this period, no new access commands are issued to the same bank. Accesses of the other bank of the synchronous DRAM by another CS space are possible. Depending on the TRP specification in MCR, the SH7604 determines the number of Tap cycles and does not issue a Data Scommand to the same bank during that period.

www.DataSheet4U.com Figure 7.15 shows an example of the basic cycle. Because a slower synchronous DRAM is connected, setting WCR and MCR bits can extend the cycle. The number of cycles from the ACTV command output cycle Tr to the READA command output cycle Tc can be specified by the RCD bit in MCR. 0 specifies 1 cycle; 1 specifies 2 cycles. For 2 cycles, a NOP command issue cycle Trw for the synchronous DRAM is inserted between the Tr cycle and the Tc cycle. The number of cycles between the READA command output cycle Tc and the initial read data fetch cycle Td1 can be specified independently for areas CS2 and CS3 between 1 cycle and 4 cycles using the W21/W20 and W31/W30 bits in WCR. The CAS latency when using bus arbitration in the partial-share master mode can be set differently for CS2 and CS3 spaces. The number of cycles at this time corresponds to the number of CAS latency cycles of the synchronous DRAM. When 2 cycles or more, a NOP command issue cycle Tw is inserted between the Tc cycle and the Td1 cycle. The number of cycles in the precharge completion waiting cycle Tap is specified by the TRP bit in MCR. When the CAS latency is 1, a Tap cycle of 1 or 2 cycles is generated. When the CAS latency is 2 or more, a Tap cycle equal to the TRP specification -1 is generated. During the Tap cycle, no commands other than NOP are issued to the same bank. Figure 7.16 shows an example of burst read timing when RCD is 1, W31/W30 is 01, and TRP is 1.

With the synchronous DRAM cycle, when the bus cycle starts in ordinary space access, the BS signal asserted for 1 cycle is asserted in each of cycles Td1–Td4 for the purpose of the external address monitoring described in the section on bus arbitration. When another CS space is accessed after an synchronous DRAM read with a wait-between-buses specification of 0, the BS signal may be continuously asserted. The address is updated every time data is fetched while burst reads are being performed. The burst transfer unit is 16 bytes, so address updating affects A3–A1. The access order follows the address order in 16-byte data transfers by the DMAC, but reading starts from the address + 4 so that the last missed data in the fill operation after a cache miss can be read.

When the data width is 16 bits, 8 burst cycles are required for a 16-byte data transfer. The data t^{4} U.Coffetch cycle goes from Td1 to Td8. From Td1 to Td8, the \overline{BS} signal is asserted in every cycle.

Synchronous DRAM CAS latency is up to 3 cycles, but the CAS latency of the bus state controller can be specified up to 4. This is so that circuits containing latches can be installed between synchronous DRAMs and the SH7604.

www.DataSheet4U.com



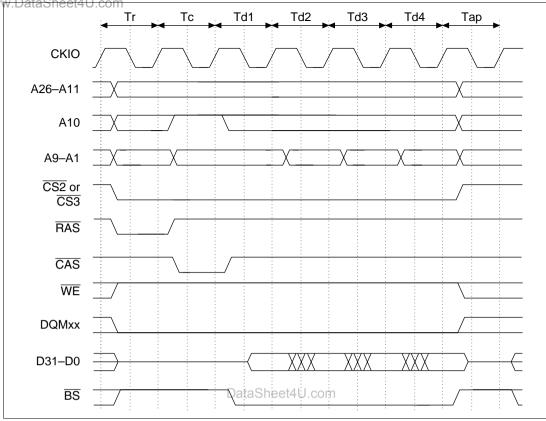


Figure 7.15 Basic Burst Read Timing (Auto-Precharge)

et4U.com

DataSheet4U.com

www.DataSheet4U.com

162 DataSheet4U.com



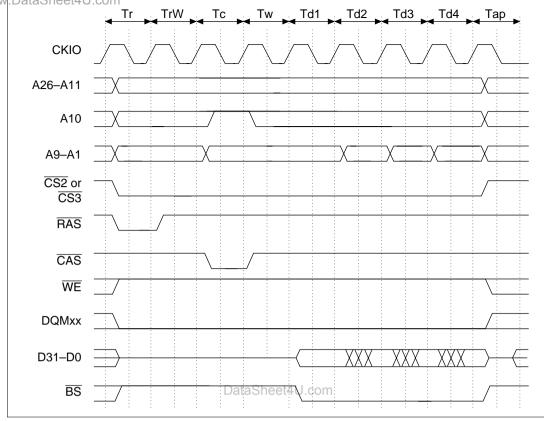


Figure 7.16 Burst Read Wait Specification Timing (Auto-Precharge)

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

When a cache area is accessed and there is a cache miss, the cache fill cycle is performed in 16byte units. This means that all the data read in the burst read is valid. Since the required data when a cache-through area is accessed has a maximum length of 32 bits, however, the remaining 12 bytes are wasted. The same kind of wasted data access is produced when synchronous DRAM is specified as the source in a DMA transfer by the DMAC and the transfer unit is other than 16 bytes. Figure 7.17 shows the timing of a single address read. Because the synchronous DRAM is set to the burst read/single write mode, the read data output continues after the required data is received. To avoid data conflict, an empty read cycle is performed from Td2 to Td4 after the required data is read in Td1 and the device waits for the end of synchronous DRAM operation. In this case, data is only fetched in Td1, so the BS signal is asserted for Td1 only.

When the data width is 16 bits, the number of burst transfers during a read is 8. BS is asserted and data fetched in cache-through and other DMA read cycles only in the Td1 and Td2 cycles (of the 8 cycles from Td1 to Td8) for longword accesses, and only in the Td1 cycle for word or byte accesses.

Empty cycles tend to increase the memory access time, lower the program execution speed, and lower the DMA transfer speed, so it is important to avoid accessing unnecessary cache-through areas and to use data structures that enable 16-byte unit transfers by placing data on 16-byte boundaries when performing DMA transfers that specify synchronous DRAM as the source.

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

164 DataSheet4U.com

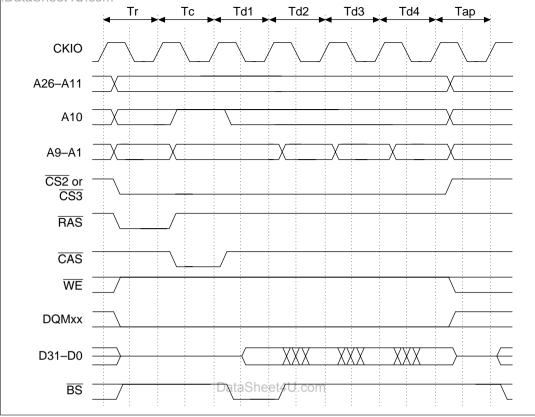


Figure 7.17 Single Read Timing (Auto-Precharge)

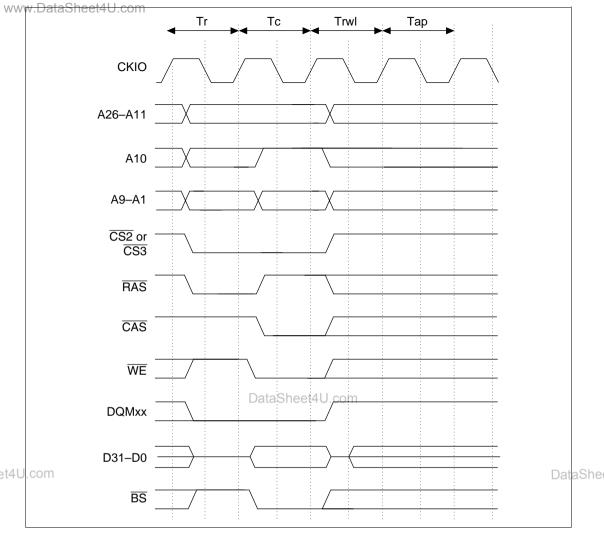
DataShe

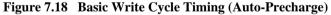
et4U.com 7.5.5 Writes

Unlike synchronous DRAM reads, synchronous DRAM writes are single writes. Figure 7.18 shows the basic timing chart for write accesses. After the ACTV command Tr, a WRITA command is issued in Tc to perform an auto-precharge. In the write cycle, the write data is output simultaneously with the write command. When writing with an auto-precharge, the bank is precharged after the completion of the write command within the synchronous DRAM, so no command can be issued to that bank until the precharge is completed. For that reason, besides a cycle Tap to wait for the precharge during read accesses, the issuing of any new commands to the same bank during this period is delayed by adding a cycle Trw1 to wait until the precharge is started. The number of cycles in the Trw1 cycle can be specified using the TRWL bit in MCR.

DataSheet4U.com

www.DataSheet4U.com





7.5.6 Bank Active Function

A synchronous DRAM bank function is used to support high-speed accesses of the same row address. When the RASD bit in MCR is set to 1, read/write accesses are performed using commands without auto-precharge (READ, WRIT). In this case, even when the access is completed, no precharge is performed. When accessing the same row address in the same bank, a READ or WRIT command can be called immediately without calling an ACTV command, just like the RAS down mode of the DRAM's high-speed page mode. Synchronous DRAM is divided Data Sinto two banks, so one row address in each can stay active. When the next access is to a offerent row address, a PRE command is called first to precharge the bank, and access is performed by an

166 DataSheet4U.com

www.DataSheet4U.com ACTV command and READ or WRIT command, in that order, after the precharge is completed. With successive accesses to different row addresses, the precharge is performed after the access request occurs, so the access time is longer. When writing, performing an auto-precharge means that no command can be called for $t_{RWL} + t_{AP}$ cycles after a WRITA command is called. When the bank active mode is used, READ or WRIT commands can be issued consecutively if the row address is the same. This shortens the number of cycles by $t_{RWL} + t_{AP}$ for each write. The number of cycles between the issue of the precharge command and the row address strobe command is determined by the TRP bit in MCR.

Whether execution is faster when the bank active mode is used or when basic access is used is determined by the proportion of accesses to the same row address (P1) and the average number of cycles from the end of one access to the next access (t_A) . When tA is longer than t_{AP} , the delay waiting for the precharge during a read becomes invisible. If t_A is longer than $t_{RWL} + t_{AP}$, the delay waiting for the precharge also becomes invisible during writes. The difference between the bank active mode and basic access speeds in these cases is the number of cycles between the start of access and the issue of the read/write command: $(t_{RP} + t_{RCD}) \times (1 - P1)$ and t_{RCD} , respectively.

The time that a bank can be kept active, t_{RAS} , is limited. When it is not assured that this period will be provided by program execution and that another row address will be accessed without a hit to the cache, the synchronous DRAM must be set to auto-refresh and the refresh cycle must be set to the maximum value t_{RAS} or less. This enables the limit on the maximum active period for each bank to be ensured. When auto-refresh is not being used, some measure must be taken in the program to ensure that the bank does not stay active for longer than the prescribed period.

Figure 7.19 shows a burst read cycle that is not an auto-precharge cycle, figure 7.20 shows a burst read cycle to a same row address, figure 7.21 shows a burst read cycle to different row addresses, figure 7.22 shows a write cycle without auto-precharge, figure 7.23 shows a write cycle to a same tashe row address, and figure 7.24 shows a write cycle to different row addresses.

In figure 7.20, a cycle that does nothing, Tnop, is inserted before the Tc cycle that issues the READ command. Synchronous DRAMs, however, have a 2 cycle latency during reads for the DQMxx signals that specify bytes. If the Tc cycle is performed immediately without inserting a Thop cycle, the DQMxx signal for the Td1 cycle data output cannot be specified. This is why the Thop cycle is inserted. When the CAS latency is 2 or more, the Thop cycle is not inserted so that timing requirements will be met even when a DQMxx signal is set after the Tc cycle.

When the SH7604 is set to the bank active mode, the access will start with figure 7.19 or figure 7.22 and repeat figure 7.20 or figure 7.23 for as long as the same row address continues to be accessed when only accesses to the respective banks of the CS3 space are considered. Accesses to other CS spaces during this period have no effect. When an access occurs to a different row address while the bank is active, figure 7.21 or figure 7.24 will be substituted for figures 7.20 and 1. com

7.23 after this is detected. Both banks will become inactive even in the bank active mode after the refresh cycle ends or after the bus is released by bus arbitration.



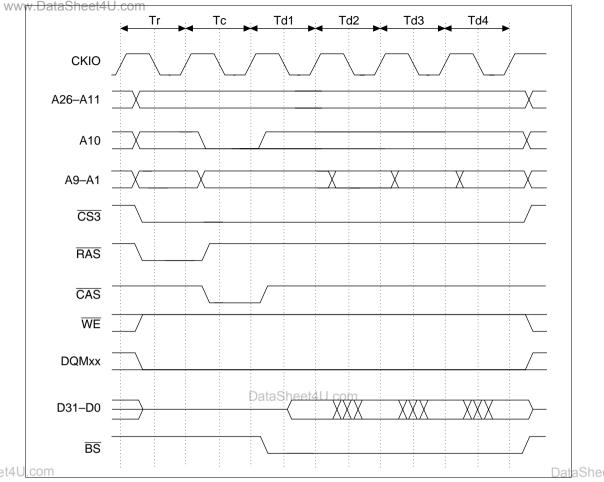


Figure 7.19 Burst Read Timing (No Precharge)

DataSheet4U.com

www.DataSheet4U.com

168 DataSheet4U.com



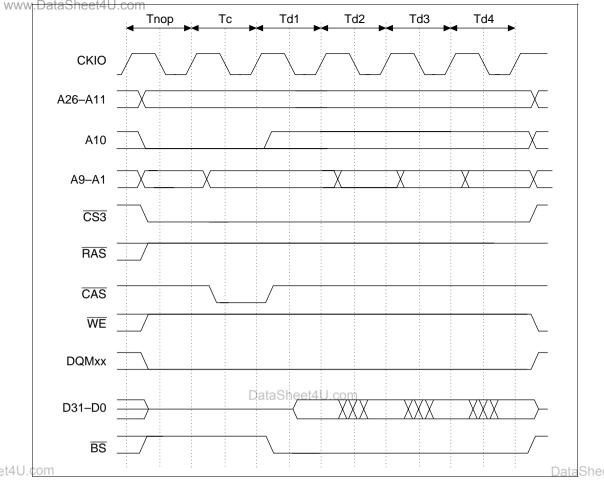


Figure 7.20 Burst Read Timing (Bank Active, Same Row Address)

DataSheet4U.com

www.DataSheet4U.com



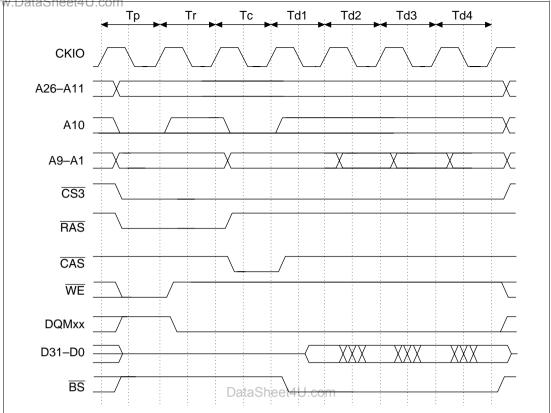


Figure 7.21 Burst Read Timing (Bank Active, Different Row Addresses)

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

170 DataSheet4U.com

www.DataSheet4U.com

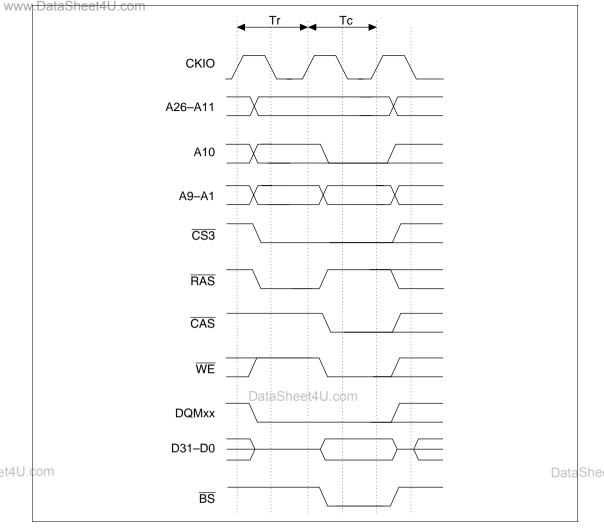


Figure 7.22 Write Timing (No Precharge)

DataSheet4U.com

www.DataSheet4U.com

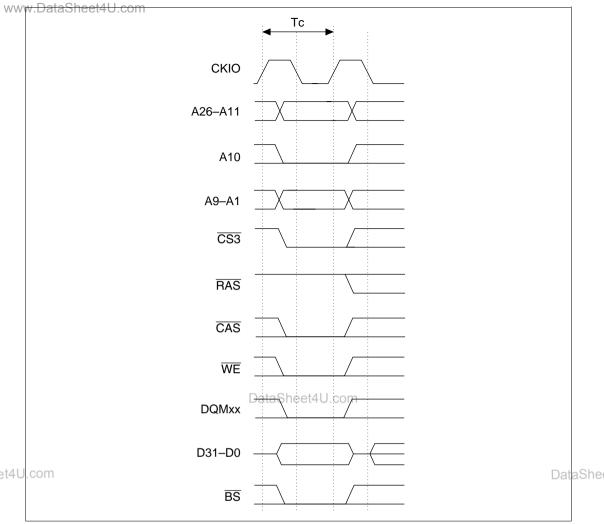


Figure 7.23 Write Timing (Bank Active, Same Row Address)

DataSheet4U.com

www.DataSheet4U.com

172 DataSheet4U.com

www.DataSheet4U.com

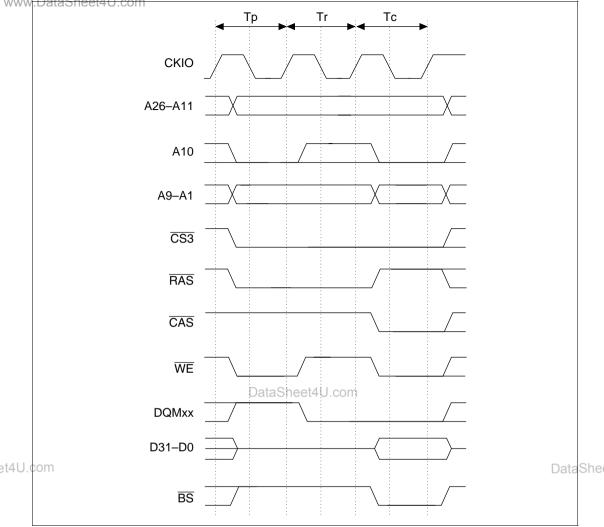


Figure 7.24 Write Timing (Bank Active, Different Row Addresses)

DataSheet4U.com

www.DataSheet4U.com

The bus state controller is equipped with a function to control refreshes of synchronous DRAM. Auto-refreshes can be performed by setting the MCR's RMD bit to 0 and the RFSH bit to 1. When the synchronous DRAM is not accessed for a long period of time, set the RFSH bit and RMODE bit both to 1 to initiate self-refresh mode, which uses low power consumption to retain data.

Auto-Refresh: Refreshes are performed at the interval determined by the input clock selected by the CKS2–CKS0 bits in RTCSR and the value set in RTCOR. Set the CKS2–CKS0 bits and RTCOR so that the refresh interval specifications of the synchronous DRAM being used are satisfied. First, set RTCOR, RTCNT and the RMODE and RFSH bits in MCR, then set the CKS2–CKS0 bits. When a clock is selected with the CKS2–CKS0 bits, RTCNT starts counting up from the value at that time. The RTCNT value is constantly compared to the RTCOR value and a request for a refresh is made when the two match, starting an auto-refresh. RTCNT is cleared to 0 at that time and the count up starts again. Figure 7.25 shows the timing for the auto-refresh cycle.

First, a PALL command is issued during the Tp cycle to change all the banks from active to precharge states. A REF command is then issued in the Trr cycle. After the Trr cycle, no new commands are output for the number of cycles specified in the TRAS bit in MCR + 2 cycles. The TRAS bit must be set to satisfy the refresh cycle time specifications (active/active command delay time) of the synchronous DRAM. When the MCR's TRP bit is 1, an NOP cycle is inserted between the Tp cycle and Trr cycle.

During a manual reset, no refresh request is issued, since there is no RTCNT count-up. To perform a refresh properly, make the manual reset period shorter than the refresh cycle interval and set RTCNT to (RTCOR -1) so that the refresh is performed immediately after the manual reset is cleared.

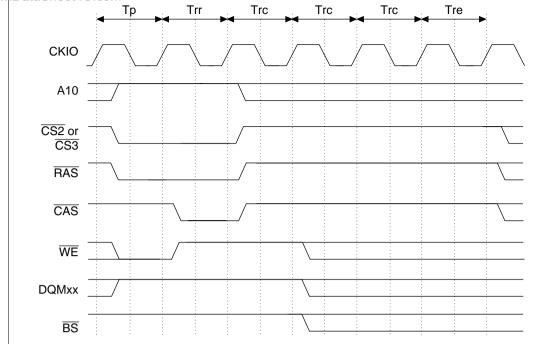
t4U.com

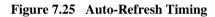
DataShe

DataSheet4U.com

www.DataSheet4U.com







Self-Refreshes: The self-refresh mode is a type of standby mode that produces refresh timing and refresh addresses within the synchronous DRAM. It is started up by setting the RMODE and RFSH bits to 1. The synchronous DRAM is in self-refresh mode when the CKE signal level is low. During the self-refresh, the synchronous DRAM cannot be accessed. To clear the self-refresh, etal. Coset the RMODE bit to 0. After self-refresh mode is cleared, issuing of commands is prohibited for ta She the number of cycles specified in the MCR's TRAS bit + 1 cycle. Figure 7.26 shows the self-refresh timing. Immediately set the synchronous DRAM so that the auto-refresh is performed in the correct interval. This ensures a correct self-refresh clear and data holding. When self-refresh mode is entered while the synchronous DRAM is set for auto-refresh or when leaving the standby mode with a manual reset or NMI, auto-refresh can be re-started if RFSH is 1 and RMODE is 0 when the self-refresh mode is cleared. When time is required between clearing the self-refresh mode and starting the auto-refresh mode, this time must be reflected in the initial RTCNT setting. When the RTCNT value is set to RTCOR – 1, the refresh can be started immediately.

If the standby function of the SH7604 is used after the self-refresh is set to enter the standby mode, the self-refresh state continues; the self-refresh state will also be maintained after returning from a standby using an NMI.

A manual reset cannot be used to exit the self-refresh state either. During a power-on reset the bus com state controller register is initialized, so the self-refresh state is ended.

www.DataSheet4U.com

Refresh Requests and Bus Cycle Requests: When a refresh request occurs while a bus cycle is executing, the refresh will not be executed until the bus cycle is completed. When a refresh request occurs while the bus is released using the bus arbitration function, the refresh will not be executed until the bus is recaptured. If RTCNT and RTCOR match and a new refresh request occurs while waiting for the refresh to execute, the previous refresh request is erased. To make sure the refresh executes properly, be sure that the bus cycle and bus capture do not exceed the refresh interval.

If a bus arbitration request occurs during a self-refresh, the bus is not released until the self-refresh is cleared. During a self-refresh, the slave chips halt if there is a master-slave structure.

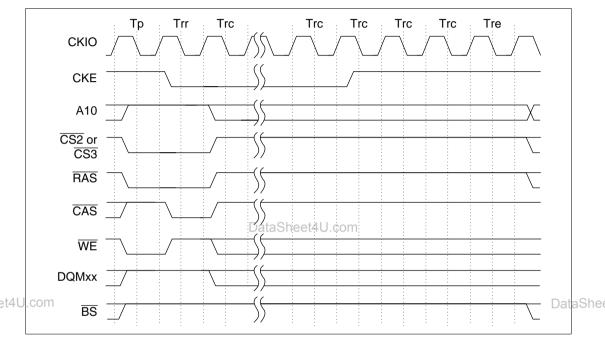


Figure 7.26 Self-Refresh Timing

DataSheet4U.com

www.DataSheet4U.com

176 DataSheet4U.com

To use synchronous DRAM, the mode must first be set after the power is turned on. To properly initialize the synchronous DRAM, the synchronous DRAM mode register must be written to after the registers of the bus state controller have first been set. The synchronous DRAM mode register is set using a combination of the $\overline{RAS}/\overline{CE}$, $\overline{CAS}/\overline{OE}$ and RD/\overline{WR} signals. They fetch the value of the address signal at that time. If the value to be set is X, the bus state controller operates by writing to address X + HTFFF8000 from the CPU, which allows the value X to be written to the synchronous DRAM mode register. Data is ignored at this time, but the mode is written using word as the size. Write any data in word size to the following addresses to select the burst read single write supported by the SH7604, a CAS latency of 1 to 3, a sequential wrap type, and a burst length of 8 or 4 (depending on whether the width is 16 bits or 32 bits).

For 16 bits:	CAS latency 1	H'FFFF8426
	CAS latency 2	H'FFFF8446
	CAS latency 3	H'FFFF8466
For 32 bits:	CAS latency 1	H'FFFF8848
	CAS latency 2	H'FFFF8888
	CAS latency 3	H'FFFF88C8

Figure 7.27 shows the mode register setting timing.

Writing to address X + H'FFFF8000 first issues an all-bank precharge command (PALL) in the Tp cycle, then issues a mode register write command in the Tmw cycle. When the TRP bit in MCR is set to 1, a single idle cycle is inserted between the Tp cycle and the Tmw cycle.

Before setting the mode register, an idle time of 100 µs (differs by memory manufacturer) must be assured after the power required by the synchronous DRAM is turned on. When the pulse width of the reset signal is longer than the idle time, the mode register may be set immediately without problem. At least the number of dummy auto-refresh cycles specified by the manufacturer (usually 8 must be executed). After setting auto-refresh, it is usual for this to occur naturally during the various initializations, but to make sure, the interval at which refresh requests are generated can be shortened only while the dummy cycles are executing. Because the address counter within the synchronous DRAM is not initialized when auto-refresh is used during single read or write accesses, an auto-refresh cycle must always be used.

DataSheet4U.com

www.DataSheet4U.com

Renesas

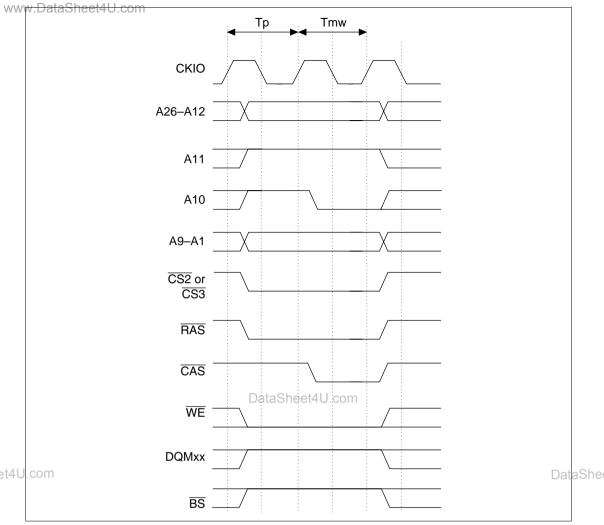


Figure 7.27 Synchronous DRAM Mode Write Timing

DataSheet4U.com

www.DataSheet4U.com

178 DataSheet4U.com

The signals for synchronous DRAM interfaces change in the SH7604 at the rising edge of the internal clock. Read data is fetched on the falling edge of an internal clock. Sampling of the signals input by the synchronous DRAM and output of the read data, however, starts at the rising edge of the external clock (figure 7.28).

When the internal clock of the SH7604 and external clock are synchronized, signal transmission from the SH7604 to the synchronous DRAM has a 1 cycle margin. The transmission of read data from the synchronous DRAM to the SH7604, however, is much tighter: only 1/2 cycle, including the synchronous DRAM access time. When a clock system is connected without a means of synchronization such as an on-chip PLL, transmission from the SH7604 to the synchronous DRAM takes 1 cycle less the delay time of the clock system and transmission from the synchronous DRAM to the SH7604 takes 1/2 cycle plus the clock system delay time. The clock system delay time depends on the power supply voltage, temperature, and manufacturing variance, so it has a fairly wide range. When the phase of the internal clock of the SH7604 is delayed using a PLL that delays the phase 90 degrees relative to external clocks, transmission from the SH7604 to the synchronous DRAM and transmission from the SH7604 to the synchronous DRAM and transmission from the SH7604 to the synchronous DRAM access the degrees relative to external clocks, transmission from the SH7604 to the synchronous DRAM and transmission from the SH7604 to the synchronous DRAM each take 3/4 cycle.

Given this, using a clock whose phase is shifted 90 degrees from the external clock using a PLL as the internal clock can ensure a margin of safety.

When using a PLL, it is important to note that synchronous DRAM does not contain an on-chip PLL. When using the external clock input clock mode, instability in the clock supplied from outside can cause shifts in phase, so a synchronization settling time in the SH7604's on-chip PLL is needed to equalize the SH7604's internal clock and the external clock. During this
et4U.cosynchronization settling time, the internal clock of the synchronous DRAM and the internal clockate of the SH7604 will not always operate in perfect synchronization. To ensure the synchronous DRAM and SH7604 operate properly, be sure that the external clock supplied is not unstable.

DataSheet4U.com

www.DataSheet4U.com

v.DataSheet4U.com WW

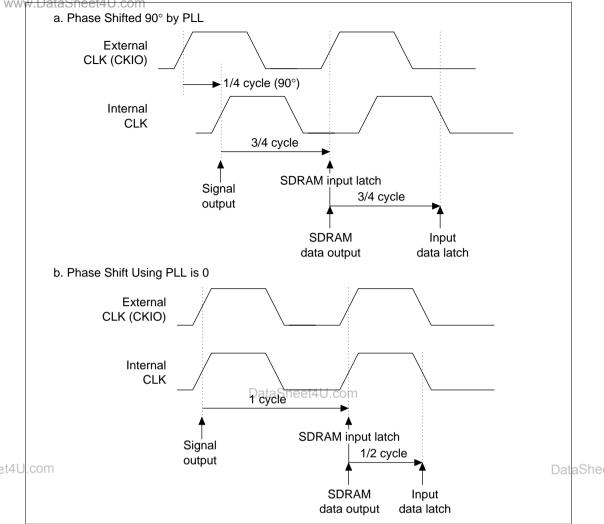


Figure 7.28 Phase Shift by PLL

DataSheet4U.com

www.DataSheet4U.com

180 DataSheet4U.com



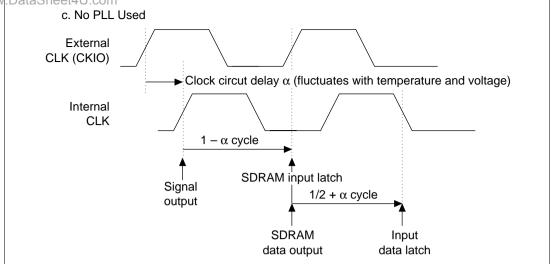


Figure 7.28 Phase Shift by PLL (cont)

7.6 DRAM Interface

7.6.1 DRAM Direct Connection

When the DRAM and other memory enable bits (DRAM2–DRAM0) in BCR1 are set to 010, the CS3 space becomes DRAM space, and a DRAM interface function can be used to directly connect the SH7604 to DRAM.

t4U.coThe data width of an interface can be 16 or 32 bits (figures 7.29 and 7.30). Two-CAS 16-bit DRAMs can be connected, since CAS is used to control byte access. The RAS, CASHH, CASHL, CASHL, CASLH, CASLL, and RD/WR signals are used to connect the DRAM. When the data width is 16 bits, CASHH, and CASHL are not used. In addition to ordinary read and write access, burst access using high-speed page mode is also supported.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

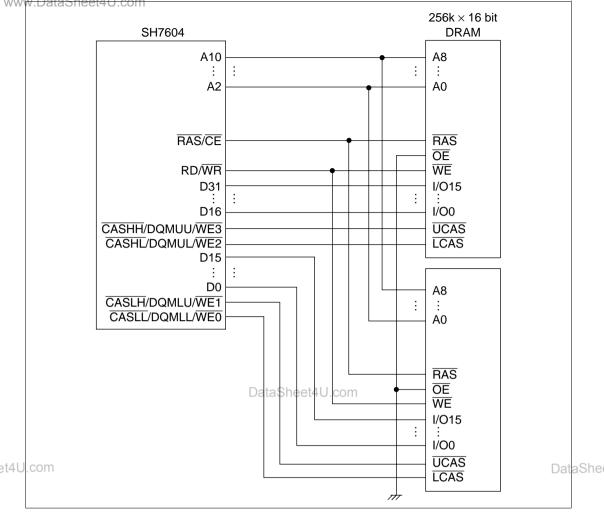


Figure 7.29 Example of DRAM Connection (32-Bit Data Width)

DataSheet4U.com

www.DataSheet4U.com

182 DataSheet4U.com

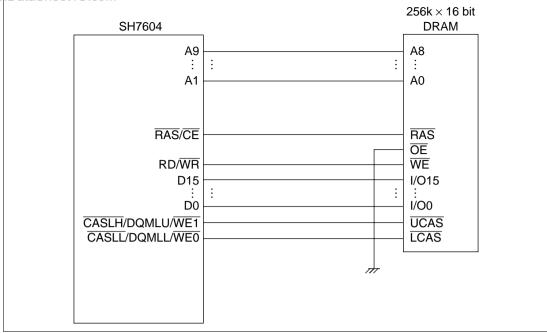


Figure 7.30 Example of DRAM Connection (16-Bit Data Width)

7.6.2 Address Multiplexing DataSheet4U.com

When the CS3 space is set to DRAM, addresses are always multiplexed. This allows DRAMs that require multiplexing of row and column addresses to be connected directly to SH7604 microprocessors without additional multiplexing circuits. There are four ways of multiplexing, DataShee which can be selected using the MCR's AMX1–AMX0 bits. Table 7.5 illustrates the relationship between the AMX1–AMX0 bits and address multiplexing. Address multiplexing is performed on address output pins A13–A1. The original addresses are output to pins A26–A14. During DRAM accesses, AMX2 is reserved, so set it to 0.

AMX0	No. of Column Address Bits	Row Address Output	Column Address Output
0	8 bits	A21–A9	A13–A1
1	9 bits	A22–A10	A13–A1
0	10 bits	A23–A11	A13–A1
1	11 bits	A24–A12	A13–A1
	0 1	AMX0Address Bits08 bits19 bits010 bits	AMX0Address BitsAddress Output08 bitsA21–A919 bitsA22–A10010 bitsA23–A11

Table 7.5 Relationship between AMX1–AMX0 and Address Multiplexing

DataSheet4U.com

www.DataSheet4U.com

The basic timing of a DRAM access is 3 cycles. Figure 7.31 shows the basic DRAM access timing. Tp is the precharge cycle, Tr is the RAS assert cycle, Tc1 is the CAS assert cycle, and Tc2 is the read data fetch cycle. When accesses are consecutive, the Tp cycle of the next access overlaps the Tc2 cycle of the previous access, so accesses can be performed in a minimum of 3 cycles each.

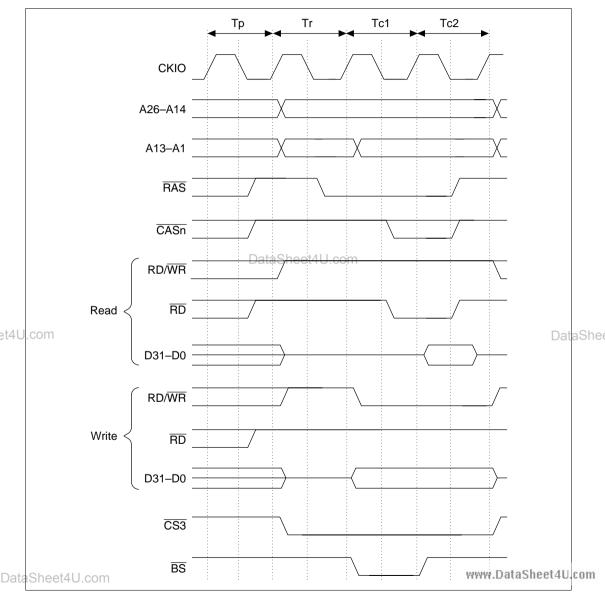
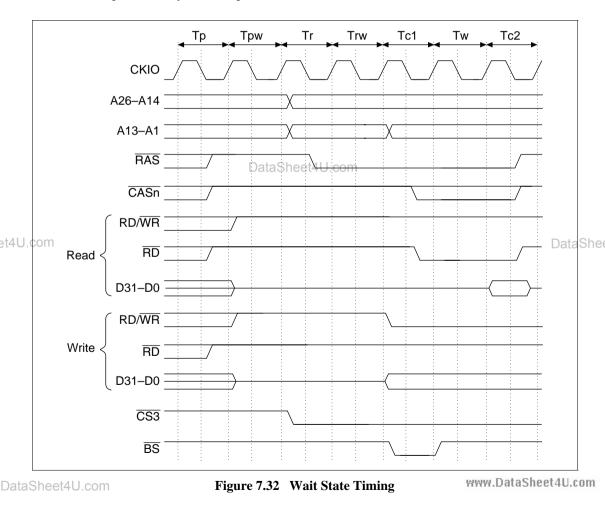


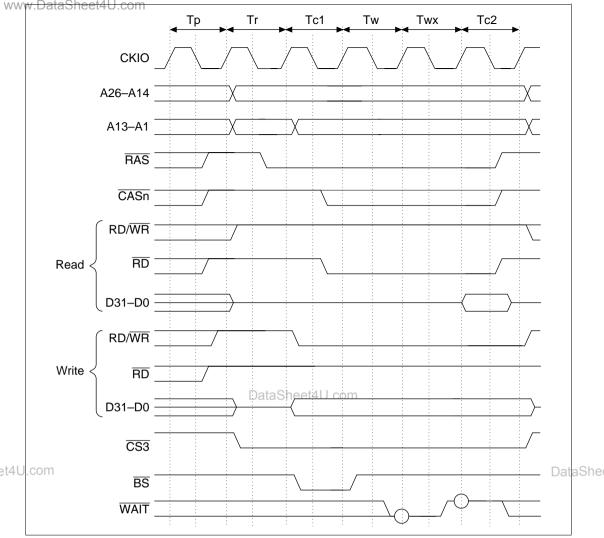
Figure 7.31 Basic Access Timing

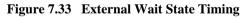
184 DataSheet4U.com

www.DataSheet4U.com 7.6.4 Wait State Control

When the clock frequency is raised, 1 cycle may not always be sufficient for all states to end, as in basic access. Setting bits in WCR and MCR enables the state to be lengthened. Figure 7.32 shows an example of lengthening a state using settings. The Tp cycle (which ensures a sufficient RAS precharge time) can be extended to 2 cycles by insertion of a Tpw cycle by means of the TRP bit in MCR. The number of cycles between RAS assert and CAS assert can be extended to 2 cycles by inserting a Trw cycle by means of the RCD bit in MCR. The number of cycles from CAS assert to the end of access can be extended from 1 cycle to 3 cycles by setting the W31/W30 bits in WCR. When a value other than 00 is set in W31 and W30, the external wait pin WAIT is also sampled, so the number of cycles is further increased. Figure 7.33 shows the timing of wait state control using the WAIT pin. In either case, when consecutive accesses occur, the Tp cycle of one access overlaps the Tc2 cycle of the previous access.







7.6.5 **Burst Access**

In addition to the ordinary mode of DRAM access, in which row addresses are output at every access and data is then accessed, DRAM also has a high-speed page mode for use when continuously accessing the same row that enables fast access of data by changing only the column address after the row address is output. Select ordinary access or high-speed page mode by setting the burst enable bit (BE) in MCR. Figure 7.34 shows the timing of burst operation in high-speed Data page mode. When performing burst access, cycles can be inserted using the wait state. ContarSheet 4U.com

function.

186

RENESAS

DataSheet4U.com

www.DataSheet4U.com The SH7604 has an address comparator to detect matches of row addresses in burst mode. When this function is used and the BE bit in MCR is set to 1, setting the MCR's RASD bit (which specifies RAS down mode) to 1 places the SH7604 in RAS down mode, which leaves the RAS signal asserted. Since the CASHH, CASHL, CASLH and CASLL signals are shared with WE3, $\overline{WE2}$, $\overline{WE1}$ and $\overline{WE0}$ of ordinary space, however, write cycles to ordinary space during RAS down mode will simultaneously initiate an erroneous write access to the DRAM. This means that when no external devices that write to other than DRAM are connected, a DRAM can be directly interfaced using RAS down mode. When RAS down mode is used, the refresh cycle must be less than the maximum DRAM RAS assert time t_{RAS} when the refresh cycle is longer than the t_{RAS} maximum.

When an external circuit is added to keep the CASHH, CASHL, CASLH, and CASLL signals connected to the DRAM asserted only when the $\overline{CS3}$ level is low, there are no restrictions on the use of RAS down mode.

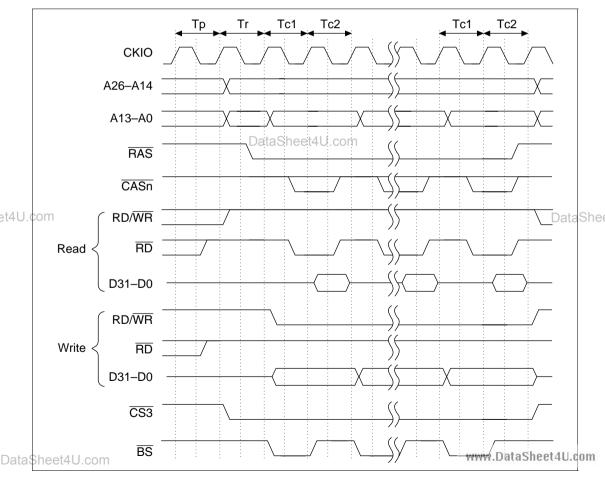
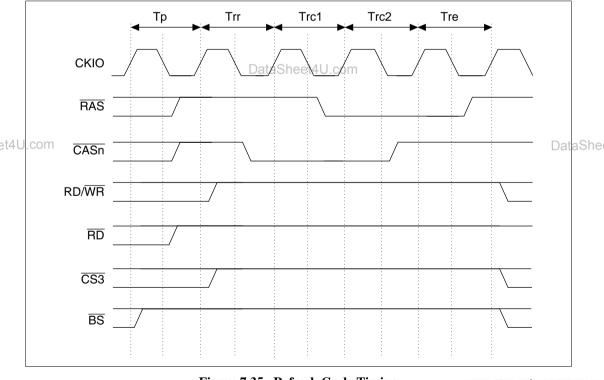


Figure 7.34 Burst Access Timing

The BSC has a function for controlling DRAM refreshes. By setting the MCR's RMODE bit to 0 and RFSH bit to 1, distributed refreshing using the CAS-before-RAS refresh cycle can be performed.

Refreshes are performed at the interval determined by the input clock selected with CKS2–CKS0 in RTCSR and the value set in RTCOR. Set the values of RTCOR and CKS2–CKS0 so they satisfy the refresh interval specifications of the DRAM being used. First, set RTCOR, RTCNT and the RMODE and RFSH bits in MCR, then set the CKS2–CKS0 bits. When a clock is selected with the CKS2–CKS0 bits, RTCNT starts counting up from the value at that time. The RTCNT value is constantly compared to the RTCOR value and a request for a refresh is made when the two match, starting a CAS-before-RAS refresh. RTCNT is cleared to 0 at that time and the count up starts again. Figure 7.35 shows the timing for the CAS-before-RAS refresh cycle.

The number of RAS assert cycles in the refresh cycle is specified by the TRAS bit in MCR. As with ordinary accesses, the specification of the RAS precharge time in refresh cycles follows the setting of the TRP bit in MCR.



DataSheet4U.com

Figure 7.35 Refresh Cycle Timing

www.DataSheet4U.com

188

DataSheet4U.com

When DRAM is used after the power is turned on, there is a requirement for a waiting period during which accesses cannot be performed (100 μ s or 200 μ s minimum) followed by the prescribed number of dummy CAS-before-RAS refresh cycles (usually 8). The bus state controller does not perform any special operations for the power-on reset, so the required power-on sequence must be implemented by the initialization program executed after a power-on reset.

7.7 Pseudo-SRAM Interface

7.7.1 Pseudo-SRAM Direct Connection

When the DRAM and other memory enable bits (DRAM2–DRAM0) in BCR1 are set to 011, the CS3 space becomes pseudo-SRAM space, and the pseudo-SRAM interface function can be used to directly connect the SH7604 to pseudo-SRAM. The interface data width is 16 or 32 bits.

The refresh and output enable signals of the connected pseudo-SRAM are multiplexed. The signals used for connecting pseudo-SRAM are the \overline{CE} , \overline{OE} , $\overline{WE3}$, $\overline{WE2}$, $\overline{WE1}$, and $\overline{WE0}$ signals. The $\overline{WE3}$ and $\overline{WE2}$ signals are not used when the data width is 16 bits. When non-multiplexed pseudo-SRAM is connected, the \overline{RD} signal is also used.

In addition to ordinary read and write access, burst access using the static column access function is also supported. Figure 7.36 shows an example of connections to 1-M pseudo-SRAM with separate \overrightarrow{OE} and \overrightarrow{RFSH} pins; figure 7.37 shows an example of connections to 4-M pseudo-SRAM with multiplexed $\overrightarrow{OE/RFSH}$ pins. 256-k pseudo-SRAM is multiplexed in the same way as 4-M pseudo-SRAM. All data widths are 32 bits.

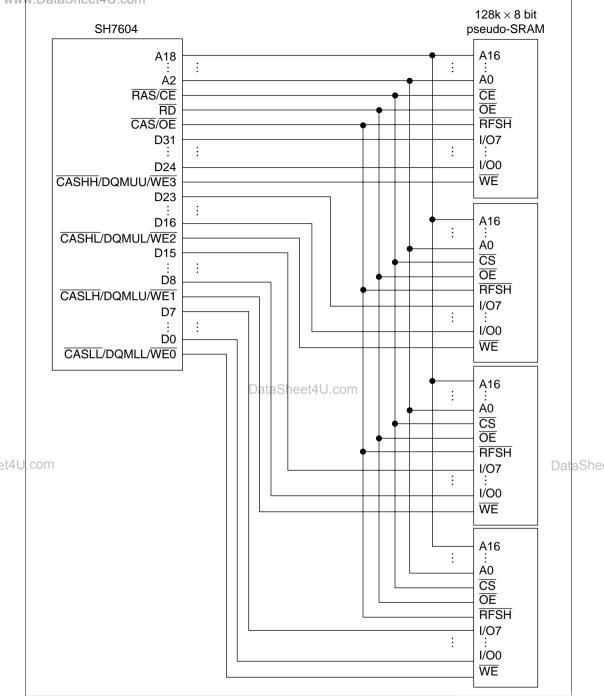
t4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com



DataSheet4UFigure 7.36 Example of Pseudo-SRAM Connection (1-Mbit Pseudo-SRAM)

RENESAS

DataSheet4U.com

190

www.DataSheet4U.com

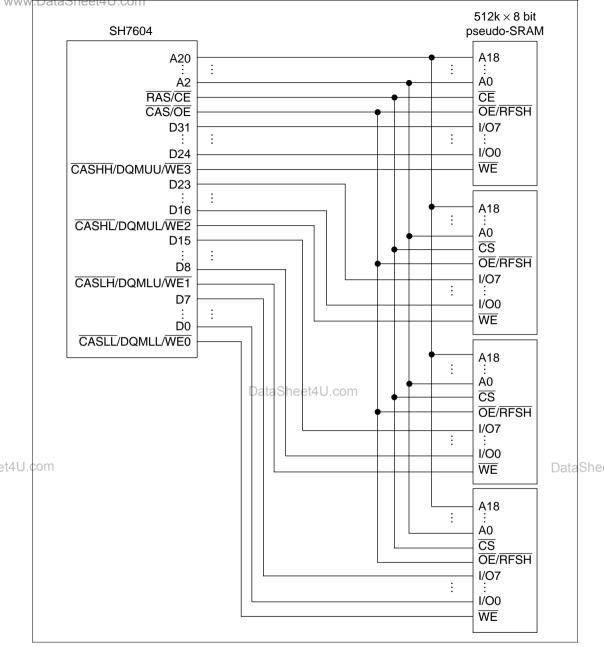
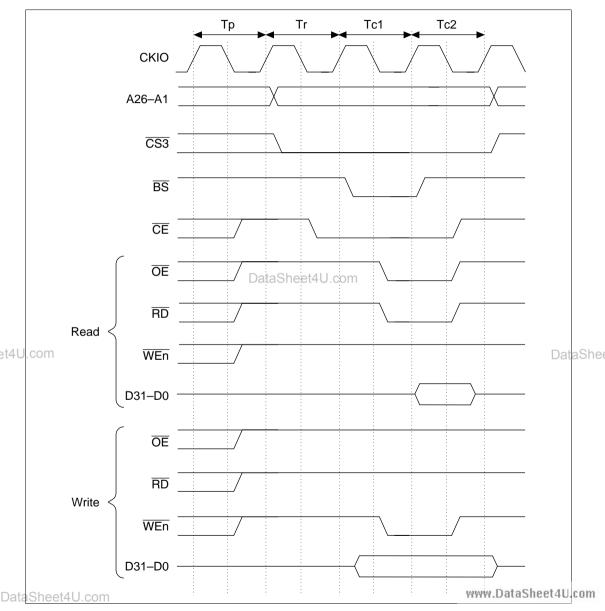


Figure 7.37 Example of Pseudo-SRAM Connection (4-Mbit Pseudo-SRAM)

www.DataSheet4U.com

Figure 7.38 shows the basic pseudo-SRAM access timing. Tp is the precharge cycle, Tr is the \overline{CE} assert cycle, Tc1 is the write data output and \overline{BS} assert cycle, and Tc2 is the read data fetch cycle. When accesses are consecutive, precharge cycle Tp overlaps the Tc2 cycle of the previous access, so reads or writes can be performed in a minimum of 3 cycles each.

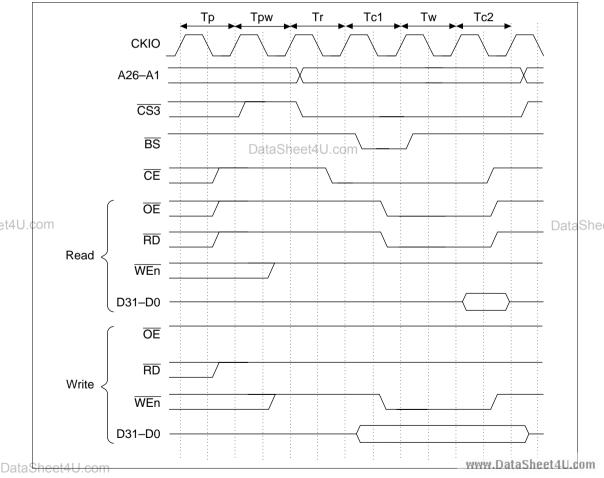




192 DataSheet4U.com

www.DataSheet4U.com 7.7.3 Wait State Control

When the clock frequency is raised, 1 cycle may not always be sufficient for all states to end, as in basic access. Setting bits in WCR and MCR enables the state to be lengthened. Figure 7.39 shows an example of lengthening a state using settings. The Tp cycle that ensures a sufficient \overline{CE} precharge time can be extended to 2 cycles by insertion of a Tpw cycle by means of the TRP bit in MCR. The number of cycles between \overline{BS} assert and the end of access can be extended from 2 to 4 cycles by setting the W31/W30 bits in WCR. When a value other than 00 is set in W31 and W30, the external wait pin \overline{WAIT} is also sampled, so the number of cycles can be further increased. Figure 7.40 shows the timing of wait state control using the \overline{WAIT} pin. In either case, when consecutive accesses occur, the Tp cycle of one access overlaps the Tc2 cycle of the previous access. The RCD bit in MCR is set to 0 for a pseudo-SRAM interface, but when set to 1, the number of cycles from the \overline{CE} assert to the \overline{BS} assert or write data output becomes 2.





www.DataSheet4U.

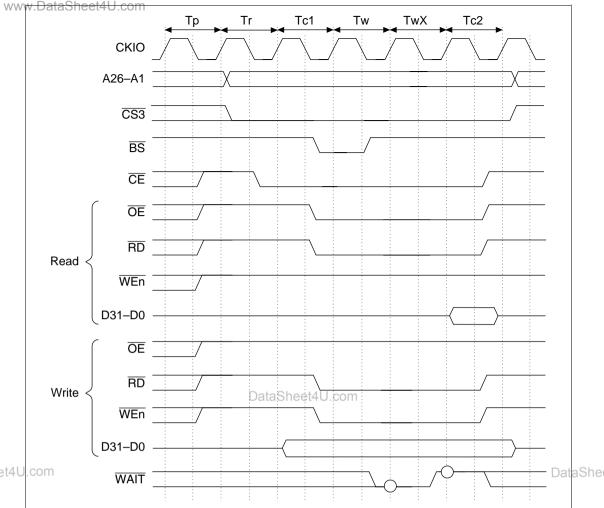


Figure 7.40 External Wait State Timing

7.7.4 **Burst Access**

In addition to normal access, in which CE is alternatively asserted and negated at every access, when consecutive accesses are to the same row address the pseudo-SRAM can access data at high speed by changing only the column address and leaving CE asserted. This function is called the static column mode. Select between ordinary access and burst mode using static column mode by setting the burst enable bit (BE) in MCR. Figure 7.41 shows the timing of burst operation using static column mode. When performing burst access, cycles can be inserted using the wait state control function.

www.DataSheet4U.com

www.DataSheet4U.

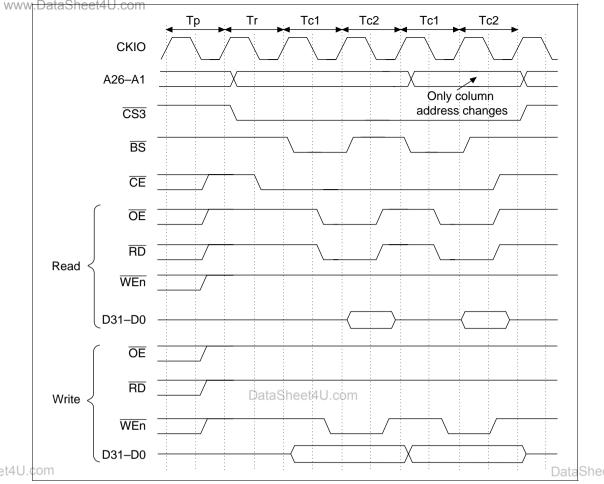


Figure 7.41 Static Column Mode

7.7.5 Refreshing

The BSC has a function for controlling pseudo-SRAM refreshing. By setting the MCR's RMODE bit to 0 and RFSH bit to 1, distributed refreshing using the auto-refresh cycle can be performed.

Refreshes are performed at the interval determined by the input clock selected with CKS2-CKS0 in RTCSR and the value set in RTCOR. Set the values of RTCOR and CKS2-CKS0 so they satisfy the refresh interval specifications of the pseudo-SRAM being used. First, set RTCOR, RTCNT and the RMODE and RFSH bits in MCR, then set the CKS2-CKS0 bits. When a clock is selected with the CKS2-CKS0 bits, RTCNT starts counting up from the value at that time. The RTCNT value is constantly compared to the RTCOR value and a request for a refresh 4U.com when the two match, starting an auto-refresh. RTCNT is cleared to 0 at that time and the count up starts again. Figure 7.42 shows the timing for the auto-refresh cycle.

DataSheet4U.com

www.DataSheet4U.com

The number of \overrightarrow{OE} assert cycles for auto-refresh is specified by the TRAS bit in MCR. As with ordinary accesses, the specification of the precharge time from \overrightarrow{OE} negation to the next \overrightarrow{CE} assert follows the setting of the TRP bit in MCR.

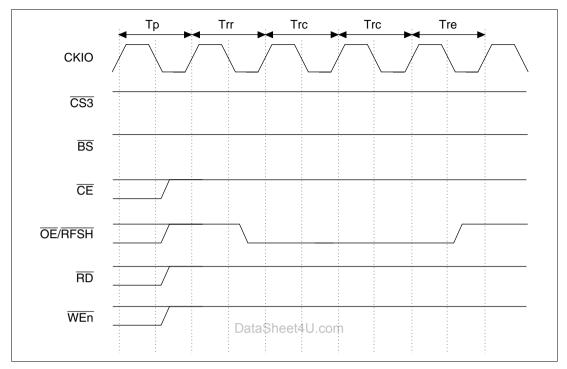


Figure 7.42 Auto-Refresh

DataSh Prescribed period of time. A self-refresh is started by setting the RMODE and RFSH bits to 1. During the self-refresh, the pseudo-SRAM cannot be accessed. To clear self-refreshing, set either the RMODE or RFSH bit to 0. After self-refresh mode is cleared, issuing of commands is inhibited for 1 auto-refresh cycle. If more time than this is required to return from self-refresh, write the program so that there are no accesses to the pseudo-SRAM, including auto-refreshes, during this period. Figure 7.43 shows the self-refresh timing. After self-refreshing is cleared, immediately set the pseudo-SRAM so that auto-refresh is performed in the correct interval. This ensures correct self-refresh clearing and data retention. When time is required between clearing the self-refreshing and initiating the auto-refresh mode, this time must be reflected in the initial RTCNT setting.

DataSheet4U.com

www.DataSheet4U.com

196 DataSheet4U.com

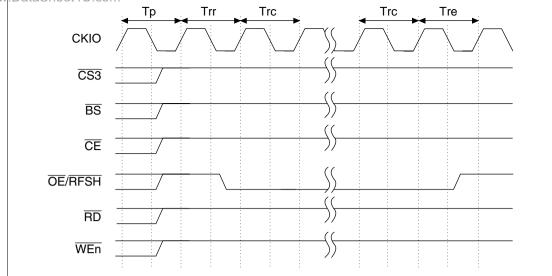


Figure 7.43 Self-Refresh

7.7.6 Power-On Sequence

When pseudo-SRAM is used after the power is turned on, there is a requirement for a waiting period during which accesses cannot be performed (100 µs minimum) followed by the prescribed number of dummy auto-refresh cycles (usually 8). The bus state controller does not perform any special operations for the power-on reset, so the required power-on sequence must be implemented by the initialization program executed after a power-on reset.

7.8 Burst ROM Interface

Set the BSTROM bit in BCR1 to set the CS0 space for connection to burst ROM. The burst ROM interface is used to permit fast access to ROMs that have the nibble access function. Figure 7.44 shows the timing of nibble accesses to burst ROM. Set for two wait cycles. The access is basically the same as an ordinary access, but when the first cycle ends, only the address is changed. The CS0 signal is not negated, enabling the next access to be conducted without the T1 cycle required for ordinary space access. From the second time on, the T1 cycle is omitted, so access is 1 cycle faster than ordinary accesses. Currently, the nibble access can only be used on 4-address ROM. This function can only be utilized for word or longword reads to 8-bit ROM and longword reads to 16-bit ROM. Mask ROMs have slow access speeds and require 4 instruction fetches for 8-bit widths and 16 accesses for cache fills. Limited support of nibble access was thus added to alleviate this problem. When connecting to an 8-bit width ROM, a maximum of 4 consecutive accesses are performed; when connecting to a 16-bit width ROM, a maximum of 2 consecutive accesses are performed. Figure 7.45 shows the relationship between data width and access size. For cache fills and DMAC 16-byte transfers, longword accesses are repeated 4 times.

www

DataSheet4U.com When one or more wait states are set for a burst ROM access, the \overline{WAIT} pin is sampled. When the burst ROM is set and 0 specified for waits, there are 2 access cycles from the second time on. Figure 7.46 shows the timing.

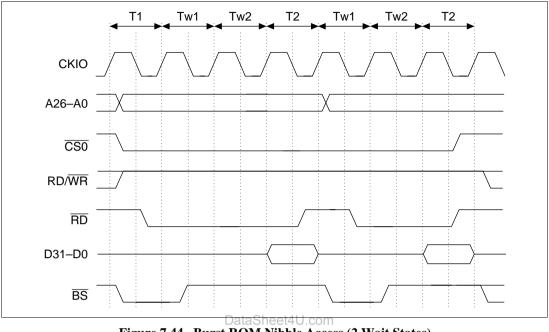


Figure 7.44 Burst ROM Nibble Access (2 Wait States)

et4U.com

DataSheet4U.com

www.DataSheet4U.com

198 DataSheet4U.com

T1	Tw	T2	Tw	T2	Tw	T2	Tw	T2
8-bit bus	-width lor	ngword a	ccess					
T1	Tw	T2	Tw	T2				
8-bit bus	-width ac	cess						
T1	Tw	T2]					
8-bit bus	-width by	te access	5					
T1	Tw	T2	Tw	T2				
16-bit bu	s-width lo	ongword	access					
T1	Tw	T2	Ī					
16-bit bu	s-width w	ord acce	SS					
T1	Tw	T2]					
16-bit bu	s-width b	yte acces	SS					
T1	Tw	T2	Ī					
32-bit bu	s-width lo	ongword	access					
T1	Tw	T2	T					
32-bit bu	s-width w	ord acce	SS					
	Tw	T2	1					



et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

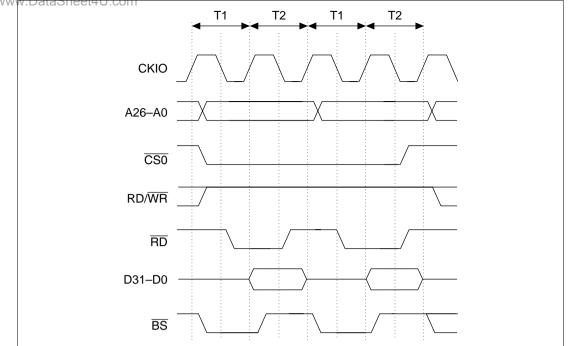


Figure 7.46 Burst ROM Nibble Access (No Wait States)

7.9 Waits between Access Cycles

Because operating frequencies have become high, when a read from a slow device is completed, data buffers may not go off in time to prevent data conflicts with the next access. This lowers et4U device reliability and causes errors. To prevent this, a function has been added to avoid data conflicts that memorizes the space and read/write state of the preceding access and inserts a wait in the access cycle for those cases in which problems are found to occur when the next access starts up. Checks are performed in two cases: if a read cycle is followed immediately by a read access to a different CS space, and if a read access is followed immediately by a write from the SH7604. When the SH7604 is writing continuously, if the format is always to have the direction of the data from the SH7604 to other memory, there are no particular problems. Neither is there any particular problem if the following read access is to the same CS space, since data is output from the same data buffer. The number of idle cycles to be inserted into the access cycle when reading from another CS space, or performing a write, after a read from the CS3 space, is specified by the IW31 and IW30 bits in WCR. Likewise, IW21 and IW20 specify the number of idle cycles after CS2 reads, IW11 and IW10 specify the number after CS1 reads, and IW01 and IW00 specify the number after CS0 reads. From 0 to 2 cycles can be specified. When there is already a gap between accesses, the number of empty cycles is subtracted from the number of idle cycles before .com Data Superior When a write cycle is performed immediately after a read access, 1 wait cycle is inserted even when 0 is specified for waits between access cycles.

200

When the SH7604 shifts to a read cycle immediately after a write, the write data becomes high impedance when the clock rises, but the $\overline{\text{RD}}$ signal, which indicates read cycle data output enable, is not asserted until the clock falls. The result is that no waits are inserted into the access cycle.

When bus arbitration is being performed, an empty cycle is inserted for arbitration, so no wait is inserted between cycles.

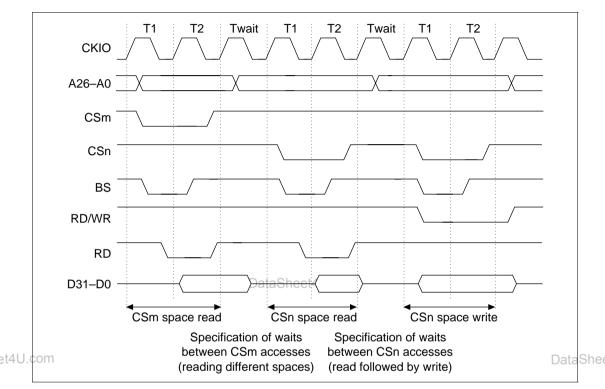


Figure 7.47 Waits between Access Cycles

7.10 Bus Arbitration

The SH7604 has a bus arbitration function that, when a bus release request is received from an external device, releases the bus to that device after the bus cycle being executed is completed. In addition, it also has a bus arbitration function for supporting the connection of two processors. These are connected to each other as master and slave through bus arbitration, which enables a multiprocessor system to be implemented with a minimum of hardware.

There are three modes for bus arbitration: master mode, partial-share master mode, and slave mode. Master mode keeps the bus under normal conditions and permits other devices to use the DataS bus by releasing it when they request its use. The slave mode normally does not have the bus. The bus is requested when an external bus access cycle comes up and then releases the bus when the

www.DataSheet4U.com access is completed. The partial-share master mode only shares CS2 space with external devices. For the CS2 space, the mode is slave mode; for other spaces, the bus is held constantly without any bus arbitration. Which CS space of the chip in master mode the CS2 space of the chip in partial-share master mode is allocated to, is determined by external circuitry.

Master or slave mode can be specified using external mode pins. Partial-share master mode is reached from master mode by a software setting. See Section 3, Oscillator Circuits and Operating Modes, for the external mode pin settings. When a device in master or slave mode does not have the bus, the bus goes to high impedance, so the master mode chip and slave mode chips can be connected directly. In the partial-share master mode, the bus is always driven, so an external buffer is needed to connect to a master bus. In master mode, a connection to an external device requesting the bus can be substituted for the slave mode connection. In the following explanation, external devices requesting the bus are also called slaves.

The SH7604 has two internal bus masters, the CPU and the DMAC. When synchronous DRAM, DRAM or pseudo-SRAM is connected and refresh control is performed, the refresh request becomes a third master. In addition to these, there are also bus requests from external devices while in the master mode. The priority for bus requests when they occur simultaneously is, highest to lowest, refresh requests, bus requests from external devices, DMAC and CPU.

When the bus is being passed between slave and master, all bus control signals are negated before the bus is released to prevent erroneous operation of the connected devices. Once the bus is received, the bus control signals change from negated to bus driven. The master and slave passing the bus between them drive the same signal values, so output buffer conflict is avoided. Turning the output buffer off for the bus control signals on the side that releases the bus and on at the side acquiring the bus can eliminate the high impedance period of the signals. It is usually not necessary to insert a pull-up resistance into these control signals to prevent malfunction caused by et4U.cexternal noise while they are at high impedance.

Bus permission is granted at the end of the bus cycle. When the bus is requested, the bus is released immediately if there is no ongoing bus cycle. If there is a current bus cycle, the bus is not released until the bus cycle ends. Even when there does not appear to be an ongoing bus cycle when seen from outside the SH7604, it cannot be determined whether or not the bus will be released immediately when a bus control signal such as a \overline{CSn} signal is seen, since an internal bus cycle, such as inserting a wait between access cycles, may have been started. The bus cannot be released during burst transfers for cache fills or 16-byte DMAC block transfers. Likewise, the bus cannot be released between the read and write cycles of a TAS instruction. Arbitration is also not performed between multiple bus cycles produced by a data width smaller than the access size, such as a longword access to an 8-bit data width memory. Bus arbitration is performed between external vector fetch, PC save, and SR save cycles during interrupt handling, which are all independent accesses.

www.DataSheet4U.com DataSheet4U.cor Because the CPU in the SH7604 is connected to cache memory by a dedicated internal bus, cache memory can be read even when the bus is being used by another bus master on the chip or

202 DataSheet4U.com



www.DataSh

DataSheet4U.com externally. Writing from the CPU always produces a write cycle externally since the write-through system is used by the SH7604 for the cache. When an external bus address monitor is not specified by the user break controller, the internal bus that connects the CPU, DMAC and on-chip peripheral modules can operate in parallel to the external bus. This means that both read and write accesses from CPU to on-chip peripheral modules and from DMAC to on-chip peripheral module are possible. If an external bus address monitor is specified, the internal bus will be used for address monitoring when the bus is passed to the external bus master, so accesses to on-chip peripheral modules by the CPU and DMAC must wait for the bus to be returned.

7.10.1 Master Mode

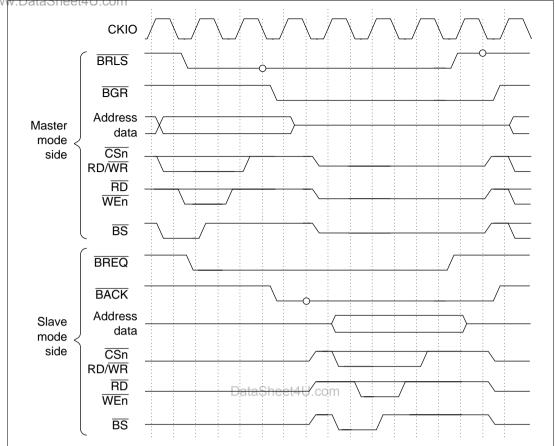
Master mode processors keep the bus unless they receive a bus request. When a bus release request (BRLS) assertion (low level) is received from an external device, buses are released and a bus grant (\overline{BGR}) is asserted (low level) as soon as the bus cycle being executed is completed. When it receives a negated (high level) BRLS signal, indicating that the slave has released the bus, it negates the BGR (to high level) and begins using the bus. When the bus is released, all output and I/O signals related to the bus interface are changed to high impedance, except for the CKE signal for the synchronous DRAM interface, the BGR signal for bus arbitration, and DMA transfer control signals DACK0 and DACK1.

When the DRAM or pseudo-SRAM has finished precharging, the bus is released. The synchronous DRAM also issues a precharge command to the active bank or banks. After this is completed, the bus is released.

The specific bus release sequence is as follows. First, the bus use enable signal is asserted synchronously with the fall of the clock. Half a cycle later, the address bus and data bus become high impedance synchronous with the rise of the clock. Thereafter the bus control signals $(\overline{BS},$ $\overline{\text{CSn}}$, $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, $\overline{\text{WEn}}$, $\overline{\text{RD}}$, $\overline{\text{RD}}$, $\overline{\text{RD}}$, $\overline{\text{RD}}$, $\overline{\text{REF}}$) become high impedance with the fall of the clock. All of these signals are negated at least 1.5 cycles before they become high impedance. Sampling for bus request signals occurs at the clock fall.

The sequence when the bus is taken back from the slave is as follows. When the negation of BRLS is detected at a clock fall, BGR is immediately negated and the master simultaneously starts to drive the bus control signals. The address bus and data bus are driven starting at the next clock rise. The bus control signals are asserted and the bus cycle actually starts from the same clock rise at which the address and data signals are driven, at the earliest. Figure 7.48 shows the timing of bus arbitration in master mode.

www.DataSheet4U.com



et4U.com

Figure 7.48 Bus Arbitration

DataShe

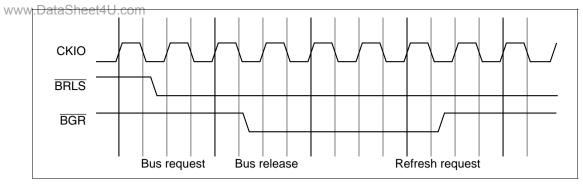
When a refresh request is generated in the SH7604 while \overline{BGR} is asserted and the bus released, the \overline{BGR} may or may not be negated.

Case in Which $\overline{\text{BGR}}$ is Negated: If access processing for an external device has not been started before the refresh request is generated, the $\overline{\text{BGR}}$ signal will be negated even while the $\overline{\text{BRLS}}$ signal is asserted. Even though the $\overline{\text{BGR}}$ signal is negated, a refresh operation will not begin unless the $\overline{\text{BRLS}}$ signal is negated. Refreshing begins as soon as $\overline{\text{BRLS}}$ is negated.

DataSheet4U.com

www.DataSheet4U.com







Case in Which \overline{\text{BGR}} is Not Negated: If access processing for an external device has been initiated before the refresh request is generated, and the device is waiting to acquire the bus, the $\overline{\text{BGR}}$ signal will not be negated. After the $\overline{\text{BRLS}}$ signal is negated, refreshing begins after completion of the access involving the external device that was waiting for the bus.

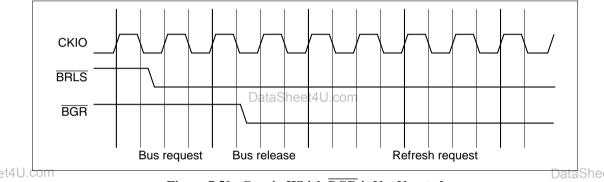


Figure 7.50 Case in Which \overline{BGR} is Not Negated

When the SH7604 is being used in slave mode, the bus is released as soon as the bus access cycle ends, but in the case of a slave designed by the user, multiple consecutive bus accesses may be attempted in order to reduce the arbitration overhead. To ensure dependable refreshing in this case, the design should provide for the bus to be released to prevent the slave holding the bus for longer than the refresh cycle.

7.10.2 Slave Mode

In slave mode, the bus is usually released. External devices cannot be accessed unless the bus arbitration sequence is performed to capture the bus. During a reset, the bus is released and the bus arbitration sequence starts from the reset vector fetch.

DataSheet4L.com The BREQ signal is asserted (to low level) synchronously with the clock fall for capturing the bus. The assertion of the BACK signal (to low level) is sampled at the clock fall. When a BACK

DataSheet4U.com

assertion is detected, the bus control signals are immediately driven at the negate level. Thereafter the address and data bus drivers turn on at the following clock rise and the bus cycle starts. The last signal negated when the access cycle ended is synchronized with the clock rise. Half a cycle after the clock rise, the \overline{BREQ} signal is negated, the master notified that the bus is released, and one cycle later the address and data output buffers turned off (high impedance). At the following clock fall, the control signals become high impedance. Figure 7.48 shows the bus arbitration timing for slave mode.

When the slave access cycle is for DRAM, synchronous DRAM or pseudo-SRAM, the bus is released when the memory precharge finishes, just as for master mode. Since refresh control is handled by the master mode device, any refresh control setting performed in the slave mode is ignored. Figure 7.51 shows an example of master mode and slave mode connections.

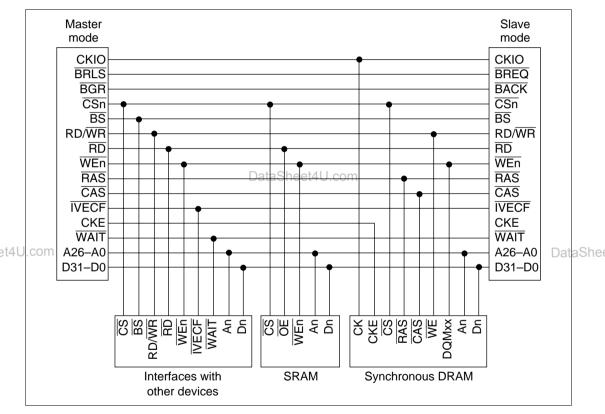


Figure 7.51 Connection between Master and Slave Devices

7.10.3 Partial-Share Master Mode

In partial-share master mode, only the CS2 space is shared with other devices. Other CS spaces Data Can always be accessed. To set partial-share master mode, set to master mode using the external mode pins and then set the PSHR bit in BCR to 1 in the power-on reset initialization procedure.

206 DataSheet4U.com

www.DataSheet4U.com During a manual reset, the values of the bus state controller setting registers are held, so they do not need to be set again.

Partial-share master mode is designed to be used with a chip in master mode. Figure 7.52 shows an example of connections between a partial-share master mode and master mode SH7604. On the master mode side, the CS3 space is connected to synchronous DRAM and the CS0 space to ROM. On the partial-share master mode side, the CS0 space is connected to ROM, the master side synchronous DRAM is connected to the CS2 space, and the CS3 space is connected to dedicated synchronous DRAM. The partial-share master is also connected through the CS2 space to the master synchronous DRAM so it can be accessed. The master, however, cannot access devices on the partial-share master side. There is a buffer for addresses and control signals and a buffer for data located between the partial-share master and the master. They are controlled by a buffer control circuit. The buffers latch signals synchronous to the clock rise and match timing, so an AC operating margin is assured. When the master side synchronous DRAM is read from the partialshare master, however, address and control line output requires an extra cycle, and input of read data requires an extra cycle. The CAS latency setting within the bus controller should be 2 higher than the actual synchronous DRAM CAS latency. If the clock cycle is sufficiently long relative to the time for addresses, control signals and write signals from the partial-share master to reach the synchronous DRAM on the master side through the buffer and to the time for read data from the synchronous DRAM on the master side to reach the partial-share master through the buffer, if the respective setup time limits can be satisfied, then there is no need to delay by one cycle clock signal synchronously with the clock. In this case, the previously described latch is not needed.

DataSheet4U.com When a processor in the partial-share master mode accesses the CS2 space, it performs the following procedure. The BREQ signal is asserted at the clock fall to request the bus from the master. The BACK signal is sampled at every clock fall, and when an assertion is received, the access cycle starts at the next clock rise. After the access ends, BREQ is negated at the clock fall. et4U.coControl of the buffer when a CS2 space device is being accessed from the partial-share master DataShe references the \overline{BREQ} and \overline{BACK} signals. Notification that the bus is enabled for use is conducted by the \overline{BACK} connected to the partial-share master, but the \overline{BACK} signal may be negated while the bus is in use when the master requires the bus back to service a refresh or the like. For this reason, the BREQ signal must be monitored to see whether the partial-share master can continue using the bus after **BACK** is asserted. For address buffers, after the address buffer is turned on by the detection of a \overline{BACK} assertion, the buffer remains on until \overline{BREQ} is negated. When \overline{BREQ} is negated, the buffer goes off. When the buffer is slow going off and it conflicts with the start of the access cycle at the master, the BREQ signal output from the partial-share master as part of the buffer control circuit must be delayed a clock and input to the \overline{BRLS} signal.

When the bus is released after the CS2 space is accessed in partial-share master mode, the bus will be released after waiting for the time required for auto-precharge if the CS2 space was synchronous DRAM. Other spaces always have the bus themselves, so there is no precharge of

DataSICS3 space memory upon release after a CS2 space bus request, even when DRAM, space Shorts 40.com DRAM or pseudo-SRAM is connected to the CS3 space. Partial-share master mode does not refresh CS2 (it is ignored).

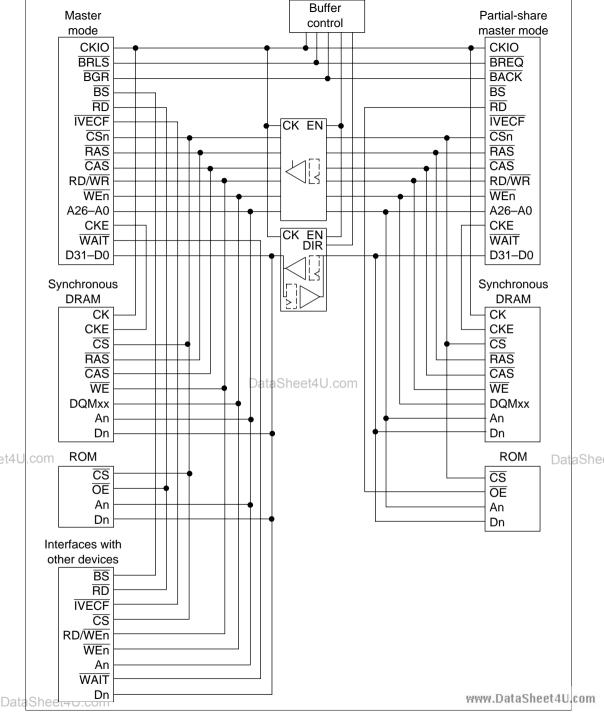


Figure 7.52 Connection between Master and Partial-Share Master Devices

The master and slave modes have a function to generate break interrupts and monitor the external bus access cycle using the user break controller. The bus cycle is monitored by sampling the external bus every time the clock rises while the bus is released. If the \overline{BS} signal is found to be asserted (low level) when sampling is performed, the address at that time (A26–A0) and read/write signal RD/WR are fetched and compared as the access address and access type (read or write).

When an external device has captured the bus and the DRAM or synchronous DRAM is in an access cycle, the following points are important to make the address monitor function correctly. $\overline{\text{BS}}$ goes low in the DRAM or synchronous DRAM access cycle in synchronization with the cycle that outputs the column address. Because only the address of the cycle in which the $\overline{\text{BS}}$ signal is low is fetched and compared, even access to memories like these that multiplex addresses requires outputting of the row address in the upper address bits. One of the bits of the address signal in the column address output cycle in synchronous DRAM is used to specify the bank address, while the other bit is used to specify whether to perform an auto-precharge. These always cause breaks on the compared address, so mask these two bits when setting the comparison address. The masked bit position is described in the section 7.5.2, Address Multiplexing.

7.10.5 Master/Slave Coordination

Roles must be shared between the master and slave to control system resources without contradictions. DRAM, synchronous DRAM and pseudo₇SRAM must be initialized before use. When using standby operation to lower power consumption, the load must also be shared.

This SH7604 was designed with the idea that the master mode device would handle all controls, such as initialization, refreshing, and standby control. When a 2-processor structure of connected master and slave is used, all processing except for direct accesses to memory is controlled by the ataShee master. When master mode is combined with partial-share master mode, the partial-share master mode processor handles initialization, refreshing, and standby control for all CS spaces connected to it except for the CS2 space. The master initializes memory connected directly to it.

The hardware or software sequence should be designed so that there are no slave-side processor accesses until memory that requires initialization before use such as DRAM, synchronous DRAM and pseudo-SRAM has completed its initialization. One method is to install an external circuit that clears slave resets from the master. Another is to have the master write a flag when initialization is complete to an SRAM or the like that does not require initialization, and then not to start access until this flag is acknowledged by the slave. A third method is to install an external circuit that can send an interrupt from master to slave and clear the slave's standby state with an interrupt from the master to the slave when initialization ends.

DataS In standby mode or the like when synchronous DRAM and pseudo-SRAM are in selfDataSheet4U.com mode, memory is not precharged until the mode is cleared, so the master cannot release the bus. The design should provide for the master to put the slave to sleep before self-refresh mode starts

Renesas

or otherwise prevent the slave access cycle from starting, which prevents the slave from producing a bus release request. The slave accesses these types of memories after the master finishes any processing necessary when the self-refresh mode is cleared, such as refresh settings.

7.11 Other Topics

7.11.1 Resets

The bus state controller is completely initialized only in a power-on reset. All signals are immediately negated, regardless of where in the bus cycle the SH7604 is, and the output buffer is turned off if the bus arbitration mode is slave. Signal negation is simultaneous with turning the output buffer off. All control registers are initialized. In standby mode, sleep mode, and a manual reset, no bus state controller control registers are initialized. When a manual reset is performed, any executing bus cycles are completed, and then the SH7604 waits for an access. When a cache fill or 16-byte DMAC transfer is executing, the CPU or DMAC that is the bus master ends the access in a longword unit, since the access request is canceled by the manual reset. This means that when a manual reset is executed during a cache fill, the cache contents can no longer be guaranteed. During a manual reset, the RTCNT does not count up, so no refresh request is generated, and a refresh cycle is not initiated. To preserve the data of the DRAM, synchronous DRAM or pseudo-SRAM, the pulse width of the manual reset must be shorter than the refresh interval. Master mode chips accept arbitration requests even when a manual reset signal is asserted. When a reset is executed only for the chip in master mode while the bus is released, the BGR signal is negated to indicate this. If the BRLS signal is continuously asserted, the bus release state is maintained.

7.11.2 Access as Seen from the CPU or DMAC

The SH7604 is internally divided into three buses: cache, internal, and peripheral. The CPU and cache memory are connected to the cache bus, the DMAC and bus state controller are connected to the internal bus, and the low-speed peripherals and mode registers are connected to the peripheral bus. The user break controller is connected to both the cache bus and the internal bus. The internal bus can be accessed from the cache bus, but not the other way around. The peripheral bus can be accessed from the internal bus, but not the other way around. This results in the following.

Data cannot be written from the DMAC to cache memory. When the DMAC causes a write to memory, the contents of memory and the cache contents will be different. To rewrite the contents of memory, the cache memory must be purged by software if the possibility exists that the data for that address exists in the cache.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com When the CPU starts a read access to a cache area, it first takes a cycle to find the cache. If there is data in the cache, it fetches it and completes the access. If there is no data in the cache, a cache data fill is performed via the internal bus, so four consecutive longword reads occur. For misses that occur when byte or word operands are accessed or branches occur to odd word boundaries (4n + 2 addresses), filling is always performed by longword accesses on the chip-external interface. In the cache-through area, the access is to the actual access address. When the access is an instruction fetch, the access size is always longword.

For cache-through areas and on-chip peripheral module read cycles, after an extra cycle is added to determine the cycle, the read cycle is started through the internal bus. Read data is sent to the CPU through the cache bus.

When word write cycles access the cache area, the cache is searched. When the data of the relevant address is found, it is written here. In parallel to this, the actual writing occurs through the internal bus. When the right to use the internal bus is held, the CPU is notified that the write is completed without waiting for the actual writing to the on-chip peripheral module or off the chip to end. When the right to use the internal bus is not held, as when it is being used by the DMAC or the like, there is a wait until the bus is acquired before the CPU is notified of completion.

Accesses to cache-through areas and on-chip peripheral modules work the same as in the cache area, except for the cache search and write.

Because the bus state controller has one level of write buffer, the internal bus can be used for another access even when the chip-external bus cycle has not ended. After a write has been performed to low-speed memory off the chip, performing a read or write with an on-chip peripheral module enables an access to the on-chip peripheral module without having to wait for the completion of the write to low-speed memory.

During reads, the CPU always has to wait for the end of the operation. To immediately continue processing after checking that the write to the device of actual data has ended, perform a dummy read access to the same address consecutively to check that the write has ended.

The bus state controller's write buffer functions in the same way during accesses from the DMAC. A dual-address DMA transfer thus starts in the next read cycle without waiting for the end of the write cycle. When both the source address and destination address of the DMA are external spaces to the chip, however, it must wait until the completion of the previous write cycle before starting the next read cycle.

www.DataSheet4U.com

When using the SH7604's emulator, operation differs from real chip operation in the following ways.

To get trace data with the emulator, all accesses performed by the CPU and DMAC must be output externally. It is not possible to completely analyze program execution or the contents of the data accessed with only traces of access cycles performed exterior to the chip.

Reads of the cache from the CPU can be performed using only the cache bus, but the access address and data read must be able to use the internal bus and external bus to be output externally. The external bus is not needed to access on-chip peripheral modules with the CPU or DMAC, but it is needed to output trace data. This means that when the emulator is used in the trace data fetch mode, internal access operations of the CPU or DMAC are not performed in parallel with the external bus cycle, so extra execution time is required compared to actual chips. Parallel execution of accesses that follow writing to external destinations also should be executed after writing is completed to carry out traces. To precisely measure the actual execution time, an actual chip rather than an emulator should be used.

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

212 DataSheet4U.com

Section 8 Cache

8.1 Introduction

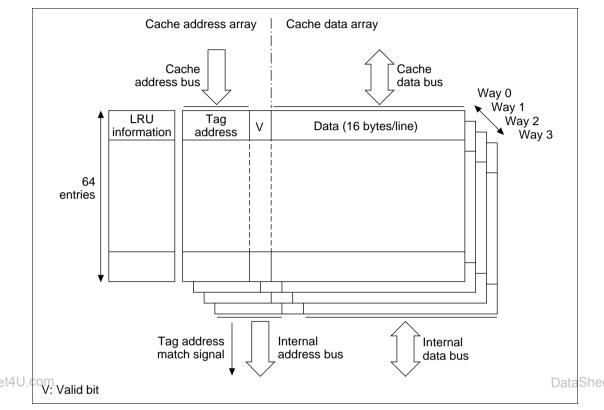


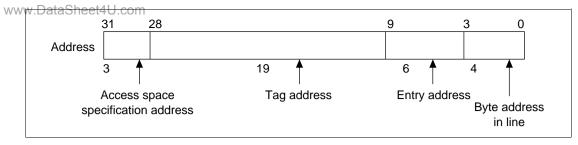
Figure 8.1 Cache Configuration

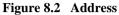
The SH7604 incorporates 4 kbytes of 4-way cache memory of mixed instruction/data type. The SH7604 can also be used as 2-kbyte RAM and 2-kbyte cache memory (mixed instruction/data type) by a setting in the cache control register CCR (two-way cache mode). CCR can specify that either instructions or data do not use cache.

Each line of cache memory consists of 16 bytes. Cache memory is always updated in line units. Four 32-bit accesses are required to update a line. Since the number of entries is 64, the six bits (A9 to A4) in each address determine the entry. A four-way set associative configuration is used, so up to four different instructions/data can be stored in the cache even when entry addresses match. To efficiently use four ways having the same entry address, replacement is provided based on a pseudo-LRU (least-recently used) replacement algorithm.

DataSheet4U.com

www.DataSheet4U.com





8.2 Cache Control Register (CCR)

Table 8.1 Cache Control Register

Name	Abbrev.	R/W	Initial Value	Address
Cache control register	CCR	R/W	H'00	H'FFFFFE92

The cache control register (CCR) is used for cache control. CCR must be set and the cache must be initialized before use.

Bit:	7	6	5	4	3	2	1	0
Bit name:	W1	WO		СР	ΤW	OD	ID	CE
Initial value:	0	0		0^{-1}	n 0	0	0	0
R/W:	R/W	R/W	R	R/W	R/W	R/W	R/W	R/W

• Bits 7 and 6—Way Specification (W1 to W0): W1 and W0 specify the way when an address DataShe array is directly accessed by address specification.

Bit 7: W1	Bit 6: W0	Description	
0	0	Way 0	(Initial value)
	1	Way 1	
1	0	Way 2	
	1	Way 3	

- Bit 5—Reserved: This bit always reads 0. The write value should always be 0.
- Bit 4—Cache Purge (CP): CP is a cache purge bit. When 1 is written to CP, all cache entries and all valid bits and LRU bits of the way are initialized to 0. After initialization is complete, the CP bit reverts to 0. The CP bit always reads 0.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet Bit 4: CP	24U.com Description	
0	Normal operation	(Initial value)
1	Cache purge	
Note: Alw	/ays read 0.	

• Bit 3—Two-Way Mode (TW): TW is the two-way mode bit. The cache operates as a four-way set associative cache when TW is 0 and as a two-way set associative cache and 2-kbyte RAM when TW is 1. In the two-way mode, ways 2 and 3 are cache and ways 0 and 1 are RAM. Ways 0 and 1 are read or written by direct access of the data array according to address space specification.

Bit 3: TW	Description	
0	Four-way mode	(Initial value)
1	Two-way mode	

• Bit 2—Data Replacement Disable (OD): OD is the bit for disabling data replacement. When this bit is 1, data fetched from external memory is not written to the cache even if there is a cache miss. Cache data is, however, read or updated during cache hits. OD is valid only when CE is 1.

Bit 2: OD	Description	
0	Normal operation	(Initial value)
1	Data not replaced even when cache miss occurs in data access	

Bit 1—Instruction Replacement Disable (ID): ID is the bit for disabling instruction DataS replacement. When this bit is 1, an instruction fetched from external memory is not written to the cache even if there is a cache miss. Cache data is, however, read or updated during cache hits. ID is valid only when CE is 1.

Bit 1: ID	Description				
0	Normal operation	(Initial value)			
1	Data not replaced even when cache miss occurs in instruction fetch				

• Bit 0—Cache Enable (CE): CE is the cache enable bit. Cache can be used when CE is set to 1.

Bit 0: CE	Description	
0	Cache disabled	(Initial value)
taSheet4U.com	Cache enabled	www.DataSheet4U.com

www.DataSheet4U.com 8.3 Address Space and the Cache

The address space is divided into six partitions. The cache access operation is specified by addresses. Table 8.2 lists the partitions and their cache operations. For more information on address spaces, see section 7, Bus State Controller. Note that the spaces of the cache area and cache-through area are the same.

Addresses A31–A29	Partition	Cache Operation
000	Cache area	Cache is used when the CE bit in CCR is 1.
001	Cache-through area	Cache is not used.
010	Associative purge area	Cache line of the specified address is purged (disabled).
011	Address array read/write area	Cache address array is accessed directly.
110	Data array read/write area	Cache data array is accessed directly.
111	I/O area	Cache is not used.

Table 8.2 Address Space and Cache Operation

8.4 Cache Operation

DataSheet4U.com

8.4.1 Cache Reads

This section describes cache operation when the cache is enabled and data is read from the CPU. One of the 64 entries is selected by the entry address part of the address output from the CPU on the cache address bus. The tag addresses of ways 0 through 3 are compared to the tag address parts of the addresses output from the CPU. A match to the tag address of a way is called a cache hit. In proper use, the tag addresses of each way differ from each other, and the tag address of only one way will match. When none of the way tag addresses match, it is called a cache miss. Tag addresses of entries with valid bits of 0 will not match in any case.

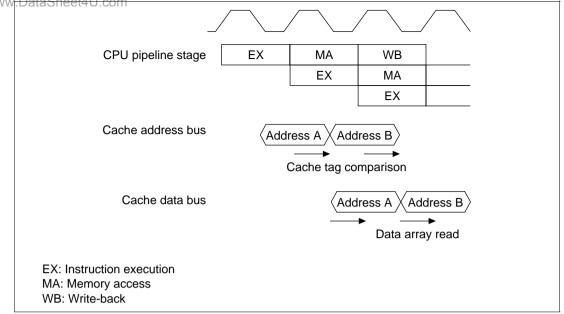
When a cache hit occurs, data is read from the data array of the way that was matched according to the entry address, the byte address within the line, and the access data size. The data is then sent to the CPU. The address output on the cache address bus is calculated in the CPU's instruction execution phase and the results of the read are written during the CPU's write-back stage. The cache address bus and cache data bus both operate as pipelines in concert with the CPU's pipeline structure. From address comparison to data read requires 1 cycle; since the address and data operate as a pipeline, consecutive reads can be performed at each cycle with no waits.

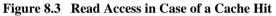
DataSheet4U.com

www.DataSheet4U.com

216 DataSheet4U.com







When a cache miss occurs, the way for replacement is determined using the LRU information, and the read address from the CPU is written in the address array for that way. Simultaneously, the valid bit is set to 1. Since the 16 bytes of data for replacing the data array are simultaneously read, the address on the cache address bus is output to the internal address bus and 4 longwords are read consecutively. Access starts with whatever address output to the internal address bus will make the longword that contains the address to be read from the cache come last as the byte address within the line as the order + 4. The data read on the internal data bus is written sequentially to the cache data array. When the last data is written to the cache data array, it is simultaneously written to the

cache data bus and the read data is sent to the CPU.

The internal address bus and internal data bus also function as pipelines, just like the cache bus.

DataSheet4U.com

www.DataSheet4U.com



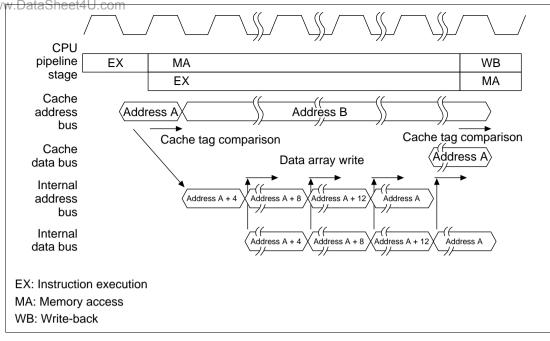


Figure 8.4 Read Access in Case of a Cache Miss

et4U.com

DataSheet4U.com

www.DataSheet4U.com

218 DataSheet4U.com

This cache is of the write-through type, and writing to external memory is performed regardless of whether or not there is a cache hit. The write address output to the cache address bus is used to compare to the tag address of the cache's address array. When they match, the write data output to the cache data bus in the following cycle is written to the data array. When they do not match, nothing is written to the cache data array. The write address is output to the internal address bus 1 cycle later than the cache data bus. The write data is similarly output to the internal data bus 1 cycle later than the cache data bus. The CPU waits until the writes onto the internal bus are completed.

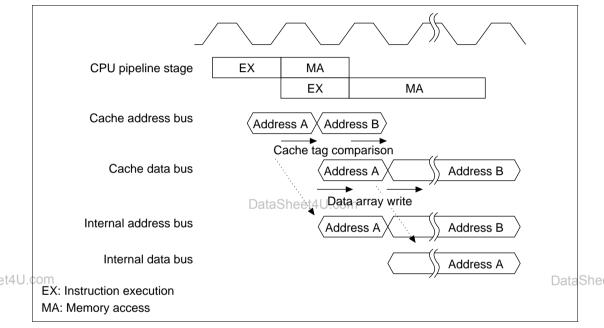


Figure 8.5 Write Access

DataSheet4U.com

www.DataSheet4U.com

When reading or writing a cache-through area, the cache is not accessed. Instead, the cache address value is output to the internal address bus. For read operations, the read data output to the internal address bus is fetched and output to the cache data bus. The read of the cache-through area is only performed on the address in question. For write operations, the write data on the cache data bus is output to the internal data bus. Writes on the cache through area are compared to the address tag; except for the fact that nothing is written to the data array, the operation is the same as the write shown in figure 8.5.

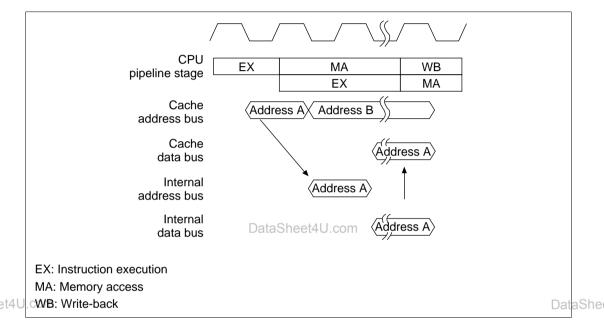


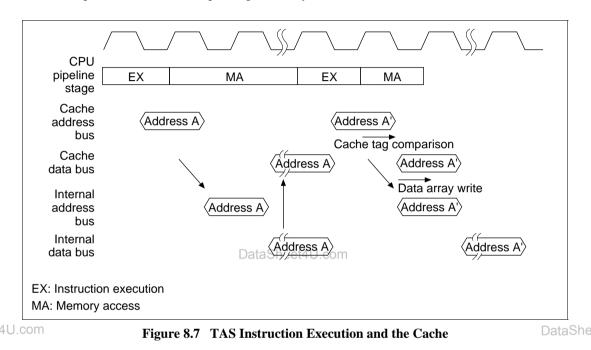
Figure 8.6 Reading Cache-Through Areas

DataSheet4U.com

www.DataSheet4U.com

220 DataSheet4U.com

The TAS instruction reads data from memory, compares it to 0, and reflects the result in the T bit of the status register while setting the most significant bit to 1. It is an address for writing to the same address. Reads from memory become cache-through operations even when the cache area is accessed. Address tags are not compared. The updated value is written to memory through the internal data bus, but before that the address tag is compared and if there are any matching entries, a write is performed to the corresponding data array.



DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com 8.4.5 Pseudo-LRU and Cache Replacement

When a cache miss occurs during a read, the data of the missed address is read from 1 line (16 bytes) of memory and replaced. This makes it important to decide which of the ways to replace. It is likely that the way least recently used has the highest probability of being the next to be accessed. This algorithm for replacing ways is called the least recently used replacement algorithm, or LRU. The hardware to implement it, however, is complex. For that reason, this cache uses a pseudo-LRU replacement algorithm that keeps track of the order of way access and replaces the oldest way.

Six bits of data are used as the LRU information. The bits indicate the access order for 2 ways, as shown in figure 8.8. When the value is 1, access occurred in the direction of the appropriate arrow in the figure. The direction of the arrow can be determined by reading the bit. All the arrows show the oldest access toward that way, which becomes the object of replacement. The access order is recorded in the LRU information bits, so the LRU information is rewritten when a cache hit occurs during a read, when a cache hit occurs during a write, and when replacement occurs after a cache miss. Table 8.3 shows the rewrite values; table 8.4 shows how ways are selected for replacement.

After a cache purge by CCR's CP bit, the LRU information is completely zeroized, so the initial order used is way $3 \rightarrow way 2 \rightarrow way 1 \rightarrow way 0$. Thereafter the way is selected according to the order of access set by the program. Since the replacement will not be correct if the LRU gets an inappropriate value, the address array write function can be used to rewrite. When this is done, be sure not to write a value other than 0 as the LRU information.

When CCR's OD bit or ID bit is 1, neither will replace the cache even if a cache miss occurs during data read or instruction fetch. Instead of replacing, the missed address data is read and directly transferred to the CPU.

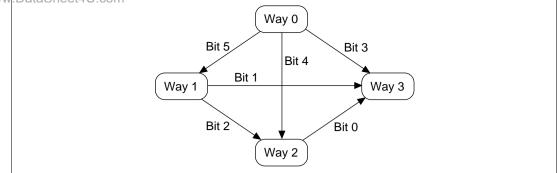
t4U.com

The two-way mode of the cache set by CCR's TW bit can only be implemented by replacing ways 2 and 3. Comparisons of tag addresses of address arrays are carried out on all four ways even in two-way mode, so the valid bit of ways 1 and 0 must be zeroized prior to operation in the two-way mode.

Writing for the tag address and valid bit for cache replacement does not wait for the read from memory to be completed. When the memory access is aborted by a reset during replacement or the like, the cache contents and memory contents may be out of sync, so always perform a purge.

DataSheet4U.com

www.DataSheet4U.com



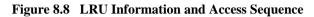


Table 8.3 LRU Information after Update

	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Way 0	0	0	0	_	_	_
Way 1	1	—		0	0	_
Way 2	_	1		1	—	0
Way 3	_	_	1	_	1	1

—: Holds the value before update.

Table 8.4 Selection Conditions for Replaced Way

	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
Way 0	1	1	1	_	_		
t4U.coWay 1	0		_	1	1	_	DataShe
Way 2	_	0	_	0	_	1	
Way 3	_	—	0	—	0	0	

-: Don't care.

DataSheet4U.com

www.DataSheet4U.com

Purges of the entire cache area can only be carried out by writing 0 to the CP bit in CCR. Writing 1 to the CP bit initializes the valid bit of the address array and all bits of the LRU information to 0. Cache purges are completed in 1 cycle, but additional time is required for writing to CCR. Always initialize the valid bit and LRU before enabling the cache.

When the cache is enabled, instruction reads are performed from the cache even during writing to CCR. This means that the prefetched instructions are read from the cache. To do a proper purge, write 0 to CCR's CE bit, then disable the cache and purge. Since CCR's CE bit is cleared to 0 by a power-on reset or manual reset, the cache can be purged immediately by a reset.

8.4.7 Associative Purges

Associative purges invalidate 1 line (16 bytes) corresponding to specific address contents when the contents are in the cache. When the contents of shared addresses are rewritten by one CPU in a multiprocessor configuration, the other CPU cache must be invalidated if it also contains the address. When writing is performed to the address found by adding H'40000000 to the purged address, the valid bit of the entry storing the address prior to the addition is initialized to 0. 16 bytes are purged in each write, so a purge of 256 bytes of consecutive areas can be accomplished in 16 writes. Access sizes when associative purges are performed should be longword. A purge of 1 line requires 2 cycles.



Figure 8.9 Associative Purge Access

8.4.8 Data Array Access

The cache data array can be read or written directly via the data array read/write area. The access sizes for the data array may be byte, word or longword. Data array accesses are completed in 1 cycle for both reads and writes. Since only the cache bus is used, the operation can proceed in parallel even when another master, such as the DMAC, is using the bus. The data array of way 0 is mapped on H'C0000000 to H'C00003FF, way 1 on H'C0000400 to H'C00007FF, way 2 on H'C0000800 to H'C0000BFF and way 3 on H'C00000C00 to H'C0000FFF. When the two-way mode is being used, the area H'C0000000 to H'C00007FF is accessed as 2 kbytes of on-chip RAM. When the cache is disabled, the area H'C0000000 to H'C0000FFF can be used as 4 kbytes of on-chip RAM.

DataSheet4U.com

www.DataSheet4U.com

When the contents of the way being used as cache is rewritten using a data array access, the contents of external memory and cache will not match, so this method should be avoided.

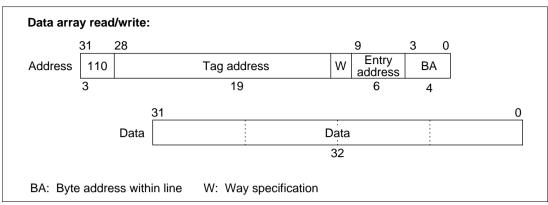


Figure 8.10 Data Array Access

8.4.9 Address Array Access

The address array of the cache can be accessed so that the contents fetched to the cache can be checked for purposes of program debugging or the like. The address array is mapped on H'60000000 to H'600003FF. Since all of the ways are mapped to the same addresses, ways are selected by rewriting the W1 and W0 bits in CCR. The address array can only be accessed in longwords.

When the address array is read, the tag address, LRU information, and valid bit are output as data. When the address array is written to, the tag address and valid bit are written from the cache J.Coaddress bus. This requires that the write address be calculated according to the value to be written to She

then written. LRU information is written from data, but 0 should always be written to prevent malfunctions.

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

Renesas

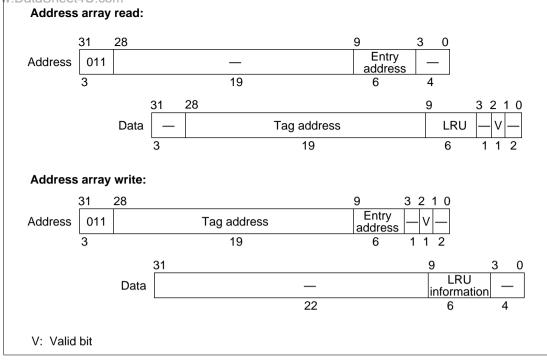


Figure 8.11 Address Array Access

DataSheet4U.com

8.5 Cache Use

8.5.1 Initialization

et4U.com

DataShe

Cache memory is not initialized in a reset. Therefore, the cache must be initialized by software before use. Cache initialization clears (to 0) the address array valid bit and all LRU information. The address array write function can be used to initialize each line, but it is simpler to initialize it once by writing 1 to the CP bit in CCR. Figure 8.12 shows how to initialize the cache.

	MOV.W	#H'FE92, R1			
	MOV.B	@R1, R0	;		
	AND	#H'FE, RO	;		
	MOV.B	#R0, @R1	; Cache disable		
	OR	#H'10, R0			
	MOV.B	R0, @R1	; Cache purge		
	OR	#H'01, R0			
Data	Sheet4 _{MOVOB1}	R0, R1	; Cache enable	www.DataSheet4U.	com

Figure 8.12 Cache Initialization

226

Since the SH7604 has no snoop function (for monitoring data rewrites), specific lines of cache must be purged when the contents of cache memory and external memory differ as a result of an operation. For instance, when a DMA transfer is performed to the cache area, cache lines corresponding to the rewritten address area must be purged. All entries of the cache can be purged by setting the CP bit in CCR to 1. However, it is efficient to purge only specific lines if only a limited number of entries are to be purged.

An associative purge is used to purge specific lines. Since cache lines are 16 bytes long, purges are performed in a 16-byte units. The four ways are checked simultaneously, and only lines holding data corresponding to specified addresses are purged. When addresses do not match, the data at the specified address is not fetched to the cache, so no purge occurs.

```
; Purging 32 bytes from address R3
MOV.L #H'40000000, R0
XOR R1, R1
MOV.L R1, @(R0, R3)
ADD #16, R3
MOV.L R1, @(R0, R3)
```

Figure 8.13 Purging Specific Addresses DataSheet4U.com

When it is troublesome to purge the cache after every DMA transfer, it is recommended that the OD bit in CCR be set to 1 in advance. When the OD bit is 1, the cache operates as cache memory only for instructions. However, when data is already fetched into cache memory, specific lines of tu.cccache memory must be purged for DMA transfers.

8.5.3 Cache Data Coherency

The SH7604's cache memory does not have a snoop function. This means that when data is shared with a bus master other than the CPU, software must be used to ensure the coherency of data. For this purpose, the cache-through area can be used, the break function can be used in external bus cycles, or a cache purge can be performed with program logic.

If the cache-through area is to be used, the data shared by the bus masters is placed in the cachethrough area. This makes it easy to maintain data coherency, since access of the cache-through area does not fetch data into the cache. When the shared data is accessed repeatedly and the frequency of data rewrites is low, a lower access speed can adversely affect performance.

To use the external bus cycle break function, the user break controller is used. Set the user break controller is used. Set the user break controller to generate an interrupt when a write cycle is detected to any of the areas that have shared data. The interrupt handling routine purges the cache. Since the cache is purged whenever a

DataSheet4U.com

www.DataSheet4U.com rewrite is detected, data coherency can be maintained. When data that extends over multiple words, such as a structure, is rewritten, however, interrupts are generated at the rewrites, which can lower performance. This method is most appropriate for cases in which it is difficult to predict and detect the timing of data updates and the update frequency is low.

To purge the cache using program logic, the data updates are detected by the program flow and the cache is then purged. For example, if the program inputs data from a disk, whenever reading of a unit (such as a sector) is completed, the buffer address used for reading or the entire cache is purged, thereby maintaining coherency. When data is to be handled between two processors, only flags to provide mutual notification of completion of data preparation or completion of a fetch are placed in the cache-through area. The data actually transferred is placed in the cache area and the cache is purged before the first data read to maintain the coherency of the data. When semaphores are used as the means of communication, data coherency can be maintained even when the cache is not purged by utilizing the TAS instruction. The TAS instruction is not read within the cache; the external access is always direct. This means that data can be synchronized with other masters when it is read.

When the update unit it is small, specific addresses can be purged, so only the relevant addresses are purged. When the update unit is larger, it is faster to purge the entire cache rather than purging all the addresses in order, and then read in the data previously existing in the cache again from external memory.

8.5.4 **Two-Way Cache Mode**

The 4-kbyte cache can be used as 2-kbyte RAM and 2-kbyte mixed instruction/data cache memory by setting the TW bit in CCR to 1. Ways 2 and 3 become cache, and ways 0 and 1 become RAM.

et4U. The cache and RAM are initialized by setting the CP bit in CCR to 1. The valid bit and LRU bitsDataShe are cleared to 0.

When the initial values of the LRU information are set to 0, ways 3 and 2 are initially used, in that order. Ways 3 and 2 are subsequently selected for replacement as specified by the LRU information. The conditions for updating the LRU information are the same as for four-way mode, except that the number of ways is two.

When designated as 2-kbyte RAM, ways 0 and 1 are accessed by data array access. Figure 8.14 shows the address mapping.

www.DataSheet4U.com

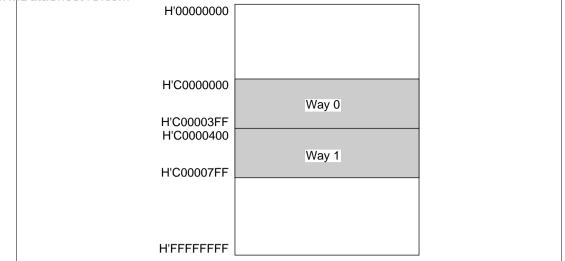


Figure 8.14 Address Mapping of 2-kbyte RAM in the Two-Way Mode

8.5.5 Usage Notes

Standby: Disable the cache before entering the standby mode for power-down operation. After returning from power-down, initialize the cache before use.

DataSheet4U.com

Cache Control Register: Changing the contents of CCR also changes cache operation. The SH7604 makes full use of pipeline operations, so it is difficult to synchronize access. For this reason, change the contents of the cache control register while disabling the cache or after the cache is disabled.

DataShe

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

230 DataSheet4U.com

9.1 Overview

The SH7604 includes a two-channel direct memory access controller (DMAC). The DMAC can be used in place of the CPU to perform high-speed data transfers between external devices equipped with DACK (transfer request acknowledge signal), external memories, memory-mapped external devices, and on-chip peripheral modules (except for the DMAC, BSC and UBC). Using the DMAC reduces the burden on the CPU and increases the operating efficiency of the chip as a whole.

9.1.1 Features

The DMAC has the following features:

- Number of channels: 2
- Address space: 4 Gbytes in the architecture
- Selectable data transfer unit: Byte, word (2 bytes), longword (4 bytes) or 16-byte unit (16-byte transfers first perform four longword reads and then four longword writes)
- Maximum transfer count: 16,777,216 (16M) transfers
- With cache hits, CPU instruction processing and DMA operation can proceed in parallel
- The maximum transfer rate for synchronous DRAM burst transfers is 38 Mbytes/sec (f = 28.7 MHz)

device) is accessed by a DACK signal (selectable) while the other is accessed by address. One

- Single address mode transfers: Either the transfer source or transfer destination (peripheral
- t4U.com

transfer unit of data is transferred in each bus cycle.

Devices that can be used in DMA transfer:

- External devices with DACK and memory-mapped external devices (including external memories)
- Dual address mode transfers: Both the transfer source and transfer destination are accessed by address. One transfer unit of data is transferred in two bus cycles.

Device combinations capable of transfer:

- Two external memories
- External memory and memory-mapped external devices
- Two memory-mapped external devices
- External memory and on-chip peripheral module (excluding the DMAC, BSC and UBC).

— Memory-mapped external devices and on-chip peripheral modules (excluding the DMAC, DataSheet4UBSC and UBC) www.DataSheet4U.com

- Two on-chip peripheral modules (excluding the DMAC, BSC and UBC) (access size permitted by a register of the peripheral module that is the transfer source or destination)
- Transfer requests
 - External requests (from DREQ pins. DREQ can be detected either by edge or by level, and either active-low or active-high can be selected)
 - On-chip peripheral module requests (serial communication interface (SCI))
 - Auto-request (the transfer request is generated automatically within the DMAC)
- Selectable bus modes: Cycle-steal mode or burst mode
- Selectable channel priority levels: Fixed or round-robin mode
- An interrupt request can be sent to the CPU when data transfer ends

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

232 DataSheet4U.com

Figure 9.1 shows a block diagram of the DMAC.

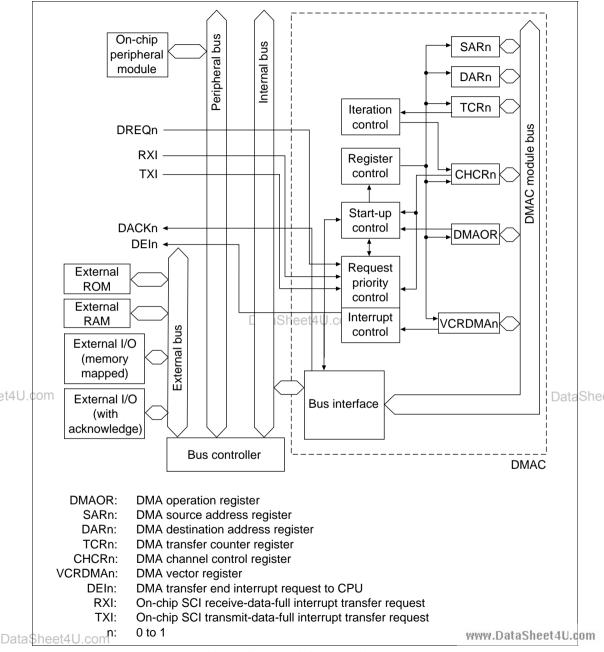




Table 9.1 shows the DMAC pins.

Table 9.1 DMAC Pin Configuration

Channel	Name	Symbol	I/O	Function
0	DMA transfer request	DREQ0	Ι	DMA transfer request input from external device to channel 0
	DMA transfer request acknowledge	DACK0	0	DMA transfer request acknowledge output from channel 0 to external device
1	DMA transfer request	DREQ1	I	DMA transfer request input from external device to channel 1
	DMA transfer request acknowledge	DACK1	0	DMA transfer request acknowledge output from channel 1 to external device

9.1.4 Register Configuration

Table 9.2 summarizes the DMAC registers. The DMAC has a total of 13 registers. Each channel has six control registers. One control register is shared by both channels.

DataSheet4U.com

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

234 DataSheet4U.com

www.DataSheet4U.com Table 9.2 DMAC Registers

Channel	Name	Abbr.	R/W	Initial Value	Address	Access Size ^{*3}
0	DMA source address register 0	SAR0	R/W	Undefined	H'FFFFFF80	32
	DMA destination address register 0	DAR0	R/W	Undefined	H'FFFFFF84	32
	DMA transfer count register 0	TCR0	R/W	Undefined	H'FFFFF88	32
	DMA channel control register 0	CHCR0	R/(W)*1	H'00000000	H'FFFFF8C	32
	DMA vector number register N0	VCRDMAC	R/(W) ^{*1}	Undefined	H'FFFFFFA0	32
	DMA request/response selection control register 0	DRCR0	R/(W) ^{*1}	H'00	H'FFFFFE71	8 ^{*3}
1	DMA source address register 1	SAR1	R/W	Undefined	H'FFFFFF90	32
	DMA destination address register 1	DAR1	R/W	Undefined	H'FFFFFF94	32
	DMA transfer count register 1	TCR1	R/W	Undefined	H'FFFFF98	32
	DMA channel control register 1	CHCR1	R/(W)*1	H'00000000	H'FFFFF9C	32
	DMA vector number register N1	VCRDMA1	R/(W)*1	Undefined	H'FFFFFFA8	32
	DMA request/response selection control register 1	DRCR1	R/(W) ^{*1}	H'00	H'FFFFFE72	8 ^{*3}
Shared	DMA operation register Dat	DMAORU	R/(W)*2	H'00000000	H'FFFFFB0	32

Notes: 1. Only 0 can be written to bit 1 of CHCR0 and CHCR1, after reading 1, to clear the flags.

2. Only 0 can be written to bits 1 and 2 of the DMAOR, after reading 1, to clear the flags.

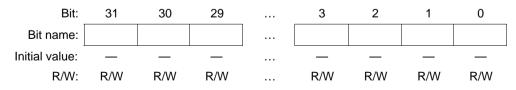
3. Access DRCR0 and DRCR1 in byte units. Access all other registers in longword units.

t4U.com

DataShe

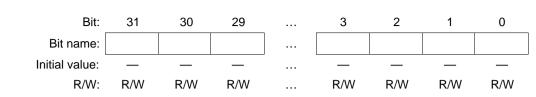
9.2 Register Descriptions

9.2.1 DMA Source Address Registers 0 and 1 (SAR0 and SAR1)



DMA source address registers 0 and 1 (SAR0 and SAR1) are 32-bit read/write registers that specify the source address of a DMA transfer. During a DMA transfer, these registers indicate the DataSinext source address. (In single-address mode, SAR is ignored in transfers from external testices 4U.com with DACK to memory-mapped external devices or external memory). In 16-byte unit transfers, always set the value of the source address to a 16-byte boundars (16n address). Operation results

cannot be guaranteed if other values are used. The value after a reset is undefined. Values are retained in standby mode and during module standbys.



9.2.2 DMA Destination Address Registers 0 and 1 (DAR0 and DAR1)

DMA destination address registers 0 and 1 (DAR0 and DAR1) are 32-bit read/write registers that specify the destination address of a DMA transfer. During a DMA transfer, these registers indicate the next destination address. (In single-address mode, DAR is ignored in transfers from memory-mapped external devices or external memory to external devices with DACK). The value after a reset is undefined. Values are retained in standby mode and during module standbys.

Bit: 31 30 29 28 27 26 25 24 Bit name: Initial value: 0 0 Dat@Sheet40.com 0 0 0 0 R/W: R R R R R R R R 0 Bit: 23 22 21 3 2 1 . . . DataShe Bit name: . . . Initial value: . . . R/W: R/W R/W R/W R/W R/W R/W R/W . . .

9.2.3 DMA Transfer Count Registers 0 and 1 (TCR0 and TCR1)

DMA transfer count registers 0 and 1 (TCR0 and TCR1) are 32-bit read/write registers that specify the DMA transfer count. The lower 24 of the 32 bits are valid. The value is written as 32 bits, including the upper eight bits. The number of transfers is 1 when the setting is H'00000001, 16,777,215 when the setting is H'00FFFFFF and 16, 777,216 (the maximum) when H'00000000 is set. During a DMA transfer, these registers indicate the remaining transfer count.

Set the initial value as the write value in the upper eight bits. These bits always read 0. The initial value after a reset is undefined. Values are retained in standby mode and during module standbys. For 16-byte transfers, set the count to 4 times the number of transfers.

DataSheet4U.com

www.DataSheet4U.com

	0110.00111		
9.2.4	DMA Channel	Control Registers 0 and 1	(CHCR0 and CHCR1)

Bit:	31	30	29		19	18	17	16
Bit name:	—	_	_		_	—	—	—
Initial value:	0	0	0		0	0	0	0
R/W:	R	R	R		R	R	R	R
Bit:	15	14	13	12	11	10	9	8
Bit name:	DM1	DM0	SM1	SM0	TS1	TS0	AR	AM
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W	R/W						
Bit:	7	6	5	4	3	2	1	0
Bit name:	AL	DS	DL	ТВ	TA	IE	TE	DE
Initial value:	0	0	0	0	0	0	0	0
R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/(W)*	R/W
	•••							

Note: Only 0 can be written, to clear the flag.

DMA channel control registers 0 and 1 (CHCR0 and CHCR1) are 32-bit read/write registers that control the DMA transfer mode. They also indicate the DMA transfer status. Only the lower 16 of the 32 bits are valid. They are written as 32-bit values, including the upper 16 bits. Write the initial values to the upper 16 bits. These bits always read 0. The registers are initialized to H'00000000 by a reset and in standby mode. Values are retained during a module standby.

Bits 15 and 14—Destination Address Mode Bits 1, 0 (DM1, DM0): Select whether the DMA ataShee destination address is incremented, decremented or left fixed (in single address mode, DM1 and DM0 are ignored when transfers are made from a memory-mapped external device, onchip peripheral module, or external memory to an external device with DACK). DM1 and DM0 are initialized to 00 by a reset and in standby mode. Values are retained during a module standby.

DataSheet4U.com

www.DataSheet4U.com

ww.DataSheet4U Bit 15: DM1	.com Bit 14: DM0	Description	
0	0	Fixed destination address	(Initial value)
	1	Destination address is incremented (+1 for +2 for word transfer size, +4 for longword tr for 16-byte transfer size)	-
1	0	Destination address is decremented (-1 for -2 for word transfer size, -4 for longword tr for 16-byte transfer size)	•
	1	Reserved (setting prohibited)	

• Bits 13 and 12—Source Address Mode Bits 1, 0 (SM1, SM0): Select whether the DMA source address is incremented, decremented or left fixed. In single address mode, SM1 and SM0 are ignored when transfers are made from an external device with DACK to a memory-mapped external device, on-chip peripheral module, or external memory. For a 16-byte transfer, the address is incremented by +16 regardless of the SM1 and SM0 values. SM1 and SM0 are initialized to 00 by a reset and in standby mode. Values are retained during a module standby.

Bit 13: SM1	Bit 12: SM0	Description	
0	0	Fixed source address (+16 for 16-byte transfer size) (Initial valu	le)
	1	Source address is incremented (+1 for byte transfer size, +2 for word transfer size, +4 for longword transfer size, +16 for 16-byte transfer size)	
1	0	Source address is decremented (-1 for byte transfer size, -2 for word transfer size, -4 for longword transfer size, +16 for 16-byte transfer size)	2
com	1	Reserved (setting prohibited)	Dat

• Bits 11 and 10—Transfer Size Bits (TS1, TS0): Select the DMA transfer size. When the transfer source or destination is an on-chip peripheral module register for which an access size has been specified, that size must be selected. During 16-byte transfers, set the transfer address mode bit for dual address mode. TS1 and TS0 are initialized to 00 by a reset and in standby mode. Values are retained during a module standby.

Bit 10: TS0	Description	
0	Byte unit	(initial value)
1	Word (2-byte) unit	
0	Longword (4-byte) unit	
1	16-byte unit (4 longword transfers)	www.DataSheet4U.com
	Bit 10: TS0 0 1 0 1 1 1	0Byte unit1Word (2-byte) unit0Longword (4-byte) unit

Bit 9—Auto Request Mode Bit (AR): Selects whether auto-request (generated within the DMAC) or module request (an external request or from the on-chip SCI module) is used for the transfer request. The AR bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 9: AR	Description	
0	Module request mode	(Initial value)
1	Auto-request mode	

Bit 8—Acknowledge/Transfer Mode Bit (AM): In dual address mode, this bit selects whether the DACK signal is output during the data read cycle or write cycle. In single-address mode, it selects whether to transfer data from memory to device or from device to memory. The AM bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 8: AM	Description
0	DACK output in read cycle/transfer from memory to device (Initial value)
1	DACK output in write cycle/transfer from device to memory

Bit 7—Acknowledge Level Bit (AL): Selects whether the DACK signal is an active-high signal or an active-low signal. The AL bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby. DataSheet4U.com

Bit 7: AL	Description	
0	DACK is an active-low signal	(Initial value)
1	DACK is an active-high signal	
ITI		Data

Bit 6—DREQ Select Bit (DS): Selects the DREQ input detection method used. The DS bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 6: DS	Description	
0	Detected by level	(Initial value)
1	Detected by edge	

Bit 5—DREQ Level Bit (DL): Selects active-high or active-low for the DREQ signal. The DL • bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

www.DataSheet4U.com

www.DataSheet4U.com Bit 5: DL	Description	
0	When DS is 0, DREQ is detected by low level; w detected by fall	hen DS is 1, DREQ is (Initial value)
1	When DS is 0, DREQ is detected by high level; v detected by rise	when DS is 1, DREQ is

• Bit 4—Transfer Bus Mode Bit (TB): Selects the bus mode for DMA transfers. The TB bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 4: TB	Description	
0	Cycle-steal mode	(Initial value)
1	Burst mode	

• Bit 3—Transfer Address Mode Bit (TA): Selects the DMA transfer address mode. The TA bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 3: TA	Description	
0	Dual address mode	(Initial value)
1	Single address mode	

• Bit 2—Interrupt Enable Bit (IE): Determines whether or not to request a CPU interrupt at the end of a DMA transfer. When the IE bit is set to 1, an interrupt (DEI) request is setnt to the CPU when the TE bit is set. The IE bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

4U.°Bit 2:	IE Description	Data
0	Interrupt disabled	(Initial value)
1	Interrupt enabled	

• Bit 1—Transfer-End Flag Bit (TE): Indicates that the transfer has ended. When the value in the DMA transfer count register (TCR) becomes 0, the DMA transfer ends normally and the TE bit is set to 1. This flag is not set if the transfer ends because of an NMI interrupt or DMA address error, or because the DME bit of the DMA operation register (DMAOR) or the DE bit was cleared. To clear the TE bit, read 1 from it and then write 0. When the TE bit is set, setting the DE bit to 1 will not enable a transfer. The TE bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

DataSheet4U.com

www.DataSheet4U.com

www.Dat Bit	aSheet4U.com	Description	
0		DMA has not ended or was aborted	(Initial value)
		Cleared by reading 1 from the TE bit and then writing 0	
1		DMA has ended normally (by TCR = 0)	

• Bit 0—DMA Enable Bit (DE): Enables or disables DMA transfers. In auto-request mode, the transfer starts when this bit or the DME bit in DMAOR is set to 1. The NMIF and AE bits in DMAOR and the TE bit must be all set to 0. In external request mode or on-chip peripheral module request mode, the transfer begins when the DMA transfer request is received from the relevant device or on-chip peripheral module, provided this bit and the DME bit are set to 1. As with the auto-request mode, the TE bit and the NMIF and AE bits in DMAOR must be all set to 0. The transfer can be stopped by clearing this bit to 0. The DE bit is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 0: DE	Description	
0	DMA transfer disabled	(Initial value)
1	DMA transfer enabled	

	Bit:	31	30	Data 29 hee	et4U.com	11	10	9	8	
	Bit name:	_	—	_	[—	—	—	—	
	Initial value:	0	0	0		0	0	0	0	
1U.com	R/W:	R	R	R		R	R	R	R	to Chou
+0.0011									Da	taShee
	Bit:	7	6	5	4	3	2	1	0	
	Bit name:	VC7	VC6	VC5	VC4	VC3	VC2	VC1	VC0	
	Initial value:	_						_		
	R/W:	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

9.2.5 DMA Vector Number Registers 0 and 1 (VCRDMA0, VCRDMA1)

DMA vector number registers 0 and 1 (VCRDMA0, VCRDMA1) are 32-bit read/write registers that set the DMAC transfer-end interrupt vector number. Only the lower eight bits of the 32 are effective. They are written as 32-bit values, including the upper 24 bits. Write the initial values to the upper 24 bits. These bits are initialized to H'000000XX (last eight bits are undefined) by a reset and in standby mode. Values are retained during a module standby.

• Bits 31 to 8—Reserved: These bits always read 0. The write value should always be 0. DataSheet4U.com

et4

• Bits 7 to 0—Vector Number Bits 7–0 (VC7–VC0): Set the interrupt vector numbers at the end of a DMAC transfer. Interrupt vector numbers of 0–127 can be set. When a transfer-end interrupt occurs, exception handling and interrupt control fetch the vector number and control is transferred to the specified interrupt handling routine. The VC7–VC0 bits are undefined upon reset and in standby mode. Always write 0 to VC7.

9.2.6 DMA Request/Response Selection Control Registers 0 and 1 (DRCR0, DRCR1)

Bit:	7	6	5	4	3	2	1	0
Bit name:	—	—	—	—	—	—	RS1	RS0
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R	R	R/W	R/W

DMA request/response selection control registers 0 and 1 (DRCR0, DRCR1) are 8-bit read/write registers that set the vector address of the DMAC transfer request source. They are written as 8-bit values. They are initialized to H'00 by a reset, but retain their values in a module standby.

- Bits 7 to 2—Reserved
- Bits 1 and 0—Resource Select Bits 1 and 0 (RS1, RS0): Specify which transfer request to input to the DMAC. Changing the transfer request source must be done when the DMA enable bit (DE) is 0. The RS1 and RS0 bits are initialized to 00 by a reset.

Bit 1: RS1	Bit 0: RS0	Description	
0	0	DREQ (external request)	(Initial value)
0 .com	1	RXI (on-chip SCI receive-data-full inter	rrupt transfer request)*
1	0	TXI (on-chip SCI transmit-data-empty request)*	
1	1	Reserved (setting prohibited)	

The DREQ settings in CHCR are DS = 1 and DL = 0.

DataSheet4U.com

www.DataSheet4U.com

9.2.7		Register	(DMAOR)
ו=••	 operation		(21111011)

Bit:	31	30	29		11	10	9	8
Bit name:	—	—	_			_	_	—
Initial value:	0	0	0		0	0	0	0
R/W:	R	R	R		R	R	R	R
Bit:	7	6	5	4	3	2	1	0
Bit name:	—	_	—		PR	AE	NMIF	DMIE
Initial value:	0	0	0	0	0	0	0	0
R/W:	R	R	R	R	R/W	R/(W)*	R/(W)*	R/W

Note: Only 0 can be written, to clear the flag.

The DMA operation register (DMAOR) is a 32-bit read/write register that controls the DMA transfer mode. It also indicates the DMA transfer status. Only the lower four of the 32 bits are valid. DMAOR is written as a 32-bit value, including the upper 28 bits. Write the initial values to the upper 28 bits. These bits always read 0. DMAOR is initialized to H'00000000 by a reset and in standby mode.

- Bits 31 to 4—Reserved: These bits always read 0. The write value should always be 0.
- Bit 3—Priority Mode Bit (PR): Selects the priority level between channels when there are transfer requests for multiple channels. It is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

4U.co <mark>Bit 3: PR</mark>	Description	DataShe
0	Fixed priority (channel 0 > channel 1)	(Initial value)
1	Round-robin (Top priority shifts to bottom after eac priority for the first DMA transfer after a reset is ch	

• Bit 2—Address Error Flag Bit (AE): This flag indicates that an address error has occurred in the DMAC. When the AE bit is set to 1, DMA transfer cannot be enabled even if the DE bit in the DMA channel control register (CHCR) is set to 1. To clear the AE bit, read 1 from it and then write 0. Operation is performed up to the DMAC transfer being executed when the address error occurred. AE is initialized to 0 by a reset and in standby mode.

E	Bit 2: AE	Description	
()	No DMAC address error	(Initial value)
DataSh	o ot d L o o m	To clear the AE bit, read 1 from it and then write 0	www.DataSheet4U.com
Jalaon	eet4U.com	Address error by DMAC	

Bit 1—NMI Flag Bit (NMIF): This flag indicates that an NMI interrupt has occurred. When the NMIF bit is set to 1, DMA transfer cannot be enabled even if the DE bit in CHCR and the DME bit are set to 1. To clear the NMIF bit, read 1 from it and then write 0. Ends after the DMAC operation executing when the NMI comes in (operation goes to destination). When the NMI interrupt is input while the DMAC is not operating, the NMIF bit is set to 1. The NMIF bit is initialized to 0 by a reset or in the standby mode. Values are held during a module standby.

Bit 1: NMIF	Description
0	No NMIF interrupt (initial value) To clear the NMIF bit, read 1 from it and then write 0.
1	NMIF has occurred

• Bit 0—DMA Master Enable Bit (DME): Enables or disables DMA transfers on all channels. A DMA transfer becomes enabled when the DE bit in the CHCR and the DME bit are set to 1. For this to be effective, however, the TE bit in CHCR and the NMIF and AE bits must all be 0. When the DME bit is cleared, all channel DMA transfers are aborted. DME is initialized to 0 by a reset and in standby mode. Its value is retained during a module standby.

Bit 0: DME	Description	
0	DMA transfers disabled on all channels	(Initial value)
1	DMA transfers enabled on all channels	

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com



When there is a DMA transfer request, the DMAC starts the transfer according to the predetermined channel priority; when the transfer-end conditions are satisfied, it ends the transfer. Transfers can be requested in three modes: auto-request, external request, and on-chip module request. A transfer can be in either single address mode or dual address mode. The bus mode can be either burst or cycle-steal.

9.3.1 DMA Transfer Flow

After the DMA source address registers (SAR), DMA destination address registers (DAR), DMA transfer count registers (TCR), DMA channel control registers (CHCR), DMA vector number registers (VCRDMA), DMA request/response selection control registers (DRCR), and DMA operation register (DMAOR) are initialized (initializing sets each register so that ultimately the condition (DE = 1, DME = 1, TE = 0, NMIF = 0, AE = 0) is satisfied), the DMAC transfers data according to the following procedure:

- 1. Checks to see if transfer is enabled (DE = 1, DME = 1, TE = 0, NMIF = 0, AE = 0)
- 2. When a transfer request comes and transfer is enabled, the DMAC transfers 1 transfer unit of data. (In auto-request mode, the transfer begins automatically when the DE bit and DME bit are set to 1. The TCR value will be decremented by 1.) The actual transfer flows vary depending on the address mode and bus mode.
- 3. When the specified number of transfers have been completed (when TCR reaches 0), the transfer ends normally. If the IE bit in CHCR is set to 1 at this time, a DEI interrupt is sent to the CPU.
- 4. When an address error occurs in the DMAC or an NMI interrupt is generated, the transfer is
- aborted. Transfers are also aborted when the DE bit in CHCR or the DME bit in DMAOR isDataShe changed to 0.

Figure 9.2 shows a flowchart illustrating this procedure.

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

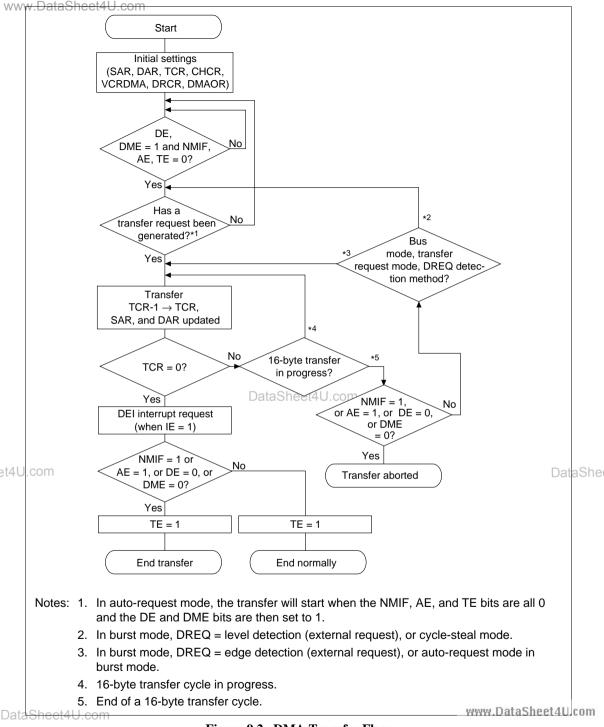


Figure 9.2 DMA Transfer Flow

DMA transfer requests are usually generated in either the data transfer source or destination, but they can also be generated by devices that are neither the source nor the destination. Transfers can be requested in three modes: auto-request, external request, and on-chip peripheral module request. The request mode is selected with the AR bit in DMA channel control registers 0 and 1 (CHCR0, CHCR1) and the RS0 and RS1 bits in DMA request/response selection control registers 0 and 1 (DRCR0, DRCR1).

CHCRDRCRARRS1RS0		RCR		Resource Select		
		RS0	Request Mode			
0	0	0	Module request mode	DREQ external request (external request mode)		
	0	1	_	RXI (SCI receive) request		
	1	0	_	TXI (SCI transmit) request		
1	Х	Х	Auto-request mode			

Auto-Request: When there is no transfer request signal from an external source (as in a memoryto-memory transfer or a transfer between memory and an on-chip peripheral module unable to request a transfer), the auto-request mode allows the DMAC to automatically generate a transfer request signal internally. When the DE bits in CHCR0 and CHCR1 and the DME bit in the DMA operation register (DMAOR) are set to 1, the transfer begins (so long as the TE bits in CHCR0 and CHCR1 and the NMIF and AE bits in DMAOR are all 0).

External Request: In this mode a transfer is started by a transfer request signal (DREQ) from an external device. Choose one of the modes shown in table 9.4 according to the application system. When DMA transfer is enabled (DE = 1, DME = 1, TE = 0, NMIF = 0, AE = 0), a transfer is performed upon input of a DREQ signal.

DataSheet4U.com

www.DataSheet4U.com

DataSheet4U.com

www.DataSheet4U.com Table 9.4 Selecting External Request Modes with the TA and AM Bits

С	HCR	Transfer			
ТА	АМ	Address Mode	Acknowledge Mode	Source	Destination
0	0	Dual address mode	DACK output in read cycle	Any* ¹	Any* ¹
	1	Dual address mode	DACK output in write cycle	Any* ¹	Any* ¹
1 0	0	Single address mode	Data transferred from memory to device	External memory ^{*2} or memory-mapped external device	External device with DACK
	1	Single address mode	Data transferred from device to memory	External device with DACK	External memory ^{*2} or memory-mapped external device
Note	es: 1.	External memory,	memory-mapped external	device, on-chip periph	eral module

Notes: 1. External memory, memory-mapped external device, on-chip peripheral module (excluding DMAC, BSC, and UBC)

2. Except synchronous DRAM

Choose to detect DREQ either by the falling edge or by level using the DS and DL bits in CHCR0 and CHCR1 (DS = 0 is level detection, DS = 1 is edge detection; for edge detection, DL = 0 is rising edge, DL = 1 is falling edge; for level detection, DL = 0 is active-low, DL = 1 is active-high). The source of the transfer request does not have to be the data transfer source or destination. DataSheet4U.com

Table 9.5 Selecting the External Request Signal with the DS and DL Bits

	DRCR	CR	
et4U.c <mark>DS</mark>	DL	External Request	DataShee
0	0	Level (active-low)	
	1	Level (active-high)	
1	0	Edge (falling)	
	1	Edge (rising)	

On-Chip Module Request: In this mode, transfers are started by the transfer request signal (interrupt request signal) of an on-chip peripheral module in the SH7064. The transfer request signals are the receive-data-full interrupt (RXI) and transmit-data-empty interrupt (TXI) of the serial communication interface (SCI) (table 9.6). If DMA transfer is enabled (DE = 1, DME = 1, TE = 0, NMIF = 0, AE = 0), DMA transfer starts upon the input of a transfer request signal.

DataSheet4U.com

www.DataSheet4U.com

248 DataSheet4U.com

When RXI (transfer request when the SCI's receive data buffer is full) is set as the transfer request, however, the transfer source must be the SCI's receive data register (RDR). Likewise, when TXI (transfer request when the SCI's transmit data buffer is empty) is set as the transfer request, the transfer destination must be the SCI's transmit data register (TDR).

DMA Transfer Request **DMA Transfer** Bus DREQ AR RS1 RS0 Source Destination Mode Request Signal Source Setting 0 0 1 SCI RXI (SCI receive-RDR Anv* Cycle-Edge, receiver data-full transfer steal active-low request) 0 1 0 SCI TXI (SCI transmit-Anv* TDR Edae. Cvcletransmitter data-empty transfer steal active-low

Table 9.6 Selecting On-Chip Peripheral Module Request Mode with the AR and RS bits

Note: External memory, memory-mapped external device, on-chip peripheral module (excluding DMAC, BSC, and UBC)

request)

When outputting transfer requests from the SCI, its interrupt enable bits (TIE and RIE in SCR) must be set to output the interrupt signals. Note that transfer request signals from on-chip peripheral modules (interrupt request signals) are sent not just to the DMAC but to the CPU as well. When an on-chip peripheral module is specified as the transfer request source, set the priority level values in the interrupt priority level registers (IPRC–IPRE) of the interrupt controller (INTC) at or below the levels set in the I3–I0 bits of the CPU's status register so that the CPU does not accept the interrupt request signal.

et4U.coThe DMA transfer request signals shown in table 9.6 are automatically fetched when the corresponding DMA transfer is performed. If cycle-steal mode is used, a DMA transfer request (interrupt request) from any module will be cleared at the first transfer; if burst mode is used, it will be cleared at the last transfer.

9.3.3 Channel Priorities

When the DMAC receives simultaneous transfer requests on two channels, it selects a channel according to a predetermined priority order. There are two priority modes, fixed and round-robin. The channel priority is selected by the priority bit, PR, in the DMA operation register (DMAOR).

Fixed Priority Mode: In this mode, the relative channel priority levels are fixed. When PR is set to 0, the priority, high to low, is channel 0 > channel 1. Figure 9.3 shows an example of a transfer in burst mode.

DataSheet4U.com

www.DataSheet4U.com

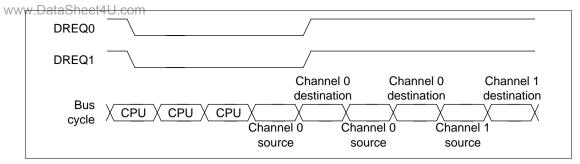
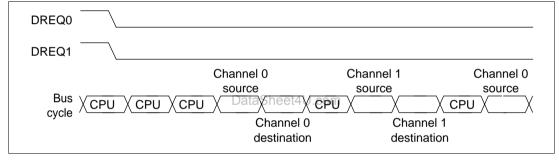


Figure 9.3 Fixed Mode Burst DMA Transfer (Dual Address, Active-Low DREQ Level)

In cycle-steal mode, once a channel 0 request is accepted, channel 1 requests are also accepted until the next request is made, which makes more effective use of the bus cycle. When requests come simultaneously for channel 0 and channel 1 when DMA operation is starting, the first is transmitted multiplexed with channel 0 and thereafter channel 1 and channel 0 transfers are performed alternately.



et4U.com

Figure 9.4 Fixed Mode Cycle-Steal DMA Transfer (Dual Address, Active-Low DREQ Level)

DataShe

Round-Robin Mode: Switches the priority of channel 0 and channel 1, shifting their ability to receive transfer requests. Each time one transfer ends on one channel, the priority shifts to the other channel. The channel on which the transfer just finished is assigned low priority. After reset, channel 0 has higher priority than channel 1.

Figure 9.5 shows how the priority changes when channel 0 and channel 1 transfers are requested simultaneously and another channel 0 transfer is requested after the first two transfers end. The DMAC operates as follows:

- 1. Transfer requests are generated simultaneously to channels 1 and 0.
- 2. Channel 1 has the higher priority, so the channel 1 transfer begins first (channel 0 waits for transfer).

Data Stewhen the channel 1 transfer ends, channel 1 becomes the lower-priority channel.

250 DataSheet4U.com

- 4. The channel 0 transfer begins.
- 5. When the channel 0 transfer ends, channel 0 becomes the lower-priority channel.
- 6. A channel 0 transfer is requested.
- 7. The channel 0 transfer begins.
- 8. When the channel 0 transfer ends, channel 0 is already the lower-priority channel, so the order remains the same.

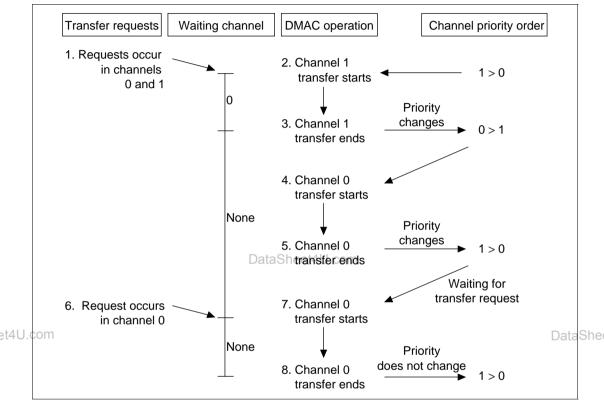


Figure 9.5 Channel Priority in Round-Robin Mode

9.3.4 DMA Transfer Types

The DMAC supports all the transfers shown in table 9.7. It can operate in single address mode or dual address mode, as defined by how many bus cycles the DMAC takes to access the transfer source and transfer destination. The actual transfer operation timing varies with the DMAC bus mode used: cycle-steal mode or burst mode.

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com Table 9.7 Supported DMA Transfers

	Destination				
Source	External Device with External DACK Memory		Memory-Mapped External Device	On-Chip Peripheral Module	
External device with DACK	Not available	Single	Single	Not available	
External memory	Single	Dual	Dual	Dual	
Memory-mapped external device	Single	Dual	Dual	Dual	
On-chip peripheral module	Not available	Dual	Dual	Dual*	

Single: Single address mode

Dual: Dual address mode

Note: Access size enabled by the register of the on-chip peripheral module that is the source or destination (excludes DMAC, BSC, and UBC).

Address Modes:

• Single Address Mode

In single address mode, both the transfer source and destination are external; one (selectable) is accessed by a DACK signal while the other is accessed by address. In this mode, the DMAC performs the DMA transfer in one bus cycle by simultaneously outputting a transfer request acknowledge DACK signal to one external device to access it while outputting an address to the other end of the transfer. Figure 9.6 shows an example of a transfer between external memory and external device with DACK. The external device outputs data to the data bus while that data is written in external memory in the same bus cycle.

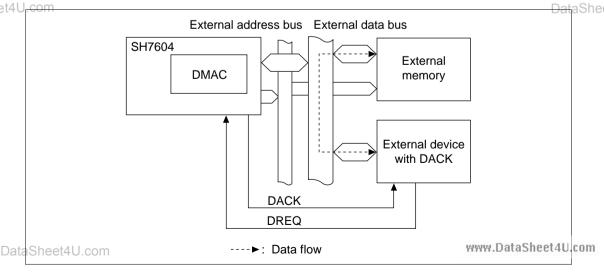


Figure 9.6 Data Flow in Single Address Mode

DataSheet4U.com

252

Two types of transfers are possible in single address mode: 1) transfers between external devices with DACK and memory-mapped external devices; and 2) transfers between external devices with DACK and external memory. Transfer requests for both of these must be by means of the external request signal (DREQ). Figure 9.7 shows the DMA transfer timing for single address mode.

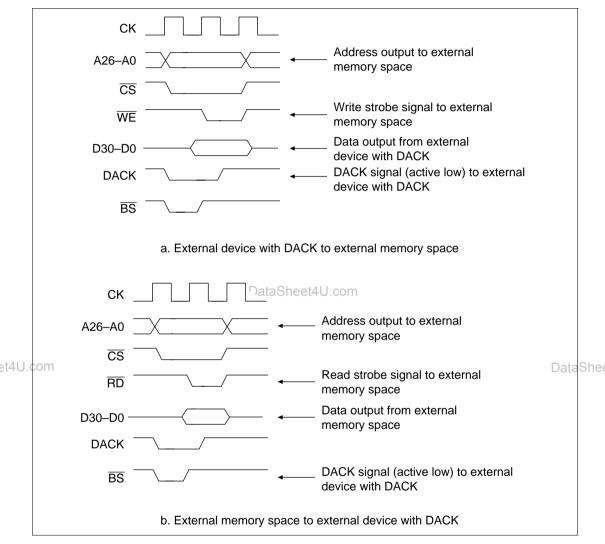


Figure 9.7 DMA Transfer Timing in Single Address Mode

DataSheet4U.com

www.DataSheet4U.com

Renesas

Dual Address Mode

In dual address mode, both the transfer source and destination are accessed (selectable) by address. The source and destination can be located externally or internally. The DMAC accesses the source in the read cycle and the destination in the write cycle, so the transfer is performed in two separate bus cycles. The transfer data is temporarily stored in the DMAC. Figure 9.8 shows an example of a transfer between two external memories in which data is read from one memory in the read cycle and written to the other memory in the following write cycle.

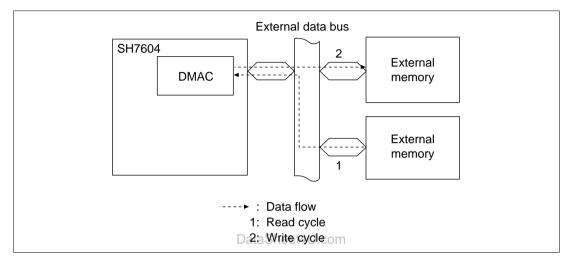


Figure 9.8 Data Flow in Dual Address Mode

In dual address mode transfers, external memory, memory-mapped external devices and onet4U.comchip peripheral modules can be mixed without restriction. Specifically, this enables transfers DataShee between the following:

- 1. External memory and external memory.
- 2. External memory and memory-mapped external devices.
- 3. Memory-mapped external devices and memory-mapped external devices.
- 4. External memory and on-chip peripheral modules (excluding the DMAC, BSC, and UBC).
- 5. Memory-mapped external devices and on-chip peripheral modules (excluding the DMAC, BSC, and UBC). The access size is that is enabled by the register of the on-chip peripheral module that is the source or destination (excludes the DMAC, BSC, and UBC).
- 6. On-chip peripheral modules (excluding the DMAC, BSC, and UBC) and on-chip peripheral modules (excluding the DMAC, BSC, and UBC).

DataSheet4U.com

www.DataSheet4U.com

254 DataSheet4U.com

Transfer requests can be auto-requests, external requests, or on-chip peripheral module requests. When the transfer request source is the SCI, however, either the data destination or source must be the SCI (see table 9.6). Dual address mode outputs DACK in either the read cycle or write cycle. CHCR controls the cycle in which DACK is output.

Figure 9.9 shows the DMA transfer timing in dual address mode.

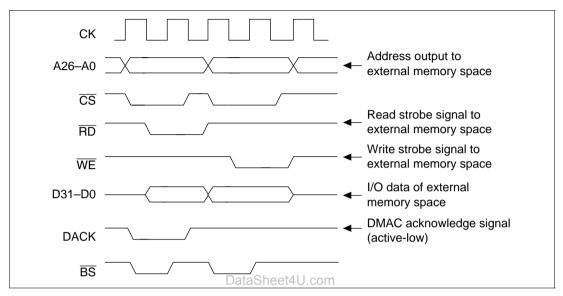


Figure 9.9 DMA Transfer Timing in Dual Address Mode (External Memory Space → External Memory Space, DACK Output in Read Cycle)

et4U.co**Bus Modes:** There are two bus modes: cycle-steal and burst. Select the mode with the TB bits in ataShe CHCR0 and CHCR1.

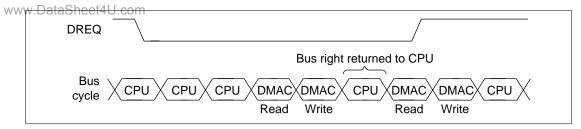
Cycle-Steal Mode

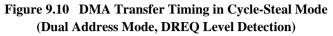
In cycle-steal mode, the bus right is given to another bus master after the DMAC transfers one transfer unit (byte, word, longword, or 16 bytes). When another transfer request occurs, the bus right is retrieved from the other bus master and another transfer is performed for one transfer unit. When that transfer ends, the bus right is passed to the other bus master. This is repeated until the transfer end conditions are satisfied.

Cycle-steal mode can be used with all categories of transfer destination, transfer source, and transfer request source. The CPU may take the bus twice when an acknowledge signal is output during the write cycle or in single address mode. Figure 9.10 shows an example of DMA transfer timing in cycle-steal mode (dual address mode, DREQ level detection).

DataSheet4U.com

www.DataSheet4U.com

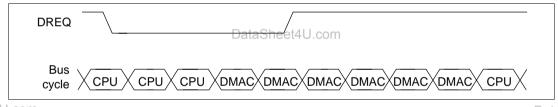




Burst Mode

In burst mode, once the DMAC gets the bus, the transfer continues until the transfer end condition is satisfied. When external request mode is used with level detection of the DREQ pin, however, negating DREQ will pass the bus to the other bus master after completion of the bus cycle of the DMAC that currently has an acknowledged request, even if the transfer end conditions have not been satisfied. Burst mode cannot be used when the transfer request originates from the serial communication interface (SCI).

Figure 9.11 shows an example of DMA transfer timing in burst mode (single address mode, DREQ level detection).



e^{t4U.com}Figure 9.11 DMA Transfer Timing in Burst Mode (Single Address Mode, DREQ Level ^{DataSher} Detection)

Refreshes cannot be performed during a burst transfer, so ensure that the number of transfers satisfies the refresh request period when a memory requiring refreshing is used.

Relationship of Request Modes and Bus Modes by DMA Transfer Category: Table 9.8 shows the relationship between request modes, bus modes, etc., by DMA transfer category.

DataSheet4U.com

www.DataSheet4U.com

256 DataSheet4U.com

www.DataSheet4U.com Table 9.8 Relationship of Request Modes and Bus Modes by DMA Transfer Category

Address Mode	Transfer Category	Request Mode	Bus Mode	Transfer Size (Bytes)
Single	External device with DACK and external memory	External	B/C	1/2/4
	External device with DACK and memory-mapped external device	External	B/C	1/2/4
Dual	External memory and external memory	All ^{*1}	B/C	1/2/4/16
	External memory and memory-mapped external device	All ^{*1}	B/C	1/2/4/16
	Memory-mapped external device and memory- mapped external device	All ^{*1}	B/C	1/2/4/16
	External memory and on-chip peripheral module	All ^{*2}	B/C*3	1/2/4/16*4
	Memory-mapped external device and on-chip peripheral module	All ^{*2}	B/C*3	1/2/4/16 ^{*4}
	On-chip peripheral module and on-chip peripheral module	All ^{*2}	B/C*3	1/2/4/16 ^{*4}

Notes: 1. External requests and auto-requests are both available. The SCI cannot be specified as the transfer request source, however, except for on-chip peripheral module requests.

- 2. External requests, auto-requests and on-chip peripheral module requests are all available. When the SCI is the transfer request source, however, the transfer destination or transfer source must be the SCI.
- 3. If the transfer request source is the SCI, cycle-steal (C) only (DREQ by edge detection, active low).
- The access size is that permitted by the register of the on-chip peripheral module that is the transfer destination or source.

Bus Mode and Channel Priority: When a given channel (1) is transferring in burst mode and there is a transfer request to a channel (0) with a higher priority, the transfer of the channel with higher priority (0) will begin immediately. When channel 0 is also operating in the burst mode, the channel 1 transfer will continue as soon as the channel 0 transfer has completely finished. When channel 0 is in cycle-steal mode, channel 1 will begin operating again after channel 0 completes the transfer of one transfer unit, but the bus will then switch between the two in the order channel 1, channel 0, channel 1, channel 0. Since channel 1 is in burst mode, it will not give the bus to the CPU. This example is illustrated in Figure 9.12.

DataSheet4U.com

at4U com

www.DataSheet4U.com

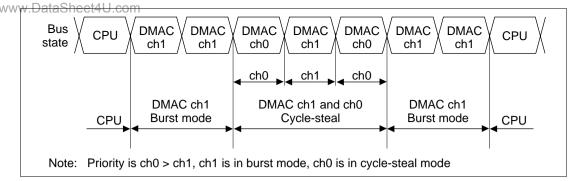


Figure 9.12 Bus Status when Multiple Channels are Operating

9.3.5 Number of Bus Cycles

The number of states in the bus cycle when the DMAC is the bus master is controlled by the bus control register (BCR1) and wait state control register (WCR) of the bus state controller just as it is when the CPU is the bus master.

9.3.6 DMA Transfer Request Acknowledge Signal Output Timing

DMA transfer request acknowledge signal DACKn is output synchronous to the DMAC address output specified by the channel control register AM bit of the address bus. The timing is normally to have the acknowledge signal become valid when the DMA address output begins and become invalid 0.5 cycles before the address output ends. (See figure 9.11.) The output timing of the acknowledge signal varies with the settings of the connected memory space. The output timing of acknowledge signals in the memory spaces is shown in figure 9.13.

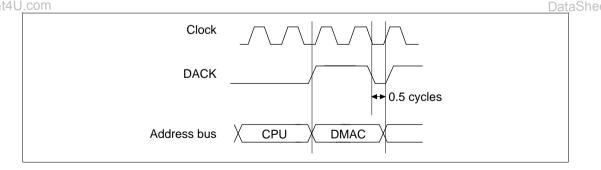


Figure 9.13

Example of DACK Output Timing

DataSheet4U.com

www.DataSheet4U.com

258 DataSheet4U.com

Renesas

Acknowledge Signal Output when External Memory Is Set as Ordinary Memory Space: The timing at which the acknowledge signal is output is the same in the DMA read and write cycles specified by the AM bit (figures 9.14 and 9.15). When DMA address output begins, the acknowledge signal becomes valid; 0.5 cycles before address output ends, it becomes invalid. If a wait is inserted in this period and address output is extended, the acknowledge signal is also extended.

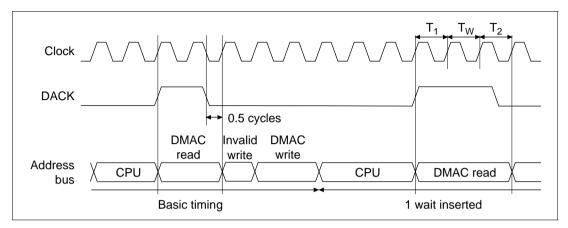
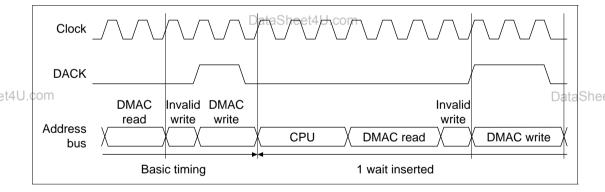


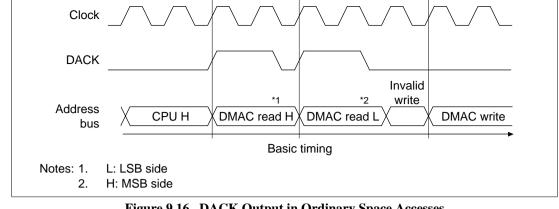
Figure 9.14 DACK Output in Ordinary Space Accesses (AM = 0)

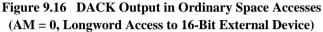


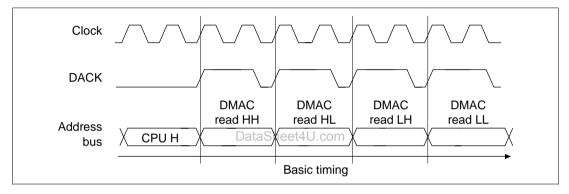


In a longword access of a 16-bit external device (figure 9.16) or an 8-bit external device (figure 9.17), or a word access of an 8-bit external device (figure 9.18), the lower and upper addresses are output 2 and 4 times in each DMAC access in order to align the data. For all of these addresses, the acknowledge signal becomes valid simultaneous with the start of output and becomes invalid 0.5 cycles before the address output ends. When multiple addresses are output in a single access to align data for synchronous DRAM, DRAM, pseudo-SRAM, or burst ROM, an acknowledge signal is output to those addresses as well.

DataSheet4U.com





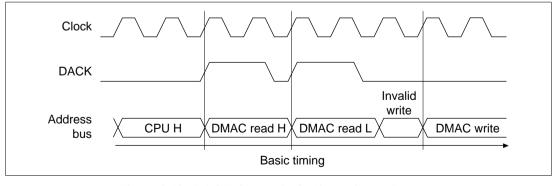


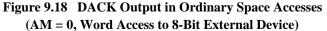
et4U.com

Figure 9.17 DACK Output in Ordinary Space Accesses (AM = 0, Longword Access to 8-Bit External Device)

DataShe

www.DataSheet4U.com

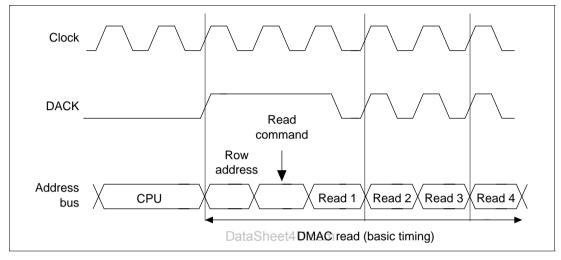


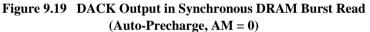


DataSheet4U.com

260 DataSheet4U.com

Acknowledge Signal Output when External Memory Is Set as Synchronous DRAM: When external memory is set as synchronous DRAM auto-precharge and AM = 0, the acknowledge signal is output across the row address, read command, wait and read address of the DMAC read (figure 9.19). Since the synchronous DRAM read has only burst mode, during a single read an invalid address is output; the acknowledge signal, however, is output on the same timing (figure 9.20). At this time, the acknowledge signal is extended until the write address is output after the invalid read. When AM = 1, the acknowledge signal is output across the row address and column address of the DMAC write (figure 9.21).





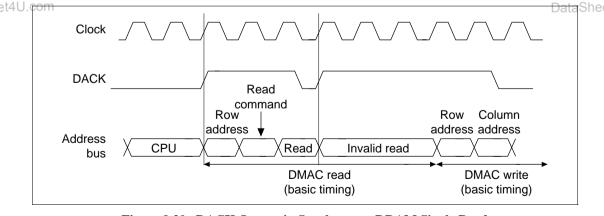
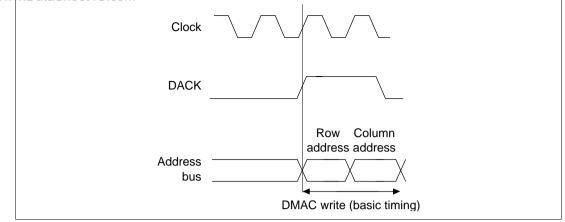
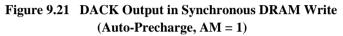


Figure 9.20 DACK Output in Synchronous DRAM Single Read (Auto-Precharge, AM = 0)

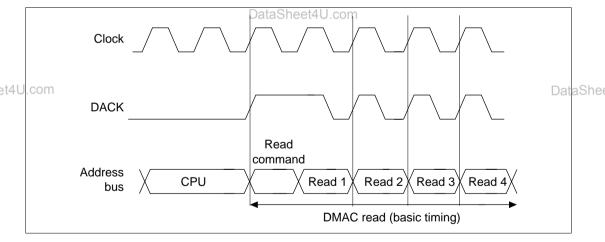
DataSheet4U.com

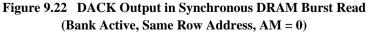
www.DataSheet4U.com





When external memory is set as bank active synchronous DRAM, during a burst read the acknowledge signal is output across the read command, wait and read address when the row address is the same as the previous address output (figure 9.22). When the row address is different from the previous address, the acknowledge signal is output across the precharge, row address, read command, wait and read address (figure 9.23).





DataSheet4U.com

www.DataSheet4U.com

262 DataSheet4U.com

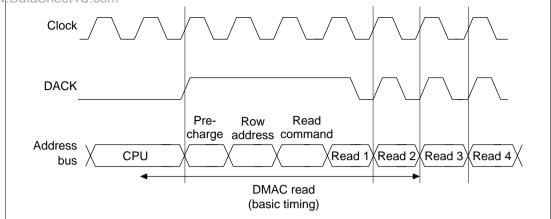


Figure 9.23 DACK Output in Synchronous DRAM Burst Read (Bank Active, Different Row Address, AM = 0)

When external memory is set as bank active synchronous DRAM, during a single read the acknowledge signal is output across the read command, wait and read address when the row address is the same as the previous address output (figure 9.24). When the row address is different from the previous address, the acknowledge signal is output across the precharge, row address, read command, wait and read address (figure 9.25). Since the synchronous DRAM read has only burst mode, during a single read an invalid address is output; the acknowledge signal is output on the same timing. At this time, the acknowledge signal is extended until the write address is output after the invalid read.

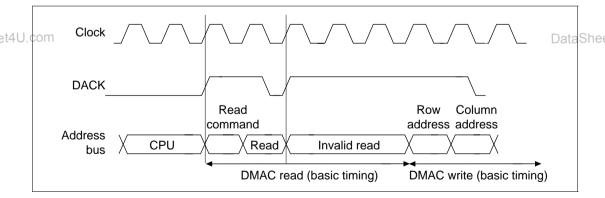


Figure 9.24 DACK Output in Synchronous DRAM Single Read (Bank Active, Same Row Address, AM = 0)

DataSheet4U.com

www.DataSheet4U.com

Renesas

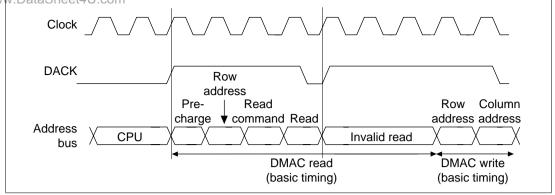
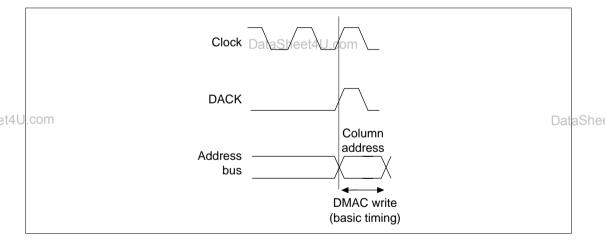
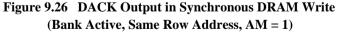


Figure 9.25 DACK Output in Synchronous DRAM Single Read (Bank Active, Different Row Address, AM = 0)

When external memory is set as bank active synchronous DRAM, during a write the acknowledge signal is output across the wait and column address when the row address is the same as the previous address output (figure 9.26). When the row address is different from the previous address, the acknowledge signal is output across the precharge, row address, wait and column address (figure 9.27).





DataSheet4U.com

www.DataSheet4U.com

264 DataSheet4U.com

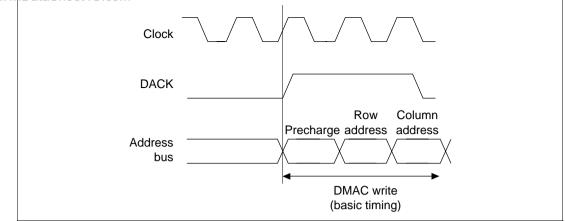


Figure 9.27 DACK Output in Synchronous DRAM Write (Bank Active, Different Row Address, AM = 1)

Acknowledge Signal Output when External Memory Is Set as DRAM: When external memory is set as DRAM and a row address is output during a read or write, the acknowledge signal is output across the row address and column address (figures 9.28–9.30).

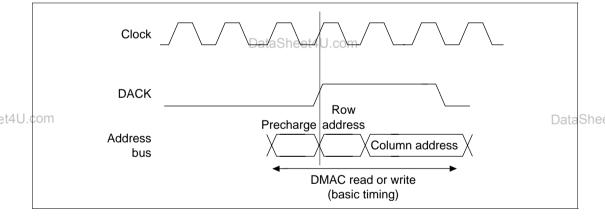
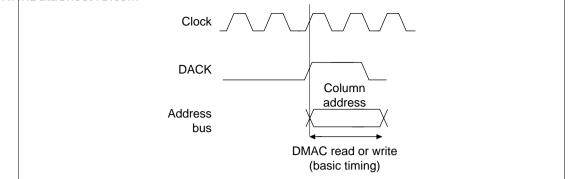
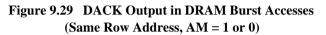


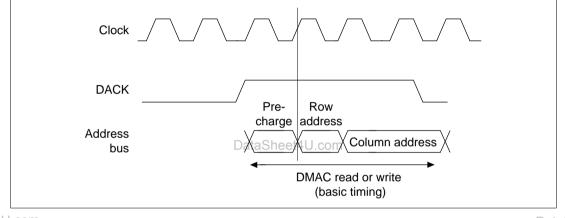
Figure 9.28 DACK Output in Normal DRAM Accesses (AM = 1 or 0)

DataSheet4U.com

www.DataSheet4U.com







et4U.com

Figure 9.30 DACK Output in DRAM Burst Accesses (Different Row Address, AM = 1 or 0)

DataShe

Acknowledge Signal Output when External Memory Is Set as Pseudo-SRAM: When external memory is set as pseudo-SRAM, the acknowledge signal is output synchronous to the DMAC address for both reads and writes (figures 9.31–9.33).

DataSheet4U.com

www.DataSheet4U.com

266 DataSheet4U.com

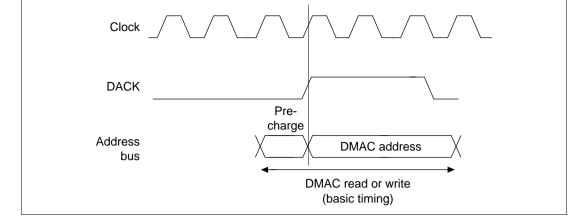
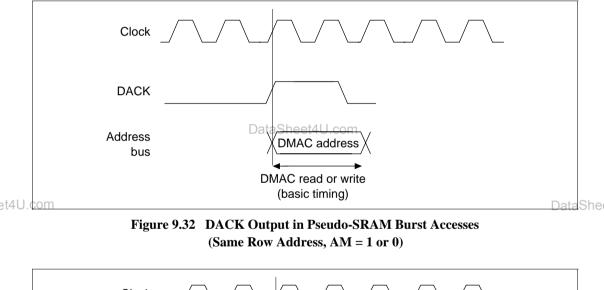
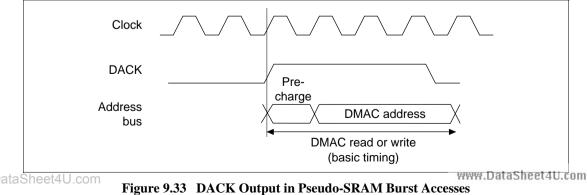


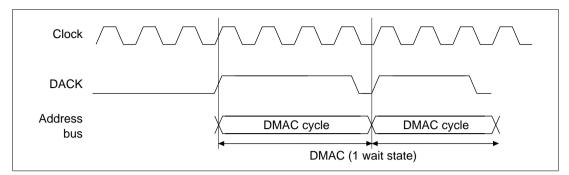
Figure 9.31 DACK Output in Normal Pseudo-SRAM Accesses (AM = 1 or 0)





(Different Row Address, AM = 1 or 0)

Acknowledge Signal Output When External Memory Is Set as Burst ROM: When external memory is set as burst ROM, the acknowledge signal is output synchronous to the DMAC address (no dual writes allowed) (figure 9.34).





9.3.7 DREQ Pin Input Detection Timing

In external request mode, DREQ pin signals are usually detected at the rising edge of the clock pulse (CKIO). When a request is detected, a DMAC bus cycle is produced three cycles later at the earliest and a DMA transfer performed. After the request is detected, the timing of the next input detection varies with the bus mode, address mode, method of DREQ input detection, and the memory connected. DataSheet4U.com

DREQ Pin Input Detection Timing in Cycle-Steal Mode:

In cycle-steal mode, once a request is detected from the DREQ pin, request detection for the next t4U. DMA transfer cannot be performed for a certain period of time. After request detection has againDataShe become possible, detectable cycles continue until a request is detected.

Figure 9.35 illustrates the timing from the detection of a request till the next time requests are detectable.

• Cycle-Steal Mode Edge Detection

Requests can be detected 2 cycles after DACK output. After that point, the request is input to DREQ. (If input prior to that point, a request may or may not be detected, depending on the internal state.)

DataSheet4U.com

www.DataSheet4U.com



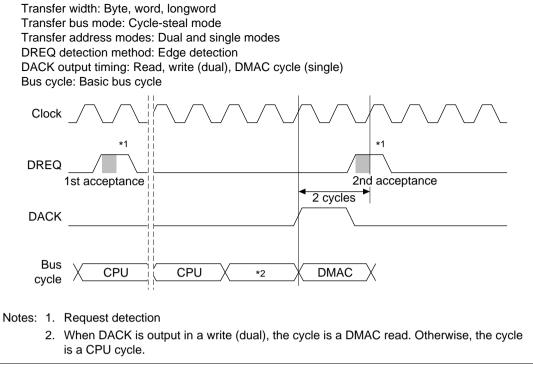


Figure 9.35 DREQ Pin Input Detection Timing in Cycle-Steal Mode with Edge Detection (1)

Figures 9.36 and 9.37 show examples of how to change the bus width of an external device.

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

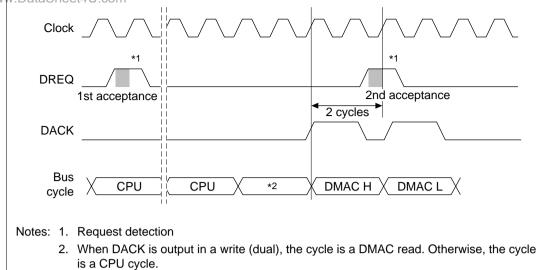


Figure 9.36 Changing the Bus Size of a 16-Bit External Device

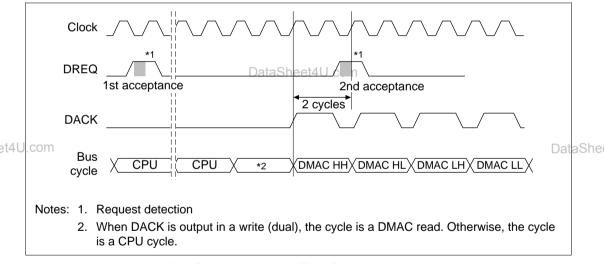


Figure 9.37 Changing the Bus Size of an 8-Bit External Device

DataSheet4U.com

www.DataSheet4U.com

270 DataSheet4U.com

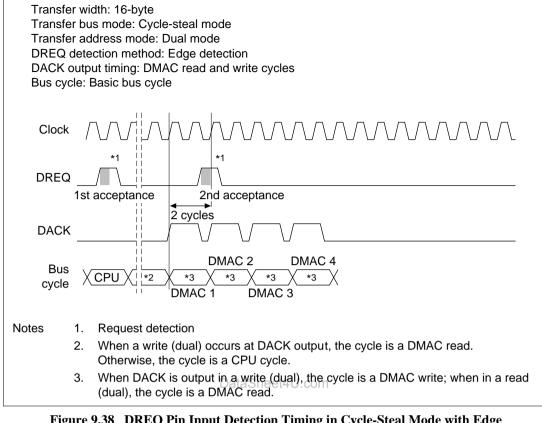


Figure 9.38 DREQ Pin Input Detection Timing in Cycle-Steal Mode with Edge **Detection** (2)

Requests can be detected 2 cycles after DACK output. After that point, the request is input to DREQ. (If input prior to that point, a request may or may not be detected, depending on the internal state.) DACK is output synchronous to all 4 transfers (figure 9.38).

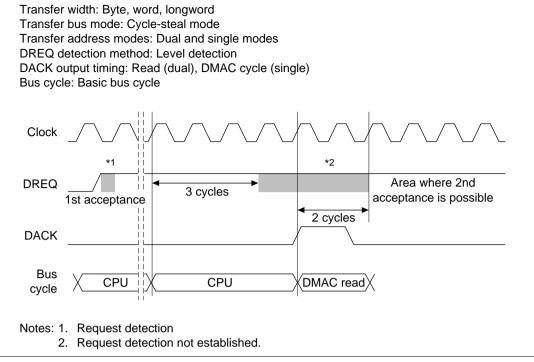


Figure 9.39 Timing of DREQ Pin Input Detection in Cycle-Steal Mode with Level Detection (1)

• Cycle-Steal Mode Level Detection

Requests can be detected for the first time 3 cycles after the bus cycle prior to the DMAC read cycle and detection starts sometime between then and 2 cycles after DACK output (figure 9.40, at a She 41). This varies with variations in waits and the like. This means that if request output is stopped within 3 cycles from the bus cycle prior to the DMAC read cycle, the next DMA transfer is not performed; if request output is stopped within 2 cycles of DACK output, the next DMA transfer may sometimes be performed. See Examples of Handling of Request Signal Acceptance later in this section (9.3.7).

DataSheet4U.com

www.DataSheet4U.com

www.DataSheet4U.com

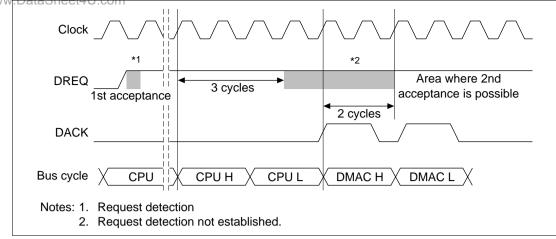


Figure 9.40 Changing the Bus Size of a 16-Bit External Device

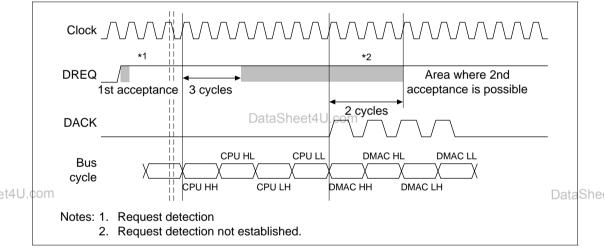
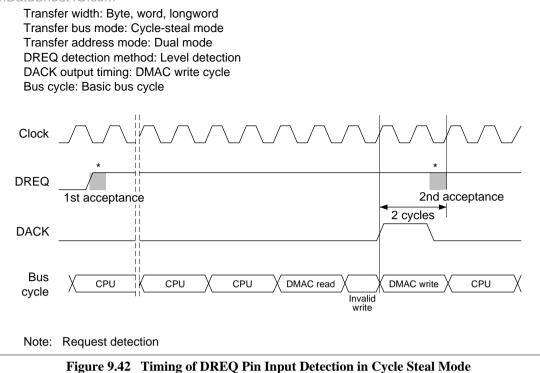


Figure 9.41 Changing the Bus Size of an 8-Bit External Device

DataSheet4U.com



with Level Detection (2)

The next request can be detected 2 cycles after DACK output (figure 9.42).

et4U.com

DataShe

DataSheet4U.com

www.DataSheet4U.com

274 DataSheet4U.com

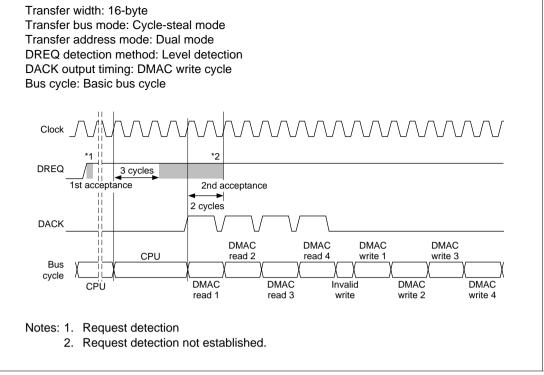
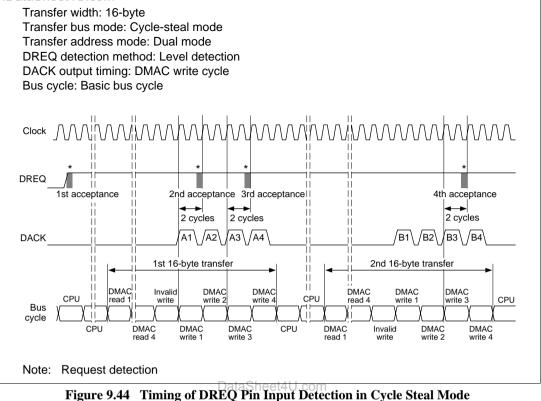


Figure 9.43 Timing of DREQ Pin Input Detection in Cycle Steal Mode with Level Detection (3)

Requests can be detected for the first time 3 cycles after the bus cycle prior to the DMAC read cycle and starts sometime between then and 2 cycles after DACK output (figure 9.43). This varies with variations in waits and the like. This means that if request output is stopped within 3 cycles at a She from the bus cycle prior to the DMAC read cycle, the next DMA transfer is not performed; if request output is stopped within 2 cycles of DACK output, the next DMA transfer may sometimes be performed.

DataSheet4U.com



with Level Detection (4)

For 16-byte transfers, DACK signals are output at all consecutive writes (figure 9.44). The et4U.cacknowledge signals are A1, A2, A3, A4, B1, B2, B3, B4,

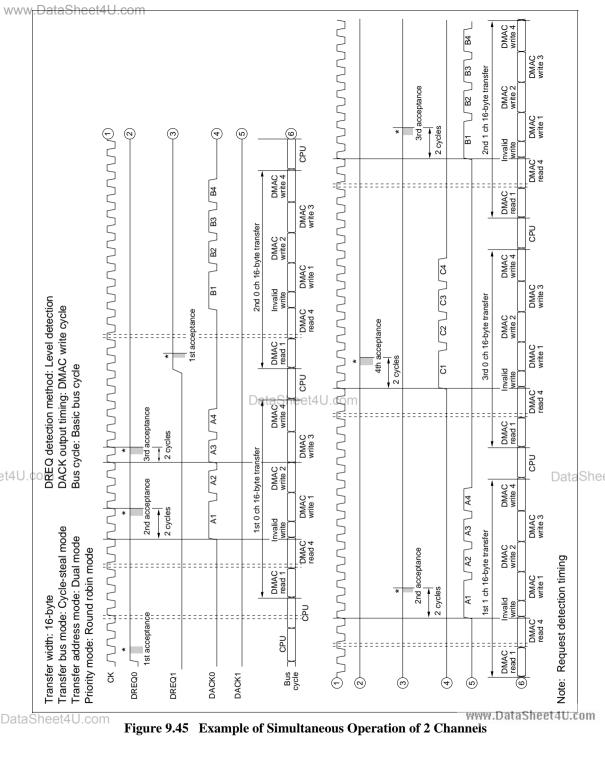
DataShe

The second transfer request can be detected 2 cycles after output of acknowledge signal A1. The third transfer request is detected at A3, that is, 2 cycles after output of the third acknowledge signal of the first transfer. The fourth transfer request is detected 2 cycles after output of B3. Requests thereafter are detected 2 cycles after the third acknowledge signal of each transfer, as with the fourth transfer.

Note: When transferring alternately on channels 0 and 1 by round robin or the like, the next request signal is detected only 2 cycles after the first acknowledge signal of each transfer (figure 9.45).

DataSheet4U.com

www.DataSheet4U.com



RENESAS

277

www.DataSheet4U.com

DREQ Pin Input Detection Timing in Burst Mode: In burst mode, the request detection timing differs when DREQ input is detected by edge and when detected by level.

When DREQ input is detected by edge, once a request is detected, DMA transfers continue until the conditions for ending the transfers are met, regardless of the state of the DREQ pin thereafter. During this period, requests cannot be detected. When the transfer start conditions are met after a transfer ends, requests can be detected again for each cycle.

When DREQ input is detected by level, whenever a request is detected for the same channel as in the next request detection cycle, that channel is executed continuously. When no request is input, however, the bus cycles of other channels and other bus masters are executed.

• Burst Mode, Single Mode, Level Detection

Acknowledge signals for request signals are output 3 cycles later at the earliest. Even when the request signal is dropped within 2 cycles of the output of this acknowledge signal, the fourth or fifth requests in figure 9.46 are accepted. This means that 4 or 5 DMA transfers are executed even when the request for the 1st acknowledge signal drops out.

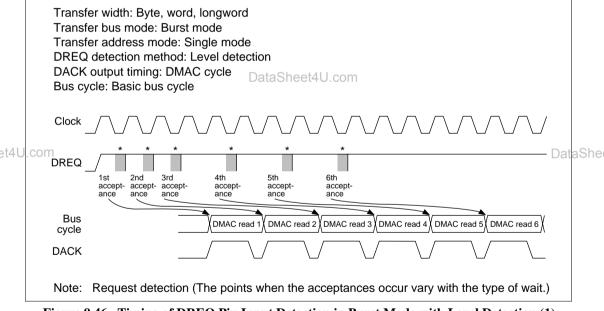


Figure 9.46 Timing of DREQ Pin Input Detection in Burst Mode with Level Detection (1) (Data Transfer from Normal Space to Device)

DataSheet4U.com

www.DataSheet4U.com

278 DataSheet4U.com

www.DataSheet4U.com

Acknowledge signals for request signals are output 4 cycles later, at the soonest. Even when the request signal is dropped within 0.5 cycle of the output of this acknowledge signal, the third request in figure 9.46 is accepted. This means that the 3rd DMA transfer is executed even when the request for the 1st acknowledge signal drops out. The detection timing for the 4th and subsequent requests is as shown in figure 9.46.

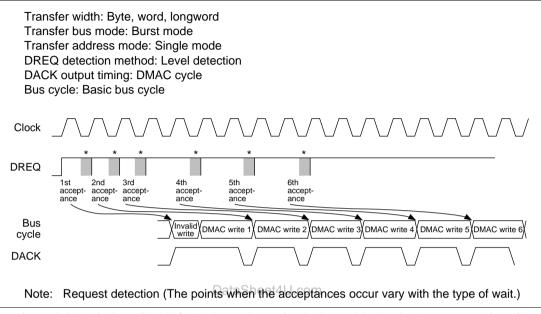


Figure 9.47 Timing of DREQ Pin Input Detection in Burst Mode with Level Detection (2) (Data Transfer from Device to Normal Space)

et4U.coAcknowledge signals for request signals are output 4 cycles later at the earliest. Even when the DataSher request signal is dropped within 0.5 cycle of the output of this acknowledge signal, the third request in figure 9.47 is accepted. This means that the 3rd DMA transfer is executed even when the request for the first acknowledge signal drops out. The detection timing for the 4th and subsequent requests is a shown in figure 9.47.

Note on Evaluation Chip: The request signal detection timing in the evaluation chip differs from that in the user chip. The evaluation chip detection timing corresponding to figures 9.46 and 9.47 is shown in figures 9.48 and 9.49.

DataSheet4U.com

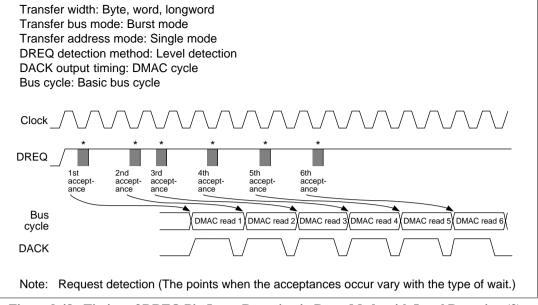
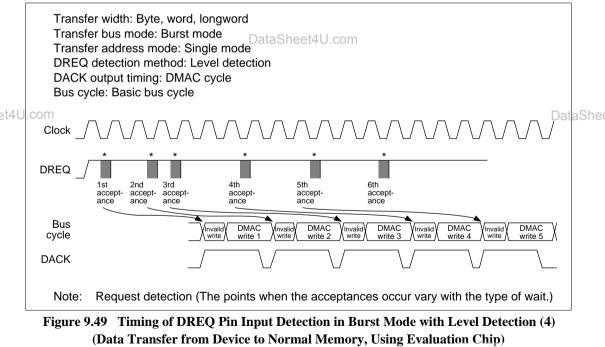


Figure 9.48 Timing of DREQ Pin Input Detection in Burst Mode with Level Detection (3) (Data Transfer from Normal Space to Device, Using Evaluation Chip)



DataSheet4U.com

www.DataSheet4U.com

Burst Mode, Dual Mode, Level Detection

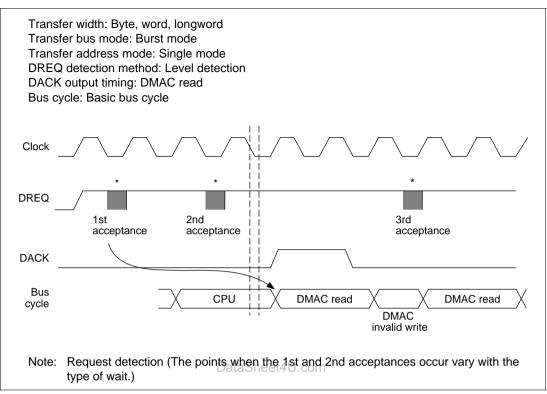


Figure 9.50 Timing of DREQ Pin Input Detection in Burst Mode with Level Detection (5)

Acknowledge signals for request signals are output 4 cycles later, at the soonest. Even when the request signal is dropped within 0.5 cycle of the output of the acknowledge signal, the 2nd request in figure 9.50 is accepted. This means that two DMA transfers are executed even when the request for the 1st acknowledge signal drops out.

DataSheet4U.com

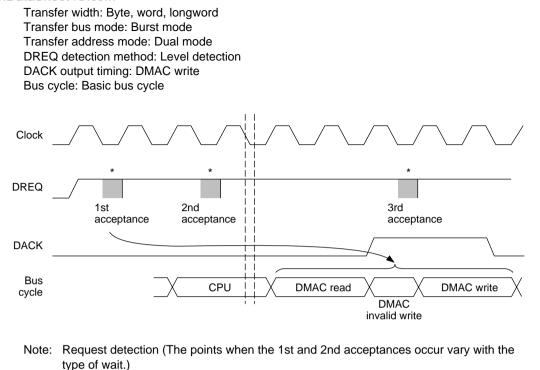


Figure 9.51 Timing of DREQ Pin Input Detection in Burst Mode with Level Detection (6)

Acknowledge signals for request signals are output 6 cycles later, at the soonest. Even when the request signal is dropped within 0.5 cycle of the output of the acknowledge signal, the 2nd request in figure 9.51 is accepted. This means that two DMA transfers are executed even when the request for the 1st acknowledge signal drops out.

Examples of Handling of Request Signal Acceptance: When DREQ level acceptance is used in the cycle-steal mode, the following methods can be used when the request signal is received:

- 1. Control the number of transfers by TCR
- 2. Use edge for request acceptance
- 3. Perform acknowledge signal output at the DMAC write timing

Additional Cautions when Emulators Are Used: When DREQ level acceptance is by an emulator in cycle-steal mode, the timing of request signal acceptance is 2 cycles after the output of the acknowledge signal, so it differs from ordinary specifications. This means that when DMAC operation is emulated, the timing is somewhat different, which may have other ramifications.

DataSheet4U.com

www.DataSheet4U.com